## FAIRCHILD

## BIPOLAR

MICROPROC=ssor DATABOOK

$\$ 3.00$

# MACROLOGIC BIPOLAR MICROPRDCESSOR DATABDOK 



## FAIROHILD

## TABLE OF CONTENTS

Page
SECTION 1
Introduction ..... 1-3
SECTION 2 - DEVICE INDEX AND SELECTOR INFORMATION
Numerical Index of Devices ..... 2-3
Device Selector Guide by Function ..... 2-4
Functional Building Blocks by Technology ..... 2-4
Memory Products Selector Guide ..... 2-5
SECTION 3 - BIPOLAR MACROLOGIC
General Description and Features ..... 3-3
${ }^{13} \mathrm{~L}$ Technology ..... 3-3
Design Considerations ..... 3-4
Definition of Symbols and Terms ..... 3-8
Device Data Sheets ..... 3-11
SECTION 4 - CMOS MACROLOGIC
General Description and Features ..... 4-3
Isoplanar C Technology ..... 4-3
Design Considerations ..... 4-3
JEDEC Industry Standard "B" Series CMOS ..... 4-8
Definition of Symbols and Terms ..... 4-11
4700 Series CMOS Family Characteristics ..... 4-13
Device Data Sheets ..... 4-17
SECTION 5 - MACROLOGIC APPLICATIONS
Microprogramming with Macrologic ..... 5-3
Implementing Data Paths with Macrologic ..... 5-14
A Simple Processor Example ..... 5-16
Macrologic Assemblers ..... 5-20
Cyclic Checks for Error Detection ..... 5-21
Programmable Bit-Rate Generator ..... 5-29
Using the 9403 and 4703 FIFOs ..... 5-35
SECTION 6
Order and Package Information ..... 6-3
SECTION 7
Fairchild Field Sales Offices, Representatives and Distributors ..... 7-3

BIPOLAR MACROLOGIC

## CMOS MACROLOGIC

## INTRODUCTION

Microprogramming is a practical method for implementing as many system functions as possible in one "centralized" logic block that is controlled by "instructions" stored in a memory. This is accomplished using a mixture of hardware and software techniques. Since designing microprogrammed systems with SSI/MSI is rather difficult and tedious, in the past there has been only limited use of microprogramming except by sophisticated users. Recently, however, the dramatic increase in digitalsystem complexity has opened up the field of microprogramming and the proliferation of available microprocessors has greatly simplified the designer's task. While focus has been on the MOS microprocessor families, interest is now moving toward the higher speed bipolar bit-slice microprocessors for microprogrammed system design. Where ultra-low power consumption and high noise margin are crucial factors, CMOS bit-slice microprocessors are gaining popularity.

Fairchild Macrologic is an LSI bit-slice family designed for optimum performance, versatility and system-cost effectiveness. The main goal in its development was to provide a set of functional building blocks that the typical design engineer frequently required but formerly had to implement with SSI and MSI. In some cases, this amounted to a straightforward combination of a number of existing MSI onto a single chip; for example, the ALRS - the foundation of the bipolar microprocessor chip set. The ALRS combines ALU, RAM, 3-state registers, and decode logic to form a fast 4-bit CPU. Other functions, however, differed considerably from existing SSI and MSI devices and consequently were difficult and expensive to implement. An example of this is the cyclic redundancy checker - a combination of shift register, ROM and exclusive-OR logic that provides the error-detecting function on one chip.

Once the functions were determined, the most appropriate technology for a particular function was selected. In some cases, low power Schottky was chosen; in some, Isoplanar Integrated Injection Logic (I3LTM); in others, CMOS or Isoplanar Schottky. Certain functions turned out to be feasible in two or more of these advanced technologies.

This databook is divided into four major sections. The first (Section 2) includes selector information for locating functions and available technologies for a given function. Also, since all Macrologic applications require memory circuits, a list of Fairchild memories is included. Section 3 contains bipolar Macrologic (advanced Schottky TTL and $\mathrm{I}^{3}$ L) data sheets. Section 4 includes the CMOS Macrologic data sheets. To illustrate the versatility of this bit-slice family, the final technical section (Section 5) introduces the reader to a few of the many Macrologic applications. It is important to realize that Macrologic can be used to implement highly sophisitcated microprogrammed digital systems, and the list of applications is virtually endless.


APPLICATIONS
5

## NUMERICAL INDEX OF DEVICES

DEVICE NO. DESCRIPTION ..... PAGE
4702 Programmable Bit-Rate Generator ..... 4-1747034704
4705$16 \times 4$ Parallel/Serial FIFO4-25
Data Path Switch ..... 4-40
Arithmetic Logic Register Stack ..... 4-45
4706 Program Stack ..... 4-53
4707 Data Access Register ..... 4-65
4708 Microprogram Sequencer ..... 4-73
4710 $16 \times 4$ Clocked RAM with 3-State Output Register ..... 4-80
9401 CRC Generator Checker ..... 3-119403
94049405
FIFO Buffer Memory ..... 3-15
Data Path Switch ..... 3-29
Arithmetic Logic Register Stack ..... 3-33
9405 with Register-to-Register Transfer ..... 3-40
Program Stack ..... 3-53
Data Access Register ..... 3-64
Microprogram Sequencer ..... 3-71
$16 \times 4$ Clocked RAM with 3-State Output Register ..... 3-78

## DEVICE SELECTOR GUIDE BY FUNCTION

FUNCTION
DEVICE NO.
TECHNOLOGY
Address Arithmetic 4707, 9407 CMOS, LS
Arithmetic Logic Unit (ALU) 4705, 9405, 9405A CMOS, LS
Bit-Rate Generator 4702 CMOS
Byte Masking 4704, 9404 CMOS, LS
Cyclic Redundancy Checks ..... 9401 ..... LS
FIFO, $16 \times 4$ Expandable 4703, 9403 CMOS, LS
FIFO, $64 \times 4$ Expandable 9423* ..... $\|^{3} L^{T M}$
LIFO Stack 4706, 9406 CMOS, LS
Microprogram Sequencer 4708, 9408 CMOS, $I^{3} L^{T M}$
Multiplexing 4704, 9404 CMOS, LS
Program Counter 4706, 9406 CMOS, LS
4707, 9407
Registers, Intelligent 4705, 9405, 9405A CMOS, LS
4707, 9407
Registers, Not Intelligent 4710, 9410 CMOS, LS
Sign Extension 4704, 9404 CMOS, LS
Stack Pointer4707, 9407CMOS, LS
*To be announced
FUNCTIONAL BUILDING BLOCKS BY TECHNOLOGY


## MEMORY PRODUCTS SELECTOR GUIDE

The following selector guide lists Fairchild memory products which will be useful when designing with Fairchild Macrologic. Device specifications for Fairchild memory products are available either as separate data sheets or within their respective technology data books - Bipolar Memory Data Book and MOS/CCD Data Book.

STATIC RAMS

| TECHNOLOGY | DEVICE NO. | ORGANIZATION | $\begin{gathered} \text { ACCESS } \\ \text { TIME } \\ \text { tAA } \\ \text { MAX (TYP) } \\ \text { ns } \end{gathered}$ | POWER DISSIPATION $P_{D}$ MAX (TYP) mW | NO. OF <br> PINS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CMOS | 4720 | $256 \times 1$ | 100 |  | 16 |
| cMOS | 4721*** | $256 \times 4$ | (450) |  | 22 |
| cmos | 4736*** | $1024 \times 1$ | (500) |  | 16 |
| ECL | 10145A | $16 \times 4$ | 9.0 | (500) | 16 |
| ECL | 10405 | $128 \times 1$ | 15 | (470) | 16 |
| ECL | 10410 | $256 \times 1$ | 30 | (475) | 16 |
| ECL | 10411 | $256 \times 1$ | 35 | (360) | 16 |
| ECL | 10415 | $1024 \times 1$ | 60 | (475) | 16 |
| ECL | 10415A | $1024 \times 1$ | 35 | (475) | 16 |
| ECL | 100415 | $1024 \times 1$ | (20) | (500) | 24 |
| MOS | 2102 | $1024 \times 1$ | 1000 | 160 | 16 |
| MOS | 2102-1 | $1024 \times 1$ | 450 | 160 | 16 |
| MOS | 2102-2 | $1024 \times 1$ | 650 | 160 | 16 |
| MOS | 2102F | $1024 \times 1$ | 350 | 160 | 16 |
| MOS | 2102 F 2. | $1024 \times 1$ | 250 | 110 | 16 |
| MOS | 2102LF | $1024 \times 1$ | 350 | 110 | 16 |
| MOS | 2102LF2 | $1024 \times 1$ | 250 | 110 | 16 |
| MOS | 2102L1 | $1024 \times 1$ | 450 | 110 | 16 |
| MOS | 2102L2 | $1024 \times 1$ | 650 | 110 | 16 |
| MOS | 3539 | $256 \times 8$ | 650 | 275 | 22 |
| MOS | 3539-1 | $256 \times 8$ | 400 | 275 | 22 |
| MOS | 3539-2 | $256 \times 8$ | 500 | 275 | 22 |
| MOS | 3542 | $1024 \times 1$ | 150 | 200 | 16 |
| MOS | 3542-2 | $1024 \times 1$ | 120 | 200 | 16 |
| MOS | 3544** | $1024 \times 4$ | 250 | 450 | 18 |
| TTL | 93419 | $64 \times 9$ | 40 | (725) | 28 |
| TTL | 93410 | $256 \times 1$ | 60 | (450) | 16 |
| TTL | 93410A | $256 \times 1$ | 45 | (450) | 16 |
| TTL | 93411 | $256 \times 1$ | 55 | (475) | 16 |
| TTL | 93411A | $256 \times 1$ | 45 | (475) | 16 |
| TTL | 93L420 | $256 \times 1$ | 45 | (275) | 16 |
| TTL | 93421 | $256 \times 1$ | 50 | (475) | 16 |
| TTL | 93421A | $256 \times 1$ | 40 | (475) | 16 |
| TTL | 93L421 | $256 \times 1$ | 90 | (275) | 16 |
| TTL | 93L412 | $256 \times 4$ | 70 | (250) | 22,24 |
| TTL | 93L422 | $256 \times 4$ | 70 | (250) | 22,24 |
| TTL | 93415 | $1024 \times 1$ | 70 | (475) | 16 |
| TTL | 93415A | $1024 \times 1$ | 45 | (475) | 16 |
| TTL | 93L415 | $1024 \times 1$ | 95 | (200) | 16 |
| TTL | 93425 | $1024 \times 1$ | 70 | (475) | 16 |
| TTL | 93425A | $1024 \times 1$ | 45 | (475) | 16 |
| TTL | 93L425 | $1024 \times 1$ | 95 | (200) | 16 |
| TTL | 93470** | $4096 \times 1$ |  | (950) | 18 |
| TTL | 93471** | $4096 \times 1$ |  | (950) | 18 |

## MEMORY PRODUCTS SELECTOR GUIDE (Cont'd)

DYNAMIC RAMS

|  |  |  | ACCESS |  |  |
| :--- | :--- | :---: | :---: | :---: | :---: |
| TECHNOLOGY | DEVICE NO. | ORGANIZATION | POWER <br> TAA <br> MAX (TYP) <br> ns | DISSIPATION <br> PD <br> MAX (TYP) <br> mW | NO. <br> OF |
|  |  |  |  | PINS |  |

ROMS

| TECHNOLOGY | DEVICE NO. | ORGANIZATION | $\begin{gathered} \text { ACCESS } \\ \text { TIME } \\ \text { tAA } \\ \text { MAX (TYP) } \\ \text { ns } \end{gathered}$ | POWER DISSIPATION PD MAX (TYP) mW | $\begin{gathered} \text { NO. } \\ \text { OF } \\ \text { PINS } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CMOS | 4735* ** | $256 \times 8$ | (250) |  | 24 |
| MOS | 3515 | $512 \times 8$ | 600 |  | 24 |
| TTL | 93457 | $256 \times 4$ | 45 | (425) | 16 |
| TTL | 93467 | $256 \times 4$ | 45 | (425) | 16 |
| TTL | 93431 | $512 \times 4$ | 50 | (475) | 16 |
| TTL | 93441 | $512 \times 4$ | 50 | (475) | 16 |
| TTL | 93432 | $512 \times 8$ | 55 | (650) | 24 |
| TTL | 93442 | $512 \times 8$ | 55 | (650) | 24 |
| TTL | 93454 | $1024 \times 8$ | 45 | (550) | 24 |
| TTL | 93464 | $1024 \times 8$ | 45 | (550) | 24 |

PROMS

| TECHNOLOGY | DEVICE NO. | ORGANIZATION | ACCESS TIME | POWER DISSIPATION | NO. |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} \text { tAA } \\ \text { MAX (TYP) } \\ \text { ns } \end{gathered}$ | $\begin{aligned} & \mathrm{PD} \\ & \mathrm{MAX}(\mathrm{TYP}) \\ & \mathrm{mW} \end{aligned}$ | $\begin{aligned} & \text { OF } \\ & \text { PINS } \end{aligned}$ |
| ECL | 10416** | $256 \times 4$ | (15) | (500) | 16 |
| TTL | 93417 | $256 \times 4$ | 45 | (425) | 16 |
| TTL | 93427 | $256 \times 4$ | 45 | (425) | 16 |
| TTL | 93436 | $512 \times 4$ | 50 | (475) | 16 |
| TTL | 93446 | $512 \times 4$ | 50 | (475) | 16 |
| TTL | 93438 | $512 \times 8$ | 55 | (650) | 24 |
| TTL | 93448 | $512 \times 8$ | 55 | (650) | 24 |
| TTL | 93452** | $1024 \times 4$ | (35) | (650) | 18 |
| TTL | 93453** | $1024 \times 4$ | (35) | (650) | 18 |

[^0]**Available 4th quarter 1976

## INTRODUCTION



## 9400 <br> BIPOLAR MACROLOGIC SERIES

## GENERAL DESCRIPTION

Fairchild 9400 Macrologic Series utilizes advanced Schottky and $I^{3} L^{\text {TM }}$ technology to provide high performance peripheral and processor oriented LSI. The design of 9400 ensures maximum design flexibility with no performance loss. The Bipolar Macrologic elements may be used with any bit length, instruction set or organization. Devices may be expanded with little or no extra components. Where applicable, bus oriented, 3 -state outputs are provided. A new, slim 24-pin package reduces PC board real estate by a third.

- 150-180 GATE COMPLEXITY
- COMPATIBLE WITH ALL TTL FAMILIES
- PERFORMANCE EQUIVALENT TO SCHOTTKY IMPLEMENTATION
- 14, 18, SLIM 24 AND 40-PIN PACKAGES
- INPUTS ABOUT 1/4 NORMAL TTL LOAD, i.e., 360-400 $\mu \mathrm{A}$
- OUTPUTS DRIVE 16 mA (10 U.L.) OR 8 mA (5 U.L.) DEPENDING ON APPLICATION
- DESIGNED FOR MAXIMUM FLEXIBILITY
- OPERATES OVER COMMERCIAL OR MILITARY TEMPERATURE RANGE


## I3L TECHNOLOGY

${ }^{3} \mathrm{~L}^{\text {TM }}$ (Isoplanar Integrated Injection Logic) combines the low power and high packing density advantages of ${ }^{12}$ L (Integrated Injection Logic) with the high speed and high packing density advantages of Fairchild's Isoplanar technology. The result is a process which offers low power ( $160 \mu \mathrm{~W}$ per gate), high speed ( 4 ns per gate) and extremely high packing density. $I^{3} \mathrm{~L}$ is used whenever high speed is required, but high complexity makes low power Schottky processing undesirable from a cost standpoint.

When designing with $I^{3} \mathrm{~L}$ Macrologic devices, TTL interface is not a problem as $I^{3} \mathrm{~L}$ Macrologic has standard on-chip TTL inputs and outputs. An I ${ }^{3} \mathrm{~L}$ current source also is contained on-chip, therefore only a single 5 V power supply is required and the chip appears to be TTL to the user. However, because internal logic is implemented with $I^{3} L$, the chip is smaller, uses less power and is less expensive than a TTL equivalent.


## DESIGN CONSIDERATIONS

TTL Macrologic has been designed so that its input and output levels and thresholds are equivalent to standard TTL when fan-out is no greater than 10. Therefore, the design considerations delineated on the following pages apply to Macrologic as well as any other TTL.

## Supply Voltage and Temperature Range

The nominal supply voltage (VCC) for all TTL, including 9400 Macrologic, is +5.0 V . Commercial grade parts
are guaranteed to perform with a $\pm 5 \%$ supply tolerance ( $\pm 250 \mathrm{mV}$ ) over an ambient temperature range of $0^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$. MIL-grade parts are guaranteed to perform with a $\pm 10 \%$ supply tolerance ( $\pm 500 \mathrm{mV}$ ) over an ambient temperature range of $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.

TTL families may be mixed for optimum system design. The following tables specify the worst case noise immunity in mixed systems.

## Worst Case TTL DC Noise Immunity / Noise Margins

## Electrical Characteristics

| Symbol | Fairchild TTL Families | Military (-55 to $+125^{\circ} \mathrm{C}$ ) |  |  |  | Commercial ( 0 to $75^{\circ} \mathrm{C}$ ) |  |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | VIL | $\mathrm{V}_{\text {IH }}$ | $\mathrm{V}_{\mathrm{OL}}$ | VOH | VIL | $\mathrm{V}_{\text {IH }}$ | VOL | VOH |  |
| TTL | Standard TTL 9000, 9N (54/74) | 0.8 | 2.0 | 0.4 | 2.4 | 0.8 | 2.0 | 0.4 | 2.4 | V |
| HTTL | High Speed TTL 9H (54H/74H) | 0.8 | 2.0 | 0.4 | 2.4 | 0.8 | 2.0 | 0.4 | 2.4 | V |
| LPTTL | Low Power TTL, 93LOO (MSI) | 0.7 | 2.0 | 0.3 | 2.4 | 0.8 | 2.0 | 0.3 | 2.4 | V |
| STTL | Schottky TTL 9S (54S/74S), 93S00 | 0.8 | 2.0 | 0.5 | 2.5 | 0.8 | 2.0 | 0.5 | 2.7 | V |
| LSTTL | Low Power Schottky TTL 9LS (54LS/74LS) | 0.7 | 2.0 | 0.4 | 2.5 | 0.8 | 2.0 | 0.5 | 2.7 | V |

$\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are the voltages generated at the output. $\mathrm{V}_{\mathrm{IL}}$ and $\mathrm{V}_{\mathrm{IH}}$ are the voltage required at the input to generate the appropriate output levels. The numbers given above are guaranteed worst-case values.

## LOW Level Noise Margins (Military)

| From | To | TTL | HTTL | LPTTL | STTL | LSTTL | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TTL | 400 | 400 | 300 | 400 | 300 | mV |  |
| HTTL | 400 | 400 | 300 | 400 | 300 | mV |  |
| LPTTL | 500 | 500 | 400 | 500 | 400 | mV |  |
| STTL | 300 | 300 | 200 | 300 | 200 | mV |  |
| LSTTL | 400 | 400 | 300 | 400 | 300 | mV |  |

From " $\mathrm{V}_{\mathrm{OL}}$ " to " $\mathrm{V}_{\mathrm{IL}}$ "

LOW Level Noise Margins (Commercial)

| From To | TTL | HTTL | LPTTL | STTL | LSTTL | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TTL | 400 | 400 | 400 | 400 | 400 | mV |
| HTTL | 400 | 400 | 400 | 400 | 400 | mV |
| LPTL | 500 | 500 | 500 | 500 | 500 | mV |
| STTL | 300 | 300 | 300 | 300 | 300 | mV |
| LSTTL | 300 | 300 | 300 | 300 | 300 | mV |

From " $\mathrm{V}_{\mathrm{OL}}$ " to " $\mathrm{V}_{\mathrm{IL}}$ "

HIGH Level Noise Margins (Military)

| From To | TTL | HTTL | LPTTL | STTL | LSTTL | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| TTL | 400 | 400 | 400 | 400 | 400 | mV |
| HTTL | 400 | 400 | 400 | 400 | 400 | mV |
| LPTTL | 400 | 400 | 400 | 400 | 400 | mV |
| STTL | 500 | 500 | 500 | 500 | 500 | mV |
| LSTTL | 500 | 500 | 500 | 500 | 500 | mV |

From " $\mathrm{V}_{\mathrm{OH}}$ " to " $\mathrm{V}_{\mathrm{IH}}$ "

HIGH Level Noise Margins (Commercial)

| From To | TTL | HTTL | LPTTL | STTL | LSTTL | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| TTL | 400 | 400 | 400 | 400 | 400 | mV |
| HTTL | 400 | 400 | 400 | 400 | 400 | mV |
| LPTTL | 400 | 400 | 400 | 400 | 400 | mV |
| STTL | 700 | 700 | 700 | 700 | 700 | mV |
| LSTTL | 700 | 700 | 700 | 700 | 700 | mV |

From " $\mathrm{V}_{\mathrm{OH}}$ " to " $\mathrm{V}_{\mathrm{IH}}$ "

## Fan-in and Fan-out

In order to simplify designing with Fairchild TTL devices, the input and output loading parameters of all families are normalized to the values shown at the right.

Input loading and output drive factors of all products described in this handbook are related to these definitions.

1 TTL Unit Load (U.L.) $=40 \mu \mathrm{~A}$ in the HIGH state (logic " 1 ")

1 TTL Unit Load (U.L.) $=1.6 \mathrm{~mA}$ in the LOW state (logic " 0 ')

Examples - Input Load

1. A 9NOO/7400 gate, which has a maximum IIL of 1.6 mA and $\mathrm{I}_{\mathrm{H}}$ of $40 \mu \mathrm{~A}$ is specified as having an input load factor of 1 U.L. (Also called a fan-in of 1 load.)
2. The 9LS95 which has a value of $\mathrm{I}_{\mathrm{IL}}=0.8 \mathrm{~mA}$ and $I_{\mathrm{IH}}$ of $40 \mu \mathrm{~A}$ on the CP terminal, is specified as having an input LOW load factor of

$$
\frac{0.8 \mathrm{~mA}}{1.6 \mathrm{~mA}} \text { or } 0.5 \mathrm{U} . \mathrm{L} .
$$

and an input HIGH load factor of

$$
\frac{40 \mu \mathrm{~A}}{40 \mu \mathrm{~A}} \text { or } 1 \mathrm{U} . \mathrm{L} .
$$

3. The 9LSOO gate which has an IIL of 0.36 mA and an $\mathrm{I}_{\mathrm{IH}}$ of $20 \mu \mathrm{~A}$, has an input LOW load factor of

$$
\frac{0.36 \mathrm{~mA}}{1.6 \mathrm{~mA}} \text { or } 0.225 \text { U.L. }
$$

(normally rounded to 0.25 U.L.) and an input HIGH load factor of

$$
\frac{20 \mu \mathrm{~A}}{40 \mu \mathrm{~A}} \text { or } 0.5 \mathrm{U} . \mathrm{L} .
$$

## Examples - Output Drive

1. The output of the 9NOO/7400 will sink 16 mA in the LOW (logic " 0 ") state and source $800 \mu \mathrm{~A}$ in the HIGH (logic " 1 ") state. The normalized output LOW drive factor is therefore

$$
\frac{16 \mathrm{~mA}}{1.6 \mathrm{~mA}}=10 \mathrm{U} . \mathrm{L} .
$$

and the output HIGH drive factor is

$$
\frac{800 \mu \mathrm{~A}}{40 \mu \mathrm{~A}} \text { or } 20 \mathrm{U} . \mathrm{L} .
$$

2. The output of the 9LSOOXC (Commercial Grade) will sink 8.0 mA in the LOW state and source $400 \mu \mathrm{~A}$ in the HIGH state. The normalized output LOW drive factor is

$$
\frac{8.0 \mathrm{~mA}}{1.6 \mathrm{~mA}} \text { or } 5 \mathrm{U} . \mathrm{L} .
$$

and the output HIGH drive factor is

$$
\frac{400 \mu \mathrm{~A}}{40 \mu \mathrm{~A}} \text { or } 10 \mathrm{U} . \mathrm{L} .
$$

Relative load and drive factors for the basic TTL families are given in Table I.

TABLE I

| FAMILY | INPUT LOAD |  | OUTPUT DRIVE |  |
| :--- | :---: | :---: | :---: | :---: |
|  | HIGH | LOW | HIGH | LOW |
| 9 LSOO | 0.5 U.L. | 0.25 U.L. | 10 U.L. | 5 U.L. |
| $9 N 00 / 7400$ | 1 U.L. | 1 U.L. | 20 U.L. | 10 U.L. |
| 9000 | 1 U.L. | 1 U.L. | 20 U.L. | 10 U.L. |
| $9 H 00 / 74$ H00 | 1.25 U.L. | 1.25 U.L. | 25 U.L. | 12.5 U.L. |
| 9S00/74S00 | 1.25 U.L. | 1.25 U.L. | 25 U.L. | 12.5 U.L. |

Values for MSI devices vary significantly from one element to another. Consult the appropriate data sheet for actual characteristics.

## Wired-OR Applications

Certain TTL devices are provided with an "open" collector output to permit the Wired-OR (actually WiredAND) function. This is achieved by connecting open collector outputs together and adding an external pullup resistor.

The value of the pull-up resistor is determined by considering the fan-out of the OR tie and the number of devices in the OR tie. The pull-up resistor value is chosen from a range between a maximum value (established to maintain the required $\mathrm{V}_{\mathrm{OH}}$ with all the OR tied outputs HIGH) and a minimum value (established so that the OR tie fan-out is not exceeded when only one output is LOW).

## Minimum and Maximum Pull-Up

Resistor Values

$$
\mathrm{R}_{\mathrm{X}(\mathrm{MIN})}=\frac{\mathrm{V}_{\mathrm{CC}(\mathrm{MAX})}-\mathrm{V}_{\mathrm{OL}}}{\mathrm{IOL}^{-N_{2}(\mathrm{LOW}) \cdot 1.6 \mathrm{~mA}}}
$$

$$
R_{X(M A X)}=\frac{V_{C C(M I N)}-V_{O H}}{N_{1} \cdot I_{O H}+N_{2}(H I G H) \cdot 40 \mu A}
$$

where:

| $\mathrm{R}_{\mathrm{X}}$ | $=$ External Pull-up Resistor |
| :--- | :--- |
| $\mathrm{N}_{1}$ | $=$ Number of Wired-OR Outputs |
| $\mathrm{N}_{2}$ | $=$ Number of Input Unit Loads being Driven |
| $\mathrm{I}_{\mathrm{OH}}=\mathrm{I}_{\mathrm{CEX}}$ | $=$ Output HIGH Leakage Current |
| $\mathrm{I}_{\mathrm{OL}}$ | $=$ LOW Level Fan-out Current of Driving Element |
| $\mathrm{V}_{\mathrm{OL}}$ | $=$ Output LOW Voltage Level $(0.5 \mathrm{~V})$ |
| $\mathrm{V}_{\mathrm{OH}}$ | $=$ Output HIGH Voltage Level $(2.4 \mathrm{~V})$ |
| $\mathrm{V}_{\mathrm{CC}}$ | $=$ Power Supply Voltage |

RX $\quad=$ External Pull-up Resistor
$\mathrm{N}_{1} \quad=$ Number of Wired-OR Outputs
$\mathrm{N}_{2} \quad=$ Number of Input Unit Loads being Driven
$\mathrm{I}_{\mathrm{OH}}=\mathrm{I}_{\mathrm{CEX}}=$ Output HIGH Leakage Current
IOL $\quad=$ LOW Level Fan-out Current of Driving Element
$\mathrm{V}_{\mathrm{OL}} \quad=$ Output LOW Voltage Level ( 0.5 V )
$\mathrm{V}_{\mathrm{OH}} \quad=$ Output HIGH Voltage Level (2.4 V)
$V_{C C} \quad=$ Power Supply Voltage

Example: Four 9LSO3 gate outputs driving four other 9LS gates or MSI inputs.

$$
\begin{gathered}
\mathrm{R}_{\mathrm{X}(\mathrm{MIN})}=\frac{5.25 \mathrm{~V}-0.5 \mathrm{~V}}{8 \mathrm{~mA}-1.6 \mathrm{~mA}}=\frac{4.75 \mathrm{~V}}{6.4 \mathrm{~mA}}=742 \Omega \\
\mathrm{R}_{\mathrm{X}(\mathrm{MAX})}=\frac{4.75 \mathrm{~V}-2.4 \mathrm{~V}}{4 \cdot 100 \mu \mathrm{~A}+2 \cdot 40 \mu \mathrm{~A}}=\frac{2.35 \mathrm{~V}}{0.48 \mathrm{~mA}}=4.9 \mathrm{k} \Omega
\end{gathered}
$$

where:

$$
\begin{array}{ll}
\mathrm{N}_{1} & =4 \\
\mathrm{~N}_{2}(\mathrm{HIGH}) & =4 \cdot 0.5 \mathrm{U} . \mathrm{L} .=2 \mathrm{U} . \mathrm{L} . \\
\mathrm{N}_{2}(\mathrm{LOW}) & =4 \cdot 0.25 \mathrm{U} . \mathrm{L} . \\
\mathrm{I}_{\mathrm{OH}} & =1 \mathrm{U} . \mathrm{L} . \\
\mathrm{I}_{\mathrm{OL}} & =8 \mathrm{~mA} \\
\mathrm{~V}_{\mathrm{OL}} & =0.5 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{OH}} & =2.4 \mathrm{~V}
\end{array}
$$

Any value of pull-up resistor between $742 \Omega$ and $4.9 \mathrm{k} \Omega$ can be used. The lower values yield the fastest speeds; the higher values yield the lowest power dissipation.

## Unused Inputs

For best noise immunity and switching speed, unused TTL inputs should not be left floating. These inputs should be held between 2.4 V and the absolute maximum input voltage.

Two possible ways of handling unused inputs are:

1. Connect unused input to $V_{C C}$. Most 9LS inputs have a breakdown voltage $>15 \mathrm{~V}$ and require, therefore, no series resistor. For all multi-emitter conventional TTL inputs, a 1 to $10 \mathrm{k} \Omega$ current limiting series resistor is recommended, to protect against $\mathrm{V}_{\mathrm{CC}}$ transients that exceed 5.5 V .
2. Connect the unused input to the output of un unused gate that is forced HIGH.

CAUTION: Do not connect an unused LSTTL input to another input of the same NAND or AND function. This method, recommended for normal TTL, increases the input coupling capacitance and thus reduces the ac noise immunity.

## Interconnection Delays

For those parts of a system in which timing is critical, designers should take into account the finite delay along the interconnections. This delay ranges from about 0.12 to $0.15 \mathrm{~ns} /$ inch for the type of interconnections normally used in TTL systems. Exceptions occur in systems using ground planes with STTL to reduce ground noise during a logic transition; ground planes give higher distributed capacitance and delays of about 0.15 to $0.22 \mathrm{~ns} /$ inch.

Most interconnections on a logic board are short enough that the wiring and load capacitance can be treated as a lumped capacitance for purposes of estimating their effect on the propagation delay of the driving circuit. When an interconnection is long enough that its delay is one-fourth to one-half of the signal transition time, the driver output waveform exhibits noticeable slope changes during a transition. This is evidence that during the initial portion of the output voltage transition the driver sees the characteristic impedance of the interconnection (normally $150 \Omega$ to $200 \Omega$ ), which for transient conditions appears as a resistor returned to the quiescent voltage existing just before the beginning of the transition. This characteristic impedance forms a voltage divider with the driver output impedance, tending to produce a signal transition having the same rise or fall time as in the no-load condition but with a reduced amplitude. This attenuated signal travels to the far end of the interconnection, which is essentially an unterminated transmission line, whereupon the signal starts doubling. Simultaneously, a reflection voltage is generated which has the same amplitude and polarity as the original signal, e.g., if the driver output signal is positive-going the reflection will be positive-going, and as it travels back toward the driver it adds to the line voltage. At the instant the reflection arrives at the driver it adds algebraically to the still-rising driver output, accelerating the transition rate and producing the noticeable change in slope.

If an interconnection is of such length that its delay is longer than half the signal transition time, the attenuated output of the driver has time to reach substantial completion before the reflection arrives. In the limit, the waveform observed at the driver output is a 2-step signal with a pedestal. In this circumstance the first load circuit to receive a full signal is the one at the far end, because of the doubling effect, while the last one to receive a full signal is the one nearest the driver since it must wait for the reflection to complete the transition. Thus, in a worst-cast situation, the net contribution to the overall delay is twice the delay of the interconnection because the initial part of the signal must travel to the far end of the line and the reflection must return.

When load circuits are distributed along an interconnection, the input capacitance of each will cause a small reflection having a polarity opposite that of the signal transition, and each capacitance also slows the transition rate of the signal as it passes by. The series of small reflections, arriving back at the driver, is subtractive and has the effect of reducing the apparent amplitude of the signal. The successive slowing of the transition rate of the transmitted signal means that it takes longer for the signal to rise or fall to the threshold level of any particular load circuit. A rough but workable approach is to treat the load capacitances as an increase in the intrinsic distributed capacitance of the interconnection. Increasing the distributed capacitance of a transmission line reduces its impedance and increases its delay. A good approximation for ordinary TTL interconnections is that distributed load capacitance decreases the characteristic impedance by about one-third and increases the delay by one-half.

Another advantage of LSTTL has to do with its output impedance during a positive-going transition. Whereas the low output impedance of STTL and HTTL allows
these circuits to force a larger initial swing into a low impedance interconnection, the low output impedance also has a disadvantage. It makes the reflection coefficient negative at the driven end of the interconnection, a circumstance that exists any time a transmission line is terminated by an impedance lower than its characteristic impedance. This means that when the reflection from the (essentially) open end of the interconnection arrives back at the driver it will be re-reflected with the opposite polarity. The result is a sequence of reflected signals which alternate in sign and decrease in magnitude, commonly known as ringing. The lower the driver output impedance, the greater the amplitude of the ringing and the longer it takes to damp out.

The output impedance of LSTTL, on the other hand, is closer to the characteristic impedance of the interconnections commonly used with TTL, and ringing is practically non-existent. Thus no special packaging is required. This advantage, combined with excellent speed, modest edge rates and very low transient currents, are some of the reasons that designers have found LSTTL extremely easy to work with and very cost effective.

## DEFINITION OF SYMBOLS AND TERMS USED IN THIS DATA BOOK

CURRENTS - Positive current is defined as conventional current flow into a device. Negative current is defined as conventional current flow out of a device. All current limits are specified as absolute values.

ICC Supply current - The current flowing into the $\mathrm{V}_{\mathrm{CC}}$ supply terminal of a circuit with the specified input conditions and the outputs open. When not specified, input conditions are chosen to guarantee worst case operation.
$\mathrm{I}_{\mathrm{IH}} \quad$ Input HIGH current - The current flowing into an input when a specified HIGH voltage is applied.

IL Input LOW current - The current flowing out of an input when a specified LOW voltage is applied.

IOH Output HIGH current - The leakage current flowing into a turned off open collector output with a specified HIGH output voltage applied. For devices with a pull-up circuit, the ${ }^{\mathrm{IOH}_{\mathrm{OH}}}$ is the current flowing out of an output which is in the HIGH state.

IOL. Output LOW current - The current flowing into an output which is in the LOW state.
IOS Output short circuit current - The current flowing out of an output which is in the HIGH state when that output is short circuited to ground (or other specified potential).

IOZH Output off HIGH current - The current flowing into a disabled 3-state output with a specified HIGH output voltage applied.

IOZL Output off LOW current - The current flowing out of a disabled 3-state output with a specified LOW output voltage applied.

VOLTAGES - All voltages are referenced to ground. Negative voltage limits are specified as absolute values (i.e., -10 V is greater than -1.0 V ).
$V_{\text {CC }} \quad$ Supply voltage - The range of power supply voltage over which the device is guaranteed to operate within the specified limits.
$\mathrm{V}_{\mathrm{CD}}$ (MAX) Input clamp diode voltage - The most negative voltage at an input when 18 mA is forced out of that input terminal. This parameter guarantees the integrity of the input diode which is intended to clamp negative ringing at the input terminal.
$\mathrm{V}_{\mathrm{IH}} \quad$ Input HIGH voltage - The range of input voltages that represents a logic HIGH in the system.
$\mathrm{V}_{\mathrm{IH}(\mathrm{MIN}) \quad \text { Minimum input HIGH voltage - The minimum allowed input HIGH in a logic system. This }}$ value represents the guaranteed input HIGH threshold for the device.
$\mathrm{V}_{\mathrm{IL}} \quad$ Input LOW voltage - The range of input voltages that represents a logic LOW in the system.
$V_{\text {ILIMAX }} \quad$ Maximum input LOW voltage - The maximum allowed input LOW in a system. This value represents the guaranteed input LOW threshold for the device.
$\mathrm{V}_{\mathrm{OH}(\mathrm{MIN}) \quad \text { Output HIGH voltage - The minimum voltage at an output terminal for the specified out- }}$ put current $\mathrm{I}_{\mathrm{OH}}$ and at the minimum value of $\mathrm{V}_{\mathrm{CC}}$.
$V_{\text {OL(MAX) }} \quad$ Output LOW voltage - The maximum voltage at an output terminal sinking the maximum specified load current lol.

| $\mathrm{V}_{\mathbf{T}+}$ | Positive-going threshold voltage - The input voltage of a variable threshold device (i.e., Schmitt Trigger) that is interpreted as a $\mathrm{V}_{\mathrm{IH}}$ as the input transition rises from below $\mathrm{V}_{\mathrm{T} \text {-(MIN). }}$ |
| :---: | :---: |
| $\mathrm{V}_{\text {T- }}$ | Negative-going threshold voltage - The input voltage of a variable threshold device (i.e., Schmitt Trigger) that is interpreted as a $\mathrm{V}_{\mathrm{IL}}$ as the input transition falls from above $V_{T+(M A X)}$. |
| AC SWITCHING PARAMETERS |  |
| ${ }^{\text {f MAX }}$ | Toggle frequency/operating frequency - The maximum rate at which clock pulses may be applied to a sequential circuit. Above this frequency the device may cease to function. |
| ${ }^{\text {tPLH }}$ | Propagation delay time - The time between the specified reference points, normally 1.3 V on the input and output voltage waveforms, with the output changing from the defined LOW level to the defined HIGH level. |
| ${ }^{\text {t }}$ HL | Propagation delay time - The time between the specified reference points, normally 1.3 V on the input and output voltage waveforms, with the output changing from the defined HIGH level to the defined LOW level. |
| ${ }^{\text {tw }}$ | Pulse width - The time between 1.3 V amplitude points on the leading and trailing edges of a pulse. |
| $t_{h}$ | Hold time - The interval immediately following the active transition of the timing pulse (usually the clock pulse) or following the transition of the control input to its latching level, during which interval the data to be recognized must be maintained at the input to ensure its continued recognition. A negative hold time indicates that the correct logic level may be released prior to the active transition of the timing pulse and still be recognized. |
| $\mathrm{t}_{\text {s }}$ | Set-up time - The interval immediately preceding the active transition of the timing pulse (usually the clock pulse) or preceding the transition of the control input to its latching level, during which interval the data to be recognized must be maintained at the input to ensure its recognition. A negative set-up time indicates that the correct logic level may be initiated sometime after the active transition of the timing pulse and still be recognized. |
| ${ }^{\text {tPHZ }}$ | Output disable' time (of a 3 -state output) from HIGH level - The time between the 1.3 V level on the input and a voltage 0.5 V below the steady state output HIGH level with the 3 -state output changing from the defined HIGH level to a high-impedance (off) state. |
| ${ }^{\text {t PLI }}$ | Output disable time (of a 3-state output) from LOW level - The time between the 1.3 V level on the input and a voltage 0.5 V above the steady state output LOW level with the 3 -state output changing from the defined LOW level to a high-impedance (off) state. |
| ${ }^{\text {tPZH }}$ | Output enable time (of a 3-state output) to a HIGH level - The time between the 1.3 V levels of the input and output voltage waveforms with the 3 -state output changing from a high-impedance (off) state to a HIGH level. |
| ${ }^{\text {t PZL }}$ | Output enable time (of a 3 -state output) to a LOW level - The time between the 1.3 V levels of the input and output voltage waveforms with the 3 -state output changing from a high-impedance (off) state to a LOW level. |
| $t_{\text {rec }}$ | Recovery time - The time between the 1.3 V level on the trailing edge of an asynchronous input control pulse and the 1.3 V level on a synchronous input (clock) pulse such that the device will respond to the synchronous input. |

## 9401

CRC GENERATOR/CHECKER

FAIRCHILD TTL MACROLOGIC

DESCRIPTION - The 9401 Cycle Redundancy Check (CRC) Generator/Checker provides an advanced tool for implementing the most widely used error detection scheme in serial digital data handling systems. A 3-bit control input selects one-of-eight generator polynomials. The list of polynomials includes CRC-16 and CRC-CCITT as well as their reciprocals (reverse polynomials). Automatic right justification is incorporated for polỳnomials of degree less than 16. Separate clear and preset inputs are provided for floppy disc and other applications. The Error output indicates whether or not a transmission error has occurred. Another control input inhibits feedback during check word transmission. The 9401 is fully compatible with all TTL families.

- gUARANTEED 10 MHz DATA RATE
- EIGHT SELECTABLE POLYNOMIALS
- ERROR INDICATOR
- SEPARATE PRESET AND CLEAR CONTROLS
- AUTOMATIC RIGHT JUSTIFICATION
- fully compatible with all ttl logic families
- 14-PIN PACKAGE
- TYPICAL APPLICATIONS:

FLOPPY AND OTHER DISC STORAGE SYSTEMS DIGITAL CASSETTE AND CARTRIDGE SYSTEMS DATA COMMUNICATION SYSTEMS

## PIN NAMES

| $\mathrm{S}_{\mathrm{O}}-\mathrm{S}_{2}$ | Polynomial Select Inputs |
| :--- | :--- |
| $\frac{\mathrm{D}}{\mathrm{CP}}$ | Data Input |
|  | Clock (Operates on HIGH-to- |
| LOW Transition) Input |  |
| $\overline{\mathrm{C}}$ | Check Word Enable Input <br> MR |
| Q | Preset (Active LOW) Input |
| Q | Master Reset (Active HIGH) Input |
| ER | Data Output (Note b) |
|  | Error Output (Note b) |


| LOADING (Note a) |  |
| :---: | ---: |
| HIGH | LOW |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
|  |  |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 10 U.L. | 5 U.L. |
| 10 U.L. | 5 U.L. |

## NOTES:

a. $\mathbf{1}$ TTL Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH/1.6 mA LOW.
b. The output LOW drive factor is 2.5 U.L. for Military (XM) and 5 U.L. for Commercial (XC) Temperature Ranges.


NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.


FUNCTIONAL DESCRIPTION - The 9401 is a 16 -bit programmable device which operates on serial data streams and provides a means of detecting transmission errors. Cyclic encoding and decoding schemes for error detection are based on polynomial manipulation in modulo arithmetic. For encoding, the data stream (message polynomial) is divided by a selected polynomial. This division results in a remainder which is appended to the message as check bits. For error checking, the bit stream containing both data and check bits is divided by the same selected polynomial. If there are no detectable errors, this division results in a zero remainder. Although it is possible to choose many generating polynomials of a given degree, standards exist that specify a small number of useful polynomials. The 9401 implements the polynomials listed in Table 1 by applying the appropriate logic levels to the select pins $\mathrm{S}_{0}, \mathrm{~S}_{1}$ and $\mathrm{S}_{2}$.
The 9401 consists of a 16 -bit register, a Read Only Memory (ROM) and associated control circuitry as shown in the block diagram. The polynomial control code presented at inputs $S_{0}, S_{1}$ and $S_{2}$ is decoded by the ROM, selecting the desired polynomial by establishing shift mode operation on the register with Exclusive OR gates at appropriate inputs. To generate the check bits, the data stream is entered via the Data inputs (D), using the HIGH-to-LOW transition of the Clock input ( $\overline{C P}$ ). This data is gated with the most significant output ( Q ) of the register, and controls the Exclusive OR gates (Figure 1). The Check Word Enable (CWE) must be held HIGH while the data is being entered. After the last data bit is entered, the CWE is brought LOW and the check bits are shifted out of the register and appended to the data bits using external gating (Figure 2).

To check an incoming message for errors, both the data and check bits are entered through the $D$ input with the CWE input held HIGH. The 9401 is not in the data path, but only monitors the message. The Error Output becomes valid after the last check bit has been entered into the 9401 by a HIGH-to-LOW transition of CP. If no detectable errors have occurred during the data transmission, the resultant internal register bits are all LOW and the Error Output (ER) is LOW. If a detectable error has occurred, ER is HIGH.

A HIGH on the Master Reset input (MR) asynchronously clears the register. A LOW on the Preset input ( $\overline{\mathrm{P}}$ ) asynchronously sets the entire register if the control code inputs specify a 16 -bit polynomial; in the case of 12 or 8 -bit check polynomials only the most significant 12 or 8 register bits are set and the remaining bits are cleared.

TABLE 1

| SELECT CODE |  |  | POLYNOMIAL | REMARKS |
| :---: | :---: | :---: | :---: | :---: |
| $S_{2}$ | $\mathrm{S}_{1}$ | $\mathrm{S}_{0}$ |  |  |
| L | L | L | $x^{16+x^{15}+x^{2}+1}$ | CRC-16 |
| L | L | H | $x^{16+x^{14}+x+1}$ | CRC-16 REVERSE |
| L | H | L | $x^{16}+x^{15}+x^{13}+x^{7}+x^{4}+x^{2}+x^{1}+1$ |  |
| L | H | H | $x^{12}+x^{11}+x^{3}+x^{2}+x^{+1}$ | CRC-12 |
| H | L | L | $x^{8}+x^{7}+x^{5}+x^{4}+x+1$ |  |
| H | L | H | $\mathrm{x}^{8+1}$ | LRC-8 |
| H | H | L | $x^{16+x^{12}+x^{5}+1}$ | CRC-CCITT |
| H | H | H | $x^{16}+x^{11}+x^{4}+1$ | CRC-CCITT REVERSE |



Fig. 1
EQUIVALENT CIRCUIT FOR $\mathbf{X}^{16+X^{15}+X^{2}+1}$

## FAIRCHILD • 9401

## DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise noted)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |
| $\mathrm{V}_{1 H}$ | Input HIGH Voltage |  | 2.0 |  |  | v | Guaranteed Input HIGH Voltage |
| $V_{\text {IL }}$ | Input LOW Voltage | XM |  |  | 0.7 | V | Guaranteed Input LOW Voltage |
|  |  | XC |  |  | 0.8 |  |  |
| $\mathrm{v}_{\text {CD }}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | V | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}, \mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |
| VOH | Output HIGH Voltage | XM | 2.4 | 3.4 |  | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |
|  |  | XC | 2.4 | 3.4 |  |  |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage | XM \& XC |  | 0.35 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA}$ |
|  |  | XC |  | 0.45 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |
| 1/H | Input HIGH Current |  |  | 1.0 | 40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ |
|  |  |  |  |  | 1.0 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}$ |
| IIL | Input LOW Current |  |  | -0.22 | -0.36 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ |
| Ios | Output Short Circuit Current |  | -15 |  | -100 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ (Note 3) |
| ICC | Supply Current |  |  | 70 | 110 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, Inputs Open |

AC CHARACTERISTICS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP <br> (Note 2) | MAX |  |  |  |
| ${ }_{f}^{\text {max }}$ | Maximum Clock Frequency | 10 | 18 |  | MHz | Fig. 3, 4, 5 | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |
| $\begin{aligned} & \overline{\mathrm{t} P H L} \\ & \mathrm{tPLH} \end{aligned}$ | Propagation Delay, Clock, MR to Data Output |  | 30 | 55 | ns |  |  |
| $\begin{aligned} & \text { tPHL } \\ & \text { tPLH } \end{aligned}$ | Propagation Delay, Preset to Data Output |  | 40 | 60 | ns |  |  |
| $\begin{aligned} & \mathrm{tPHL} \\ & \text { tPLH } \end{aligned}$ | Propagation Delay, Clock, MR or Preset to Error Output |  | 40 | 60 | ns |  |  |

AC SET-UP REQUIREMENTS: $V_{C C}=5.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |  |
| ${ }_{t w} \bar{C} \bar{P}(L)$ | Clock Pulse Width (LOW) | 35 |  |  | ns | Fig. 2 | $C_{L}=15 \mathrm{pF}$ |
| $\mathrm{t}_{s} \mathrm{D}$ | Set-up Time, Data to Clock | 55 | 35 |  | ns | Fig. 6 |  |
| $\mathrm{t}_{s}$ CWE | Set-up Time, CWE to Clock | 55 | 35 |  | ns |  |  |
| th | Hold Time, Data and CWE to Clock | 0 | -10 |  | ns |  |  |
| ${ }_{t_{w}{ }^{\text {P }} \text { (L) }}$ | Preset Pulse Width (LOW) | 40 | 30 |  | ns | Fig. 4 |  |
| $\mathrm{t}_{\mathrm{w}} \mathrm{MR}(\mathrm{H})$ | Master Reset Pulse Width (HIGH) | 35 | 25 |  | ns | Fig. 6 |  |
| trec | Recovery Time, MR and Preset to Clock | 50 | 25 |  | ns | Fig. 4, 5 |  |

## NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{C}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.


NOTES:

1. Check word Enable is HIGH while data is being clocked, LOW during transmission of check bits.
2. 9401 must be reset or preset before each computation.
3. CRC check bits are generated and appended to data bits.

Fig. 2
CHECK WORD GENERATION


Fig. 5
PROPAGATION DELAYS, MR TO O AND ER PLUS RECOVERY TIME, MR TO $\overline{\mathbf{C P}}$

## 9403

# FIRST-IN FIRST-OUT (FIFO) BUFFER MEMORY <br> FAIRCHILD TTL MACROLOGIC 

DESCRIPTION - The 9403 is an expandable fall-through type high-speed First-In First-Out (FIFO) Buffer Memory optimized for high speed disc or tape controllers and communication buffer applications. It is organized as 16 words by four bits and may be expanded to any number of words or any number of bits (in multiples of four). Data may be entered or extracted asynchronously in serial or parallel, allowing economical implementation of buffer memories.
The 9403 has 3 -state outputs which provide added versatility and is fully compatible with all TTL families.

- 10 MHz SERIAL OR PARALLEL DATA RATE
- SERIAL OR PARALLEL INPUT
- SERIAL OR PARALLEL OUTPUT
- EXPANDABLE WITHOUT EXTERNAL LOGIC
- 3-STATE OUTPUTS
- FULLY COMPATIBLE WITH ALL TTL FAMILIES
- SLIM 24-PIN PACKAGE



## PIN NAMES

| N | DESCRIPTION | LOADING (Note a) |  | COMMENTS |
| :---: | :---: | :---: | :---: | :---: |
| NAME |  | HIGH | LOW |  |
| $\mathrm{D}_{0}-\mathrm{D}_{3}$ | Parallel Data Inputs | 1.0 U.L. | 0.23 U.L. |  |
| $\mathrm{D}_{\text {S }}$ | Serial Data Input | 1.0 U.L. | 0.23 U.L. |  |
| PL | Parallel Load Input | 1.0 U.L. | 0.23 U.L. | HIGH on PL enables $D_{0}-D_{3}$. Not edge triggered. Ones catching. |
| $\overline{\text { CPS } 1}$ | Serial Input Clock | 1.0 U.L. | 0.23 U.L. | Edge triggered. Activates on falling edge. |
| $\overline{\text { IES }}$ | Serial Input Enable | 1.0 U.L. | 0.23 U.L. | Enables serial and parallel input when LOW. |
| TTS | Transfer to Stack Input | 1.0 U.L. | 0.23 U.L. | A LOW on this pin initiates fall through. |
| $\overline{\text { OES }}$ | Serial Output Enable Input | 1.0 U.L. | 0.6 U.L. | Enables serial and parallel output when LOW. |
| TOS | Transfer Out Serial Input | 1.0 U.L. | 0.23 U.L. | A LOW on this pin enables a word to be transferred from the stack to the output register. (TOP must be HIGH also for the transfer to occur). Not edge triggered. |
| TOP | Transfer Out Parallel Input | 1.0 U.L. | 0.23 U.L. | A HIGH on this pin enables a word to be transferred from the stack to the output register. (TOS must be LOW for the transfer to occur). Not edge triggered. |
| $\overline{\mathrm{MR}}$ | Master Reset | 1.0 U.L. | 0.23 U.L. | Active LOW. |
| $\overline{\mathrm{EO}}$ | Output Enable | 1.0 U.L. | 0.23 U.L. | Active LOW. |
| $\overline{\text { CPSO }}$ | Serial Output Clock Input | 1.0 U.L. | 0.23 U.L. | Edge triggered. Activates on falling edge. |
| $\mathrm{O}_{0}-\mathrm{O}_{3}$ | Parallel Data Outputs | 130 U.L. | 10 U.L. | (Note b) |
| $\mathrm{Q}_{\mathrm{S}}$ | Serial Data Output | 10 U.L. | 10 U.L. | (Note b) |
| TRF | Input Register Full Output | 10 U.L. | 5 U.L. | LOW when input register is full (Note b). |
| $\overline{\text { ORE }}$ | Output Register Empty Output | 10 U.L. | 5 U.L. | HIGH when output register contains valid data. |

NOTE: a. 1 Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW.
b. Output fan-out with $\mathrm{V}_{\mathrm{OL}} \leqslant 0.5 \mathrm{~V}$.

FUNCTIONAL DESCRIPTION - As shown in the block diagram the 9403 consists of three sections:

1. An Input Register with parallel and serial data inputs as well as control inputs and outputs for input handshaking and expansion.
2. A 4 -bit wide, 14 -word deep fall-through stack with self-contained control logic.
3. An Output Register with parallel and serial data outputs as well as control inputs and outputs for output handshaking and expansion.

Since these three sections operate asynchronously and almost independently, they will be described separately below:

## Input Register (Data Entry):

The Input Register can receive data in either bit-serial or in 4-bit parallel form. It stores this data until it is sent to the fallthrough stack and generates the necessary status and control signals.
Figure 1 is a conceptual logic diagram of the input section. As described later, this 5 -bit register is initialized by setting the F3 flip-flop and resetting the other flip-flops. The Q-output of the last flip-flop (FC) is brought out as the "Input Register Full" output ( $\overline{\mathrm{RFF}}$ ). After initialization this output is HIGH.

Parallel Entry - A HIGH on the PL input loads the $D_{0}-D_{3}$ inputs into the $F_{0}-F_{3}$ flip-flops and sets the FC flip-flop. This forces the $\overline{\mathrm{IRF}}$ output LOW indicating that the input register is full. During parallel entry, the $\overline{\mathrm{CPSI}}$ input must be LOW. If parallel expansion is not being implemented, $\overline{\mathrm{IES}}$ must be LOW to establish row mastership (see Expansion section).


Fig. 1
CONCEPTUAL INPUT SECTION

Serial Entry - Data on the DS input is serially entered into the $F_{3}, F_{2}, F_{1}, F_{0}$, FC shift register on each HIGH-to-LOW transition of the CPSI clock input, provided IES and PL are LOW.
After the fourth clock transition, the four data bits located in the four flip-flops $F_{0}-F_{3}$. The FC flip-flop is set, forcing the $\overline{\mathrm{IRF}}$ output LOW and internally inhibiting $\overline{\mathrm{CPS}}$ clock pulses from effecting the register. Figure 2 illustrates the final positions in a 9403 resulting from a 64-bit serial bit train. $\mathrm{B}_{0}$ is the first bit, $\mathrm{B}_{63}$ the last bit.
Transfer to the Stack - The outputs of Flip-Flops $\mathrm{F}_{0}-\mathrm{F}_{3}$ feed the stack. A LOW level on the TTS input initiates a "fallthrough" action. If the top location of the stack is empty, data is loaded into the stack and the input register is re-initialized. Note that this initialization is postponed until PL is LOW again. Thus, automatic FIFO action is achieved by connecting the $\overline{\text { IRF }}$ output to the TTS input.
An RS Flip-Flop (the Request Initialization Flip-Flop shown in Figure 10) in the control section records the fact that data has been transferred to the stack. This prevents multiple entry of the same word into the stack despite the fact the IRF and $\overline{T T S}$ may still be LOW. The Request Initialization Flip-Flop is not cleared until PL goes LOW. Once in the stack, data falls through the stack automatically, pausing only when it is necessary to wait for an empty next location. In the 9403, as in most modern FIFO designs, the $\overline{M R}$ input only initializes the stack control section and does not clear the data.


Fig. 2
FINAL POSITIONS IN A 9403 RESULTING
FROM A 64-BIT SERIAL TRAIN

Output Register (Data Extraction) - The Output Register receives 4-bit data words from the bottom stack location, stores it and outputs data on a 3-state 4-bit parallel data bus or on a 3-state serial data bus. The output section generates and receives the necessary status and control signals. Figure 3 is a conceptual logic diagram of the output section.


Fig. 3
CONCEPTUAL OUTPUT SECTION

Parallel Data Extraction - When the FIFO is empty after a LOW pulse is applied to $\overline{M R}$, the Output Register Empty ( $\overline{\mathrm{ORE}}$ ) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided the "Transfer Out Parallel" (TOP) input is HIGH. As a result of the data transfer $\overline{\text { ORE }}$ goes HIGH, indicating valid data on the data outputs (provided the 3 -state buffer is enabled). TOP can now be used to clock out the next word. When TOP goes LOW, $\overline{\text { ORE will go LOW indicating that the output data has been extracted, but the }}$ data itself remains on the output bus until the next HIGH level at TOP permits the transfer of the next word (if available) into the Output Register. During parallel data extraction $\overline{\mathrm{CPSO}}$ should be LOW. $\overline{\mathrm{TOS}}$ should be grounded for single slice operation or connected to the appropriate $\overline{\mathrm{ORE}}$ for expanded operation (see Expansion section).
TOP is not edge triggered. Therefore, if TOP goes HIGH before data is available from the stack, but data does become available before TOP goes LOW again, that data will be transferred into the Output Register. However, internal control circuitry prevents the same data from being transferred twice. If TOP goes HIGH and returns to LOW before data is available from the stack, ORE remains LOW indicating that there is no valid data at the outputs.

Serial Data Extraction - When the FIFO is empty after a LOW pulse is applied to $\overline{M R}$, the Output Register Empty ( $\overline{O R E}$ ) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided $\overline{\text { TOS }}$ is LOW and TOP is HIGH. As a result of the data transfer $\overline{\text { ORE goes HIGH indicating }}$ valid data in the register. The 3-state Serial Data Output, $\mathrm{Q}_{\mathrm{S}}$, is automatically enabled and puts the first data bit on the output bus. Data is serially shifted out on the HIGH-to-LOW transition of CPSO. To prevent false shifting, $\overline{\mathrm{CPSO}}$ should be LOW when the new word is being loaded into the Output Register. The fourth transition empties the shift register, forces ORE output LOW and disables the serial output, $Q_{S}$ (refer to Figure 3). For serial operation the $\overline{O R E}$ output may be tied to the TOS input, requesting a new word from the stack as soon as the previous one has been shifted out.

## EXPANSION -

Vertical Expansion - The 9403 may be vertically expanded to store more words without external parts. The interconnections necessary to form a 46 -word by 4 -bit FIFO are shown in Figure 4. Using the same technique, any FIFO of ( $15 \mathrm{n}+1$ ) words by four bits can be constructed, where $n$ is the number of devices. Note that expansion does not sacrifice any of the 9403's flexibility for serial/parallel input and output. For other expansion schemes, refer to the applications section of this book.


Fig. 4

Horizontal Expansion - The 9403 can also be horizontally expanded to store long words (in multiples of four bits) without external logic. The interconnections necessary to form a 16 -word by 12 -bit FIFO are shown in Figure 5 . Using the same technique, any FIFO of 16 words by 4 n bits can be constructed, where n is the number of devices. The IRF output of the right most device (most significant device) is connected to the TTS inputs of all devices. Similarly, the $\overline{\text { ORE output of the }}$ most significant device is connected to the TOS inputs of all devices. As in the vertical expansion scheme, horizontal expansion does not sacrifice any of the 9403's flexibility for serial/parallel input and output.
It should be noted that this form of horizontal expansion extracts a penalty in speed. A single FIFO is guaranteed to operate at 10 MHz ; an array of four FIFOs connected in the above manner is guaranteed at 4.3 MHz . An expansion scheme that provides higher speed but requires additional components is shown in the Applications section of this book.

Horizontal and Vertical Expansion - The 9403 can be expanded in both the horizontal and vertical directions without any external parts and without sacrificing any of its FIFO's flexibility for serial/parallel input and output. The interconnections necessary to form a 31 -word by 16 -bit FIFO are shown in Figure 6 . Using the same technique, any FIFO of ( $15 \mathrm{~m}+1$ ) words by $(4 n)$ bits can be constructed, where $m$ is the number of devices in a column and $n$ is the number of devices in a row.
Figures 7 and 8 show the timing diagrams for serial data entry and extraction for the 31 -word by 16 -bit FIFO shown in Figure 6. The final position of data after serial insertion of 496 bits into the FIFO array of Figure 6 is shown in Figure 9.


Fig. 5
A HORIZONTAL EXPANSION SCHEME

FAIRCHILD • 9403


Fig. 6
A 31 X 16 FIFO ARRAY


Fig. 7

FAIRCHILD • 9403


Fig. 8
SERIAL DATA EXTRACTION FOR ARRAY OF FIG. 6


Fig. 9
FINAL POSITION OF A 496-BIT SERIAL INPUT

Interlocking Circuitry - Most conventional FIFO designs provide status signals analogous to IRF and ORE. However, when these devices are operated in arrays, variations in unit to unit operating speed require external gating to assure all devices have completed an operation. The 9403 incorporates simple but effective "master/slave" interlocking circuitry to eliminate the need for external gating.
In the 9403 array of Figure 6 devices 1 and 5 are defined as "row masters" and the other devices are slaves to the master in their row. No slave in a given row will initialize its Input Register until it has received LOW on its $\overline{\operatorname{IES}}$ input from a row master or a slave of higher priority.
In a similar fashion, the $\overline{\text { ORE }}$ outputs of slaves will not go HIGH until their $\overline{\mathrm{OES}}$ inputs have gone HIGH. This interlocking scheme ensures that new input data may be accepted by the array when the $\overline{\text { RF }}$ output of the final slave in that row goes LOW and that output data for the array may be extracted when the $\overline{\text { ORE }}$ of the final slave in the output row goes HIGH.
The row master is established by connecting its $\overline{\text { IES }}$ input to ground while a slave receives its $\overline{\operatorname{IES}}$ input from the $\overline{\operatorname{RFF}}$ output of the next higher priority device. When an array of 9403 FIFOs is initialized with a LOW on the $\overline{M R}$ inputs of all devices, the $\overline{\overline{R F F}}$ outputs of all devices will be HIGH. Thus, only the row master receives a LOW on the $\overline{\text { IES }}$ input during initialization. Figure 10 is a conceptual logic diagram of the internal circuitry which determines master/slave operation. Whenever $\overline{\mathrm{MR}}$ and $\overline{\text { IES }}$ are LOW, the Master Latch is set. Whenever TTS goes LOW the Request Initialization Flip-Flop will be set. If the Master Latch is HIGH, the Input Register will be immediately initialized and the Request Initialization Flip-Flop reset. If the Master Latch is reset, the Input Register is not initialized until $\overline{I E S}$ goes LOW. In array operation, activating the TTS initiates a ripple input register initialization from the row master to the last slave.
A similar operation takes place for the output register. Either a TOS or TOP input initiates a load-from-stack operation and sets the ORE Request Flip-Flop. If the Master Latch is set, the last Output Register Flip-Flop is set and $\overline{\text { ORE goes HIGH. If }}$ the Master Latch is reset, the $\overline{\mathrm{ORE}}$ output will be LOW until an $\overline{\mathrm{OES}}$ input is received.


Fig. 10

## DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise noted)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |  |
| $\mathrm{V}_{1 H}$ | Input HIGH Voltage |  | 2.0 |  |  | v | Guaranteed Input HIGH Voltage |  |
| $V_{\text {IL }}$ | Input LOW Voltage | XM |  |  | 0.7 | V | Guaranteed Input LOW Voltage |  |
|  |  | XC |  |  | 0.8 |  |  |  |
| $\mathrm{v}_{\text {CD }}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | V | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}, \mathrm{I}_{\text {I }}=-18 \mathrm{~mA}$ |  |
| VOH | Output HIGH Voltage, $\overline{\text { ORE, IRF }}$ | XM | 2.4 | 3.4 |  | v | $V_{C C}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |  |
|  |  | XC | 2.4 | 3.4 |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage,$a_{0}-a_{3}, a_{s}$ | XM | 2.4 | 3.4 |  | V | $\mathrm{IOH}^{\prime}=-2.0 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$ |
|  |  | XC | 2.4 | 3.1 |  |  | $1 \mathrm{OH}=-5.7 \mathrm{~mA}$ |  |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage,$a_{0}-a_{3}, a_{s}$ | XM |  | 0.25 | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=8.0 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$ |
|  |  | XC |  | 0.35 | 0.5 | V | $\mathrm{I}_{\mathrm{OL}}=16 \mathrm{~mA}$ |  |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage, $\overline{\text { ORE, }}$, $\overline{\mathrm{RF}}$ | XM |  | 0.25 | 0.4 | V | $1 \mathrm{OL}=4.0 \mathrm{~mA}$ | $V_{C C}=\mathrm{MIN}$ |
|  |  | XC |  | 0.35 | 0.5 |  | $1 \mathrm{OL}=8.0 \mathrm{~mA}$ |  |
| I OZH | Output Off HIGH Current $\mathrm{Q}_{0}-\mathrm{O}_{3}, \mathrm{O}_{S}$ |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2.0 \mathrm{~V}$ |  |
| IOZL | Output Off LOW Current $\mathrm{O}_{0}-\mathrm{O}_{3}, \mathrm{O}_{S}$ |  |  |  | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2.0 \mathrm{~V}$ |  |
| IIH | Input HIGH Current |  |  | 1.0 | 40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{~V}_{\text {IN }}=2.7 \mathrm{~V}$ |  |
|  |  |  |  |  | 1.0 | mA |  |  |  |
| IIL | Input LOW Current, all except $\overline{\text { EES }}$ Input LOW Current, $\overline{\text { OES }}$ |  |  |  | -0.36 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ |  |
|  |  |  |  |  | -0.96 |  |  |  |  |
| 'os | Output Short Circuit Current $\mathrm{O}_{0}-\mathrm{O}_{3}, \mathrm{Q}_{\mathrm{S}}, \overline{\mathrm{ORE}}, \overline{\mathrm{OES}}$ |  | -30 |  | -130 | mA | $\mathrm{V}_{\text {CC }}=$ MAX, $\mathrm{V}_{\text {OUT }}=0,($ Note 3$)$ |  |
| ${ }^{\text {I C C }}$ | Supply Current | XM |  | 115 | 155 | mA | $V_{C C}=$ MAX, Inputs Open |  |
|  |  | XC |  | 115 | 170 |  |  |  |  |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $V_{C C}=5.0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC CHARACTERISTICS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{\text {t PHL }}$ | Propagation Delay, Negative-Going CP to IRF Output |  | 18 | 25 | ns | Stack not Full, PL LOW, Figures 11 and 12 |
| ${ }^{\text {P PLH }}$ | Propagation Delay, Negative-Going $\overline{\mathrm{TTS}}$ to $\overline{\mathrm{RFF}}$ |  | 48 | 64 | ns |  |
| $\begin{aligned} & \text { tpLH, } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Negative-Going $\overline{\text { CPSO }}$ to QS Output |  | 30 | 40 | ns | OES LOW, TOP HIGH, Figures 13 and 14 |
|  |  |  | 17 | 23 | ns |  |
| tPLH. | Propagation Delay, Positive-Going TOP to Outputs $\mathrm{O}_{0}-\mathrm{O}_{3}$ |  | 40 | 56 | ns | $\overline{\mathrm{EO}}, \overline{\mathrm{CPSO}}$ LOW, Figure 15 |
| ${ }^{\text {tPHL }}$ |  |  | 31 | 45 | ns |  |
| ${ }^{\text {t PHL }}$ | Propagation Delay, Negative-Going $\overline{\mathrm{CPSO}}$ to $\overline{\text { ORE }}$ |  | 32 | 42 | ns | $\overline{\mathrm{OES}}$ LOW, TOP HIGH, Figures 13 and 14 |
| ${ }^{\text {tPHL }}$ | Propagation Delay, Negative-Going TOP to $\overline{\text { ORE }}$ |  | 40 | 54 | ns | Parallel Output, $\overline{\mathrm{EO}}, \overline{\mathrm{CPSO}}$ LOW, Figure 15 |
| ${ }^{\text {tPLH }}$ | Propagation Delay, Positive-Going TOP to $\overline{\text { ORE }}$ |  | 51 | 68 |  |  |
| ${ }^{\text {t }}$ FFT | Fall Through Time |  | 450 | 600 | ns | $\overline{T T S}$ Connected to $\overline{\text { RF }}$ $\overline{\mathrm{TOS}}$ Connected to $\overline{\mathrm{ORE}}$ $\overline{\mathrm{IES}}, \overline{\mathrm{OES}}, \overline{\mathrm{EO}}, \overline{\mathrm{CPSO}}$ LOW, TOP HIGH, Figure 16 |
| ${ }^{\text {PLLH }}$ | Propagation Delay, Negative-Going $\overline{\mathrm{TOS}}$ to Positive-Going $\overline{\mathrm{ORE}}$ |  | 41 | 53 | ns | Data in stack, TOP HIGH, <br> Figures 13 and 14 |

AC CHARACTERISTICS (Cont'd): $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{\text {t PHL }}$ | Propagation Delay, Positive-Going PL to Negative-Going IRF |  | 33 | 44 | ns | Stack not Full, Figures 17 and 18 |
| ${ }^{\text {PLLH }}$ | Propagation Delay, Negative-Going PL to Positive-Going IRF |  | 20 | 28 | ns |  |
| ${ }^{\text {PLLH }}$ | Propagation Delay, Positive-Going $\overline{\mathrm{OES}}$ to $\overline{\mathrm{ORE}}$ |  | 26 | 38 | ns |  |
| ${ }^{\text {P PLH }}$ | Propagation Delay, Positive-Going $\overline{\mathrm{IES}}$ to Positive-Going IRF |  | 31 | 40 | ns | Figure 18 |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PZL}} \\ & \mathrm{t}_{\mathrm{PZH}} \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{OE}}$ to $\mathrm{O}_{0}, \mathrm{Q}_{1}, \mathrm{O}_{2}, \mathrm{O}_{3}$ |  | 9.0 | 14 | ns | Propagation Delay Out of the High Impedance State |
| $\begin{aligned} & { }^{{ }^{\mathrm{P} P H Z}}, \\ & \mathrm{t}_{\mathrm{t} P L Z} \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{OE}}$ to $\mathrm{Q}_{\mathrm{O}}, \mathrm{Q}_{1}, \mathrm{Q}_{2}, \mathrm{Q}_{3}$ |  | 7.0 | 14 | ns | Propagation Delay Into the High Impedance State |
| $\begin{aligned} & \mathrm{t}_{\mathrm{P} P L}, \\ & { }^{\mathrm{t}_{\mathrm{PPZH}}} \\ & \hline \end{aligned}$ | Propagation Delay, Negative-Going $\overline{\mathrm{OES}}$ to $\mathrm{Q}_{\mathrm{S}}$ |  | 13 | 18 | ns | Propagation Delay Out of the High Impedance State |
| $\begin{aligned} & { }^{{ }^{\mathrm{P} P L Z}}, \\ & { }^{\mathrm{t}} \mathrm{PHZ} \\ & \hline \end{aligned}$ | Propagation Delay, Negative-Going $\overline{\mathrm{OES}}$ to $\mathrm{Q}_{\mathrm{S}}$ |  | 7.0 | 14 | ns | Propagation Delay Into the High Impedance State |
| ${ }^{t} A P$ | Parallel Appearance Time, $\overline{\mathrm{ORE}}$ to $\mathrm{O}_{\mathrm{O}}-\mathrm{O}_{3}$ |  | -12 | -5.0 | ns | Time elapsed between $\overline{\text { ORE }}$ going HIGH and valid data |
| ${ }^{\text {t }}$ AS | Serial Appearance Time, $\overline{\text { ORE }}$ to $\mathrm{Q}_{\mathrm{S}}$ |  | 6.0 | 10 | ns | appearing at output. Negative number indicates data available before $\overline{\mathrm{ORE}}$ goes HIGH. |

AC SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{\text {t }}$ PWH | $\overline{\text { CPSI Pulse Width (HIGH) }}$ | 25 | 19 |  | ns | Stack not full, PL LOW, <br> Figures 11 and 12 |
| ${ }^{\text {t PWWL }}$ | $\overline{\text { CPSI Pulse Width (LOW) }}$ | 20 | 11 |  | ns |  |
| ${ }^{\text {t }}$ PWH | PL Pulse Width (HIGH) | 40 | 29 |  | ns | Stack not full, Figures 17 and 18 |
| ${ }^{\text {t PWWL }}$ | $\overline{\text { TTS }}$ Pulse Width (LOW) Serial or Parallel Mode | 20 | 9.0 |  | ns | Stack not full, <br> Figures 11, 12, 17, 18 |
| ${ }^{\text {t PWL }}$ | $\overline{\mathrm{MR}}$ Pulse Width (LOW) | 25 | 13 |  | ns | Figure 16 |
| $\mathrm{t}_{\text {PWW }}$ | TOP Pulse Width (High) | 20 | 13 |  | ns | $\overline{\text { CPSO }}$ LOW, data available in stack, <br> Figure 15 |
| ${ }^{\text {t }}$ PWL | TOP Pulse Width (LOW) | 30 | 17 |  | ns |  |
| ${ }^{\text {t PWW }}$ | $\overline{\text { CPSO }}$ Pulse Width (HIGH) | 32 | 18 |  | ns | TOP HIGH, data in stack, <br> Figures 13 and 14 |
| ${ }^{\text {t PWWL }}$ | $\overline{\text { CPSO Pulse Width (LOW) }}$ | 30 | 16 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}}$ | Set-up Time, $\mathrm{D}_{\mathrm{S}}$ to Negative $\overline{\mathrm{CPSI}}$ | 28 | 17 |  | ns | PL LOW, Figures 11 and 12 |
| ${ }_{\text {th }}$ | Hold Time, $\mathrm{D}_{\text {S }}$ to $\overline{\mathrm{CPSI}}$ | 0 | -6.0 |  | ns | PL LOW, Figures 11 and 12 |
| ${ }^{\text {s }}$ | Set-up Time, $\overline{T T S}$ to $\overline{\mathrm{RF}}$ Serial or Parallel Mode | 0 | -20 |  | ns | Figures 11, 12, 17, 18 |
| ${ }^{\text {s }}$ | Set-up Time Negative-Going $\overline{\text { ORE }}$ to Negative-Going $\overline{\mathrm{TOS}}$ | 0 | -24 |  | ns | TOP HIGH, <br> Figures 13 and 14 |
| ${ }^{\text {trec }}$ | Recovery Time $\overline{M R}$ to any Input | 10 | 5.0 |  | ns | Figure 16 |
| $\mathrm{t}_{\text {s }}$ | Set-up Time, Negative-Going $\overline{\text { IES }}$ to $\overline{\text { CPSI }}$ | 32 | 23 |  | ns | Figure 12 |
| $\mathrm{t}_{\mathrm{s}}$ | Set-up Time, Negative-Going TTS to $\overline{\text { CPSI }}$ | 76 | 58 |  | ns | Figure 12 |
| $\mathrm{t}_{\mathrm{s}}$ | Set-up Time, Parallel Inputs to PL | 0 | -22 |  | ns | Length of time parallel inputs must be applied prior to rising edge of PL. |
| ${ }^{\text {th }}$ | Hold Time, Parallel Inputs to PL | 0 |  |  | ns | Length of time parallel inputs must reamin applied after falling edge of PL. |



Fig. 11
SERIAL INPUT, UNEXPANDED OR MASTER OPERATION
Conditions: stack not full, $\overline{\text { IES, }}$, PL LOW


Fig. 12
SERIAL INPUT, EXPANDED SLAVE OPERATION
Conditions: stack not full, $\overline{\mathrm{ESS}}$ HIGH when initiated, PL LOW


Fig. 13
SERIAL OUTPUT, UNEXPANDED OR MASTER OPERATION
Conditions: data in stack, TOP HIGH, $\overline{\text { IES }}$ LOW when initiated, $\overline{\mathrm{OES}}$ LOW


Fig. 14
SERIAL OUTPUT, SLAVE OPERATION
Conditions: data in stack, TOP HIGH, $\overline{\mathrm{IES}}$ HIGH when initiated


Fig. 15
PARALLEL OUTPUT, 4-BIT WORD OR MASTER IN PARALLEL EXPANSION
Conditions: $\overline{\text { IES }}$ LOW when initiated, $\overline{\mathrm{EO}}, \overline{\mathrm{CPSO}}$ LOW; data available in stack


Fig. 16
FALL THROUGH TIME
Conditions: $\overline{T T S}$ connected to $\overline{\mathrm{RF}}, \overline{\mathrm{TOS}}$ connected to $\overline{\mathrm{ORE}}, \overline{\mathrm{IES}}, \overline{\mathrm{OES}}, \overline{\mathrm{EO}}, \overline{\mathrm{CPSO}}$ LOW, TOP HIGH


Fig. 17
PARALLEL LOAD MODE, 4-BIT WORD (UNEXPANDED) OR MASTER IN PARALLEL EXPANSION Conditions: stack not full, $\overline{\text { IES }}$ LOW when initialized


Fig. 18
PARALLEL LOAD, SLAVE MODE
Conditions: stack not full, device initialized (Note 1) with IES HIGH

NOTES:

1. Initialization requires a master reset to occur after power has been applied.
2. TTS normally connected to $\overline{\mathrm{RF}}$.
3. If stack is full, IRF will stay LOW

## 9404

DATA PATH SWITCH
FAIRCHILD TTL MACROLOGIC

DESCRIPTION - The 9404 Data Path Switch (DPS) is a combinatorial array for closing data path loops around arithmetic/logic networks such as the 9405A (Arithmetic Logic Register Stack). A total of 30 instructions (see Table 1) facilitate logic shifting, masking, sign extension, introduction of common constants and other operations.

The 5-bit Instruction ( $\mathrm{I}_{0} \mathrm{I}_{4}$ ) selects one of the 30 instructions operating on two sets of 4-bit data inputs ( $\mathrm{D}_{0}-\mathrm{D}_{3}, \mathrm{~K}_{0}-\mathrm{K}_{3}$ ). Left Input (LI), Left Output (LO), Right Input (RI) and Right Output (RO) are available for expansion in 4 -bit increments. An active LOW Output Enable input ( $\overline{\mathrm{EO}}$ ) provides 3 -state control of the Data Outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ for bus oriented applications.
The 9404 is fully compatible with all TTL families.

- EXPANDABLE IN MULTIPLES OF FOUR BITS
- 20 ns DELAY OVER 16-BIT WORD (EXCEPT SIGN EXTEND FUNCTION)
- TWO 4-BIT DATA INPUT BUSSES
- 4-BIT DATA OUTPUT BUS WITH 3-STATE OUTPUT BUFFERS
- USEFUL FOR BYTE MASKING AND SWAPPING
- PROVIDES ARITHMETIC OR LOGIC SHIFT
- PROVIDES FOR SIGN EXTENSION
- GENERATES COMMONLY USED CONSTANTS
- SLIM 24-PIN PACKAGE


## PIN NAMES

| $\mathrm{D}_{0}-\mathrm{D}_{3}$ | D-Bus Inputs (active LOW) |
| :--- | :--- |
| $\mathrm{K}_{0}-\mathrm{K}_{3}$ | K-Bus Inputs (active LOW) |
| $\mathrm{I}_{0}^{--\mathrm{I}_{4}}$ | Instruction Input |
| LI | Shift Left Input (active LOW) |
| LO | Shift Left Output (active LOW) (Note b) |
| RI | Shift Right Input (active LOW) |
| RO | Shift Right Output (active LOW) (Note b) |
| $\overline{\mathrm{EO}}$ | Output Enable Input (active LOW) |
| $\mathrm{O}_{\mathrm{O}}-\mathrm{O}_{3}$ | Data Output (Note b) |


| LOADING (Note a) |  |
| :---: | ---: |
| HIGH | LOW |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 10 U.L. | 5.0 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 10 U.L. | 5.0 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 130 U.L. | 10 U.L. |

## NOTES:

a) 1 Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW
b) Output current measured at $\mathrm{V}_{\mathrm{OUT}}=0.5 \mathrm{~V}$


DIP (TOP VIEW)


NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

## BLOCK DIAGRAM



TABLE 1
INSTRUCTION SET FOR THE 9404

| INPUTS | OUTPUTS | FUNCTION | INPUTS | OUTPUTS | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{O}_{3} \mathrm{O}_{2} \mathrm{O}_{1} \mathrm{O}_{0}$ | N | $l_{4} \mathrm{l}_{3} \mathrm{l}_{2} \mathrm{l}_{1} \mathrm{l}_{0}$ |  | FUNCTION |
| L L L L L | L L | Byte Mask | H L L L L | RI RI RI RI RI | K-Bus Sign Extend |
| L L L L H | H H H H | Byte Mask | H L L L H |  | K-Bus Sign Extend |
| L L L H L | L H | Minus "2" in 2s Comp (1) | H L L H L | RI RI RI RI RI | D-Bus Sign Extend |
| L L L H H | L L L L | Minus "1" in 2s Comp ${ }^{(1)}$ | H L L H H |  | D-Bus Sign Extend |
| L L H L L | $\mathrm{D}_{3} \quad \mathrm{D}_{2} \quad \mathrm{D}_{1} \quad \mathrm{D}_{0}$ | Byte Mask, D-Bus | H L H L L |  | D-Bus Shift Left |
| L L H L H | H H H H | Byte Mask, D-Bus | H L H L H |  | K-Bus Shift Left |
| L L H H L | $\mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}$ | Byte Mask, D-Bus | H L H H |  | D-Bus Shift Right |
| L L H H H | L L L L | Byte Mask, D-Bus | H L H H H | $\mathrm{D}_{3} \mathrm{D}_{3} \mathrm{D}_{2} \quad \mathrm{D}_{1} \mathrm{D}_{0}$ | D-Bus Shift Right Arith ${ }^{(2)}$ |
| L H L L L | H H H | Negative Byte Sign Mask | H H L L L |  | K-Bus Shift Right |
| L H L L H | H H H H | Positive Byte Sign Mask | H H L L H | $K_{3} K_{3} K_{2} K_{1} K_{0}$ | K-Bus Shift Right Arith ${ }^{(2)}$ |
| L H L H L | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Byte Mask, K-Bus | H H L H L | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Byte Mask, K-Bus |
| L H L H H | L | Byte Mask, K-Bus | H H L H H | H H H H | Byte Mask, K-Bus |
| L H H L L | $\mathrm{D}_{3} \mathrm{D}_{2} \quad \mathrm{D}_{1} \mathrm{D}_{0}$ | Load Byte | H H H L L | $\mathrm{D}_{3} \mathrm{D}_{2} \quad \mathrm{D}_{1} \quad \mathrm{D}_{0}$ | Complement D-Bus |
| L H H L H | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Load Byte | H H H L H | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Complement K-Bus |
| L H H H L | H H H | Plus "1" | H H H H L |  | Undefined (Reserved) |
| L H H H H | H $\quad \mathrm{H} \quad \mathrm{H} \quad \mathrm{H}$ | Zero | H H H H H |  | Undefined (Reserved) |

$\mathrm{H}=\mathrm{HIGH}$ Level
(1) Comp $=$ Complement
L = LOW Level
(2) Arith = Arithmetic

FUNCTIONAL DESCRIPTION - The 9404 combines the functions of a dual 4 -input multiplexer, a true/complement one/zero generator, and a shift left/shift right array.
As shown in Table 1, there are two shift right modes. The arithmetic right shift preserves the sign bit in the most significant position while the logic shift moves all positions. Right shift is defined as a 1-bit shift toward the least significant position.
For half-word arithmetic the 9404 provides instructions which extend the sign bit left through the more significant slices. Shift linkages are available as individual inputs and outputs for complete flexibility.

The 9404 may be used to generate constants $+1,0,-1$ and -2 in 2 's complement notation.

EXPANSION - Arrays of larger than 4-bit word lengths are easily obtained. Figure 1 illustrates a 16-bit array constructed using four devices; device 1 is the least significant and device 4 is the most significant slice. Within each slice, inputs and outputs with ' 0 ' subscript are the least significant bits.

The $\mathrm{I}_{1}$ through $\mathrm{I}_{4}$ inputs of all devices are bussed. These four bus lines together with the $\mathrm{I}_{0}$ inputs of the devices form an 8 -bit instruction bus to control the array. In some applications, it may be possible to connect the $I_{0}$ inputs of devices 1 and 2 together and the $\mathrm{I}_{\mathrm{O}}$ inputs of devices 3 and 4 together, so that only six bits are needed to control the arrays. Connecting the LO of device 1 to RI of device 2, LO of device 2 to RI of device 3, etc., provides left shift (i.e., shift towards most significant bit) and sign extension. In a similar fashion right shift operation is accomplished by connecting the Ll input of a device to the RO of the next more significant device.
The sign-extend group consists of two adjacent instructions differing only in $I_{0}$ (refer to Table 1). When the code HLLHH is placed on the instruction inputs ( $D$-Bus Sign Extend), the most significant bit of the $D$ bus ( $D 3$ ) is available on the LO output. The companion code HLLHL will copy the RI input (connected to LO of the previous stage) onto the output bus ( $\mathrm{D}_{\mathrm{O}^{-}}{ }^{-}$ $\mathrm{D}_{3}$ ) and to its own LO output. Thus when a sign extend function is desired (e.g., arithmetic operations on the eight least significant bits in a 16 -bit machine) the code HLLH will be applied to instruction inputs ( $I_{4}, I_{3}, I_{2}, I_{1}$ ) of all the 9404 s. I $I_{0}$ of the most significant byte will be LOW and $\mathrm{I}_{\mathrm{O}}$ of the least significant byte will be HIGH . In a similar fashion sign-extend function on a number present on the K-Bus is executed by the code HLLL on $\mathrm{I}_{4}, I_{3}, I_{2}$, and $\mathrm{I}_{1}$.


Fig. 1
16-BIT 9404 ARRAY

The 9404 provides several options for masking operations. For example, Byte Mask operation (LLLL on $I_{4}, I_{3}, I_{2}, I_{1}$ ) will force the output bus either HIGH or LOW depending on $I_{0}$. Connecting $I_{0}$ of the most significant byte HIGH and $\mathrm{I}_{0}$ of the least significant byte LOW will force the outputs of the DPS array to a state of (OOFF) 16. A LOW on any output is assumed as logic 1. When the output bus of the 9404 is used as an input to a 16-bit Arithmetic Logic Register Stack (ALRS) network (see Figure 2), the ALRS can execute a logic AND function between its input bus and one of its registers, thus masking the least significant byte of that register. More complex masking operation can be executed using the Byte AND Mask and Byte OR Mask operations (see Table 1).


Fig. 2
16-BIT DATA PATH

FAIRCHILD MACROLOGIC 9404

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise noted)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage |  | 2.0 |  |  | V | Guaranteed Input HIGH Voltage |  |
| $V_{\text {IL }}$ | Input LOW Voltage | XM |  |  | 0.7 | v | Guaranteed Input LOW Voltage |  |
|  |  | XC |  |  | 0.8 |  |  |  |
| $\mathrm{V}_{C D}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | V | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}, \mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |  |
|  | Output HIGH Voltage LO, RO | XM | 2.4 | 3.4 |  | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |  |
| OH |  | XC | 2.4 | 3.4 |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage$\mathrm{O}_{0}-\mathrm{O}_{3}$ | XM | 2.4 | 3.4 |  | V | $\mathrm{IOH}^{\prime}=-2.0 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$ |
|  |  | XC | 2.4 | 3.1 |  |  | $\mathrm{IOH}^{\prime}=-5.7 \mathrm{~mA}$ |  |
| IOH | Output HIGH Current |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=5.5 \mathrm{~V}$ |  |
|  | Output LOW Voltage LO, RO | XM |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=4.0 \mathrm{~mA}$ |  |
| , |  | XC |  | 0.4 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |  |
|  | Output LOW Voltage | XM |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |  |
| , OL | $\mathrm{O}_{0}-\mathrm{O}_{3}$ | XC |  | 0.4 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=16 \mathrm{~mA}$ |  |
| IOZH | Output Off HIGH Current |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2.0 \mathrm{~V}$ |  |
| IOZL | Output Off LOW Current |  |  |  | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2.0 \mathrm{~V}$ |  |
| 1/H | Input HIGH Current |  |  | 1.0 | $\begin{gathered} 40 \\ 1.0 \end{gathered}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & V_{C C}=\text { MAX, } V_{I N}=2.7 \mathrm{~V} \\ & V_{C C}=\text { MAX, } V_{I N}=5.5 \mathrm{~V} \end{aligned}$ |  |
| IIL | Input LOW Current |  |  |  | -0.36 | mA | $V_{C C}=M A X, V_{\text {IN }}=0.4 \mathrm{~V}$ |  |
| Ios | Output Short Circuit Current |  | -30 |  | -130 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ (Note 3) |  |
| ICC | Supply Current |  |  | 60 | 90 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}$, Inputs Open |  |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC CHARACTERISTICS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| tPLH tPHL | Propagation Delay, <br> Data Inputs ( $\mathrm{D}_{0}-\mathrm{D}_{3}, \mathrm{~K}_{0}-\mathrm{K}_{3}$ ) to Output $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ |  | 18 | 25 | ns |  |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, <br> Data Inputs ( $\mathrm{D}_{0}-\mathrm{D}_{3}, \mathrm{~K}_{0}-\mathrm{K}_{3}$ ) to Shift Outputs (LO, RO) |  | 12 | 17 | ns |  |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, RI to LO |  | 12 | 17 | ns | EO LOW |
| $\overline{\text { tPLH }}$ tPHL | Propagation Delay, <br> Instruction $\left(\mathrm{I}_{0}^{-1}\right.$ ) to Data Outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ |  | 19 | 27 | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, <br> Instruction ( $\mathrm{I}_{0}-\mathrm{I}_{5}$ ) to Shift Outputs (RO, LO) |  | 19 | 27. | ns |  |
| $\begin{aligned} & \hline \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Enable Delay, $\overline{\mathrm{EO}}$ to Outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ |  | 12 | 17 | ns |  |
| $\begin{aligned} & \hline \text { tPLZ } \\ & \text { tPHZ } \end{aligned}$ | Disable Delay, $\overline{\mathrm{EO}}$ to Outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ |  | 9 | 15 | ns |  |

# 9405 <br> ARITHMETIC LOGIC REGISTER STACK <br> FAIRCHILD TTL MACROLOGIC 

DESCRIPTION - The Arithmetic Logic Register Stack (ALRS) is designed to implement accumulators in high performance microprogrammed digital systems. The device contains a 4-bit arithmetic logic unit (ALU), an 8-word by 4-bit RAM, and associated control logic. The ALU implements eight arithmetic and logic functions where one 4-bit operand is supplied from an external source (input data bus) and the second 4-bit operand is supplied internally from one of the eight RAM words selected by the Address Inputs ( $A_{0}-A_{2}$ ). The result of the operation is loaded into the same RAM location and simultaneously, is loaded into the Output Register making it available at the 3 -state output data bus.
The 9405 operates on four bits of data but features are provided for expansion to longer word lengths. Carry propagate and carry generate facilities are provided for an external carry lookahead where maximum operating speed is required. In applications where high speed arithmetic is not needed, ripple expansion may also be implemented. The 9405 provides three status signals: Zero, Negative and Overflow. These qualify the result of an operation. The 9405 is fully compatible with all TTL families.
Note: The 9405A is recommended for all new designs. See the 9405A data sheet.

- EIGHT ACCUMULATORS IN A SINGLE PACKAGE
- HIGH SPEED - $\mathbf{1 0} \mathrm{MHz}$ MICROINSTRUCTION RATE
- EXPANDABLE IN MULTIPLES OF FOUR BITS
- PROVIDES FOR RIPPLE OR CARRY LOOKAHEAD
- IMPLEMENTS 64 MICROINSTRUCTIONS
- PROVIDES StATUS - ZERO, NEGATIVE, AND OVERFLOW
- 3-STATE OUTPUTS
- SLIM 24-PIN PACKAGE


## PIN NAMES

| $\bar{D}_{0}-\bar{D}_{3}$ | Data Inputs | 1.0 U.L. | 0.23 U.L. |
| :---: | :---: | :---: | :---: |
| $\mathrm{A}_{0}-\mathrm{A}_{2}$ | Address Instruction Inputs | 1.0 U.L. | 0.23 U.L. |
| $\mathrm{I}_{0} \mathrm{I}_{2}$ | ALU Instruction Inputs (Note b) | 1.0 U.L. | 0.23 U.L. |
| MSS | Most Significant Slice Input (Active HIGH) | 1.0 U.L. | 0.23 U.L. |
| CP | Clock Input | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{EO}}$ | Output Enable Input (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{EX}}$ | Execute Input (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ | Data Outputs (Active LOW) | 130 U.L. | 10 U.L. |
| $\bar{W}$ | Ripple Carry Output (Active LOW) (Note c) | 10 U.L. | 5 U.L. |
| $\bar{X}$ | Carry Propagate Output (Note d) | 10 U.L. | 5 U.L. |
| $\bar{Y}$ | Carry Generate Output (Note e) | 10 U.L. | 10 U.L. |
| Z | Zero Status Output (Active HIGH, Open Collector) (Note f) |  | 5 U.L. |

NOTES:
a) 1 Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW ( 0.5 V ).
b) Io used also for Carry Input on lesser significant slices.
c) $\mathbf{W}$ Output also carries instruction information.
d) $\bar{X}$ Output provides Negative Status (active LOW) on most significant slice.
e) $\bar{Y}$ Output provides Overflow Status (active LOW) on most significant slice.
f) An external pull-up resistor is required to supply HIGH level drive capability.


FAIRCHILD • 9405

## BLOCK DIAGRAM



TABLE 1
INSTRUCTION FIELD ASSIGNMENT

| $12 l_{1} l_{0}$ | INTERNAL OPERATION |  |
| :---: | :---: | :---: |
| L L L |  | Accumulate |
| L L H | $\mathrm{R}_{\mathrm{X}}$ plus $\overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{X}}$ | Accumulate |
| L H L | $\mathrm{R}_{\mathrm{X}} \cdot \overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{X}}$ | Logical AND |
| L H H | $\overline{\text { D-Bus }} \rightarrow \mathrm{R}_{\mathrm{X}}$ | Load |
| H L L | $\mathrm{R}_{\mathrm{X}} \rightarrow$ Output Register | Output |
| H L H | $\mathrm{R}_{\mathrm{X}}+\overline{\text { D-Bus }} \rightarrow \mathrm{R}_{\mathrm{X}}$ | Logical OR |
| H H L | $\mathrm{R}_{\mathrm{X}} \oplus \overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{X}}$ | Exclusive OR |
| H H H | D-Bus $\rightarrow \mathrm{R}_{\mathrm{X}}$ | Load Complement |

NOTES:

1. $R_{X}$ is the RAM location addressed by $A_{0}-A_{2}$.
2. The result of any operation is always loaded into the Output Register.

FUNCTIONAL DESCRIPTION - As shown in the block diagram the 9405 Arithmetic Logic Register Stack (ALRS) consists of a 4-bit ALU, an 8-word by 4-bit RAM with output latches, an Instruction Decoder, control logic and a 4-bit Output Register.
The ALU receives the active LOW input data $\left(\bar{D}_{0}-\bar{D}_{3}\right)$ as one operand while the RAM provides the second operand through latches. The ALU output is stored in both the RAM and Output Register. The active LOW output data ( $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ ) is obtained from the Output Register through 3 -state buffers. An active LOW Output Enable ( $\overline{\mathrm{EO}}$ ) input controls these buffers; a HIGH level $\overline{\mathrm{EO}}$ disables the buffers (high impedance state).
The instruction bus for the 9405 consists of two fields, $A$ and $I ; A_{0}-A_{2}$ specify the desired location of the RAM and $I_{0}-I_{2}$ specify the desired function to be performed. Table 1 lists instruction code assignments. Thus, the 9405 provides eight accumulators $\left(R_{0}-R_{7}\right)$ and eight different operations may be performed on any of these accumulators. The $I_{0}-I_{2}$ inputs are decoded by the Instruction Decoder to generate necessary control signals for the ALU. The ALU also generates and transmits to the control logic the following signals: Carry Out (C), Carry Propagate (P), Carry Generate (G), Negative (N) and Overflow (V) status. The control logic manipulates the status signals as a function of $\mathrm{I}_{0}-\mathrm{I}_{2}$ and a control input MSS. A HIGH on the MSS input declares the most significant slice in a 9405 array (the MSS can be tied directly to $V_{C C}$ ). All devices, except the most significant 9405 should have a LOW level (ground) on the MSS input. The control logic generates three device outputs, $\bar{W}, \bar{X}$ and $\bar{Y}$ for arrayed operation. An all zero result from the ALU is decoded and presented at the open collector Zero (Z) output.
The $I_{0}$ input serves a dual purpose. For arithmetic instructions, it is used as the carry input and for non-arithmetic instructions it serves as an instruction input. This is possible because only two arithmetic instructions require carry. The dual purpose use of $I_{0}$ plays an important role in 9405 expansion schemes.

Operation - The 9405 operates on a single clock. A microcycle starts as the clock goes HIGH. For normal operation the Execute ( $\overline{E X}$ ) is LOW. Data is read from the RAM through enabled latches and applied as one operand to the ALU. Data inputs ( $\bar{D}_{0}-\bar{D}_{3}$ ) are applied to the $A L U$ as the other operand and the operation as determined by instruction lines $I_{0}-I_{2}$ is executed. When CP is LOW, the latches are disabled and the result of the operation is written back into the RAM provided that $\overline{E X}$ is LOW. The A lines must obviously be held stable during this time. On the LOW-to-HIGH transition of the CP, the result of the operation is loaded into the output register and a new microcycle can start. If $\overline{E X}$ is held HIGH, the operation selected by the I and A inputs is performed, but the result is not written back into the RAM and is not clocked into the output register.

EXPANSION - The 9405 is organized to operate on a 4-bit wide data bus but can easily be expanded for longer words. Expansion requires that carries from lesser significant slices be propagated towards the most significant slice. The 9405 provides full lookahead capability for high speed arithmetic. Appropriate Carry Generate $(\bar{Y})$ and Carry Progagate $(\bar{X})$ outputs are provided so that only one external carry lookahead generator is needed for every four 9405 s. When speed is not a prime consideration, it is possible to implement ripple carry expansion.
In arrayed operation, it is common to bus the $\overline{E X}, C P$ and $\overline{E O}$ inputs of all devices. The $Z$ output is open collector and is normally OR-tied with the other devices and to an external load resistor so that a HIGH level indicates a zero result from an operation in the array.
Figure 1 shows a ripple carry 16 -bit wide array using four 9405 s. The MSS input is tied to $\mathrm{V}_{\mathrm{CC}}$ on the most significant slice (ALRS 4); the MSS inputs of the other devices are tied to ground. The instruction bus of this array consists of A-field and 1 -field. A-field is obtained by connecting corresponding $A$ inputs of all four devices. The $I_{0}$ input of device 1 (i.e., least significant slice) in conjunction with the bussed $I_{1}, I_{2}$ inputs forms the I-field for the array. The $I_{0}$ inputs of devices 2,3 and 4 are connected to the $\bar{W}$ outputs of devices 1,2 and 3 respectively. The ALU network generates the carry propagate output. The control logic operates on this signal as a function of $I_{1}$ and $I_{2}$ to generate the $\bar{W}$ output. If both $I_{1}$ and $I_{2}$ are LOW (i.e., an arithmetic instruction), the $\bar{W}$ output is the carry output of that slice. In case of non-arithmetic instructions, it assumes the state of the $I_{0}$ input. Thus, in Figure 1, if an arithmetic instruction is specified, carry propagates through the $\bar{W}$ output to $\mathrm{I}_{0}$ input of the next higher significant slice. On the other hand, non-arithmetic instructions effectively connect all $\mathrm{I}_{0}$ inputs together to form the $I$-field for the array. The $\bar{W}$ output of device 4 is the carry output from the array. The control logic also generates $\bar{X}$ and $\bar{Y}$ outputs which participate in expansion when full carry lookahead is required. These outputs are normally ignored in ripple expansion except for the most significant slice. In the most significant slice, $\overline{\mathrm{X}}$ and $\overline{\mathrm{Y}}$ correspond to Negative and Overflow status signals.
The $\bar{X}$ output of device 4 is LOW, if the result of an operation has its most significant bit as " 1 " (i.e., negative result). Similarly a LOW on $\bar{Y}$ output of device 4 indicates that arithmetic overflow has occurred. If the two operands have the same sign and the result has opposite sign, then it is assumed that an overflow has occurred. It should be noted that $\bar{W}, \bar{X}$ and $\bar{Y}$ are not controlled by $\overline{\mathrm{EX}}$ or CP. Figure 2 shows a 16 -bit array with full carry lookahead expansion. Implementation of the lookahead scheme requires the use of an external $93 S 42 / 74 \mathrm{~S} 182$ in addition to the four 9405 s in the array. Since device 1 is the least significant and device 4 is the most significant slice, the MSS inputs of the first three devices are connected to ground while device 4 has a HIGH at this input. The A-field for the array instruction bus is obtained by connecting corresponding $A$ inputs of all four devices. Bussed $I_{1}$ and $I_{2}$ inputs together with the $I_{0}$ input of device 1 form the 1 -field for the array. The $I_{0}$ inputs for devices 2, 3 and 4 are obtained from the $93 S 42 / 74$ S182 carry outputs ( $C_{n+x}, C_{n+y}$, and $C_{n+z}$ respectively). Also the $P$
and G inputs of $93 S 42 / 74 \mathrm{~S} 182$ are connected to $\bar{X}$ and $\bar{Y}$ outputs of the 9405 s as shown. The control logic in the 9405 (see block diagram) generates $\bar{X}$ and $\bar{Y}$ outputs as a function of $I_{1}, I_{2}$ and MSS inputs as well as the Carry Generate and Carry Propagate outputs of the ALU. If the MSS input of a slice is LOW and an arithmetic instruction is specified, its $\overline{\mathrm{X}}$ output reflects Carry Propagate and $\bar{Y}$ reflects Carry Generate outputs from that slice. For an arithmetic instruction the $I_{0}$ input is treated as carry-in into a slice irrespective of MSS. Thus, whenever $I_{1}$ and $I_{2}$ are LOW, the array behaves as an adder with full carry lookahead. The $\bar{W}$ outputs still reflect carry output, which is ignored for devices 1,2 and 3 . The $\bar{W}$ output of device 4 is the carry output from the array. Also, note that the $I_{0}$ input of device 1 is not only an instruction input but also provides the carry input to the array so the $I_{0}$ input of device 1 must be connected to the appropriate $93 S 42 / 74 \mathrm{~S} 182$ input as shown.
When a non-arithmetic instruction is specified to the array, the control logic of the 9405 forces a LOW on $\bar{X}$ and a HIGH on $\bar{Y}$ outputs on all except the most significant slice. An examination of the $93542 / 74 \mathrm{~S} 182$ logic reveals that whenever $P$ is LOW and G is HIGH the associated carry output is the same as the carry input. Thus, in Figure 2 devices 2, 3, and 4 will assume the logic level as that presented to the $I_{0}$ input of device 1 during non-arithmetic instructions effectively bussing $I_{0}$ through all four devices. As in the case of ripple expansion $\bar{X}$ and $\bar{Y}$ outputs of device 4 represent Negative and Overflow from the array.


Fig. 1
RIPPLE CARRY EXPANSION


Fig 2.
CARRY LOOKAHEAD EXPANSION

FAIRCHILD • 9405

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP. | MAX |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | Input HIGH Voltage |  | 2.0 |  |  | V | Guaranteed Input | HIGH Voltage |
| $V_{\text {IL }}$ | Input LOW Voltage | XM |  |  | 0.7 | V | Guaranteed Input LOW Voltage |  |
|  |  | XC |  |  | 0.8 |  |  |  |
| $\mathrm{V}_{\mathrm{CD}}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage $\bar{W}, \bar{x}$ Outputs | XM | 2.4 | 3.4 |  | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |  |
|  |  | XC | 2.4 | 3.4 |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage$\bar{o}_{0}, \bar{o}_{1}, \overline{\mathrm{o}}_{2}, \overline{\mathrm{o}}_{3}$ | XM | 2.4 | 3.4 |  | V | $1 \mathrm{IOH}=-2.0 \mathrm{~mA}$ | $V_{C C}=\mathrm{MIN}$ |
|  |  | XC | 2.4 | 3.1 |  |  | $1 \mathrm{OH}=-5.7 \mathrm{~mA}$ |  |
| ${ }^{1} \mathrm{OH}$ | Output HIGH Current Z Output |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=5.5 \mathrm{~V}$ |  |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage $\bar{W}, \bar{x}, z$ | XM |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=4.0 \mathrm{~mA}$ |  |
|  |  | XC |  | 0.4 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}$ | 8.0 mA |
| VOL | Output LOW Voltage$\bar{o}_{0}, \bar{o}_{1}, \bar{o}_{2}, \bar{o}_{3}, \bar{Y}$ | XM |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |  |
|  |  | XC |  | 0.4 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=16 \mathrm{~mA}$ |  |
| IOZH | Output Off Current HIGH |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=$ MAX, $\mathrm{v}_{\text {O }}$ | $T=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2 \mathrm{~V}$ |
| IOZL | Output Off Current LOW |  |  |  | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2 \mathrm{~V}$ |  |
| $1_{1 H}$ | Input HIGH Current |  |  | 1.0 | 40 | $\mu \mathrm{A}$ | $V_{C C}=$ MAX, $V_{1}$ | $=2.7 \mathrm{~V}$ |
|  |  |  |  |  | 1.0 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{1}$ | $=5.5 \mathrm{~V}$ |
| IIL | Input LOW Current |  |  |  | -0.36 | mA | $\mathrm{V}_{\text {CC }}=$ MAX, $\mathrm{V}_{\text {I }}$ | $=0.4 \mathrm{~V}$ |
| Ios | Output Short Circuit Current |  | -30 | -60 | -100 | mA | $\mathrm{V}_{C C}=\mathrm{MAX}, \mathrm{V}_{\mathrm{O}}$ | $\mathrm{T}=0 \mathrm{~V}$ ( Note 3) |
| Icc | Supply Current |  |  | 110 | 160 | mA | $\mathrm{V}_{\text {CC }}=$ MAX, Inputs Open |  |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC CHARACTERISTICS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, See Fig. 3

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |  |
| ${ }^{t}$ PLH. <br> tpHL | Propagation Delay, Positive Going CP to $\overline{\mathrm{O}}_{\mathrm{O}}, \overline{\mathrm{O}}_{1}, \overline{\mathrm{O}}_{2}, \overline{\mathrm{O}}_{3}$ |  | 18 | 25 | ns | EO, $\overline{\text { EX }}$ LOW |  |
| ${ }^{\text {tpLH. }}$ <br> tpHL | Propagation Delay, Io to $\bar{W}$ |  | 15 | 20 | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2} \mathrm{HIGH}$ |  |
| ${ }^{\text {tpLH}}$, <br> ${ }^{\text {tpHL }}$ | Propagation Delay, Data $\left(\bar{D}_{0}, \bar{D}_{1}, \bar{D}_{2}, \bar{D}_{3}\right)$ to $\bar{W}$ |  | 30 | 40 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |  |
| tPLH, | Propagation Delay, Data |  | 36 | 54 | ns | MSS HIGH | $11_{1} 1_{2}$ LOW |
| ${ }^{\text {tPHL }}$ | ( $\overline{\mathrm{D}}_{0}, \overline{\mathrm{D}}_{1}, \overline{\mathrm{D}}_{2}, \overline{\mathrm{D}}_{3}$ ) to $\overline{\mathrm{X}}, \overline{\mathrm{Y}}$ |  | 30 | 40 | ns | MSS LOW |  |
| ${ }^{\text {tpLH. }}$ <br> ${ }^{\text {tPHL }}$ | Propagation Dealy, $I_{1}, I_{2} \text { to } \bar{X}, \bar{y}$ |  | 36 | 48 | ns | MSS LOW |  |
| ${ }^{t}$ PLH. <br> ${ }^{\text {tPHL }}$ | Propagation Delay, Data ( $\overline{\mathrm{D}}_{0}, \overline{\mathrm{D}}_{1}, \overline{\mathrm{D}}_{2}, \overline{\mathrm{D}}_{3}$ ) to Z |  | 53 | 70 | ns | $1 \mathrm{k} \Omega$ External Load Resistor to $\mathrm{V}_{\mathrm{CC}}$ |  |
| ${ }^{t} \mathrm{PLH}$. <br> tpHL | Propagation Delay, Io to $\bar{W}$ |  | 33 | 44 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |  |
| tplH. ${ }^{\text {tpHL }}$ | Propagation Delay, $I_{1}, I_{2} \text { to } \bar{W}$ |  | 17 | 26 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |  |
| ${ }^{\text {tpLH. }}$ <br> ${ }^{\text {tPHL }}$ | Propagation Delay, $\bar{D}_{3}$ to $\bar{X}$ |  | 46 | 60 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ HIGH, MSS HIGH |  |

FAIRCHILD • 9405

AC CHARACTERISTICS (Cont'd): $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, See Fig. 3

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{t}$ PLH. <br> tpHL | Propagation Delay, Address ( $A_{0}, A_{1}, A_{2}$ ) to $\bar{X}, \bar{Y}$ |  | 49 | 64 | ns | 11.12 LOW, MSS LOW |
| ${ }^{t} \mathrm{PLH}$. <br> tpHL | Propagation Delay, Address $\left(A_{0}, A_{1}, A_{2}\right)$ to $\bar{X}, \bar{Y}$ |  | 72 | 95 | ns | 11.12 LOW, MSS HIGH |
| ${ }^{\text {tpLH. }}$ <br> ${ }^{\text {tPHL }}$ | Propagation Delay, Address ( $A_{0}, A_{1}, A_{2}$ ) to $\bar{X}$ |  | 72 | 95 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2} \mathrm{HIGH}, \mathrm{MSS}$ HIGH |
| ${ }^{t}$ PLH. <br> ${ }^{\text {tPHL }}$ | Propagation Delay, Address ( $A_{0}, A_{1}, A_{2}$ ) to $\bar{W}$ |  | 50 | 65 | ns | $I_{1}, I_{2}$ LOW |
| tple, <br> tPHL | Propagation Delay, Address $\left(A_{0}, A_{1}, A_{2}\right)$ to $Z$ |  | 61 | 80 | ns | $1_{1}, I_{2}$ LOW |
| ${ }^{\text {tPLH }}$ | Propagation Delay, |  | 23 | 31 | ns |  |
| ${ }^{\text {tPHL }}$ | $\mathrm{l}_{1}, \mathrm{l}_{2}$ to $\bar{X}, \overline{\mathrm{Y}}$ |  | 48 | 63 | ns | 1. 22 LOW, MSS HIGH |
| tplH. <br> tPHL | Propagation Delay, Io to $\bar{X}, \bar{Y}$ |  | 43 | 57 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW, MSS HIGH |
| ${ }^{\text {tpLH}}$, <br> ${ }^{\text {tPHL }}$ | Propagation Delay, $1_{1}, 1_{2} \text { to } Z$ |  | 42 | 60 | ns | $1_{1}, l_{2}$ LOW |
| ${ }^{\text {tpLH. }}$ <br> ${ }^{\mathrm{t} P \mathrm{PL}}$ | Propagation Delay, lo to $Z$ |  | 28 | 40 | ns | $1_{1}, 1_{2}$ LOW |
| $\begin{aligned} & \text { tPZH, } \\ & \text { tpZL } \\ & \hline \end{aligned}$ | Enable Delay, $\overline{\mathrm{EO}}$ to Outputs $\overline{\mathrm{O}}_{0}, \overline{\mathrm{O}}_{1}, \overline{\mathrm{O}}_{2}, \overline{\mathrm{O}}_{3}$ |  | 10 | 16 | ns |  |
| $\begin{aligned} & \text { tPLZ } \\ & \text { tPHZ } \\ & \hline \end{aligned}$ | Disable Display, $\overline{\mathrm{EO}}$ to $\overline{\mathrm{O}}_{0}, \overline{\mathrm{O}}_{1}, \overline{\mathrm{O}}_{2}, \overline{\mathrm{O}}_{3}$ |  | 10 | 16 | ns |  |

AC SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, See Fig. 3

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{t} \mathrm{CW}$ | Clock Period | 90 | 60 |  | ns |  |
| ${ }^{\text {tPWH }}$ | Clock Pulse Width (HIGH) | 40 | 25 |  | ns |  |
| ${ }^{\text {tPWL }}$ | Clock Pulse Width (LOW) | 25 | 15 |  | ns |  |
| $\mathrm{t}_{5} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{E X}$ to CP Rising Edge | 35 | 20 |  | ns |  |
| $t_{h} \overline{E X}$ | Hold Time, $\overline{E X}$ to CP Rising Edge | 0 |  |  | ns |  |
| $\mathrm{t}_{5} \mathrm{~A} 1$ | Set-Up Time, $A_{0}, A_{1}, A_{2}$ to Negative Going CP (Note 1) | 45 | 28 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \mathrm{A} 2$ | Set-Up Time, $A_{0}, A_{1}, A_{2}$ to Positive Going CP (Note 1) | 90 | 60 |  | ns |  |
| $t_{h} A$ | Hold Time, $\mathrm{A}_{0}, \mathrm{~A}_{1}, \mathrm{~A}_{2}$ to Positive Going CP | 0 | -3.0 |  | ns |  |
| $t_{s} \bar{D}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}, \overline{\mathrm{D}}_{1}, \overline{\mathrm{D}}_{2}, \overline{\mathrm{D}}_{3}$ to Positive Going CP | 50 | 33 |  | ns | EX LOW |
| $t_{n} \bar{D}$ | Hold Time, $\overline{\mathrm{D}}_{0}, \overline{\mathrm{D}}_{1}, \overline{\mathrm{D}}_{2}, \overline{\mathrm{D}}_{3}$ to Positive Going Clock | 0 | -25 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \mathrm{l} 1$ | Set-Up Time, $I_{0}, I_{1}, I_{2}$ to Negative Going Clock | 8.0 | 4.0 |  | ns |  |
| $t_{\text {l }} 1$ | Hold Time, $\mathrm{I}_{0} \mathrm{I}_{1}, \mathrm{I}_{2}$ to Positive Going Clock | 0 | -12 |  | ns |  |
| $\mathrm{ts}_{5} 12$ | Set-Up Time, $\mathrm{I}_{1}, \mathrm{I}_{2}$ to Positive Going Clock | 70 | 50 |  | ns |  |
| $\mathrm{t}_{5} 13$ | Set-Up Time $I_{0}$ to Positive Going Clock | 36 | 24 |  | ns |  |

## NOTE:

1. Both set-up times must be met simultaneously.


NOTES:
a) Delay for logical operation ( $I_{1}$ or $I_{2} \mathrm{HIGH}$ )
b) Delay for arithmetic operation ( $I_{1}=I_{2}=$ LOW $)$

Fig. 3

DESCRIPTION - The 9405A Arithmetic Logic Register Stack (ALRS) is designed to implement accumulators/general registers in high performance, microprogrammed digital systems (microprocessors). The 9405A is a 4-bit slice with expansion features for larger word lengths.

The device contains a 4-bit ALU, 8-word by 4-bit RAM, a 4-bit edge-triggered output register and associated control logic. The ALU implements eight arithmetic and logic functions on two 4-bit operands. The desired function is specified by three instruction inputs (I-field). One of the operands is supplied from an external source (D-Bus). The second operand is supplied internally from one of the eight RAM locations. The desired RAM location is specified by the address inputs (A-field) when the clock input is HIGH. The result from the ALU is loaded into a RAM location during the period when the clock input is LOW. The address for the desired RAM location for writing is also specified by the A-field. Moreover, the result from the ALU is also loaded into the output register on LOW-to-HIGH transistion of the clock input. The output register provides the 4-bit output (O-Bus) through 3 -state buffers.
For accumulator oriented microprocessor architectures, the A-field inputs to the 9405A remain the same during the HIGH and LOW period of the clock cycle. However, in general register oriented architectures, the A-field inputs are changed appropriately to realize the source and destination registers during HIGH and LOW period of the clock respectively.
Carry propagate and carry generate outputs are provided by the 9405A to facilitate carry lookahead expansion. The industry standard 93S42/74S182 carry lookahead unit can be used for this purpose. If high speed arithmetic is not needed, ripply carry expansion can be used. The ripple expansion eliminates the need for an external carry lookahead unit. The 9405A also provides four status signals (condition codes) to characterize the result of an operation - Zero, Negative, Overflow and Carry.
The 9405A is downward compatible with the 9405 and should be used in new designs. The 9405A is fully compatible with all TTL families.

[^1]

FAIRCHILD•9405A

## PIN NAMES

$\begin{array}{ll}\bar{D}_{O}-\bar{D}_{3} & \text { Data Inputs (Active LOW) } \\ A_{O}-A_{2} & \text { Address Inputs } \\ I_{0}-I_{2} & \text { Instruction Inputs (Note b) } \\ \mathrm{MSS} & \text { Most Significant Slice Input (Active HIGH) } \\ \mathrm{CP} & \text { Clock Input } \\ \overline{\mathrm{EO}} & \text { Output Enable Input (Active LOW) } \\ \overline{\mathrm{EX}} & \text { Execute Input (Active LOW) } \\ \overline{\mathrm{O}_{0}}-\overline{\mathrm{O}}_{3} & \text { Data Outputs (Active LOW) } \\ \bar{W} & \text { Ripple Carry Output (Active LOW) (Note c) } \\ \overline{\mathrm{X}} & \text { Carry Propagate Output (Note d) } \\ \overline{\mathrm{Y}} & \text { Carry Generate Output (Note e) } \\ \mathrm{Z} & \text { Zero Status Output (Active HIGH, Open Collector)(Note f) }\end{array}$
NOTES:
a) 1 Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW ( 0.5 V ).
b) $I_{0}$ used also for carry input.
c) W output also carries instruction information.
d) X output provides Negative status (active LOW) on most significant slice.
e) Y output provides Overflow status (active LOW) on most significant slice.
f) An external pull-up resistor is required to supply HIGH drive capability.

| LOADING (Note a) |  |
| :---: | :---: |
| HIGH | LOW |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 130 U.L. | 10 U.L. |
| 10 U.L. | 5.0 U.L. |
| 10 U.L. | 5.0 U.L. |
| 10 U.L. | 5.0 U.L. |
|  | 5.0 U.L. |

## BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION - As shown in the block diagram, the 9405A consists of a 4-bit ALU, 8-word by 4-bit RAM with latches, an Instruction Decoder, control logic and a 4-bit Output Register.
The ALU receives the active LOW data ( $\bar{D}_{0}-\bar{D}_{3}$ ) as one operand while the RAM provides the second operand through its latches. The ALU output is fed as input to the RAM and the Output Register. The active LOW output bus $\left(\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}\right)$ is from the Output Register through 3 -state buffers. A HIGH on the $\overline{\mathrm{EO}}$ input disables the buffers (high impedance state) while a LOW enables them.
The 6-bit instruction input for the 9405A consists of two 3 -bit fields: A-field and I-field. $A_{0}-A_{2}$ specifies the operation to be performed. The 8 -word RAM can be considered to be providing eight registers ( $R_{0}-R_{7}$ ) and eight different operations can be performed on these registers. The I-field inputs are decided by the Instruction Decoder to generate necessary control signals for the ALU. The ALU generates Carry (C), Carry Propagate (P), Carry Generate (G), Negative (N) and Overflow (V) signals to be used by the control logic. The control logic manipulates these signals as a function of the l-field inputs and an external control input signal MSS. The MSS input separates the most significant slice in an array of 9405 As from the remaining slices. A HIGH on the MSS denotes the most significance (MSS input may be tied directly to $\mathrm{V}_{\mathrm{CC}}$ ). In general, all except the most significant 9405A will have a LOW on the MSS input. The control logic generates three user outputs, $\overline{\mathrm{W}}, \overline{\mathrm{X}}$ and $\overline{\mathrm{Y}}$. The significance of these outputs is discussed under the Expansion section. The Zero output $(Z)$ is provided by an open collector transistor.
Table 1 lists the l-field assignment for the 9405A. There are only two arithmetic instructions in the table which require carry. It can also be noticed that the $I_{0}$ is the carry input. In the $9405 A$ operation $I_{0}$ plays a dual role and will be discussed in the Expansion section.

The CP input is used to clock the 9405A. The content of the specified RAM location is read into the output latches whenever the CP input is HIGH. These latches are disabled when the CP is LOW. Thus, the information that was presented when CP was HIGH will be stored in the latches. Writing of the ALU result occurs whenever the CP and $\overline{E X}$ inputs are LOW. If the CP or $\overline{E X}$ input becomes HIGH, writing into the RAM will be terminated and the result will be loaded into the Output Register on the transition.

Operation - The 9405A can be used in two modes: general register and accumulator. In the general register mode, one address $\left(R_{x}\right)$ is used to select a register $\left(R_{0}-R_{7}\right)$ for the source operand and another address ( $R_{y}$ ) is used to select a register ( $R_{0}-R_{7}$ ) as the destination for the result. This is accomplished by changing the A-field during the negative half cycle of the clock. In the accumulator mode, a single address is used to select a register ( $R_{0}-R_{7}$ ) for the source operand and the result is loaded back into the same register (implied destination). This mode is achieved by keeping the A-field unchanged for the entire clock cycle. The following page describes these modes in more detail.

TABLE 1
INSTRUCTION FIELD ASSIGNMENT

| $l_{2}$ | $\mathrm{I}_{1}$ | ${ }^{1} 0$ | ACCUMULATOR MODE ( $\mathrm{R}_{\mathrm{x}}=\mathrm{R}_{\mathrm{y}}$ ) |  | GENERAL REGISTER MODE ( $\mathrm{R}_{\mathrm{x}} \neq \mathrm{R}_{\mathrm{y}}$ ) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| L | L | L | $\mathrm{R}_{\mathrm{x}}$ plus $\overline{\mathrm{D}-\mathrm{Bus}}$ plus $1 \rightarrow \mathrm{R}_{\mathrm{X}}$ | Accumulate and Increment | $\mathrm{R}_{\mathrm{X}}$ plus $\overline{\mathrm{D}-\mathrm{Bus}}$ plus $1 \rightarrow \mathrm{R}_{\mathrm{y}}$ | Add with Carry |
| L | L | H | $\mathrm{R}_{\mathrm{x}}$ plus $\overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{x}}$ | Accumulate | $\mathrm{R}_{\mathrm{x}}$ plus $\overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{y}}$ | Add |
| L | H | L | $\mathrm{R}_{x} \overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{x}$ | Logical AND | $\mathrm{R}_{\mathbf{x}} \cdot \overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathbf{y}}$ | Logical AND |
| L | H | H | $\overline{\text { D-Bus }} \rightarrow \mathrm{R}_{\mathbf{x}}$ | Load | $\overline{\text { D-Bus }} \rightarrow \mathrm{R}_{\mathrm{y}}$ | Load |
| H | L | L | $\mathrm{R}_{\mathrm{x}} \rightarrow$ Output Register | Read | $\mathrm{R}_{\mathrm{x}} \rightarrow \mathrm{R}_{\mathrm{y}}$ | Transfer |
| H | L | H | $\mathrm{R}_{\mathrm{x}}+\overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{x}}$ | Logical OR | $\mathrm{R}_{\mathrm{x}}+\overline{\mathrm{D-Bus}} \rightarrow \mathrm{R}_{\mathrm{y}}$ | Logical OR |
| H | H | L | $\mathrm{R}_{\mathrm{x}} \oplus \overline{\mathrm{D}-\mathrm{Bus}} \rightarrow \mathrm{R}_{\mathrm{x}}$ | Exclusive OR | $R_{x} \oplus \overline{\text { D-Bus }} \rightarrow R_{y}$ | Exclusive OR |
| H | H | H | D-Bus $\rightarrow \mathrm{R}_{\mathrm{x}}$ | Load Complement | D-Bus $\rightarrow \mathrm{R}_{\mathrm{y}}$ | Load Complement |

## NOTES:

1. $R_{x}$ is the RAM location addressed by $A_{0}-A_{2}$ when $C P$ is HIGH.
2. $R_{y}$ is the RAM location addressed by $A_{0}-A_{2}$ when CP is LOW.
3. The result of any operation is always loaded into the Output Register at the end of the cycle provided that $\overline{\mathrm{EX}}$ is LOW.


NOTE: MSS is connected to $\mathrm{V}_{\mathrm{CC}}$ for most significant slice, otherwise grounded.
Fig. 1
GENERAL REGISTER MODE

General Register Mode - The general register mode of operation is depicted in Figure 1. A microcycle starts when the CP makes a LOW-to-HIGH transition. During the period when the clock is HIGH, data from the RAM is read into the latches. The A-field specifies the source register address for this operation. The latch outputs provide the source operand to the ALU. Inputs $\bar{D}_{0}-\bar{D}_{3}$ are the second operand to the ALU. The ALU will generate the result of the selected operation specified by the I-field. When the CP goes LOW, the latches are disabled, thus the source operand is stored in the latches. Because the $\overline{E X}$ input is not LOW, writing into the RAMM has not yet started. The A-field is changed to reflect the address of the destination register. When the $\overline{E X}$ goes LOW, writing into RAM is started and the output of the ALU will be written into the destination register. When the CP and/or $\overline{E X}$ goes HIGH, writing into the RAM will be terminated and the result will be loaded into the Output Register.
Switching the A-field is straightforward (see Figure 1). A quad 2-input multiplexer (93S157) is used to drive the A-field. One set of inputs ( $X_{0}-X_{2}$ ) to the multiplexer are the address bits corresponding to the source register address and the second set of inputs ( $Y_{0}-Y_{2}$ ) are the destination register address bits. The CP input for the 9405A is the output of a flip-flop connected in the complementing mode. The select input of the multiplexer is also controlled by the flip-flop output. The $\overline{\mathrm{EX}}$ input to the 9405A is obtained by gating the clock signal with the flip-flop output.
Accumulator Mode - The accumulator mode of operation is shown in Figure 2. As before, a microcycle starts when the CP makes a LOW-to-HIGH transition. Data is read from the specified RAM location into the latches and applied to the ALU. The A-field inputs specify the address of the desired location. The ALU performs the operation specified by the 1 -field on $D_{0}-D_{3}$ inputs and the latch outputs. When the CP goes LOW, the latches are disabled from tracking the RAM output. If the $\overline{E X}$ input and CP are LOW writing into the RAM is initiated. In the accumulator mode, the A-field remains unchanged and the result from the ALU will be written into the same location and loaded into the Output Register on the LOW-to-HIGH transition of CP provided that $\overline{\mathrm{EX}}$ is LOW.


NOTE: MSS IS CONNECTED TO VCC FOR MOST SIGNIFICANT SLICE, OTHERWISE GROUNDED.

NOTE: MSS is connected to $V_{C C}$ for most significant slice, otherwise grounded.

## Fig. 2

ACCUMULATOR MODE

EXPANSION - The 9405A is organized as a 4-bit slice and can easily be expanded for longer words. Expansion requires that carries from lesser significant slices be propagated towards the most significant slice. The 9405A provides. full lookahead capability for high speed arithmetic. Appropriate Carry Generate $(\bar{Y})$ and Carry Propagate $(\bar{X})$ outputs are provided so that only one external carry lookahead generator is needed for every four 9405As. When speed is not a prime consideration, it is also possible to implement ripple carry expansion.

In arrayed operation, it is common to bus the $\overline{E X}, C P$ and $\overline{E O}$ inputs of all devices to form a fixed word length array. The Z outputs are connected together through a load resistor to $\mathrm{V}_{\mathrm{CC}}$ so that a HIGH indicates a "zero" result from an operation in the array.
Figure 3 shows a 16-bit array with ripple carry expansion using four 9405As. The MSS input is tied to $\mathrm{V}_{\mathrm{CC}}$ on the most significant slice (ALRS 4); the MSS inputs of the other devices are tied to ground. The instruction bus of this array consists of A-field and $I$-field. A-field is obtained by connecting corresponding $A$ inputs of all four devices. The $I_{0}$ input of device 1 (i.e., least significant slice) in conjunction with the bussed $I_{1}, I_{2}$ inputs forms the l-field for the array. The $I_{0}$ inputs of devices 2,3 and 4 are connected to the $\bar{W}$ outputs of devices 1,2 and 3 respectively. The ALU network generates the carry output (see block diagram). The control logic operates on this signal as a function of $I_{1}$ and $I_{2}$ to generate the $\bar{W}$ output. If both $I_{1}$ and $I_{2}$ are LOW (i.e., an arithmetic instruction), the $\bar{W}$ output is the carry output of that slice. In case of non-arithmetic instructions, the $\bar{W}$ output of a device assumes the state of its $I_{0}$ input. Thus, in Figure 3, if an arithmetic instruction is specified, carry propagates through the $\bar{W}$ output to $I_{0}$ input of the next higher significant slice. On the other hand, nonarithmetic instructions effectively connect all $I_{0}$ inputs together to form the l-field for the array. The $\bar{W}$ output of device 4 is the carry output from the array. The control logic also generates $\bar{X}$ and $\bar{Y}$ outputs which participate in expansion when external carry lookahead is used. These outputs are normally ignored in ripple expansion except for the most significant slice. In the most significant slice, $\overline{\mathrm{X}}$ and $\overline{\mathrm{Y}}$ correspond to Negative and Overflow status signals.

The $\bar{X}$ output of device 4 is LOW if the result of an operation has its most significant bit as " 1 " (i.e., negative result). Similarly a LOW on $\bar{Y}$ output of device 4 indicates that arithmetic overflow has occurred. If the two operands have the same sign and the result has opposite sign, then it is assumed that an overflow has occurred. It should be noted that $\bar{W}, \bar{X}$ and $\bar{Y}$ are not controlled by EX or CP.
Figure 4 shows a 16 -bit array with external carry lookahead expansion. Implementing the lookahead scheme requires the use of an external 93S42/74S182 in addition to the four 9405As in the array. Since device 1 is the least significant and device 4 is the most significant slice, the MSS inputs of the first three devices are connected to ground while device 4 has a HIGH at this input. The A-field for the array instruction bus is obtained by connecting corresponding A inputs of all four devices. Bussed $I_{1}$ and $I_{2}$ inputs, together with the $I_{0}$ input of device 1 , form the 1 -field for the array. The $I_{0}$ inputs for devices 2,3 and 4 are obtained from the $93 S 42 / 74 \mathrm{~S} 182$ carry outputs ( $\mathrm{C}_{n+x}, C_{n+y}$, and $\mathrm{C}_{n+z}$ respectively). Also the $\overline{\mathrm{P}}$ and $\overline{\mathrm{G}}$ inputs of $93 \mathrm{~S} 42 / 74 \mathrm{~S} 182$ are connected to $\overline{\mathrm{X}}$ and $\overline{\mathrm{Y}}$ outputs of the 9405As as shown. The control logic in the 9405A (see block diagram) generates $\bar{X}$ and $\bar{Y}$ outputs as a function of $I_{1}, I_{2}$ and MSS inputs, as well as the Carry Generate and Carry Propagate
outputs of the ALU. If the MSS input of a slice is LOW and an arithmetic instruction is specified, its $\bar{X}$ output reflects Carry Propagate and $\bar{Y}$ reflects Carry Generate outputs from that slice. For an arithmetic instruction the $I_{0}$ input is treated as carry-in into a slice irrespective of MSS. Thus, whenever $I_{1}$ and $I_{2}$ are LOW, the array behaves as an adder with full carry lookahead. The $\bar{W}$ outputs still reflect carry output, which is ignored for devices 1,2 and 3 . The $\bar{W}$ output of device 4 is the carry output from the array. Also, note that the $I_{0}$ input of device 1 is not only an instruction input but also provides the carry input to the array. The $I_{0}$ input of device 1 must be connected to the appropriate $93542 / 74 \mathrm{~S} 182$ input as shown.
When a non-arithmetic instruction is specified to the array, the control logic of the 9405A forces a LOW on $\bar{X}$ and a HIGH on $\bar{Y}$ outputs on all except the most significant slice. An examination of the $93 S 42 / 74$ S 182 logic reveals that whenever $\bar{P}$ is LOW and $\overline{\mathrm{G}}$ is HIGH the associated carry output is the same as the carry input. Thus, in Figure 4 devices 2, 3, and 4 will assume the same logic level as that presented to the $I_{0}$ input of device 1 during non-arithmetic instructions. This effectively connects $I_{0}$ through all four devices. As in the case of ripple expansion, $\bar{X}$ and $\bar{Y}$ outputs of device 4 represent Negative and Overflow from the array.
Figures 3 and 4 both illustrate 16 -bit arrays where the D -Bus ( $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{15}$ ) represents the 16-bit input to the-array, and the O-Bus ( $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{15}$ ) represents the 16 -bit 3-state output from the array. $\overline{\mathrm{D}}_{0}$ and $\overline{\mathrm{O}}_{0}$ represent the low order bits of the input and output respectively.


Fig. 3
RIPPLE CARRY EXPANSION


Fig. 4
CARRY LOOKAHEAD EXPANSION

FAIRCHILD•9405A

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise noted)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | Input HIGH Voltage |  | 2.0 |  |  | V | Guaranteed Input | HIGH Voltage |
| $V_{\text {IL }}$ | Input LOW Voltage | XM |  |  | 0.7 | V | Guaranteed Input LOW Voltage |  |
|  |  | XC |  |  | 0.8 |  |  |  |
| $\mathrm{V}_{\mathrm{CD}}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | v | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\text {I }}=-18 \mathrm{~mA}$ |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage $\bar{W}, \bar{X}, \bar{Y}$ Outputs | XM | 2.4 | 3.4 |  | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |  |
|  |  | XC | 2.4 | 3.4 |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage$\mathrm{O}_{0}, \mathrm{O}_{1}, \mathrm{O}_{2}, \mathrm{O}_{3}$ | XM | 2.4 | 3.4 |  | V | $1 \mathrm{OH}=-2.0 \mathrm{~mA}$ | $V_{C C}=\mathrm{MIN}$ |
|  |  | XC | 2.4 | 3.1 |  |  | $1 \mathrm{OH}=-5.7 \mathrm{~mA}$ |  |
| ${ }^{1} \mathrm{OH}$ | Output HIGH Current Z Output |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{V}_{\mathrm{OH}}=5.5 \mathrm{~V}$ |  |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage $\bar{w}, \bar{x}, z$ | XM |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=4.0 \mathrm{~mA}$ |  |
|  |  | XC |  | 0.4 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}$ | 8.0 mA |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage$\mathrm{o}_{0}, \mathrm{o}_{1}, \mathrm{o}_{2}, \mathrm{o}_{3}, \overline{\mathrm{Y}}$ | XM |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |  |
|  |  | XC |  | 0.4 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}$ |  |
| IOZH | Output Off HIGH Current |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2 \mathrm{~V}$ |  |
| IOZL | Output Off LOW Current |  |  |  | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2 \mathrm{~V}$ |  |
| IIH | Input HIGH Current |  |  | 1.0 | 40 | $\mu \mathrm{A}$ | $V_{\text {CC }}=$ MAX, $V_{\text {I }}$ | $=2.7 \mathrm{~V}$ |
|  |  |  |  |  | 1.0 | mA | $V_{C C}=$ MAX, $V_{1}$ | $=5.5 \mathrm{~V}$ |
| IIL | Input LOW Current |  |  |  | -0.36 | mA | $V_{\text {CC }}=$ MAX, $V_{\text {I }}$ | $=0.4 \mathrm{~V}$ |
| Ios | Output Short Circuit Current |  | -30 |  | -100 | mA | $V_{C C}=$ MAX, $V_{\text {O }}$ | $\mathrm{T}=0 \mathrm{~V}$ (Note 3) |
| Icc | Supply Current |  |  | 110 | 160 | mA | $\mathrm{V}_{C C}=\mathrm{MAX}, \mathrm{In}$ | s Open |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC CHARACTERISTICS: $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, See Fig. 3

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |  |
| ${ }^{\text {tPLH }}$, tpHL | Propagation Delay, Positive Going CP to $\mathrm{O}_{0}, \mathrm{O}_{1}, \mathrm{O}_{2}, \mathrm{O}_{3}$ |  | 18 | 25 | ns | EO, EX LOW |  |
| ${ }^{t}$ PLH, <br> tpHL | Propagation Delay, to to $\bar{W}$ |  | 10 | 16 | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2} \mathrm{HIGH}$ |  |
| tPLH, tPHL | Propagation Delay, Data $\left(\mathrm{D}_{0}, \mathrm{D}_{1}, \mathrm{D}_{2}, \mathrm{D}_{3}\right)$ to $\bar{W}$ |  | 30 | 40 | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2}$ LOW |  |
| tPLH, | Propagation Delay, Data |  | 48 | 54 | ns | MSS HIGH | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |
| ${ }^{\text {tPHL }}$ | ( $\mathrm{D}_{0}, \mathrm{D}_{1}, \mathrm{D}_{2}, \mathrm{D}_{3}$, to $\overline{\mathrm{X}}, \overline{\mathrm{Y}}$ |  | 30 | 40 | ns | MSS LOW |  |
| tpLH, <br> tpHL | Propagation Delay, $I_{1}, I_{2} \text { to } \bar{X}, \bar{Y}$ |  | 22 | 30 | ns | MSS LOW |  |
| $\begin{aligned} & \text { tPLH, } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Data ( $\mathrm{D}_{\mathrm{o}}, \mathrm{D}_{1}, \mathrm{D}_{2}, \mathrm{D}_{3}$ ) to Z |  | 48 | 60 | ns | $1 \mathrm{k} \Omega$ External Load Resistor to $\mathrm{V}_{\mathrm{CC}}$ |  |
| $\overline{\mathrm{tPLH}^{2}}$ tPHL | Propagation Delay, $I_{0}$ to $\bar{W}$ |  | 16 | 22 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |  |
| $\begin{aligned} & \text { tPLH, } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{1}, I_{2}$ to $\bar{W}$ |  | 13 | 18 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |  |
| $\begin{aligned} & \text { tPLH, } \\ & \text { tpHL } \end{aligned}$ | Propagation Delay, $D_{3}$ to $\bar{X}$ |  | 32 | 44 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2} \mathrm{HIGH}, \mathrm{MSS}$ HIGH |  |
| tple, <br> tPHL | Propagation Delay, Address $\left(A_{0}, A_{1}, A_{2}\right) \text { to } X, Y$ |  | 42 | 58 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW, MSS LOW |  |
| tpLH, <br> tPHL | Propagation Delay, Address ( $A_{0}, A_{1}, A_{2}$ ) to $X, Y$ |  | 57 | 75 | ns | $1_{1}, l_{2}$ LOW, MSS HIGH |  |
| $\begin{aligned} & \text { tPLH, }^{\prime} \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Address $\left(A_{0}, A_{1}, A_{2}\right)$ to $X$ |  | 53 | 70 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2} \mathrm{HIGH}, \mathrm{MSS}$ HIGH |  |

## FAIRCHILD • 9405 A

AC CHARACTERISTICS (Cont ${ }^{\prime}$ ): $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, See Fig. 3 and 5

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{t}$ PLH, tPHL | Propagation Delay, Address $\left(A_{0}, A_{1}, A_{2}\right)$ to $W$ |  | 44 | 60 | ns | $I_{1}, I_{2}$ LOW |
| tpLH, <br> tPHL | Propagation Delay, Address $\left(A_{0}, A_{1}, A_{2}\right)$ to $Z$ |  | 61 | 75 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW |
| tPLH, | Propagation Delay, |  | 39 | 55 | ns | W, MSS H |
| ${ }^{\text {tPHL }}$ | $I_{1}, I_{2}$ to $X, Y$ |  | 28 | 55 | ns | 1, ${ }_{2}$ LOW, MSS HIGH |
| ${ }^{t} \mathrm{PLH}$, <br> tPHL | Propagation Delay, $I_{0}$ to $X, Y$ |  | 30 | 40 | ns | $\mathrm{I}_{1}, \mathrm{I}_{2}$ LOW, MSS HIGH |
| $\begin{aligned} & \text { tPLH, } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{1}, I_{2}$ to $Z$ |  | 44 | 60 | ns | $I_{1}, I_{2}$ LOW |
| tpLH, <br> tPHL | Propagation Delay, $I_{0}$ to $Z$ |  | 30 | 40 | ns | $I_{1}, I_{2}$ LOW |
| tpZH, <br> tPZL | Enable Delay, EO to Outputs $\mathrm{O}_{0}, \mathrm{O}_{1}, \mathrm{O}_{2}, \mathrm{O}_{3}$ |  | 11 | 16 | ns | . |
| $\begin{aligned} & \text { tPLZ, } \\ & \text { tPHZ } \end{aligned}$ | Disable Display, EO to $\mathrm{O}_{0}, \mathrm{O}_{1}, \mathrm{O}_{2}, \mathrm{O}_{3}$ |  | 10 | 16 | ns |  |

AC SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$,
See Fig. 5 for One Address Mode, Fig. 6 for Two Address Mode.

| SYMBOL | PARAMETER | MIN | TYP | MAX | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{\mathrm{t}}{ }^{\text {c }}$ W | Clock Period | 75 | 50 |  | ns |  |
| ${ }^{\text {tPWH }}$ | Clock Pulse Width (HIGH) | 35 | 23 |  | ns |  |
| tPWL | Clock Pulse Width (LOW) | 25 | 14 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \overline{\mathrm{EX}}_{1}$ | Set-Up Time, Positive-Going $\overline{E X}$ to NegativeGoing CP (Note 1) | 0 | -9 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \overline{\mathrm{EX}}_{2}$ | Set-Up Time, Negative-Going $\overline{\mathrm{EX}}$ to PositiveGoing CP (Note 1) | 15 | 10 |  | ns |  |
| $t_{\text {ch }} \overline{\mathrm{E}}$ | Hold Time, $\overline{E X}$ to CP | 0 |  |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \mathrm{A}_{1}$ | Set-Up Time, $A_{0}, A_{1}, A_{2}$ to NegativeGoing CP (Note 1) (Source Address) | 35 | 22 |  | ns |  |
| $\mathrm{t}_{s} \mathrm{~A}_{2}$ | Set-Up Time, $A_{0}, A_{1}, A_{2}$ to PositiveGoing CP (Note 1) (Source Address) | 75 | 50 |  | ns |  |
| $\mathrm{t}_{5} \mathrm{~A}_{2}$ | Set-Up Time, $A_{0}, A_{1}, A_{2}$ to NegativeGoing $\overline{E X}$ (Note 1) (Destination Address) | 13 | 7 |  | ns |  |
| $t_{h} A$ | Hold Time, $\mathrm{A}_{0}, \mathrm{~A}_{1}, \mathrm{~A}_{2}$ to PositiveGoing CP (Destination Address) | 0 |  |  | ns |  |
| ${ }_{\text {tha }}{ }^{\text {d }}$ | Hold Time, $A_{0}, A_{1}, A_{2}$ to NegativeGoing CP (Note 2) (Source Address) | 0 |  |  | ns |  |
| ${ }_{t h} \mathrm{~A}_{2}$ | Hold Time, $\mathrm{A}_{0}, \mathrm{~A}_{1}, \mathrm{~A}_{2}$ to PositiveGoing CP (Note 2) (Destination Address) | 0 | -4 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \overline{\mathrm{D}}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}, \overline{\mathrm{D}}_{1}, \overline{\mathrm{D}}_{2}, \overline{\mathrm{D}}_{3}$ to PositiveGoing CP | 45 | 30 |  | ns |  |
| $t_{h} \bar{D}$ | Hold Time, $\overline{\mathrm{D}}_{0}, \overline{\mathrm{D}}_{1}, \overline{\mathrm{D}}_{2}, \overline{\mathrm{D}}_{3}$ to PositiveGoing CP | 0 | -10 |  | ns |  |

NOTES:

1. Both set-up times must be met.
2. Both hold times must be met.

FAIRCHILD • 9405A

INSTRUCTION SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{C}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$,
See Fig. 4 for Multiple Slice Array Configuration

| SYMBOL | PARAMETER | SINGLE SLICE |  |  | LEAST SIGNIFICANT SLICE OF MULTIPLE SLICE ARRAY |  |  | NON LEAST SIGNIFICANT SLICES |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |
| $\mathrm{t}_{\mathrm{s}} 11$ | Set-Up Time, $I_{0}, I_{1}, I_{2}$ to Negative-Going Clock (Note 1) | 8 | 4 |  | $8+{ }^{\text {(max }}$ ( | 4+t (typ) |  | $\begin{gathered} \text { Note } \\ 2 \end{gathered}$ | Note $2$ |  | ns |
| $\mathrm{t}_{s} \mathrm{I}_{2}$ | Set-Up Time, $1_{1}, 1_{2}$ to Positive-Going Clock | 40 | 25 |  | 40 | 25 |  | 40 | 25 |  | ns |
| ${ }_{t}{ }^{\prime} 3$ | Set-Up Time, $\mathrm{I}_{0}$ to Positive-Going Clock | 40 | 25 |  | 40 | 25 |  | 18 | 10 |  | ns |
| ${ }^{t}{ }^{\text {l }}$ | Hold Time, $\mathrm{I}_{0}, \mathrm{I}_{1}, \mathrm{I}_{2}$ to Positive-Going Clock | 0 |  |  | 0 |  |  | 0 |  |  | ns |

NOTE:

1. $t=$ propagation delay of carry lookahead unit. i.e., $t_{p d} C_{I N}$ to $C_{n+x}$. In the case of the $93 S 42 / 74 S 182, t_{\text {max }}=11.5 \mathrm{~ns}$ and $t_{t y p}=9.0 \mathrm{~ns}$.
2. There is no $t_{s} l_{1}$ set-up requirement for non least significant slices. However, the set-up requirement for the least significant slice must be met.


NOTES:
a) Delay for logical operation ( $1_{1}$ or $\mathrm{I}_{2} \mathrm{HIGH}$ )
b) Delay for arithmetic operation $\left(I_{1}=I_{2}=\right.$ LOW $)$

Fig. 5
ALRS TIMING DIAGRAM, SINGLE ADDRESS MODE


NOTES:
a. Delay for logical operation ( $1_{1}$ or $\left.l_{2} \mathrm{HIGH}\right)$
b. Delay for arithmetic operation ( $I_{1}=I_{2}=$ LOW $)$

Fig. 6
ALRS TIMING DIAGRAM-TWO ADDRESS MODE

## AC CHARACTERISTICS: MULTIPLE SLICE OPERATION

A single 9405A slice operating without overhead is guaranteed to operate at 13.3 MHz ( 75 ns ). Such a configuration, however, would be extremely rare. AC guarantees for multiple slice operation depend on the configuration actually used. Several examples follow.

8-bit Machine with Ripple Carry


| DESCRIPTION | TYP | MAX |
| :--- | ---: | :---: |
| Assume that at time, $\mathrm{t}=0$, the clock goes HIGH and the <br> instruction and address information appear at the 9405A inputs |  |  |
| t pd-Address to $\overline{\mathrm{W}}$ of 9405A \#1 ( $\overline{\mathrm{W}}$ is the carry-out pin) $^{\mathrm{t}_{\text {pd }}-9405 \mathrm{~A} \# 2, \mathrm{I}_{0} \text { to Status Flags (See Note 1) }}$ | 44 ns | 60 ns |
| Total clock period required | 30 ns | 40 ns |
| Frequency | 74 ns | 100 ns |

8-bit Machine with Ripple Carry and DPS in Data Path (Note 2)


| DESCRIPTION | TYP | MAX |
| :--- | :---: | :---: |
| Assume that at time, $\mathrm{t}=0$, the clock goes HIGH and the <br> instruction and address information appear at the <br> 9404 and $9405 A$ inputs |  |  |
| $\mathrm{t}_{\text {pd }}-$ Rising edge of clock to $\overline{0}$ outputs of 9405A \#1 | 18 ns | 25 ns |
| $\mathrm{t}_{\text {pd }}-9404 \# 1, \overline{\mathrm{D}}$ inputs to $9404 \# 1,0$ outputs <br> $($ See 9404 data sheet) $)$ | 15 ns | 25 ns |
| $\mathrm{t}_{\text {pd }}-9405 A \# 1, \overline{\mathrm{D}}$ inputs to $\overline{\mathrm{W}}(\overline{\mathrm{W}}$ is the carry-out pin) | 30 ns | 40 ns |
| $\mathrm{t}_{\text {pd }}-9405 \mathrm{~A} \# 2, \mathrm{I}_{0}$ to Status Flags (See Note 1) | 30 ns | 40 ns |
| Total clock period required | 93 ns | 130 ns |
| Frequency | 10.7 MHz | 7.7 MHz |

Notes on following pages.

16-bit Machine with Carry Lookahead


| DESCRIPTION | TYP | MAX |
| :---: | :---: | :---: |
| Assume that at time, $\mathrm{t}=0$, the clock goes HIGH and the instruction and address information appear at the 9404 and 9405A inputs |  |  |
| $\mathrm{t}_{\text {pd }}$-Address inputs to $\bar{X}, \overline{\mathrm{Y}}$ outputs of 9405A \#1 | 42 ns | 58 ns |
| ${ }^{t_{p d}}$-G and $P$ inputs of carry lookahead (Note: All G and P outputs are generated simultaneously. Therefore, 9405A \# 2, \#3, \#4 set-up simultaneously.) | 5 ns | 7 ns |
| $\mathrm{t}_{\mathrm{pd}}$-9405A \# 4, $\mathrm{I}_{0}$ to Status. Flags (See Note 1) | 30 ns | 40 ns |
| Total clock period required | 77 ns | 105 ns |
| Frequency | 13 MHz | 9.5 MHz |

16-bit Machine with Carry Lookahead and DPS in Data Path (Note 3)


Notes on following pages.

## 16-bit Machine with Carry Lookahead and DPS in Data Path (Cont'd)

| DESCRIPTION | TYP | MAX |
| :---: | :---: | :---: |
| Assume that at $\mathrm{t}=0$, the clock goes HIGH and the instruction and address information appear at the 9404 and 9405A inputs. |  |  |
| $\mathrm{t}_{\text {pd }}-\mathrm{R}$ ising edge of clock to $\overline{0}$ output of 9405A \#1 | 18 ns | 25 ns |
| $\mathrm{t}_{\text {pd }}-9404$ \# 1, $\overline{\mathrm{D}}$ inputs to $\overline{0}$ outputs | 15 ns | 25 ns |
| ${ }^{\mathrm{t}}{ }_{\mathrm{pd}}-9405 \mathrm{~A} \# 1, \overline{\mathrm{D}}$ inputs to $\overline{\mathrm{X}}, \overline{\mathrm{Y}}$ outputs ( $\mathrm{X}, \mathrm{Y}$ are carry propagate and generate) | 30 ns | 40 ns |
| $t_{p d}$-Carry propagate and generate inputs of carry lookahead to carry out. (Note that all carry outs are generated simultaneously.) | 5 ns | 7 ns |
| $\mathrm{t}_{\mathrm{pd}}$-9405A \# 4, $\mathrm{I}_{0}$ to Status Flags (See Note 1) | 30 ns | 40 ns |
| Total clock period required | 98 ns | 137 ns |
| Frequency | 10 MHz | 7.3 MHz |

Architectures with Finite Delay between Rising Clock and the Appearance of Instructions and Address Information
Consider the previous case (16-bit with carry lookahead and DPS). After the clock rises, 25 ns is required before data appears at the input of the 9404. During this 25 ns there is no need for instruction or address information. Therefore, so long as the address and instructions appear within this 25 ns , no time is lost. Consequently, a pipeline system where the propagation delay of the pipeline register is less than 25 ns will operate at the speed guaranteed for the data path alone; i.e., 7.3 MHz guaranteed for a 16 -bit machine employing carry lookahead, 9404 s in the data path, and a pipeline register with propagation delay less than 25 ns .

## NOTES:

1. The 9405 s could actually respond to a rising clock after the 18 ns (the $I_{0}$ to rising clock set-up time max). However, the status flags are not available until 40 ns have elapsed.
2. In this configuration, carry out for $9405 A \# 1$ cannot be generated until the $D$ inputs are present. These originate from the $9405 A \not \# 1$ output register and must pass through $9404 \# 1$ before reaching the $9405 \mathrm{~A} \# 1$ inputs.
3. In this configuration, carry propagate and generate outputs from 9405A \#1 cannot be generated until the $D$ inputs are present. These originate from 9405A \#1 outputs register and must pass through $9404 \# 1$ before reaching the $9405 A \# 1$ inputs.

# 9406 <br> PROGRAM STACK 

FAIRCHILD TTL MACROLOGIC

DESCRIPTION - The 9406 is a 16 -word by 4 -bit "push-down pop-up" Program Stack. It is designed to implement Program Counter (PC) and return address storage for nested subroutines in programmable digital systems. The 9406 executes 4 instructions: Return, Branch, Call and Fetch as specified by a 2-bit instruction. When the device is initialized, PC is in the top location of the stack. As a new PC value is "pushed" into the stack (Call operation), all previous PC values effectively move down one level. The top location of the stack is the current PC. Up to 16 new Program Counter values can be stored, which gives the 9406 a 15 level nesting capability. "Popping" the stack (Return operation) brings the most recent PC to the top of the stack. The remaining two instructions affect only the top location of the stack. In the Branch operation a new PC value is loaded into the top location of the stack from the $\bar{D}_{0}-\bar{D}_{3}$ Inputs. In the Fetch operation, the contents of the top stack location (current PC value) are put on the $\mathrm{X}_{0}-\mathrm{X}_{3}$ bus and the current PC value is incremented.
The 9406 may be expanded to any word length without additional logic. 3-state output drivers are provided on the 4-bit address outputs ( $\mathrm{X}_{0}-\mathrm{X}_{3}$ ) and data outputs ( $\overline{\mathrm{O}}_{0}-$ $\overline{\mathrm{O}}_{3}$ ); the X-Bus outputs are enabled internally during the Fetch instruction while the O Bus outputs are controlled by an Output Enable ( $\overline{\mathrm{EO}}_{0}$ ). Two status outputs, Stack Full $(\overline{\mathrm{SF}})$ and Stack Empty ( $\overline{\mathrm{SE}}$ ) are provided. The 9406 is fully compatible with all TTL families.

- 16-WORD BY 4-BIT LIFO
- 15-LEVEL NESTING CAPABILITY
- 10 MHz MICROINSTRUCTION RATE
- PROGRAM COUNTER LOADS FROM DATA BUS
- OPTIONAL AUTOMATIC INCREMENT OF PROGRAM COUNTER
- STACK LIMIT STATUS INDICATORS
- SLIM 24-PIN PACKAGE
- 3-STATE OUTPUTS


## PIN NAMES

| $\bar{D}_{0}-\bar{D}_{3}$ | Data Inputs (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| :---: | :---: | :---: | :---: |
| $\mathrm{I}_{0}, \mathrm{I}_{1}$ | Instruction Inputs | 1.0 U.L. | 0.23 U.L. |
| EX | Execute Input (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| CP | Clock Input | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{MR}}$ | Master Reset Input (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{Cl}}$ | Carry Input (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{EO}}_{0}$ | Output Enable Input (Active LOW) | 1.0 U.L. | 0.23 U.L. |
| $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ | Output Data Outputs (Active LOW) (Note b) | 130 U.L. | 10 U.L. |
| $x_{0}-x_{3}$ | Address Outputs (Note b) | 130 U.L. | 10 U.L. |
| $\overline{\mathrm{CO}}$ | Carry Output (Active LOW) (Note b) | 10 U.L. | 5 U.L. |
| $\overline{\mathrm{SF}}$ | Stack Full Output (Active LOW) (Note b) | 10 U.L. | 5 U.L. |
| $\overline{\mathrm{SE}}$ | Stack Empty Output (Active LOW) (Note b) | 10 U.L. | 5 U.L. |

NOTES:
a. 1 unit load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW.
b. Output fan-out with $\mathrm{V}_{\mathrm{OL}} \leqslant 0.5 \mathrm{~V}$.

| LOGIC SYMBOL $\begin{aligned} & V_{C C}=\operatorname{Pin} 24 \\ & G N D=P \text { in } 12 \end{aligned}$ |
| :---: |
| CONNECTION DIAGRAM DIP (TOP VIEW) |

NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

FAIRCHILD • 9406

BLOCK DIAGRAM


TABLE 1
INSTRUCTION SET FOR THE 9406

| $I_{1} l_{0}$ | INSTRUCTION | INTERNAL OPERATION | X-BUS | O-BUS (WITH EOO LOW) |
| :---: | :---: | :---: | :---: | :---: |
| L L | Return (Pop) | Decrement Stack Pointer | Disabled | Depending on the relative timing of $\overline{E X}$ and $C P$, the outputs will reflect the current program counter or the new value while $C P$ is LOW. When CP goes HIGH again, the output will reflect the new value. |
| L H | Branch (Load PC) | Load D-Bus into Current Program Counter Location | Disabled | Current Program Counter until CP goes HIGH again, then updated with newly entered PC value. |
| H L | Call (Push) | Increment Stack Pointer and Load D-Bus into New Program Counter Location | Disabled | Depending on the relative timing of $\overline{E X}$ and $C P$, the outputs will reflect the current program counter or the previous contents of the incremented SP location. When CP goes HIGH again, the outputs will reflect the newly entered PC value. <br> See Figure 9 for details. |
| H H | Fetch <br> (Increment PC) | Increment Current Program Counter if $\overline{\mathrm{CI}}$ is LOW | Current Program Counter while both CP and $\overline{E X}$ are LOW, disabled while CP or $\overline{E X}$ is HIGH | Current Program Counter until CP goes HIGH again, then updated with incremented PC value. |

FUNCTIONAL DESCRIPTION - As shown in the block diagram, the 9406 consists of an Input Multiplexer, a $16 \times 4$ RAM with output latches addressed by the Stack Pointer (SP), an incrementor, control logic, and output buffers. The 9406 is organized around three 4-bit busses; the input data bus ( $\bar{D}_{0}-\bar{D}_{3}$ ), output data bus ( $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ ) and the address bus ( $\mathrm{X}_{0}-\mathrm{X}_{3}$ ). The 9406 implements four instructions as determined by Inputs $I_{0}$ and $I_{1}$ (see Table 1). The O-Bus is derived from the RAM output latches and enabled by a LOW on the Output Enable ( $\overline{\mathrm{EO}}_{0}$ ) input. The X -Bus is also derived from the output latches; it is enabled internally during the Fetch instruction. Execution of instructions is controlled by the Execute ( $\overline{\mathrm{EX}}$ ) and Clock (CP) inputs.

Fetch Operation - The Fetch operation places the content of the current Program Counter (PC) on the X-Bus. If the Carry In (CI) is I_OW, the current PC is incremented in preparation for the next Fetch. If CI is HIGH , the value of the current PC is unchanged, (Iterative Fetch).

The instruction code is set up on the I lines when CP is HIGH. The Execute ( $\overline{E X}$ ) is normally LOW at this time. The control logic interprets $I_{0}$ and $I_{1}$ and selects the incrementor output as the data source to the RAM via the Input Multiplexer. The current PC value is loaded into the latches and is available on the O-Bus if $\overline{\mathrm{EO}}_{0}$ is LOW. When CP is LOW the latches are disabled from following the RAM output, when both CP and $\overline{E X}$ are LOW, buffers are enabled, applying the current PC to the X -Bus. The output of the incrementor is written into the RAM during the period when CP and $\overline{\mathrm{EX}}$ are LOW. If $\overline{\mathrm{Cl}}$ is LOW, the value stored in the current PC, plus one, is written into the RAM. If $\overline{\mathrm{Cl}}$ is HIGH , the current PC is not incremented. Carry Out $(\overline{\mathrm{CO}})$ is LOW when the content of the current PC is at its maximum, i.e., all ones and the Carry In ( $\overline{\mathrm{Cl}}$ ) is LOW. When CP or $\overline{E X}$ goes HIGH, writing into the RAM is inhibited and the address buffers ( $X_{0}-X_{3}$ ) are disabled.
Branch Operation - During a Branch operation, the data inputs ( $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ ) are loaded into the current program counter.
The instruction code and the $\overline{E X}$ Input are set up when CP is HIGH. The Stack Pointer remains unchanged. When CP goes LOW (assuming $\overline{E X}$ is LOW) the D-Bus Inputs are written into the current PC. The X-Bus drivers are not enabled during a Branch operation.

Call Operation - During a Call operation the content of the data bus is loaded into the top location of the stack and all previous PC values are effectively moved down one level.

The instruction code and the $\overline{E X}$ input are set up when CP is HIGH. When $\overline{\mathrm{EX}}$ is LOW, a "one" is added to the Stack Pointer value thus incrementing the RAM address. Since the output latches go to the nontransparent or store mode when CP is LOW, the O-Bus outputs will reflect the RAM output at the CP negative-going transition. If EX goes LOW considerably before CP goes LOW, the O-Bus will correspond to the previous contents of the incremented RAM address after CP goes LOW. If CP goes LOW a very short time after $\overline{E X}$, the O-Bus will remain unchanged until the LOW to HIGH transition of CP. When CP is LOW (assuming $\overline{E X}$ is LOW) the D-Bus inputs are written into this new RAM location. On the LOW-to-HIGH transition of CP, the incremented Stack Pointer value is loaded into the Stack Pointer and the O-Bus outputs reflect the newly entered data. When the RAM address is " 1111 " the Stack Full output ( $\overline{\mathrm{SF}}$ ) is LOW, indicating that no further Call operations should be initiated. If an additional Call operation is performed SP is incremented to (0000), the contents of that location will be written over, $\overline{\mathrm{SF}}$ will go HIGH and the Stack Empty ( $\overline{\mathrm{SE}})$ will go LOW.

The X -Bus drivers are not enabled during a Call operation.
Return Operation - During the Return operation the previous PC is "popped" to become the current PC.
The instruction is set up when CP is HIGH. When $\overline{\mathrm{EX}}$ is LOW, a "one" is subtracted from the Stack Pointer value, thus decrementing the RAM address. If $\overline{E X}$ goes LOW considerably before CP goes LOW, the O-Bus will correspond to the new value after $\overline{E X}$ goes LOW. If CP goes LOW a short time after $\overline{E X}$, the O-Bus will remain unchanged until the LOW-to-HIGH transition of $C P$.
On the LOW-to-HIGH transition of CP the decremented Stack Pointer value is loaded into the Stack Pointer and the O-Bus outputs correspond to the new "popped" value.
The X-Bus drivers are not enabled during a Return operation. When the RAM address is " 0000 ", the Stack Empty output $(\overline{S E})$ is LOW, indicating that no further return operations should be initiated. If an additional Return operation is performed, SP is decremented to "1111", the $\overline{\mathrm{SE}}$ will go HIGH and the Stack Full output ( $\overline{\mathrm{SF}}$ ) will go LOW. A LOW on the Master Reset $(\overline{\mathrm{MR}})$ causes the SP to be reset and the contents of that RAM location (0000) to be cleared. The Stack Empty ( $\overline{\mathrm{SE}}$ ) output goes LOW. This operation overrides all other inputs.

EXPANSION - The 9406 may be expanded to any word length in multiples of four without external logic. The connection for expanded operation is shown in Figure 1. Carry In $(\overline{\mathrm{Cl}})$ and Carry Out $(\overline{\mathrm{CO}})$ are connected to provide automatic increment of the current program counter during Fetch. The $\overline{C l}$ input of the least significant 9406 is tied LOW to ground.
If automatic increment during Fetch is not desired, the $\overline{\mathrm{Cl}}$ input of the least significant 9406 is held HIGH.

## FAIRCHILD • 9406


*Tie to $V_{C C}$ to disable automatic increment.

Fig. 1
16 BY 12 PROGRAM STACK

DC CHARACTERISTICS OVER OPERATION TEMPERATURE RANGE (unless otherwise noted)


NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{C}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC SET-UP REQUIREMENTS - ALL MODES OF OPERATION: $V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$

| SYMBOL | PARAMETERS | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{\text {t }}$ CW | Clock Period | 100 | 70 |  | ns |  |
| tPWH | Clock Pulse Width (HIGH) | 60 | 40 |  | ns |  |
| tPWL | Clock Pulse Width (LOW) | 40 | 25 |  | ns |  |
| $\mathrm{ts}_{\mathrm{s}} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{E X}$ to CP |  | 0 |  | ns |  |
| $t^{\text {b }} \overline{\mathrm{EX}}$ | Hold Time, $\overline{\text { EX }}$ to CP |  | 0 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \mathrm{l}$ | Set-Up Time, $\mathrm{I}_{0}, \mathrm{I}_{1}$ to Negative-Going Clock |  | 20 |  | ns | Figure 2 |
| $t_{h} \mathrm{l}$ | Hold Time, $\mathrm{I}_{0}, \mathrm{I}_{1}$ to Positive-Going Clock |  | 0 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \overline{\mathrm{Cl}}$ | Set-Up Time, $\overline{\mathrm{Cl}}$ to Negative-Going Clock |  | 5 |  | ns |  |
| ${ }_{t h} \overline{C l}$ | Hold Time, $\overline{\mathrm{Cl}}$ to Positive-Going Clock |  | 0 |  | ns |  |
| $\mathrm{t}_{s} \overline{\mathrm{D}}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ to Positive-Going Clock |  | 20 |  | ns | $\cdots$ |
| $t_{h} \bar{D}$ | Hold Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ to Positive-Going Clock |  | 0 |  | ns |  |
| tPWL $^{\text {MR }}$ | $\overline{\mathrm{MR}}$ Pulse Width (LOW) | 40 | 25 |  | ns | Figure 3 |
| trec | $\overline{\mathrm{MR}}$ to Negative-Going Clock | 45 | 30 |  | ns | , |



Fig. 2
WAVEFORMS FOR ALL OPERATIONS

Refer to individual timing diagrams for each operation to determine output response.

FAIRCHILD • 9406

AC CHARACTERISTICS - FETCH OPERATION: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$

| SYMBOL | PARAMETERS | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Carry $\ln (\overline{\mathrm{Cl}})$ to Carry Out ( $\overline{\mathrm{CO}}$ ) |  | 11 7 | $\begin{aligned} & 16 \\ & 12 \end{aligned}$ | ns | Figure 4 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Positive-Going CP to Carry Out ( $\overline{\mathrm{CO}}$ ) |  | $\begin{aligned} & 28 \\ & 46 \end{aligned}$ | $\begin{aligned} & 41 \\ & 66 \end{aligned}$ | ns | Figure 5 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Negative-Going $\overline{E X}$ to Carry Out ( $\overline{\mathrm{CO}}$ ) |  | $\begin{aligned} & 34 \\ & 38 \end{aligned}$ | $\begin{aligned} & 45 \\ & 60 \end{aligned}$ | ns | Figure 6 |



Fig. 4
CARRY-IN TO CARRY-OUT


Fig. 5
CLOCK TO CARRY-OUT


Fig. 6
EXECUTE TO CARRY-OUT

## AC CHARACTERISTICS AND SET-UP REQUIREMENTS - BRANCH (LOAD PC) OPERATION:

| SYMBOL | PARAMETERS | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Positive-Going CP to Outputs ( $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ ) |  | $\begin{aligned} & 28 \\ & 45 \end{aligned}$ | $\begin{aligned} & 41 \\ & 66 \end{aligned}$ | ns | $\overline{E O}_{0}$ LOW <br> Figures 7 and 8 |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\mathrm{I}_{0}, \mathrm{I}_{1}$ to Negative-Going EX | 30 | 20 |  | ns |  |
| $\mathrm{th}^{\text {r }}$ | Hold Time $\mathrm{I}_{0}, \mathrm{I}_{1}$ to Positive-Going $\overline{\mathrm{EX}}$ | 0 | 0 |  | ns | $\overline{\mathrm{EX}}$ goes HIGH before CP, Figure 8 |
| th | Hold Time, $I_{0}, I_{1}$ to Positive-Going CP | 0 | 0 |  | ns | CP goes HIGH before $\overline{E X}$, Figure 7 |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ to Positive-Going CP | 25 | 16 |  | ns | gures 7 and |
| th | Hold Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ to Positive-Going CP | 0 | 0 |  | ns | Figures 7 and |
| tPWL | $\overline{\text { EX Pulse Width }}$ | 45 | 30 |  | ns | $\overline{\text { EX }}$ Goes HIGH Before CP, Figure 8 |

FAIRCHILD • 9406


AC CHARACTERISTICS AND SET-UP REQUIREMENTS - CALL (PUSH) OPERATION:
$\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ (Figure 9)

| SYMBOL | PARAMETERS | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Positive-Going CP to New Value of $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ |  | $\begin{aligned} & 25 \\ & 75 \end{aligned}$ | $\begin{gathered} 40 \\ 130 \\ \hline \end{gathered}$ | ns | $\overline{E O}_{0}$ LOW |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Negative-Going $\overline{\mathrm{EX}}$ to Intermediate Value of $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ |  | $\begin{aligned} & 22 \\ & 64 \end{aligned}$ | $\begin{aligned} & 35 \\ & 85 \end{aligned}$ | ns | $\overline{\mathrm{EO}}_{0}$ LOW, Set-Up Requirements $\mathrm{t}_{\mathrm{s} 1} \overline{\overline{\mathrm{EX}}}$ must be met |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Negative-Going $\overline{E X}$ to $\overline{\mathrm{SE}}, \overline{\mathrm{SF}}$ |  | $\begin{aligned} & 18 \\ & 43 \end{aligned}$ | $\begin{aligned} & 28 \\ & 59 \end{aligned}$ | ns |  |
| $\mathrm{t}_{\mathrm{s}}$ | Set-Up Time, Negative-Going $\overline{E X}$ to $\mathrm{I}_{0}, \mathrm{I}_{1}$ | 30 | 20 |  | ns |  |
| th | Hold Time, Positive-Going CP to $\mathrm{IO}_{0}, \mathrm{I}_{1}$ | 0 |  |  | ns |  |
| $\mathrm{t}_{\mathbf{s} 1} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{\mathrm{EX}}$ to Negative-Going CP which Guarantees Intermediate Data on $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ while CP is LOW | 65 | 45 |  | ns |  |
| $\mathrm{t}_{\text {s2 }} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{E X}$ to Negative-Going CP which Guarantees no Change in $\overline{\mathrm{O}}_{\mathbf{0}}-\overline{\mathrm{O}}_{3}$ While CP is LOW | 0 |  |  | ns |  |
| $t_{n} \overline{E X}$ | Hold Time, Positive-Going CP to Positive-Going $\overline{\mathrm{EX}}$ | 0 |  |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ to Positive-Going CP | 30 | 20 |  | ns |  |
| th | Hold Time, Positive-Going CP to $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ | 0 |  |  | ns |  |



Fig. 9
CALL (PUSH) OPERATION
NOTES:

1. Condition which occurs when $\overline{E X}$ goes LOW considerably before $C P$ goes $L O W$ ( $t_{s} \overline{E X}$ is met).
2. Condition which occurs when EX goes LOW slightly before CP goes LOW ( $\mathrm{t}_{\mathrm{s} 2} \mathrm{EX}$ is met).

AC CHARACTERISTICS AND SET-UP REQUIREMENTS - RETURN (POP) OPERATION:
$\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ (Figure 10)

| SYMBOL | PARAMETERS | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| tPLH <br> tPHL | Propagation Delay, Positive-Going CP to New Value of $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ |  | $\begin{array}{r} 25 \\ 103 \end{array}$ | $\begin{array}{r} 40 \\ 130 \end{array}$ | ns | $\overline{\mathrm{EO}}_{0}$ LOW |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Negative-Going $\overline{\mathrm{EX}}$ to New Value of $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ |  | $\begin{array}{r} 23 \\ 101 \end{array}$ | $\begin{array}{r} 40 \\ 130 \end{array}$ | ns | $\overline{\mathrm{EO}}_{0}$ LOW, Set-Up Requirements $\mathrm{t}_{\mathrm{s} 1} \overline{\mathrm{EX}}$ must be met |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Negative-Going $\overline{\mathrm{EX}}$ to $\overline{S E}, \overline{S F}$ |  | $\begin{aligned} & 18 \\ & 43 \end{aligned}$ | $\begin{aligned} & 28 \\ & 59 \end{aligned}$ | ns |  |
| $\mathrm{t}_{5}$ | Set-Up Time, Negative-Going $\overline{\mathrm{EX}}$ to $\mathrm{I}_{0}, \mathrm{I}_{1}$ | 30 | 20 |  | ns |  |
| th | Hold Time, Positive-Going CP to $\mathrm{I}_{0}, \mathrm{I}_{1}$ | 0 |  |  | ns |  |
| $t_{s} 1 \overline{E X}$ | Set-Up Time, $\overline{E X}$ to Negative-Going CP which Guarantees the New Value on $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ <br> While CP is LOW | 65 | 45 |  | ns |  |
| $\mathrm{t}_{\text {s } 2} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{E X}$ to Negative-Going CP. Either $t_{s} 2 \overline{E X}$ or $t_{s} 3 \overline{E X}$ must be met for Proper Operation | 0 |  |  | ns |  |
| $t_{s} 3 \overline{E X}$ | Set-Up Time, EX to Positive-Going CP. <br> Either $\mathrm{t}_{\mathrm{s} 3} \overline{\mathrm{EX}}$ or $\mathrm{t}_{\mathrm{s} 2} \overline{\mathrm{EX}}$ (Above) must be met for Proper Operation. | 45 | 30 |  | ns | - |



Fig. 10
RETURN (POP) OPERATION
NOTES:

1. Condition which occurs when $\overline{E X}$ goes LOW considerably before $C P$ goes LOW ( $t_{s} \overline{E X}$ is met).
2. Condition which occurs when $\overline{E X}$ goes LOW slightly before or after $C P$ goes LOW (either $t_{s} 2 E X$ or $t_{s} 3 \overline{E X}$ are met).

AC CHARACTERISTICS AND SET-UP REQUIREMENTS - FETCH OPERATION:
$V_{C C}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$

| SYMBOL | PARAMETERS | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay Positive-Going CP to Incremented Value of $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ |  | $\begin{aligned} & 22 \\ & 59 \end{aligned}$ | $\begin{aligned} & 30 \\ & 80 \end{aligned}$ | ns | $\overline{\mathrm{EO}}_{0}, \overline{\mathrm{CI}}^{\text {LOW, Figures } 13 \text { and } 14}$ |
| tPZL <br> tPZH | Turn-On Delay, from CP or $\overline{\mathrm{EX}}$ <br> Whichever goes LOW last to $X_{0}-X_{3}$ |  | $\begin{aligned} & 13 \\ & 12 \end{aligned}$ | $\begin{aligned} & 18 \\ & 17 \end{aligned}$ | ns | $\overline{\mathrm{EO}} \times$ LOW, Figures $11,12,13$ and 14 |
| $\begin{aligned} & \text { tPLZ } \\ & \text { tPHZ } \end{aligned}$ | Delay Going into HIGH Impedance State |  | $\begin{gathered} 7 \\ 10 \end{gathered}$ | $\begin{aligned} & 12 \\ & 16 \end{aligned}$ | ns |  |
| ${ }^{\text {t }}$ | Set-Up Time, $\mathrm{I}_{0}, \mathrm{I}_{1}$ to Negative-Going $\overline{\mathrm{EX}}$ | 30 | 20 |  | ns |  |
| th | Hold Time , $\mathbf{I}_{0}, I_{1}$ to $C P$ or $\overline{E X}$ whichever goes HIGH first | 0 |  |  | ns | Figures 11, 12, 13 and 14 |
| $\mathrm{t}_{5}$ | Set-Up Time, Negative Going $\overline{E X}$ to Positive-Going CP | 40 | 25 |  | ns |  |
| $\mathrm{t}_{\mathbf{S}}$ | Negative-Going $\overline{\mathrm{Cl}}$ to Positive-Going CP | 30 | $20^{*}$ |  | ns | Fetch with Increment, Figures 13 and 14 |
| th | Positive-Going $\overline{\mathrm{Cl}}$ to Negative-Going $\overline{\mathrm{EX}}$ | 0 |  |  |  | Iterative Fetch, Figures 11 and 12 |

FAIRCHILD • 9406


Fig. 11
ITERATIVE FETCH

CONDITIONS $\overline{E O}_{0}$ LOW, $\overline{\mathrm{EX}}$ goes HIGH before CP
$I_{0}-I_{1}$

$\overline{\mathrm{CI}}$
-
C1


## 9407

DATA ACCESS REGISTER<br>FAIRCHILD TTL MACROLOGIC

DESCRIPTION - The 9407 Data Access Register (DAR) is designed to perform the memory address functions for RAM resident stack applications. The DAR can implement general registers with an adder network in programmable digital systems. The 9407 contains three 4-bit registers intended for Program Counter ( $\mathrm{R}_{0}$ ), Stack Pointer ( $\mathrm{R}_{1}$ ) and Operand Address $\left(R_{2}\right)$. It implements 16 instructions (see Table 1) which allow either pre or post decrement/increment and register-to-register transfer in a single clock cycle. It is expandable in 4-bit increments and can operate at a 10 MHz microinstruction rate on a 16 -bit word. The 3 -state outputs are provided for bus oriented applications. The 9407 is fully compatible with all TTL families.

- HIGH SPEED - $\mathbf{1 0} \mathbf{~ M H z}$ MICROINSTRUCTION RATE
- THREE 4-BIT REGISTERS
- 16 INSTRUCTIONS FOR REGISTER MANIPULATION
- TWO SEPARATE OUTPUT PORTS, ONE TRANSPARENT
- RELATIVE ADDRESSING CAPABILITY
- 3-STATE OUTPUTS
- OPTIONAL PRE OR POST ARITHMETIC
- EXPANDABLE IN MULTIPLES OF FOUR BITS
- SLIM 24-PIN PACKAGE


## PIN NAMES

$\bar{D}_{0}-\bar{D}_{3}$
$I_{0}-I_{3}$
$\overline{\mathrm{CI}}$
$\overline{\mathrm{CO}}$
CP
$\overline{\mathrm{EX}}$
$\overline{\mathrm{EO}} \mathrm{X}$
$\overline{\mathrm{EO}}_{0}$
$\mathrm{X}_{0}-\mathrm{X}_{3}$
$\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$
$\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$

Data Inputs (Active LOW)
Instruction Word Inputs
Carry Input (Active LOW) (Note b)
Carry Output (Active LOW)
Clock Input ( $\mathrm{L} \rightarrow \mathrm{H}$ Edge-Triggered)
Execute Input (Active LOW)
Address Output Enable Input
(Active LOW)
Data Output Enable Input
(Active LOW)
Address Outputs (Note b)
Data Outputs (Active LOW)
(Note b)

| LOADING (Note a) |  |
| :---: | ---: |
| HIGH | LOW |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 10 U.L. | 5 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
|  |  |
| 1.0 U.L. | 0.23 U.L. |
|  |  |
| 130 U.L. | 10 U.L. |
| 130 U.L. | 10 U.L. |

NOTES:
a. 1 Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW.
b. Output Current measured at $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}$.


FAIRCHILD • 9407

BLOCK DIAGRAM


FUNCTIONAL DESCRIPTION - The 9407 contains a 4-bit slice of three registers ( $R_{0}-R_{2}$ ), a 4-Bit Adder, 3 -state address output buffers ( $\mathrm{X}_{0}-\mathrm{X}_{3}$ ) and a separate Output Register with 3 -state buffers ( $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ ), allowing output of the register contents on the data bus (refer to the block diagram). The DAR performs 16 instructions, selected by $\mathrm{I}_{0}-\mathrm{I}_{3}$ inputs, as listed in Table 1.

Operation _ For normal operation EX is brought LOW while CP is HIGH. A microcycle starts as the clock goes HIGH. Data inputs $\bar{D}_{0}-\bar{D}_{3}$ are applied to the Adder as one of the operands. Three of the four instruction lines $\left(I_{1}, I_{2}, I_{3}\right)$ select which of the three registers, if any, is to be used as the other operand. The LOW-to-HIGH transition of the CP input writes the result from the Adder into a register ( $\mathrm{R}_{0}-R_{2}$ ) and into the Output Register provided $\overline{E X}$ is LOW. If the $I_{0}$ input is HIGH, the multiplexer routes the result from the Adder to the 3 -state buffer controlling the address bus ( $\mathrm{X}_{0}-\mathrm{X}_{3}$ ) independent of $\overline{\mathrm{EX}}$ and CP. If $\mathrm{I}_{0}$ is LOW, the multiplexer routes the output of the selected register directly into the 3 -state buffer controlling the address bus $\left(X_{0}-X_{3}\right)$, independent of $\overline{E X}$ and $C P$.

TABLE 1
INSTRUCTION SET FOR THE 9407

| INSTRUCTION |  |  |  | COMBINATORIAL FUNCTION AVAILABLE ON THE X-bUS | SEQUENTIAL FUNCTION OCCURRING ON THE NEXT RISING CP EDGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $1_{3}$ | $\mathrm{I}_{2}$ | 11 | 10 |  |  |
| L | L | L. | L | $\mathrm{R}_{0}$ |  |
| L | L | L | H | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{0}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{0}$ and Output Register |
| L | L | H | L | $\mathrm{R}_{0}$ |  |
| L | L | H | H | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | plus $\mathrm{Cl} \rightarrow \mathrm{R}_{1}$ and Output Register |
| L | H | L | L | $\mathrm{R}_{0}$ |  |
| L | H | L | H | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Register |
| L | H | H | L | $\mathrm{R}_{1} \quad-$ |  |
| L | H | H | H | $\mathrm{R}_{1}$ plus $\overline{\mathrm{D}}$ p/us $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{1}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{1}$ and Output Register |
| H | L | L | L | $\mathrm{R}_{2}$ | D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Register |
| H | L | L | H | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Registe |
| H | L | H | L | $\mathrm{R}_{0}$ | $\overline{\mathrm{D}}$ p/us $\overline{\mathrm{Cl}} \rightarrow \mathrm{R}_{0}$ and Output Register |
| H | L | H | H | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\overline{\mathrm{D}}$ plus $\mathrm{Cl} \rightarrow \mathrm{R}_{0}$ and Output Register |
| H | H | L | L | $\mathrm{R}_{2}$ |  |
| H | H | L | H | $\mathrm{R}_{2}$ p/us $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{2}$ plus $\overline{\mathrm{D}}$ plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Register |
| H | H | H | L | $\mathrm{R}_{1}$ | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}} \rightarrow \mathrm{R}_{1}$ and Output Register |
| H | H | H | H | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | D plus $\overline{C l} \rightarrow \mathrm{R}_{1}$ and Output Register |

L = LOW Level
H $=$ HIGH Level

9407 EXPANSION - The 9407 is organized as a 4-bit register slice. The active LOW $\overline{\mathrm{Cl}}$ and $\overline{\mathrm{CO}}$ lines allow ripple-carry expansion over longer word lengths.

APPLICATIONS - The 9407 is organized as a 4-bit register slice. The $\overline{\mathrm{CI}}$ and $\overline{\mathrm{CO}}$ lines allow ripple-carry expansion over longer word lengths. Figure 1 is a block diagram of a typical application. Each block of the Macrologic parts represents four identical slices, thus creating a 16 -bit array. For this application the register utilizations in the DAR may be as follows:
$R_{0}$ is the program counter (PC), $R_{1}$ is the Stack Pointer (SP) for memory resident stack and $R_{2}$ contains the operand address. For an instruction fetch, PC can be gated on the X -Bus while it is being incremented (i.e., D -Bus $=1$ ). If the fetched instruction calls for an effective address for calculation, which is displaced from the PC, the displacement can be added to the PC and loaded into $R_{2}$ during the next microcycle.
A different type of application using the DAR is shown in Figure 2. Four 9407s are used here as the major elements in a data path loop closed by four 9404s (DPS). This data path can be used for dedicated multiply/divide function. The DAR register utilization in this application can be as follows :
$\mathrm{R}_{0}$ is the multiplicand in case of multiply or the divisor in case of divide;
$\mathrm{R}_{1}$ is the temporary result in case of multiply or the dividand/quotient in case of divide;
$\mathrm{R}_{2}$ is the product in case of multiply or a temporary register in case of divide.


Fig. 1
TYPICAL MEMORY ADDRESS APPLICATION


Fig. 2
TYPICAL DATA PATH APPLICATION

FAIRCHILD • 9407

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise noted)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |
| $\underline{\mathrm{V}_{\text {IH }}}$ | Input HIGH Voltage |  | 2.0 |  |  | V | Guaranteed Input HIGH Voltage |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage | XM |  |  | 0.7 | V | Guaranteed Input LOW Voltage |
|  |  | XC |  |  | 0.8 |  |  |
| $\mathrm{V}_{\text {CD }}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | V | $\mathrm{V}_{\text {CC }}=\mathrm{MIN}, \mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |
| VOH | Output HIGH Voltage, $\overline{\mathrm{CO}}$ | XM | 2.4 | 3.4 |  | V | $V_{C C}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |
|  |  | XC | 2.4 | 3.4 |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage$x_{0}-x_{3}, \bar{o}_{0}-\bar{o}_{1}$ | XM | 2.4 | 3.4 |  | V | $\mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA} \quad \mathrm{~V}_{\mathrm{CC}}=\mathrm{MIN}$ |
|  |  | XC | 2.4 | 3.1 |  |  | $1 \mathrm{OH}=-5.7 \mathrm{~mA} \quad \mathrm{VCC} \mathrm{M}$ |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage, $\overline{\mathrm{CO}}$ |  |  | 0.3 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=4.0 \mathrm{~mA}$ |
|  |  |  |  | 0.4 | 0.5 |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage$x_{0}-x_{3}, \bar{o}_{0}-\bar{o}_{3}$ |  |  | $\begin{aligned} & 0.3 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.5 \end{aligned}$ | V | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}_{\mathrm{OL}}=8.0 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}^{2}=16 \mathrm{~mA} \end{aligned}$ |
| IOZH | Output Off HIGH Current |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2 \mathrm{~V}$ |
| IOZL | Output Off LOW Current |  |  |  | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=2 \mathrm{~V}$ |
|  | Input HIGH Current |  |  | 1.0 | 40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ |
| IIH |  |  |  |  | 1.0 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}$ |
| IIL | Input LOW Current |  |  |  | -0.36 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ |
| IOS | Output Short Circuit Current |  | -30 |  | -100 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ (Note 3) |
| Icc | Supply Current |  |  | 90 | - 145 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}$, Inputs Open |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{C}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{\text {t }}$ W | Clock Period (Note) | 90 | 60 |  | ns |  |
| tPWH | Clock Pulse Width (HIGH) (Note) | 60 | 40 |  | ns |  |
| tPWL | Clock Pulse Width (LOW) (Note) | 30 |  |  | ns |  |
| $\mathrm{t}_{\mathrm{s}}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}, \overline{\mathrm{Cl}}$ to Negative-Going Clock | 20 |  |  | ns |  |
| $t_{h}$ | Hold Time, $\mathrm{I}_{\mathrm{O}}-\mathrm{I}_{3}$ to Positive-Going Clock | 0 |  |  | ns |  |
| $\mathrm{t}_{\mathrm{s}} \overline{\mathrm{D}}$ | Set-Up Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}, \overline{\mathrm{Cl}}$ to Negative-Going Clock | 20 |  |  | ns |  |
| $t_{h} \bar{D}$ | Hold Time, $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}, \overline{\mathrm{Cl}}$ to Negative-Going Clock | 0 |  |  | ns |  |
| $t_{s} 1$ | Set-Up Time, $\overline{\mathrm{Cl}}$ to Positive-Going Clock | 5 |  |  | ns |  |
| $\mathrm{th}^{1}$ | Hold Time, $\overline{\mathrm{Cl}}$ to Positive-Going Clock |  | 0 |  | ns |  |

FAIRCHILD • 9407

AC CHARACTERISTICS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Positive-Going CP to $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ (Note). |  | $\begin{aligned} & 17 \\ & 22 \end{aligned}$ | $\begin{aligned} & 24 \\ & 29 \end{aligned}$ | ns | $\overline{\mathrm{EO}}_{0}$ LOW, Figure 5 |
| $\begin{aligned} & \text { tpLH } \\ & \text { tPHL } \end{aligned}$ | Instruction Code, $I_{1}-I_{3}$ to $X_{0}-X_{3}$ |  | $\begin{aligned} & 22 \\ & 22 \end{aligned}$ | $\begin{aligned} & 29 \\ & 29 \end{aligned}$ | ns | $\overline{\mathrm{EO}} \times$ LOW, I OLOW, Figure 3 |
| tpLH <br> tPHL | Instruction Code, $I_{1}-I_{3}$ to $X_{0}-X_{3}$ |  | $\begin{aligned} & 42 \\ & 37 \end{aligned}$ | $\begin{aligned} & 58 \\ & 51 \end{aligned}$ | ns | $\overline{\text { EO }} \times$ LOW, $\mathrm{I}_{0} \mathrm{HIGH}$, Figure 3 |
| tpLH <br> tPHL | Positive-Going Clock to $\mathrm{X}_{0}-\mathrm{X}_{3}$ |  | $\begin{aligned} & 35 \\ & 29 \end{aligned}$ | $\begin{aligned} & 48 \\ & 39 \end{aligned}$ | ns | EOX, ${ }^{10}$ LOW Figure 5 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Positive-Going Clock to $\mathrm{X}_{0}-\mathrm{X}_{3}$ |  | $\begin{aligned} & 51 \\ & 51 \end{aligned}$ | $\begin{aligned} & 68 \\ & 68 \end{aligned}$ | ns | $\overline{\text { EO }} \times$ LOW, Io HIGH, Figure 5 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Data Inputs to $\mathrm{X}_{0}-\mathrm{X}_{3}$ |  | $\begin{aligned} & 19 \\ & 19 \end{aligned}$ | $\begin{aligned} & 26 \\ & 26 \end{aligned}$ | ns | $I_{0}$ HIGH, $I_{1}-I_{3}$ Stable, EOX LOW, Figure 6 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay $\overline{\mathrm{Cl}}$ to $\mathrm{X}_{0}-\mathrm{X}_{3}$ |  | $\begin{aligned} & 16 \\ & 19 \end{aligned}$ | $\begin{aligned} & 24 \\ & 26 \end{aligned}$ | ns | $I_{0}$ HIGH, I $1-I_{3}$ Stable, EOX LOW, Figure 7 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay $\mathrm{I}_{0}$ to $\mathrm{X}_{0}-\mathrm{X}_{3}$ |  | $\begin{aligned} & 14 \\ & 14 \end{aligned}$ | $\begin{aligned} & 19 \\ & 19 \end{aligned}$ | ns | $\overline{\text { EO }} \times$ LOW, Figure 4 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Positive-Going <br> Clock to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 35 \\ & 41 \end{aligned}$ | $\begin{aligned} & 48 \\ & 56 \end{aligned}$ | ns | Figure 5 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{Cl}}$ to $\overline{\mathrm{CO}}$ |  | $\begin{array}{r} 9 \\ 16 \end{array}$ | $\begin{aligned} & 15 \\ & 25 \end{aligned}$ | ns | Figure 7 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Data Inputs $\overline{\mathrm{D}}_{0}-\bar{D}_{3}$ to $\overline{\mathrm{CO}}$ |  | $\begin{array}{r} 9 \\ 14 \\ \hline \end{array}$ | $\begin{aligned} & 15 \\ & 21 \end{aligned}$ | ns | Figure 6 |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Instruction Inputs $I_{1}-I_{3} \text { to } \overline{\mathrm{CO}}$ |  | $\begin{aligned} & 25 \\ & 39 \end{aligned}$ | $\begin{aligned} & 33 \\ & 53 \end{aligned}$ | ns | Figure 3 |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \\ & \hline \end{aligned}$ | Enable Delay, $\overline{\mathrm{EO}}_{0}$ to Outputs $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$, $\overline{E O}_{X}$ to $X_{0}-X_{3}$ |  | 11 | 18 | ns |  |
| $\begin{aligned} & \mathrm{tPLZ} \\ & \mathrm{tphZ} \end{aligned}$ | Disable Delay, $\overline{\mathrm{EO}}_{0}$ to $\overline{\mathrm{O}}_{0}, \overline{\mathrm{O}}$ $\overline{\mathrm{EO}} \mathrm{x}$ to $\mathrm{X}_{0}-\mathrm{X}_{3}$ |  | 9 | 15 | ns |  |

TIMING DIAGRAMS


NOTE:
The internal clock is generated from CP and $\overline{\mathrm{EX}}$. The internal Clock is HIGH if $\overline{E X}$ or CP is HIGH, LOW if $\overline{E X}$ and CP are LOW.

Fig. 3
Fig. 4

TIMING DIAGRAMS (Cont'd)


Fig. 5


Fig. 6
Fig. 7

# 9408 <br> MICROPROGRAM SEQUENCER <br> FAIRCHILD I $^{3} L^{\text {TM }}$ MACROLOGIC 

DESCRIPTION - The 9408 Microprogram Sequencer controls the order in which microinstructions are fetched from the control memory. It contains a 10-bit program counter, a 4-level last-in first-out stack and associated control logic. It can control up to a maximum of 1024 words of memory. For larger word capacities external paging can be used. The 9408 is controlled by a 4-bit instruction input. The instruction set includes Fetch, Conditional and Unconditional Branches, Branch to Subroutine and Return from Subroutine.

There are seven test inputs - four participate in conditional branches, and three in multiway branches. The conditional test lines are flip-flop buffered. These flip-flops can be tested individually by appropriate branch instructions. The three multiway test inputs are used to form the least significant three bits of the branch address for a multiway branch. Thus, branching occurs at one of eight unique locations depending on the bit pattern present on these three inputs.

The 9408 is designed to operate in pipeline or non-pipeline mode as desired by the user. The device operates synchronously with the clock input and can be initialized using the Master Reset input.

The 9408 is fabricated using Integrated Injection Logic ( $\left.\right|^{3} L^{\top M}$ ) technology and fully compatible with all TTL families.

## - CONTROLS 1024 WORDS OF MICROPROGRAM MEMORY (10-BIT ADDRESS) <br> - UNRESTRICTED BRANCHING WITHIN 10-BIT ADDRESS SPACE <br> - 16 INSTRUCTIONS <br> - FOUR FLIP-FLOP BUFFERED TEST INPUTS FOR CONDITIONAL BRANCHES <br> - 8-WAY BRANCH CAPABILITY <br> - PIPELINE/NON-PIPELINE MODE OF OPERATION

| PIN NAMES |  | LOADING (Note a) |  |
| :---: | :---: | :---: | :---: |
|  |  | HIGH | LOW |
| $\mathrm{BA}_{0}-\mathrm{BA} 9$ | Branch Address Inputs | 0.5 U.L. | 0.23 U.L. |
| $\mathrm{T}^{-{ }^{-1} \mathrm{~T}_{3}}$ | Test Inputs | 0.5 U.L. | 0.23 U.L. |
| $\mathrm{MW}^{-}-\mathrm{MW}_{2}$ | Multiway Branch Inputs | 0.5 U.L. | 0.23 U.L. |
| 11 | Instruction Input | 0.5 U.L. | 0.23 U.L. |
| $\mathrm{I}_{1}, \mathrm{I}_{2}, \mathrm{I}_{3}$ | Instruction Inputs | 1.0 U.L. | 0.46 U.L. |
| PLS | Pipeline Select Input | 0.5 U.L. | 0.23 U.L. |
| $\overline{M R}$ | Master Reset Input (Active LOW) | 0.5 U.L. | 0.23 U.L. |
| CP | Clock Pulse Input | 1.0 U.L. | 0.46 U.L. |
| STRB | Strobe Input | 0.5 U.L. | 0.23 U.L. |
| $\mathrm{A}_{0}-\mathrm{A}_{9}$ | Address Outputs | 10 U.L. | 5.0 U.L. |
| VIA ${ }_{0}, \mathrm{VIA}_{1}$ | VIA Outputs | 10 U.L. | 5.0 U.L. |
| INH | Inhibit Output | 10 U.L. | 5.0 U.L. |



Note a. 1 TTL Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH/1.6 mA LOW

FAIRCHILD • 9408


FAIRCHILD•9408

TABLE 1
9408 INSTRUCTION SET

| Unconditional | MNEMONIC | DEFINITION | $13 l_{2} 110$ | $\mathrm{T}_{3} \mathrm{~T}_{2} \mathrm{~T}_{1} \mathrm{~T}_{0}$ | $\mathrm{O}_{9} \mathrm{O}_{8} \mathrm{O}_{7} \cdots \mathrm{O}_{2} \mathrm{O}_{1} \mathrm{O}_{0}$ | $\mathrm{VIA}_{1} \mathrm{VIA}_{0}$ | INH | DESCRIPTION OF OPERATION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{BRV}_{0}$ | Branch VIA 0 | L HLL | XXXX | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | L L | H | $\mathrm{BA}_{0}-\mathrm{BAg}_{9} \rightarrow \mathrm{PC}$ |
|  | $B^{\text {R }}{ }_{1}$ | Branch VIA 1 | L HLH | $\mathrm{X} \times \times \mathrm{x}$ | $\mathrm{BAg}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | L H | H | $\mathrm{BA}_{0}-\mathrm{BAg} \rightarrow \mathrm{PC}$ |
| Branch | $\mathrm{BRV}_{2}$ | Branch VIA 2 | LHHL | $x \times \times \times$ | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | H L | H | $B A_{0}-B A S g \rightarrow P C$ |
|  | $\mathrm{BRV}_{3}$ | Branch VIA 3 | LHHH | $X \times \times \times$ | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | H H | H | $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ |
| Instructions | BMW | Branch Multiway | LLHH | $\mathrm{X} \times \times \mathrm{X}$ | $\mathrm{BA}_{9} \mathrm{BA}_{3}-\mathrm{MW}_{2} \mathrm{MW}_{0}$ | L L | H | $\begin{aligned} & \mathrm{MWO}_{0}-\mathrm{MW}_{2} \\ & \mathrm{BA}_{3}-\mathrm{BA}_{9} \rightarrow \mathrm{PC} \end{aligned}$ |
|  | BSR | Branch to Subroutine | L L L H | X X X X | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | L L | H | $B A_{0}-B A g \rightarrow P C \&$ <br> Push the Stack |
|  | $\mathrm{BTH}_{0}$ | Branch on $\mathrm{T}_{0}$ HIGH | H HLL | $\begin{aligned} & X \times X H \\ & X X X L \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}-B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 0 is HIGH: $\mathrm{BA}_{0}-\mathrm{BA} \mathrm{~g}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 0 is LOW: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
|  | BTH1 | Branch on $\mathrm{T}_{1}$ <br> HIGH | H HLH | $\begin{aligned} & \text { XXHX } \\ & X X L X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 1 is HIGH : $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 1 is LOW: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
|  | $\mathrm{BTH}_{2}$ | Branch on $\mathrm{T}_{2}$ <br> HIGH | HHHL | $\begin{aligned} & \text { XHXX } \\ & \text { XLXX } \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 2 is HIGH: $B A_{0}-B A_{9} \rightarrow P C$ <br> If Test Register 2 is LOW: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
| Conditional Branch | $\mathrm{BTH}_{3}$ | Branch on $\mathrm{T}_{3}$ <br> HIGH | HHH | $\begin{aligned} & H X X X \\ & L X X X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}-B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 3 is HIGH: $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 3 is LOW: $P C+1 \rightarrow P C$ |
| Instructions | BTLO | Branch on $\mathrm{T}_{0}$ <br> LOW | HLLL | $\begin{aligned} & X \times X L \\ & X X X H \end{aligned}$ | $\begin{gathered} \mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0} \\ \mathrm{PC}+1 \end{gathered}$ | L L | H | If Test Register 0 is LOW: $B A_{0}-B A_{9} \rightarrow P C$ <br> If Test Register 0 is HIGH: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
| $\cdots$ | BTL1 | Branch on $\mathrm{T}_{1}$ <br> LOW | HLLH | $\begin{aligned} & X X L X \\ & X X H X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 1 is LOW: $B A_{0}-B A_{9} \rightarrow P C$ <br> If Test Register 1 is HIGH: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
|  | BTL2 | Branch on $\mathrm{T}_{2}$ <br> LOW | HLHL | $\begin{aligned} & X L X X \\ & X H X X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}-B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 2 is LOW: $\mathrm{BA}_{0}-\mathrm{BA} 9 \rightarrow \mathrm{PC}$ <br> If Test Register 2 is HIGH: $P C+1 \rightarrow P C$ |
|  | BTL3 | Branch on $\mathrm{T}_{3}$ <br> LOW | HLHH | $\begin{aligned} & \text { LXXX } \\ & H X X X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}-B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 3 is LOW: $\mathrm{BA}_{0}-\mathrm{BA} 9 \rightarrow \mathrm{PC}$ <br> If Test Register 3 is HIGH: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
| Miscellaneous Instructions | RTS | Return from Subroutine | LLLL | $\mathrm{X} \times \times \mathrm{X}$ | Contents of the Stack Addressed by Read Pointer | L L | L | Pop the Stack |
| Instructions | FTCH | FETCH | LLHL | X $\times \times \times$ | PC+1 | L L | L | $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |

FUNCTIONAL DESCRIPTION - The 9408 Microprogram Sequencer, shown in the block diagram consists of a 10-bit Program Counter (PC), a 4 -word by 10-bit Last-In First-Out (LIFO) Stack with associated control, an Input Multiplexer, a Pipeline Multiplexer, an Instruction Decoder, a 10-bit Incrementer, and a 4-bit Test Register comprised of four edge-triggered D flip-flops.
The Pipeline Multiplexer has two ports - the PC output provides the input port for the non-pipeline mode and the Input Multiplexer output provides the input port for the pipeline mode. Port selection is controlled by the Pipeline Select (PLS) and Master Reset ( $\overline{\mathrm{MR}}$ ) inputs. A LOW level on the $\overline{M R}$ input forces the non-pipeline mode of operation and clears the PC. Thus when the 9408 is initialized by the $\overline{M R}$ input the $A_{0}$ through $A_{g}$ outputs are LOW regardless of the state of the PLS input. A LOW level on the PLS input specifies non-pipeline mode and a HIGH specifies pipeline mode.

The Program Counter is a 10-bit edge-triggered register. The LOW-to-HIGH transition on the Clock (CP) input loads the Input Multiplexer output into the PC. Because of the edge-triggered nature of the PC register, the PC output remains static for a full clock cycle. Thus, in the non-pipeline mode, the PC output can be used to address a control memory built with static devices without storing the memory output in an external microinstruction register. However, in the pipeline mode, the 9408 provides the next address information as soon as available; therefore, execution of a microinstruction can be overlapped with the fetching of the next microinstruction. To ensure microinstruction stability for a full clock cycle, the con-trol-memory output should be buffered with an external microinstruction register.
The Input Multiplexer receives data from four different sources. One port is the output of the LIFO Stack; a second is the output of the 10-bit Incrementer. The Incrementer always adds one to the PC contents. The third and fourth ports are the branch and multiway-branch ports, the latter comprised of the seven most significant Branch Address inputs (BA3 through BAg) and the three Multiway inputs, (MW0 through MW2).

The 4-word by 10-bit LIFO Stack is a RAM and receives data from the Incrementer output. The stack control logic generates the appropriate control signals, while stack pointers in the Stack Control generate the read and write addresses.

The 4-bit Test Register consists of four type-D flip-flops. The data inputs, which are the four Test inputs ( $\mathrm{T}_{0}$ through $\mathrm{T}_{3}$ ), are loaded on the LOW-to-HIGH transition of the Strobe input (STRB).

The Instruction Decoder receives the 4-bit Instruction input ( $I_{0}$ through $I_{3}$ ) and the Test Register output and generates the VIAO, VIA 1 and Inhibit (INH) outputs of the 9408. In addition, it generates appropriate logic signals for the Stack Control and Input Multiplexer.

Stack Control - The 9408 has a 4-level subroutine nesting capability as detailed in Figure 1. The $\mathrm{R}_{0}$ and $\mathrm{R}_{1}$ (Read Address) inputs to the 4 -word by 10 -bit LIFO Stack specify the address from which information will be read. The $\mathrm{W}_{0}$ and $\mathrm{W}_{1}$ (Write Address) inputs specify the address into which information will be written; and the 9408 Incrementer output provides the information to be written into the stack (see block diagram). In addition, writing into the memory is controlled by the Write Enable ( $\overline{\mathrm{WE}}$ ) and $\overline{\mathrm{CP}}$ inputs.

The $R_{0}, R_{1}$ and $W_{0}, W_{1}$ inputs of the LIFO Stack are derived from the outputs of a 3-bit edge-triggered register called the Stack Pointer (SP). The least significant two bits ( $\mathrm{SPO}_{0}$ and $\mathrm{SP}_{1}$ ) of this register are the read address inputs to the memory. The SP outputs are also connected to a Stack-Pointer Incrementer and a Decrementer that generate SP + 1 and SP-1 respectively. The least significant two bits of the Incrementer are the write address bits for the memory.

The outputs of the Incrementer, Decrementer and the Stack Pointer are fed as inputs to a 3-port Stack-Pointer Multiplexer which, in turn, feeds the Stack Pointer inputs. Stack pointer loading always occurs on the LOW-to-HIGH transition of the $\overline{\mathrm{CP}}$ input. The $\overline{\mathrm{MR}}$ input clears the Stack Pointer. The Stack Pointer Control receives two inputs from the 9408 Instruction Decoder - the BSR input, which is active whenever a Branch-to-Subroutine (BSR) instruction is present on the $\mathrm{I}_{0}$ through $I_{3}$ inputs, and the RTS input, which is active whenever a Return-from-Subroutine (RTS) instruction is specified. The port selection of the Stack Pointer Multiplexer is controlled by the outputs of the Stack Pointer Control. For all 9408 instructions except BSR and RTS, the Stack Pointer Multiplexer selects the Stack Pointer outputs as the instruction source.
Writing into the memory takes place whenever the $\overline{W E}$ and $\overline{C P}$ inputs are LOW. Note that the most significant register bit, $S P_{2}$, controls the $\overline{\mathrm{WE}}$ input to prevent writing into the memory when all four locations are filled with return addresses. Thus the 9408 does not store and return addresses beyond four nesting levels.

## FAIRCHILD•9408



Fig. 1
STACK CONTROL

## 9408 INSTRUCTIONS

The 9408 instruction set has 16 instructions (Table 1). These instructions can be divided into three groups - unconditional branches, conditional branches and miscellaneous - and are specified by appropriate logic levels on the $I_{0}$ - $I_{3}$ inputs.

The unconditional branch group consists of four Branch VIA instructions ( $B R V_{0}-B R V_{3}$ ), Branch Multiway (BMW) and Branch to Subroutine (BSR). This group requires that the next address be explicitly specified on the BA inputs.

The conditional branch group consists of eight instructions, Branch Test HIGH ( $\mathrm{BTH}_{0}-\mathrm{BTH}_{3}$ ) and Branch Test LOW ( $\mathrm{BTL}_{0}-\mathrm{BTL}_{3}$ ), for interrogating the four test flip-flops of the 9408 individually. The $\mathrm{BTH}_{0}-\mathrm{BTH}_{3}$ instructions test flip-flops $\mathrm{T}_{0}-\mathrm{T}_{3}$ respectively for a HIGH on the O output (see block diagram). Similarly BTLO-BTL 3 test for a LOW on the corresponding $Q$ output. If the test condition is satisfied, the next address is taken from the Branch Address (BAO-BAg) inputs. If the test condition is not satisified the 9408 performs a Fetch operation.

The miscellaneous group consists of two instructions - Fetch (FTCH) and Return from Subroutine (RTS). These instructions do not require explicit specification of the next address. For the FTCH instruction, the next address is assumed to be the address of the current microinstruction +1 . For RTS, the next address is taken from the Stack. The Inhibit (INH) output of the 9408 is LOW only for FTCH and RTS instructions. For all other instruction, the INH output is HIGH.

The VIA outputs of the $9408\left(\mathrm{VIA}_{0}, \mathrm{VIA}_{1}\right)$ are LOW for all instructions except $\mathrm{BRV}_{1}-\mathrm{BRV}_{3}$. For $\mathrm{BRV}_{1}$, the $\mathrm{VIAO}_{0}$ is HIGH and $\mathrm{VIA}_{1}$ LOW. For $\mathrm{BRV}_{2}$, the $\mathrm{VIA}_{0}$ is LOW and VIA 1 HIGH. For $\mathrm{BRV}_{3}$, both $\mathrm{VIA}_{0}$ and $\mathrm{VIA}_{1}$ are HIGH.

## Unconditional Branches

$B R V_{O}-B R V_{3}-$ Whenever a Branch VIA instruction code is present on the $\mathrm{I}_{0}-\mathrm{I}_{3}$ inputs, the Instruction Decoder (see block diagram) establishes the appropriate HIGH/LOW pattern on the VIA 0 and VIA 1 outputs per Table 1. The Instruction Decoder also forces the INH output HIGH. Moreover, the BA $O_{0}$ - BAg inputs are selected as the source of the next address by the Input Multiplexer.

If the 9408 is in the pipeline mode (PLS input HIGH), the Pipeline Multiplexer transfers the $\mathrm{BA}_{0}-\mathrm{BA}_{9}$ inputs to the $\mathrm{A}_{0}{ }^{-}$ Ag outputs. The $\mathrm{BA}_{0}-\mathrm{BA} 9$ inputs are loaded into the PC on the LOW-to-HIGH transition of the CP input. On the other hand, if the non-pipeline mode of operation is selected, the $B A_{0}-B A g$ inputs appear on the output only after the LOW-toHIGH transition of the CP input.

BMW - For a Branch Multiway instruction, the Instruction Decoder forces the VIA 0 and VIA 1 outputs LOW and INH output HIGH. The Input Multiplexer selects the $\mathrm{BA}_{3}-\mathrm{BA} 9$ inputs as the most significant seven bits and $\mathrm{MW}_{0}-\mathrm{MW}_{2}$ inputs as the least significant three bits of the next address. If the pipeline mode of operation is selected, the next address formed by the Input Multiplexer ( $\mathrm{BA}_{3}-\mathrm{BA}_{9}$ and $\mathrm{MW} \mathrm{O}_{0}-\mathrm{MW}_{2}$ inputs) is transferred to the $\mathrm{A}_{0}-\mathrm{Ag}$ outputs. On the LOW-to-HIGH transition of the CP input, this next address is also leaded into the PC. For non-pipeline mode, the next address is available on the $A_{0}-A_{g}$ output only after the $C P$ transition.

BSR - During a Branch-to-Subroutine instruction, the Instruction Decoder forces a LOW on the VIA oand VIA 1 outputs and a HIGH on the INH output. The Input Multiplexer selects the BAO - BAg inputs as the source for the next address. If the pipeline mode is selected, this next address is transferred to the $A_{0}-A_{g}$ outputs by the Pipeline Multiplexer. As usual, the PC is updated with this next address on the LOW-to-HIGH transition of the CP input. During non-pipeline operation, the next address appears on the output only after the CP transition.

The PC holds the address of the current microinstruction. For the BSR instruction, the return address must be stored in the Stack, which is fed by the PC through an Incrementer (see block diagram). When the CP input is LOW, the incremented value is written into the Stack as a return address. The LOW-to-HIGH transition of the CP input not only loads the PC with the next address, i.e., $\mathrm{BA}_{0}-\mathrm{BA} 9$ inputs, but also increments the Stack Pointer as explained above.

## Conditional Branches

$\mathrm{BTH}_{\mathrm{O}}-\mathrm{BTH}_{3}$ - For a Branch Test HIGH instruction, the Instruction Decoder establishes a LOW on VIAO and VIA 1 outputs and HIGH on the INH output. It then tests for a HIGH on the Q output of the corresponding flip-flop in the test register. If a HIGH level is found, the Input Multiplexer selects the BAO - BA9 inputs as the source for the next address.

On the other hand, if the tested Q output of the flip-flop is LOW, the Incrementer output is selected as the source of the next address by the Input Multiplexer. In either case, the PC is loaded with the next address on the LOW-to-HIGH transition of the CP input. As usual, if the pipeline mode is selected, the next address is transferred to the $A_{0}-A_{9}$ outputs. For non-pipeline mode, the next address appears on the output after the clock transition.
$B T L_{0}$ - BTL3 - Operation of the Branch Test LOW instructions is identical to BTHO - BTH3 except that Q outputs of the test register flip-flops are tested for a LOW. If the tested output is LOW, a branch occurs. If tested output is HIGH the Incrementer output is the next address.

## Miscellaneous

FTCH - For a Fetch instruction, the Instruction Decoder establishes a LOW on the VIAO and VIA 1 outputs. In addition, the INH output is also LOW. The Input Multiplexer selects the Incrementer output as the next address. If pipeline mode is selected, the Incrementer output is transferred to the $\mathrm{A}_{0}-\mathrm{A}_{9}$ outputs. For non-pipeline mode, the incremented address appears at the output only after the clock transition.

RTS - For a Return-from-Subroutine instruction, the Instruction Decoder establishes a LOW on the VIA $0_{0}$, VIA $_{1}$ and the INH outputs. The Input Multiplexer selects the Stack output as the source of the next address. As usual, for the pipeline mode, the next address is transferred to the output by the Pipeline Multiplexer. For non-pipeline operation, the next address appears on the output only after the clock transition. In addition, this instruction also decrements the Stack Pointer as described above.

DC CHARACTERISTICS: (Over Operating Temperature Range unless otherwise noted)

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP (2) | MAX |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage | 2.0 |  |  | V | Guaranteed Input HIGH Voltage |
| VIL | Input LOW Voltage XM <br>  XC |  |  | $\begin{aligned} & 0.7 \\ & 0.8 \end{aligned}$ | V | Guaranteed Input LOW Voltage |
| $\mathrm{V}_{\mathrm{CD}}$ | Input Clamp Diode Voltage |  | -0.9 | -1.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |
| $\mathrm{V}_{\mathrm{OH}}$ |  | $\begin{array}{r} 2.4 \\ 2.4 \\ \hline \end{array}$ | $\begin{aligned} & 3.4 \\ & 3.4 \end{aligned}$ |  | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOH}=-400 \mu \mathrm{~A}$ |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage |  | 0.25 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=8.0 \mathrm{~mA}$ |
| $\mathrm{IH}^{\text {H }}$ | Input HIGH Current, All except CP, $\mathrm{I}_{1}, \mathrm{I}_{2}, \mathrm{I}_{3}$ |  | 1.0 | 20 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IN}}=2.7 \mathrm{~V}$ |
|  | Input HIGH Current, CP, $\mathrm{I}_{0}, \mathrm{I}_{2}, \mathrm{I}_{3}$ |  | 1.0 | 40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ |
|  | Input HIGH Current, All Inputs |  |  | 1.0 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ |
| IL | Input LOW Current, All except CP, $\mathrm{I}_{0}, \mathrm{I}_{2}, \mathrm{I}_{3}$ |  | 0.21 | 0.36 | mA | $V_{C C}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ |
|  | Input LOW Current, CP, $\mathrm{I}_{0}, \mathrm{I}_{2}, \mathrm{I}_{3}$ |  | 0.42 | 0.72 |  | C MAX, ViN $=0.4 \mathrm{~V}$ |
| Ios | Output Short Circuit Current, $\mathrm{O}_{0} \mathrm{O}_{3}, \mathrm{O}_{S}$ | -15 |  | -100 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0$ (Note 3) |
| Icc | Supply Current |  | 130 |  | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{MR}$ LOW |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

FAIRCHILD•9408

AC CHARACTERISTICS: $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| tPHH | Propagation Delay, Instruction to VIA |  | 35 |  | ns | $\begin{aligned} & \mathrm{I}_{1}, \mathrm{I}_{2} \mathrm{HIGH}, \mathrm{I}_{3} \text { LOW } \\ & \mathrm{I}_{0}=\text { Input, } \mathrm{VIA}_{0}=\text { Output } \end{aligned}$ |
| ${ }^{\text {tPLL }}$ |  |  | 35 |  | ns |  |
| ${ }^{\text {tPHH }}$ | Propagation Delay, Instruction to INHIBIT |  | 35 |  | ns | $\begin{aligned} & I_{1} \text { HIGH, I } I_{2}, I_{3} \text { LOW } \\ & I_{0}=\text { Input, I }{ }_{N H}=\text { Output } \end{aligned}$ |
| ${ }^{\text {tPLL }}$ |  |  | 35 |  | ns |  |
| ${ }^{\text {tPHH }}$ | Propagation Delay, Positive <br> Going CP to Any A (Non-Pipeline) |  | 45 |  | ns | $\mathrm{I}_{1} \mathrm{HIGH}, \mathrm{PL}, \mathrm{I}_{0}, \mathrm{I}_{2}, \mathrm{I}_{3}$ LOW |
| ${ }^{\text {tPHL }}$ |  |  | 52 |  | ns |  |
| ${ }^{\text {tPHH }}$ | Propagation Delay, Positive Going CP to Any A (Pipeline) |  | 98 |  | ns | $\mathrm{PL}, \mathrm{I}_{1} \mathrm{HIGH}$, <br> $I_{0}, I_{2}, I_{3}$ LOW |
| ${ }^{\text {tPHL }}$ |  |  | 98 |  | ns |  |
| ${ }^{\text {tPHH }}$ | Propagation Delay, <br> BA to A (Pipeline) |  | 22 |  | ns | $\begin{aligned} & \mathrm{PL}, \mathrm{I}_{0}, \mathrm{I}_{1}, \mathrm{I}_{2} \mathrm{HIGH} \\ & \mathrm{I}_{3} \text { LOW } \end{aligned}$ |
| ${ }^{\text {tPLL }}$ |  |  | 28 |  | ns |  |
| tPHH | Propagation Delay, <br> Instruction to Any A (Pipeline) |  | 72 |  | ns | $I_{0}, I_{1}, B_{A}$, PL HIGH $I_{3}, \mathrm{MW}_{0}$ LOW, $\mathrm{A}_{0}=$ Output $\mathrm{I}_{2}=$ Input, $\mathrm{A}_{0}=$ Output |
| ${ }^{\text {tPLL }}$ |  |  | 72 |  | ns |  |
| tPWH | Min CP Pulse Width (HIGH) |  | 18 |  | ns | $\begin{aligned} & \mathrm{I}_{1} \mathrm{HIGH} \\ & \mathrm{I}_{0}, \mathrm{I}_{2}, \mathrm{I}_{3}, \mathrm{PL} \text { LOW } \end{aligned}$ |
| tPWL | Min CP Pulse Width (LOW) |  | 30 |  | ns |  |
| ${ }^{\text {s }}$ | Set-up Time, BA to CP |  | 15 |  | ns | $I_{2}$ HIGH, $I_{0}, I_{1}, I_{3}$, PL LOW <br> $B A_{O}=$ Input, $A_{O}=$ Output |
| $t^{\prime}$ | Hold Time, BA to CP |  | 5 |  | ns | $I_{2}$ HIGH, $I_{0}, I_{1}, I_{3}$ PL LOW $B A_{O}=$ Input; $A_{O}=$ Output |
| $\mathrm{ts}^{\text {S }}$ | Set-up Time, Instruction to CP |  | 90 |  | ns | $\begin{aligned} & I_{0}, \mathrm{I}_{1}, \mathrm{BA} A_{0} \text { HIGH } \\ & I_{3}, \mathrm{MW}_{0}, \text { PL LOW } \\ & \mathrm{I}_{2}=\text { Input, } \mathrm{A}_{0}=\text { Output } \end{aligned}$ |
| th | Hold Time, Instruction to CP |  | $-20$ |  | ns |  |
| $\mathrm{t}_{s}$ | Set-up Time, Strobe to CP (Required to achieve conditional branch in the same microcycle) |  | 60 |  | ns | $\begin{aligned} & I_{3}, \text { TEST }_{0} \text { HIGH } \\ & I_{0}, I_{1}, I_{2}, P L, B A_{0} \text { LOW } \\ & \text { Strobe }=\text { Input, } A_{0}=\text { Output } \end{aligned}$ |
| $\mathrm{t}_{s}$ | Set-up Time, Test to Strobe |  | 5 |  | ns | $\begin{aligned} & \mathrm{I}_{2}, \mathrm{I}_{3}, \mathrm{PL} \text { HIGH } \\ & \mathrm{I}_{0}, \mathrm{I}_{1}, \text { BA } \mathrm{A}_{0} \text { LOW } \\ & \mathrm{TEST}_{0}=\text { Input, } \mathrm{A}_{0}=\text { Output } \end{aligned}$ |
| $t^{\prime}$ | Hold Time, Test to Strobe |  | 15 |  | ns | $\begin{aligned} & I_{2}, I_{3}, \text { PL HIGH } \\ & I_{0}, I_{1}, \text { BA } \\ & \mathrm{TEST}_{\mathrm{O}} \text { LOW } \\ & \text { Input, } \mathrm{A}_{0}=\text { Output } \end{aligned}$ |
| trec | Recovery Time, MR to CP |  | 20 |  | ns |  |

# 9410 <br> REGISTER STACK•16×4 RAM <br> WITH 3-STATE OUTPUT REGISTER <br> FAIRCHILD TTL MACROLOGIC 

DESCRIPTION - The 9410 is a register oriented high speed 64-bit Read/Write Memory organized as 16 -words by 4 -bits. An edge-triggered 4 -bit output register allows new input data to be written while previous data is held. 3-state outputs are provided for maximum versatility. The 9410 is fully compatible with all TTL families.

## - EDGE-TRIGGERED OUTPUT REGISTER

- TYPICAL ACCESS TIME OF 35 ns
- 3-STATE OUTPUTS
- OPTIMIZED FOR REGISTER STACK OPERATION
- TYPICAL POWER OF 375 mW
- 18-PIN PACKAGE


## PIN NAMES

| $\mathrm{A}_{0}-\mathrm{A}_{3}$ | Address Inputs |
| :--- | :--- |
| $\frac{\mathrm{D}_{0}-\mathrm{D}_{3}}{\overline{\mathrm{CS}}}$ | Data Inputs |
| $\overline{\mathrm{EO}}$ | Chip Select Input (Active LOW) |
| $\overline{\mathrm{WE}}$ | Output Enable Input (Active LOW) |
| CP | Write Enable Input (Active LOW) <br>  <br> $\mathrm{C}_{0}-\mathrm{Q}_{3}$ |
|  | Clock Input (Outputs Change on LOW <br> to HIGH Transition) |
|  | Outputs |


| LOADING (Note a) |  |
| :---: | ---: |
| HIGH | LOW |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
| 1.0 U.L. | 0.23 U.L. |
|  |  |
| 130 U.L. | 10 U.L. |
|  | (Note b) |



## FUNCTIONAL DESCRIPTION

Write Operation - When the three control inputs: Write Enable (WE), Chip Select (CS), and Clock (CP), are LOW the information on the data inputs $\left(D_{0}-D_{3}\right)$ is written into the memory location selected by the address inputs $\left(A_{0}-A_{3}\right)$. If the input data changes while WE, CS, and CP are LOW, the contents of the selected memory location follows these changes, provided set-up time criteria are met.
Read Operation - Whenever CS is LOW and CP goes from LOW-to-HIGH, the contents of the memory location selected by the address inputs ( $A_{0}-A_{3}$ ) is edge-triggered into the Output Register.
A 3-State Output Enable (EO) controls the output buffers. When EO is HIGH the four outputs $\left(\mathrm{Q}_{0}-\mathrm{O}_{3}\right)$ are in a high impedance or OFF state; when EO is LOW, the outputs are determined by the state of the Output Register.

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise noted)

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEST CONDITIONS (Note 1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |
| $\mathrm{V}_{\text {IH }}$ | Input HIGH Voltage |  | 2.0 |  |  | V | Guaranteed Input HIGH Voltage |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage | XM |  |  | 0.7 | V | Guaranteed Input LOW Voltage |
|  |  | XC |  |  | 0.8 |  |  |
| $\mathrm{V}_{\mathrm{CD}}$ | Input Clamp Diode Voltage |  |  | -0.9 | -1.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\text {IN }}=-18 \mathrm{~mA}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | XM | 2.4 | 3.4 |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}$ |
|  |  | XC | 2.4 | 3.1 |  |  | $\mathrm{I}^{\mathrm{OH}}=-5.2 \mathrm{~mA} \quad \mathrm{CC}$ |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage | XM \& XC |  | 0.25 | 0.4 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{IOL}=8.0 \mathrm{~mA}$ |
|  |  | XC |  | 0.35 | 0.5 | V | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MIN}, \mathrm{I}_{\mathrm{OL}}=16 \mathrm{~mA}$ |
| IOZH. | Output Off HIGH Current |  |  |  | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=3 \mathrm{~V}$ |
| IOZL | Output Off LOW Current |  |  |  | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{E}}=3 \mathrm{~V}$ |
| $1_{1 H}$ | Input HIGH Current |  |  | 1.0 | 40 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ |
|  |  |  |  |  | 1.0 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}$ |
| IIL | Input LOW Current |  |  |  | -0.36 | mA | $\mathrm{V}_{\mathrm{CC}}=\mathrm{MAX}, \mathrm{V}_{\text {IN }}=0.4 \mathrm{~V}$ |
| IOS | Output Short Circuit Current |  | -30 |  | -100 | mA | $\mathrm{V}_{\text {CC }}=\mathrm{MAX}, \mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ (Note 3) |
| ${ }^{\text {ICCH }}$ | Supply Current |  |  | 75 | 110 | mA | $V_{C C}=$ MAX, Inputs Open |

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.
2. Typical limits are at $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
3. Not more than one output should be shorted at a time.

AC CHARACTERISTICS: $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| READ MODE |  |  |  |  |  |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Enable Delay, Output Enable to Output |  | 9 9 | $\begin{aligned} & 15 \\ & 15 \end{aligned}$ | ns <br> ns | Figure 1 |
| $\begin{aligned} & \text { tpHZ } \\ & \text { tpLZ } \end{aligned}$ | Disable Time, Output Enable to Output |  | $\begin{aligned} & 10 \\ & 10 \end{aligned}$ | $\begin{aligned} & 16 \\ & 16 \end{aligned}$ | ns ns | Figure 1 |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, Clock to Output |  | $\begin{aligned} & 14 \\ & 14 \end{aligned}$ | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | ns ns | Figure 2 |
| $\mathrm{t}_{\mathrm{s}} \mathrm{AR}$ | Set-up Time to Read from Address to Clock | 38 | 25 |  | ns | Figure 2 |
| $t_{h} A R$ | Hold Time to Read from Address to Clock | 0 |  |  | ns | Figure 2 |
| WRITE MODE |  |  |  |  |  |  |
| tw | Write Enable, Chip Select, or Clock Pulse Width Required to Write (Note a) | 21 | 12 |  | ns | Figure 3 |
| $\mathrm{t}_{\mathrm{s}} \mathrm{AW}$ | Set-up Time Address to Write Enable (Note b) | 5 |  |  | ns | Figure 3 |
| $t_{\text {h }}$ AW | Hold Time Address to Write Enable (Note b) | 0 |  |  | ns | Figure 3 |
| $\mathrm{t}_{s}$ DW | Set-up Time Data to Write Enable (Note b) | 16 | 9 |  | ns | Figure 3 |
| $t_{\text {b }}$ DW | Hold Time Data to Write Enable | 0 |  |  | ns | Figure 3 |

NOTES:
a) Writing occurs when $\overline{W E}, \overline{C E}$ and $C P$ are LOW.
b) Assuming $\overline{W E}$ is utilized as Writing Strobe.

## READ MODE AC PARAMETERS



Fig. 1

PROPAGATION DELAY OUTPUT ENABLE TO DATA OUTPUTS


Other Conditions: $\overline{\mathrm{CS}}=\overline{\mathrm{OE}}=$ LOW
Fig. 2
PROPAGATION DELAY CLOCK TO DATA OUTPUTS, AND SET-UP AND HOLD TIMES ADDRESS TO CLOCK TO READ


Other Conditions: $\overline{\mathrm{CS}}=\mathbf{C P}=$ LOW
Fig. 3
WRITE ENABLE PULSE
WIDTH, SET-UP AND HOLD
TIMES ADDRESS AND DATA TO WRITE ENABLE


DEVICE INDEX AND SELECTOR INFORMATION

BIPOLAR MACROLOGIC


CMOS MACROLOGIC


## 4700 CMOS MACROLOGIC SERIES

## GENERAL DESCRIPTION

Fairchild CMOS logic combines popular CMOS functions with the advanced Isoplanar C process. The result is a logic family with a superior combination of noise immunity and standardized drive characteristics. At static conditions, these devices dissipate very low power, typically 10 nW per gate. The low power combined with the wide ( 3 to 15 V ) recommended operating supply voltage requirement greatly minimizes power supply costs. The CMOS family is designed with standardized output drive characteristics which, combined with relative insensitivity to output capacitance loading, simplify system design.

- LOW POWER - TYPICALLY 10 nW PER GATE STATIC
- WIDE OPERATING SUPPLY VOLTAGE RANGE 3 TO 15 V RECOMMENDED 18 V ABSOLUTE MAXIMUM
- HIGH NOISE IMMUNITY
- BUFFERED OUTPUTS STANDARDIZE OUTPUT DRIVE AND REDUCE VARIATION OF PROPAGATION DELAY WITH OUTPUT CAPACITANCE
- WIDE OPERATING TEMPERATURE RANGE

COMMERCIAL $\quad-40^{\circ} \mathrm{C}$ TO $+85^{\circ} \mathrm{C}$ MILITARY $\quad-55^{\circ} \mathrm{C}$ TO $+125^{\circ} \mathrm{C}$

- HIGH DC FAN-OUT - GREATER THAN 50


## ISOPLANAR C TECHNOLOGY

The Fairchild CMOS logic family uses Isoplanar C for high performance. This technology combines local oxidation isolation techniques with silicon gate technology to achieve an approximate $35 \%$ to $100 \%$ savings in area as shown in Figure 4-1. Operating speeds are increased due to the self-alignment of the silicon gate and reduced sidewall capacitance.

Conventional CMOS circuits are fabricated on an n-type substrate as shown in Figure 4-2. The p-type substrate required for complementary n-channel MOS is obtained by diffusing a lightly doped p-region into the n-type substrate. Conventional CMOS fabrication requires more chip area and has slower circuit speeds than Isoplanar C CMOS. This is a result of the $n+o r$ $\mathrm{p}+$ channel stop which surrounds the p - or n -channels respectively in conventional metal gate CMOS, Silicon gate CMOS (Figure 4-3) has a negligible reduction in area, though transient performance is improved.

## DESIGN CONSIDERATIONS

Fairchild Isoplaner F4000 Series CMOS is a complete family of SSI, MSI, and LSI silicon gate CMOS. The 4700 CMOS Macrologic series is the LSI segment of this family. The following discussion of design considerations covers Fairchild's entire F4000 series CMOS family.


Originally designed for aerospace applications, CMOS now finds its way into portable instruments, industrial and medical electronics, automotive applications and computer peripherals, besides dominating the electronic watch market.

In late 1973, Fairchild introduced the F4000 CMOS family, using Isoplanar technology to achieve superior electrical performance. Most of these devices are functional equivalents and pin-for-pin replacements of the well-known 4000 series; some are equivalent to TTL circuits and some are proprietary logic designs.

A few CMOS devices, such as bidirectional analog switches, exploit the unique features of CMOS technology; some take advantage of the smaller device size and higher potential packing density to achieve true LSI complexity; but most of the available CMOS elements today are of SSI and MSI complexity and perform logic functions that have been available in DTL or TTL for many years. Therefore, it is both helpful and practical to compare the performance of CMOS with that of the more familiar DTL/TTL (Figure 4-4).

CMOS speed is comparable to $74 \mathrm{~L}-\mathrm{TTL}$ and DTL, and about three to six times slower than TTL or Low Power Schottky (LS-TTL). Voltage noise immunity and fan out are almost ideal, supply voltage is noncritical, and the quiescent power consumption is close to zero-several orders of magnitude lower than for any competing technology.

## Power Consumption

Under static conditions, the p-channel (top) and the $n$-channel (bottom) transistors are not conducting simultaneously, thus only leakage current flows from the positive ( $\mathrm{V}_{\mathrm{DD}}$ ) to the negative $\left(\mathrm{V}_{\mathrm{SS}}\right)$ supply connection. This leakage current is typically 0.5 nA per gate, resulting in very attractive low power consumption of 2.5 nW per gate (at 5 V ).

Whenever a CMOS circuit is exercised, when data or clock inputs change, additional power is consumed to charge and discharge capacitances (on-chip parasitic capacitances as well as load capacitances). Moreover, there is a short time during the transition when both the top and the bottom transistors are partially conducting. This dynamic power consumption is obviously proportional to the frequency at which the circuit is
exercised, to the load capacitance and to the square of the supply voltage. As shown in Figure 4-5, the power consumption of a CMOS gate exceeds that of a low power Schottky gate somewhere between 500 kHz and 2 MHz of actual output frequency.

At 100 transitions per second, the dynamic power consumption is far greater than the static dissipation; at one million transitions per second, it exceeds the power consumption of LS-TTL. Comparing the power consumption of more complex devices (MSI or LSI) in various technologies may show a different result. In any complex design, only a small fraction of the gates actually switch at the full clock frequency, most gates operate at a much lower average rate and consume, therefore, much less power.

A realistic comparison of power consumption between different technologies involves a thorough analysis of the average switching speed of each gate in the circuit. The small static supply current, IDD is specified on individual data sheets for 5,10 and 15 V . The dynamic power dissipation for 5,10 and $15 \mathrm{~V}, 15$ and 50 pF may be found in graph form for frequencies of 100 Hz to 10 MHz . The total power may be calculated, $\mathrm{P}_{\mathrm{T}}=\left(I_{D D} \times \mathrm{V}_{\mathrm{DD}}\right)+$ dynamic power dissipation.

## Supply Voltage Range

CMOS is guaranteed to function over the unprecedented range of 3 to 15 V supply voltage. Characteristics are guaranteed for 5,10 and 15 V operation and can be extrapolated for any voltage in between. Operation below 4.5 V is not very meaningful because of the increase in delay (loss of speed), the increase in output impedance and the loss of noise immunity. Operation above 15 V is not recommended because of high dynamic power consumption and risk of noise spikes on the power supply exceeding the breakdown voltage (typ $>20 \mathrm{~V}$ ), causing SCR latch-up and destroying the device unless the current is externally limited.

The lower limit of power supply voltage, including ripple, is determined by the required noise immunity, propagation delay or interface to TTL. The upper limit of supply voltage, including ripple and transients, is determined by power dissipation or direct interface to TTL. The F4049, F4050 and F4104 provide level translation between TTL and CMOS when CMOS supply

| PARAMETER | STANDARD TTL | 74L | DTL | LOW POWER SCHOTTKY | $\begin{gathered} \text { F4000 } \\ \text { CMOS } \\ 5 \mathrm{~V} \text { SUPPLY } \end{gathered}$ | $\begin{gathered} \text { F4000 } \\ \text { CMOS } \\ 10 \text { V SUPPLY } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PROPAGATION DELAY (GATE) FLIP-FLOP TOGGLE FREQUENCY QUIESCENT POWER (GATE) NOISE IMMUNITY FAN-OUT | 10 ns <br> 35 MHz <br> 10 mW <br> 1 V <br> 10 | 33 ns <br> 3 MHz <br> 1 mW <br> 1 V <br> 10 | 30 ns <br> 5 MHz <br> 8.5 mW <br> 1 V <br> 8 | 45 MHz <br> 2 mW <br> 0.8 V <br> 20 | 40 ns <br> 8 MHz <br> 10 nW <br> $2 V$ <br> 50* |  |

*OR AS DETERMINED BY ALLOWABLE PROPAGATION DELAY
Fig. 4-4
CMOS COMPARED TO OTHER LOGIC FAMILIES
voltages over 5 V are used. While devices are usable to 18 V , operation above 12 V is discouraged for reasons of power dissipation.

Low static power consumption combined with wide supply voltage range make CMOS the ideal logic family for battery operated equipment.

## Propagation Delay

Compared to TTL and LS-TTL, all CMOS devices are slow and very sensitive to capacitive loading. See Figure 4-6. The Fairchild F4000 family uses both advanced processing (Isoplanar) and improved circuit design (buffered gates) to achieve propagation delays and output rise times that are superior to any other junction-isolated CMOS design. (Silicon-on-sapphire, SOS, can achieve similar performance but at a substantial cost penalty).

Isoplanar processing achieves lower parasitic capacitances which reduce the on-chip delay and increase the maximum toggle frequency of flip-flops, registers and counters. Buffering all outputs, even on gates, results in lower output impedance and thus reduces the effect of capacitive loading.

Propagation delay is affected by three parameters: capacitive loading, supply voltage, and temperature.

## Capacitance Loading Effect

Historically, semiconductor manufacturers have always specified the propagation delay at an output load of 15 pF , not because anybody considers this a representative systems environment, but rather because it was the lowest practical test-jig capacitance. It also generated the most impressive specifications. TTL with an output impedance less than $100 \Omega$ is little affected by an increase in capacitive loading; a 100 pF load increases the delay by only about 4 ns . CMOS, however with an output impedance of $1 \mathrm{k} \Omega$ (worst case at 5 V ) is 10 times more sensitive to capacitance loading. Figures 4-7 and $4-8$ show the positive- and negative-going delays as a function of load capacitance. It should be noted that the older, unbuffered gates have an even higher output impedance, a larger dependence on output loading, and do not show the same symmetry.

## Supply Voltage Effect

Figures 4-9 and 4-10 show propagation delay as a function of supply voltage and again indicate the symmetry of the posi-tive- and negative-going delays. Increasing the supply voltage from 5 to 10 V more than doubles the speed of CMOS gates. Increasing the supply voltage to 15 V almost doubles the speed again, but, as mentioned before, results in a significant increase in dynamic power dissipation.


Fig. 4-5


Fig. 4-7


Fig. 4-6


Fig. 4-8

The best choice for slow applications is 5 V . For reasonably fast systems, choose 10 or 12 V . Any application requiring 15 V to achieve short delays and fast operation should be investigated for excessive power dissipation and should be weighed against an LS-TTL.approach.

## Temperature Effect

Figures 4-11 and $4-12$ show propagation delay as a function of ambient temperature. The temperature dependence of CMOS is much simpler than with TTL, where three factors contribute - increase of beta with temperature, increase of resistor value with temperature, and decrease of junction forward voltage drop with increasing temperature. In CMOS, essentially only the carrier mobility changes, thus increasing the impedance and hence the delay with temperature. For F4000 devices, this temperature dependence is less than $0.3 \%$ per ${ }^{\circ} \mathrm{C}$, practically linear over the full temperature range. Note that the commercial temperature range is -40 to $+85^{\circ} \mathrm{C}$ rather than the usual 0 to $+75^{\circ} \mathrm{C}$.

CMOS delays increase with temperature. They are very sensitive to capacitive loading but can be reduced by increasing the supply voltage to 10 or even 15 V .

To determine propagation delays, the effects of capacitive loading, supply voltage, manufacturing tolerances and ambient
temperature must be considered. Start with the values of tPLH (propagation delay, a LOW-to-HIGH output transition) and tPHL (propagation delay, a HIGH-to-LOW output transition) given in the individual data sheets. Delay values for $V_{D D}$ at 5 , 10 and 15 V and output capacity of 15 and 50 pF are provided. Manufacturing tolerances account for the differences between MIN, TYP and MAX.

## Noise Immunity

One of the most advertised and also misunderstood CMOS features is noise immunity. The input threshold of a CMOS gate is approximately $50 \%$ of the supply voltage and the voltage transfer curve is almost ideal. As a result, CMOS can claim very good voltage noise immunity, typically $45 \%$ of the supply voltage, i.e., 2.25 V in a 5 V system, 4.5 V in a 10 V system. Compare this with the TTL transfer curve in Figure $4-13$ and its resultant 1 V noise immunity in a lightly loaded system and only 0.4 V worst case.

Since CMOS output impedance, output voltage and input threshold are symmetrical with respect to the supply voltage, the LOW and HIGH level noise immunities are practically equal. Therefore, a CMOS system can tolerate ground or $V_{D D}$ drops and noise on these supply lines of more than 1 V , even in a 5 V system. Moreover, the inherent CMOS delays act as a


Fig. 4-9


Fig. 4-11


Fig. 4-10


Fig. 4-12

noise filter; 10 ns spikes tend to disappear in a chain of CMOS gates, but are amplified in a chain of TTL gates. Because of these features, CMOS is very popular with designers of industrial control equipment that must operate in an electrically and electromagnetically "polluted" environment.

Unfortunately these impressive noise margin specifications disregard one important fact: the output impedance of CMOS is 10 to 100 times higher than that of TTL. CMOS interconnections are therfore less "stiff" and much more susceptible to capacitively coupled noise. In terms of such current injected crosstalk from high noise voltages through small coupling capacitances, CMOS has about six times less noise margin than TTL. It takes more than 20 mA to pull a TTL output into the threshold region, but it takes only 3 mA to pull a CMOS output into the threshold of a 5 V system.

The nearly ideal transfer characteristic and the slow response of CMOS circuits make them insensitive to low voltage, magnetically coupled noise. The high output impedance, however, results in a poor rejection of capacitively coupled noise.

## Interface to TTL

When CMOS is operated with a 5 V power supply, interface to TTL is straightforward. The input impedance of CMOS is very high, so that any form of TTL will drive CMOS without loss of fan-out in the LOW state. Unfortunately, most TTL has insufficient HIGH state voltage (typically 3.5 V ) to drive CMOS reliably. A pull up resistor ( $1 \mathrm{k} \Omega$ to $10 \mathrm{k} \Omega$ ) from the output of the TTL device to the 5 V power supply will effectively pull the HIGH state level to 4.5 V or above. Alternately, DTL Hex inverters may be used between the TTL and CMOS. 9LS Low Power Schottky and 93L00 Low Power TTL/MSI utilize the unique output configuration shown in Figure 4-14 to pull its output to $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{BC}}$ or approximately 4.3 V when lightly loaded.


Fig. 4-14
THE 93L00 AND 9LSOO TTL FAMILIES WILL DRIVE CMOS DIRECTLY WITHOUT RESISTORS AS LONG AS THERE ARE ONLY CMOS DEVICES BEING DRIVEN FROM THE OUTPUT.

All F4000 logic elements will drive a single 9LS low power Schottky input fan in directly. A 9LS Hex inverter such as the 9LS04 makes an excellent low cost TTL buffer with a fan out of 20 into 9LS or 5 into standard TTL. Alternately, the F4049 and F4050 Hex buffers may be used to drive a fan out of 8 into 9LS or 2 into standard TTL.

When operating CMOS at voltages higher than 5 V direct interface to TTL cannot be used. The F4104 Quad Level Translator converts TTL levels to high voltage CMOS up to 15 V. The F4049 and F4050 Hex Buffers will accept high voltage CMOS levels up to 15 V and drive 2 standard TTL loads.

## Input/Output Capacity

CMOS devices exhibit input capacities in the 1.5 to 5 pF range and output capacity in the 3 to 7 pF range.

## Output Impedance

All F4000 logic devices employ standardized output buffers. It should be noted that these impedances do not change with input pattern as do conventional CMOS gates. Buffers, analog switches and analog multiplexers employ special output configurations which are detailed in individual data sheets.

## Input Protection

The gate input to any MOS transistor appears like a small $(<1 \mathrm{pF})$ very low leakage $\left(<10^{-12} \mathrm{~A}\right)$ capacitor. Without special precautions, these inputs could be electrostatically charged to a high voltage, causing a destructive breakdown of the dielectric and permanently damaging the device. Therefore, all CMOS inputs are protected by a combination of series resistor and shunt diodes. Various manufacturers have used different approaches; some use a single diode, others use two diodes, and some use a resistor with a parasitic substrate diode.

Each member of the F 4000 family utilizes a series resistor, nominally $200 \Omega$, and two diodes, one to $V_{\text {DD }}$, and the other to $V_{S S}$ (Figure 4-15). The resistor is a poly-silicon "true resistor" without a parasitic substrate diode. This ensures that the input impedance is always at least $200 \Omega$ under all biasing conditions, even when $V_{D D}$ is short circuited to $V_{S S}$. $A$

parasitic substrate diode would represent a poorly defined shunt to $\mathrm{V}_{\mathrm{SS}}$ in this particular case.

The diodes exhibit typical forward voltage drops of 0.9 V at 1 mA and reverse breakdowns of 20 V for $\mathrm{D}_{1}$ and 20 V for $\mathrm{D}_{2}$. For certain special applications such as oscillators, the diodes actually conduct during normal operation. However, currents must be limited to 10 mA .

## Handling Precautions

All MOS devices are subject to damage by large electrostatic charges. All F4000 devices employ the input protection described in Figure 4-15, however, electrostatic damage can still occur. The following handling precautions should be observed.

1. All F4000 devices are shipped in conducting foam or tubes. They should be removed for inspection or assembly using proper precautions.
2. Ionized air blowers are recommended when automatic incoming inspection is performed.
3. F4000 devices, after removal from their shipping material, should be placed leads down on a grounded surface. Conventional cookie tins work well. Under no circumstances should they be placed in polystyrene foam or plastic trays used for shipment and handling of conventional ICs.
4. Individuals and tools should be grounded before coming in contact with F4000 devices.
5. Do not insert or remove devices in sockets with power applied. Ensure power supply transients, such as occur during power turn-on or off; do not exceed maximum ratings.
6. In the system, all unused inputs must be connected to either a logic HIGH or logic LOW level such as $V_{S S}, V_{D D}$ or the output of a logic element.
7. After assembly on PC boards, ensure that static discharge cannot occur during storage or maintenance. Boards may be stored with their connectors surrounded with conductive foam. Board input/output pins may be protected with large value resistors ( $10 \mathrm{M} \Omega$ ) to ground.
8. In extremely hostile environments, an additional series input resistor ( 10 to $100 \mathrm{k} \Omega$ ) provides even better protection at a slight speed penalty.

## A Word to the TTL Designer

Designing with CMOS is generally an easy transition and allows the designer to discard many of the old design inhibitions for new found freedoms. A few of these are:

Fan-out - It is practically unlimited from a dc point of view and is restricted only by delay and rise time considerations.

Power Supply Regulation - Anything between 3 V and 15 V goes, as long as all communicating circuits are fed from the same voltage.

Ground and VCC Line Drops - The currents are normally so small that there is no need for heavy supply line bussing.
$V_{C C}$ Decoupling - It can be reduced to a few capacitors per board.
Heat Problems - They do not exist, unless an attempt is made to run CMOS very fast and from more than 10 V .

It should also be noted that there are a few warnings called for when designing with CMOS and that many of the hard-earned good engineering basics cannot be forgotten. A few of the new design challenges include:
Unused Inputs - They must be connected to VSS or VDD ( $\mathrm{V}_{\mathrm{CC}}$ or ground) lest they generate a logical "maybe". The bad TTL habit of leaving unused inputs open is definately out.
Oscillations - Slowly rising or falling inputs signals can lead to oscillations and multiple triggering. A poorly regulated and decoupled power supply magnifies this problem since the CMOS input threshold varies with the supply voltage.

Timing Details - Even slow systems require a careful analysis of worst case timing delays, derated for maximum temperature, minimum supply voltage and maximum capacitive loading. Many CMOS flip-flops, registers and latches have a real hold time requirement, i.e., inputs must remain stable even after the active clock edge; some require a minimum clock rise time. This hasn't been a problem with TTL. CMOS systems, even slow ones, are prone to unsuspected clock skew problems, especially since a heavily loaded clock generator can have a poor rise time.

## JEDEC INDUSTRY STANDARD "B' SERIES CMOS

Throughout first quarter of 1976 the CMOS vendor industry, in total, was invited to participate in the generation of a new JEDEC Industry Standard CMOS "B" Series specification. Unanimous agreement was reached in April of 1976 and confirmed by industry wide ballot in May.
This section is meant to extend knowledge of the new Industry Standard "B" Series specification to the customer and ensure that all Fairchild CMOS products meet or exceed all specifications of the new JEDEC standard.

In fact, since first introduction of the Isoplanar CMOS Family in 1973, all Fairchild CMOS products have been designed and tested to meet or exceed the recently announced JEDEC specifications as listed in the JEDEC 'Standard Specification for description of " $B$ " Series CMOS devices" dated June, 1976.

## STANDARD SPECIFICATION FOR <br> DESCRIPTION OF "в" SERIES CMOS DEVICES

(Formulated under the cognizance of the JEDEC JC-40.2
Committee on CMOS Standardization)

## 1. Purpose

### 1.1 Purpose

To develop a standard of " B " Series CMOS Specifications to provide for uniformity, multiplicity of sources, elimination of confusion, and ease of device specification and system design by users.

### 1.2 Scope

This tentative Standard covers standard specifications for description of " B " Series CMOS devices.

## 2. Definitions

2.1 " $B$ "Series
" $B$ " Series CMOS includes both buffered and unbuffered devices.

## 2.2 "Buffered"

A buffered output is one that has the characteristic that the output "on" impedance is independent of any and all valid input logic conditions, both preceding and present.

## 3. Standard Specifications

3.1 Listing of Standard Specifications

Table 1 lists the standard specifications for "B" Series CMOS devices.

### 3.2 Absolute Maximum Ratings

In the maximum ratings listed below voltages are referenced to $\mathrm{V}_{\mathrm{SS}}$.

| DC Supply Voltage | $\mathrm{V}_{\mathrm{DD}}$ | -0.5 V to +18 V |
| :--- | :--- | :--- |
| Input Voltage | $\mathrm{V}_{\mathrm{IN}}$ | -0.5 V to V DD +0.5 V |
| DC Input Current |  |  |
| (any one input) | $\mathrm{I}_{\mathrm{IN}}$ | $\pm 10 \mathrm{~mA}$ |
| Storage Temperature <br> Range |  |  |

### 3.3 Recommended Operating Conditions

Recommended operating conditions are listed below.

| DC Supply Voltage <br> Operatings Temperature | VDD | +3 V to +15 V |
| :--- | :--- | :--- |
| Range |  |  |
| Military-Range Devices | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Commercial-Range Devices | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |

### 3.4 Designation of " $B$ " Series CMOS Devices

Those parts which have analog inputs and/or outputs shall be included in the " $B$ " Series providing those parts' maximum ratings and logical input and output parameters conform to the " B " Series, such as (including, but not limited to):

| $4046 B$ | $4066 B$ |
| :--- | :--- |
| $4051 B$ | $4511 B$ |
| 4053B | $4528 B$ |
| $4053 B$ |  |

Products that meet " B " Series specifications except that the logical outputs are not buffered and the $\mathrm{V}_{\text {IL }}$ and $\mathrm{V}_{\text {IH }}$ specifications are $20 \%$ and $80 \%$ of VDD respectively shall be marked with the UB designation, such as (including, but not limited to):

| 4000UB | 4012UB |
| :--- | :--- |
| 4001UB | $4023 \cup B$ |
| 4002UB | $4025 \cup B$ |
| 4011UB |  |

As defined by the previous Industry Standard Specification, Fairchild offers immediate availability of the following devices:

| 4001B | $4025 B$ | $4068 B$ | $4520 B$ | $4731 B$ |
| :--- | :--- | :--- | :--- | :--- |
| 4002B | $4027 B$ | $4069 U B$ | $4528 B$ | $40014 B$ |
| 4006B | $4028 B$ | $4070 B$ | $4539 B$ | $40085 B$ |
| 4007UB | $4029 B$ | $4071 B$ | $4555 B$ | $40097 B$ |
| 4008B | $4030 B$ | $4073 B$ | $4556 B$ | $40098 B$ |
| 4011B | $4035 B$ | $4075 B$ | $4582 B$ | $40160 B$ |
| 4012B | $4040 B$ | $4076 B$ | $4702 B$ | $40161 B$ |
| 4013B | $4041 B$ | $4077 B$ | $4703 B$ | $40162 B$ |
| 4014B | $4042 B$ | $4078 B$ | $4704 B$ | $40163 B$ |
| 4015B | $4043 B$ | $4081 B$ | $4705 B$ | $40174 B$ |
| 4016B | $4044 B$ | $4085 B$ | $4706 B$ | $40175 B$ |
| 4017B | $4046 B$ | $4086 B$ | $4707 B$ | $40192 B$ |
| 4018B | $4049 B$ | $4104 B$ | $4710 B$ | $40193 B$ |
| 4019B | $4050 B$ | $4510 B$ | $4720 B$ | $40194 B$ |
| 4020B | $4051 B$ | $4511 B$ | $4721 B$ | $40195 B$ |
| 4021B | $4052 B$ | $4512 B$ | $4723 B$ |  |
| 4023B | $4053 B$ | $4516 B$ | $4724 B$ |  |
| 4024B | $4066 B$ | $4518 B$ | $4725 B$ |  |

TABLE 1

|  | PARAMETER | $\begin{aligned} & \text { TEMP. } \\ & \text { RANGE } \end{aligned}$ | $V_{D D}$ <br> (Vdc) | CONDITIONS | LIMITS |  |  |  |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | T LOW* |  | $+25^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\text {HIGH* }}$ |  |  |
|  |  |  |  |  | MIN | MAX | MIN | MAX | MIN | MAX |  |
| ${ }^{\prime}$ DD | Quiescent Device Current <br> GATES | MilComm | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{v}_{\mathrm{SS}} \text { or } \mathrm{V}_{\mathrm{DD}}$ <br> All valid input combinations | $\begin{array}{r} \hline 0.25 \\ 0.5 \\ 1.0 \\ 1.0 \\ 2.0 \\ 4.0 \\ \hline \end{array}$ |  | $\begin{array}{r} 0.25 \\ 0.5 \\ 1.0 \\ 1.0 \\ 2.0 \\ 4.0 \\ \hline \end{array}$ |  | $\begin{array}{r} 7.5 \\ 15 \\ 30 \\ 7.5 \\ 15 \\ 30 \end{array}$ |  | $\mu \mathrm{A}$$\mu \mathrm{A}$ |
|  |  |  | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ |  |  |  |  |  |  |  |  |
|  | BUFFERS, | Mil | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ or $\mathrm{V}_{\mathrm{DD}}$ |  | $\begin{aligned} & 1.0 \\ & 2.0 \\ & 4.0 \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 2.0 \\ & 4.0 \end{aligned}$ |  | $\begin{array}{r} 30 \\ 60 \\ 120 \end{array}$ | $\mu \mathrm{A}$ |
|  | FLIP-FLOPS | Comm | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | All valid input combinations |  | $\begin{array}{r} 4 \\ 8 \\ 16 \end{array}$ |  | $\begin{array}{r}4 \\ 8 \\ 16 \\ \hline\end{array}$ |  | $\begin{array}{r} 30 \\ 60 \\ 120 \end{array}$ | $\mu \mathrm{A}$ |
|  |  | Mil | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {SS }}$ or $\mathrm{V}_{\mathrm{DD}}$ |  | 5 10 20 |  | 5 10 20 |  | $\begin{aligned} & 150 \\ & 300 \\ & 600 \end{aligned}$ |  |
|  | MSI | Comm | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | All valid input combinations |  | $\begin{aligned} & 20 \\ & 40 \\ & 80 \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 40 \\ & 80 \end{aligned}$ |  | $\begin{aligned} & 150 \\ & 300 \\ & 600 \end{aligned}$ | $\mu \mathrm{A}$ |
| $\mathrm{v}_{\mathrm{OL}}$ | $\begin{aligned} & \text { Output LOW } \\ & \text { Voltage } \end{aligned}$ | All | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\begin{aligned} & V_{I N}=V_{S S} \text { or } V_{D D} \\ & \left\|l_{\mathrm{O}}\right\|<1 \mu \mathrm{~A} \end{aligned}$ |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | All | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\begin{aligned} & V_{I N}=V_{S S} \text { or } V_{D D} \\ & \|I O\|<1 \mu A \end{aligned}$ | $\begin{array}{r} 4.95 \\ 9.95 \\ 14.95 \end{array}$ |  | $\begin{array}{r} \hline 4.95 \\ 9.95 \\ 14.95 \end{array}$ |  | $\begin{array}{r} 4.95 \\ 9.95 \\ 14.95 \end{array}$ |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage | All | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V} \text { or } 4.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=1.0 \mathrm{~V} \text { or } 9.0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=1.5 \mathrm{~V} \text { or } 13.5 \mathrm{~V} \\ & \mid \mathrm{I}_{\mathrm{O}}<1 \mu \mathrm{~A} \end{aligned}$ |  | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ |  | 1.5 3.0 4.0 |  | 1.5 3.0 4.0 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage | All | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V} \text { or } 4.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=1.0 \mathrm{~V} \text { or } 9.0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=1.5 \mathrm{~V} \text { or } 13.5 \mathrm{~V} \\ & \left\|\mathrm{I}_{\mathrm{O}}\right\| \mu 1 \mu \mathrm{~A} \end{aligned}$ | $\begin{array}{r} 3.5 \\ 7.0 \\ 11.0 \end{array}$ |  | $\begin{array}{r} 3.5 \\ 7.0 \\ 11.0 \end{array}$ |  | $\begin{array}{r} 3.5 \\ 7.0 \\ 11.0 \end{array}$ |  | V |
| ${ }^{\text {I OL }}$ | Output LOW (Sink) Current | Mil Comm | $\begin{array}{r} 5 \\ 10 \\ 15 \\ 5 \\ 10 \\ 15 \end{array}$ | $\mathrm{V}_{\mathrm{O}}=0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0$ or 5 V $\mathrm{~V}_{\mathrm{O}}=0.5 \mathrm{~V} \mathrm{~V}_{\mathrm{IN}}=0$ or 10 V $\mathrm{~V}_{\mathrm{O}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0$ or 15 V $\mathrm{~V}_{\mathrm{O}}=0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0$ or 5 V $\mathrm{~V}_{\mathrm{O}}=0.5 \mathrm{~V} \mathrm{~V}_{\mathrm{IN}}=0$ or 10 V $\mathrm{~V}_{\mathrm{O}}=1.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0$ or 15 V | $\begin{array}{r} \hline 0.64 \\ 1.6 \\ 4.2 \\ 0.52 \\ 1.3 \\ 3.6 \end{array}$ |  | $\begin{array}{r} \hline 0.51 \\ 1.3 \\ 3.4 \\ 0.44 \\ 1.1 \\ 3.0 \end{array}$ |  | 0.36 0.9 2.4 0.36 0.9 2.4 |  | mA $\mathrm{mA}$ |
| ${ }^{\prime} \mathrm{OH}$ | Output HIGH (Source) Current | Mil Comm | $\begin{array}{r} 5 \\ 10 \\ 15 \\ 5 \\ 10 \\ 15 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=4.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \text { or } 5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=9.5 \mathrm{~V}, \mathrm{~V}_{I N}=0 \text { or } 10 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=13.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \text { or } 15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=4.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \text { or } 5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=9.5 \mathrm{~V}, \mathrm{~V}_{I N}=0 \text { or } 10 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=13.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \text { or } 15 \mathrm{~V} \end{aligned}$ | $\begin{array}{r} \hline-0.25 \\ -0.62 \\ -1.8 \\ -0.2 \\ -0.5 \\ -1.4 \\ \hline \end{array}$ |  | $\begin{array}{r} \hline-0.2 \\ -0.5 \\ -1.5 \\ -0.16 \\ -0.4 \\ -1.2 \end{array}$ |  | $\begin{array}{r} -0.14 \\ -0.35 \\ -1.1 \\ -0.12 \\ -0.3 \\ -1.0 \end{array}$ |  | mA $\mathrm{mA}$ |
| IN | Input Current | $\begin{array}{c\|} \hline \mathrm{Mil} \\ \mathrm{Comm} \end{array}$ | $\begin{aligned} & 15 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0 \text { or } 15 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \text { or } 15 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & \pm 0.1 \\ & \pm 0.3 \end{aligned}$ |  | $\begin{aligned} & \pm 0.1 \\ & \pm 0.3 \end{aligned}$ |  | $\begin{aligned} & \pm 1.0 \\ & \pm 1.0 \end{aligned}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance per Unit Load | All | - | Any input |  |  |  | 7.5 |  |  | pF |

[^2]CURRENTS - Positive current is defined as conventional current flow into a device. Negative current is defined as conventional current flow out of a device.
$I_{I N}$ - (Input Current) - The current flowing into a device at specified input voltage and $V_{D D}$.
$\mathrm{I}_{\mathrm{OH}}$ - (Output HIGH Current) - The drive current flowing out of the device at specified HIGH output voltage and $\mathrm{V}_{\mathrm{DD}}$.
$I_{O L}$ - (Output LOW Current) - The drive current flowing into the device at specified LOW output voltage and $V_{D D}$.
$I_{D D}$ - (Quiescent Power Supply Current) - The current flowing into the $\mathrm{V}_{\mathrm{DD}}$ pin at specified input and $\mathrm{V}_{\mathrm{DD}}$ conditions.
${ }^{\prime} \mathrm{OZH}$ - (Output OFF HIGHCurrent) - The leakage current flowing into the output of a 3 -state device in the "OFF" state at a specified HIGH output voltage and $V_{D D}$.
${ }^{\prime}$ OZL - (Output OFF LOW Current) - The leakage current flowing out of a 3-state device in the "OFF" state at a specified HIGH output voltage and $V_{D D}$.

IIL - (Input LOW Current) - The current flowing into a device at a specified LOW level input voltage and a specified $V_{D D}$.
$I_{I H}$ - (Input HIGH Current) - The current flowing into a device at a specified HIGH level input voltage and a specified $V_{D D}$.
${ }^{\text {IDDL }}$ - (Quiescent Power Supply LOW Current) — The current flowing into the $V_{D D}$ pin with a specified LOW level input voltage on all inputs and specified $V_{D D}$ conditions.
IDDH - (Quiescent Power Supply HIGHCurrent) - The current flowing into the $V_{D D}$ pin with a specified HIGH level input voltage on all inputs and specified $V_{D D}$ conditions.
$I^{\prime}$ - (OFF State Leakage Current) - The leakage current flowing into the output of a 3 -state device in the "OFF" state at a specified output voltage and $V_{D D}$.

VOLTAGES - All voltages are referenced to $\mathrm{V}_{\mathrm{SS}}$ (or $\mathrm{V}_{\mathrm{EE}}$ ) which is the most negative potential applied to the device.
$V_{D D}$ - (Drain Voltage) - The most positive potential on the device.
$\mathrm{V}_{I H}$ - (Input HIGH Voltage) - The range of input voltages that represents a logic HIGH level in the system.
$\mathrm{V}_{\mathrm{IL}}$ - (Input LOW Voltage) - The range of input voltages that represents a logic LOW level in the system.
$\mathrm{V}_{\mathrm{IH}}(\min )$ - (Minimum Input HIGH Voltage) - The minimum allowed input HIGH level in a logic system.
$\mathrm{V}_{\mathrm{IL}}$ (max) - (Maximum Input LOW Voltage) - The maximum allowed input LOW level in a system.
$\mathrm{V}_{\mathrm{OH}}$ - (Output HIGH Voltage) - The range of voltages at an output terminal with specified output loading and supply voltage. Device inputs are conditioned to establish a HIGH level at the output.
$\mathrm{V}_{\mathrm{OL}}$ - (Output LOW Voltage) - The range of voltages at an output terminal with specified output loading and supply voltage. Device inputs are conditioned to establish a LOW level at the output.
$\mathrm{V}_{\mathrm{SS}}$ - (Source Voltage) - For a device with a single negative power supply, the most negative power supply, used as the reference level for other voltages. Typically ground.
$\mathrm{V}_{\mathrm{EE}}$ - (Source Voltage) - One of two $\left(\mathrm{V}_{\mathrm{SS}}\right.$ and $\left.\mathrm{V}_{\mathrm{EE}}\right)$ negative power supplies. For a device with dual negative power supplies, the most negative power supply used as a reference level for other voltages.

## ANALOG TERMS

RON - (ON Resistance) - The effective "ON" state resistance of an analog transmission gate, at specified input voltage, output load and VDD.
$\Delta R_{\mathrm{ON}}$ - (" $\Delta^{\prime \prime}$ ON Resistance) - The difference in effective "ON" resistance between any two transmission gates of an analog device at specified input voltage, output load and $\mathrm{V}_{\mathrm{DD}}$.

## DEFINITION OF SYMBOLS AND TERMS USED IN THIS DATA BOOK (Cont'd)

## AC SWITCHING PARAMETERS

$f_{\text {MAX }}$ - (Toggle Frequency/Operating Frequency) - The maximum rate at which clock pulses may be applied to a sequential circuit with the output of the circuit changing between $30 \%$ of $\mathrm{V}_{\mathrm{DD}}$ and $70 \%$ of $\mathrm{V}_{\mathrm{DD}}$. Above this frequency the device may cease to function. See Figure 4-17.
$t_{\text {PLH }}$ - (Propagation Delay Time) - The time between the specified reference points, normally 50\% points on the input and output voltage waveforms, with the output changing from the defined LOW level to the defined HIGH level. See Figure 3-1.
$t_{\text {PHL }}$ - (Propagation Delay Time) - The time between the specified reference points, normally 50\% points on the input and output voltage waveforms, with the output changing from the defined HIGH level to the defined LOW level. See Figure 3-1.
 to $90 \%$ of $V_{D D}$, which is changing from LOW to HIGH. See Figure 4-16.
${ }^{\text {t }}$ THL - (Transition Time, HIGH to LOW) - The time between two specified reference points on a waveform, normally $90 \%$ to $10 \%$ of $\mathrm{V}_{\mathrm{DD}}$, which is changing from HIGH to LOW. See Figure 4-16.
$t_{w}$ - (Pulse Width) - The time between 50\% amplitude points on the leading and trailing edges of pulse.
$t_{h}$ - (Hold Time) - The interval immediately following the active transition of the timing pulse (usually the clock pulse) or following the transition of the control input to its latching level, during which interval the data to be recognized must be maintained at the input to ensure its continued recognition. A negative hold time indicates that the correct logic level may be released prior to the active transition of the timing pulse and still be recognized.
$\mathbf{t}_{\mathbf{s}}$ - (Set-up Time) - The interval immediately preceding the active transition of the timing pulse (usually the clock pulse) or preceding the transition of the control input to its latching level, during which interval the data to be recognized must be maintained at the input to ensure its recognition. A negative set-up time indicates that the correct logic level may be initiated sometime after the active transition of the timing pulse and still be recognized.
${ }^{\text {t PHZ }}$ - (3-State Output Disable Time, HIGH to Z) — The time between the specified reference points, normally the 50\% point on the Output Enable input voltage waveform and a point representing a $0.1 \mathrm{~V}_{\mathrm{DD}}$ drop on the output voltage waveform of a 3-state device, with the output changing from the defined HIGH level to a high impedance UFF state.
 point on the Output Enable input voltage waveform and a point representing a $0.1 \mathrm{~V}_{\mathrm{DD}}$ rise on the output voltage waveform of a 3 -state device, with the output changing from the defined LOW level to a high impedance OFF state.
${ }^{\text {t }}$ PZH - (3-State Output Enable Time, $\mathbf{Z}$ to HIGH) - The time between the specified reference points, normally the 50\% point on the Output Enable input voltage waveform and a point representing $0.5 \mathrm{~V}_{\mathrm{DD}}$ on the output voltage waveform of a 3 -state device, with the output changing from a high impedance OFF state to the defined HIGH level.
${ }^{\text {t }}$ PZL $-(3$-State Output Enable Time, Z to LOW) - The time between the specified reference points, normally the 50\% point on the Output Enable input voltage waveform and a point representing $0.5 \mathrm{~V}_{\mathrm{DD}}$ on the output voltage waveform of a 3 -state device, with the output changing from a high impedance OFF state to the defined LOW level.
$t_{\text {rec }}$ - (Recovery Time) - The time between the end of an overriding asynchronous input, typically a Clear or Reset input, and the earliest allowable beginning of a synchronous control input, typically a Clock input, normally measured at $50 \%$ points on both input voltage waveforms.
${ }^{\mathrm{t}} \mathrm{CW}$ (Clock Period) - The time between $50 \%$ amplitude points on the leading edges of a clock pulse.


# 4700 SERIES CMOS FAMILY CHARACTERISTICS 

## ABSOLUTE MAXIMUM RATINGS

(Non-operating) above which useful life may be impaired. All voltages are referenced to $\mathrm{V}_{\mathrm{SS}}$ :

Supply Voltage VDD
Voltage on any Input
Current into any Input
Maximum Power Dissipation
Storage Temperature
Pin Temperature (Soldering, 10 s )
-0.5 to 18 V
-0.5 to $V_{D D}+0.5 \mathrm{~V}$
$\pm 10 \mathrm{~mA}$
400 mW
$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
$300^{\circ} \mathrm{C}$

## RECOMMENDED OPERATING CONDITIONS

Fairchild CMOS will operate over a recommended $V_{D D}$ power supply range of 3 to 15 V , as referenced to $\mathrm{V}_{\mathrm{SS}}$ (usually ground). Parametric limits are guaranteed for $V_{D D}$ equal to 5,10 and 15 V . Where low power dissipation is required, the lowest power supply voltage, consistent with required speed, should be used. For larger noise immunity, higher power supply voltages should be specified. Because of its wide operating range, power supply regulation and filtering are less critical than with other types of logic. The lower limit of supply regulation is 3 V , or as determined by required system speed and/or noise immunity or interface to other logic. The recommended upper limit is 15 V or as determined by power dissipation constraints or interface to other logic.
Unused inputs must by connected to $\mathrm{V}_{\text {DD }}, \mathrm{V}_{\text {SS }}$ or another input.
Care should be used in handling CMOS devices; large static charges may damage the device.
Operating temperature ranges are $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for Commercial and $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ for Military.

| PARAMETER | 4700XC |  |  | $4700 \times \mathrm{M}$ |  |  | UNITS |
| :--- | ---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Supply Voltage, VDD | 3 |  | 15 | 3 |  | 15 | V |
| Operating Free Air <br> Temperature Range | -40 | +25 | +85 | -55 | +25 | +125 | ${ }^{\circ} \mathrm{C}$ |

X = Package Type; F for Flatpak, D for Ceramic DIP, P for Plastic DIP. See Ordering Information section.
DC CHARACTERISTICS FOR THE 4700 MACROLOGIC SERIES CMOS FAMILY
Parametric Limits listed below are guaranteed for the entire Fairchild CMOS Family unless otherwise specified on the individual data sheets.

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEMP | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | Input HIGH Voltage | 3.5 |  |  | V | All | Guaranteed Input HIGH Voltage |  |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage |  |  | 1.5 | V | All | Guaranteed Input LOW Voltage |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\begin{aligned} & 4.95 \\ & 4.95 \end{aligned}$ |  |  | V | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ | $\mathrm{I}_{\mathrm{OH}}<1 \mu \mathrm{~A}$, Inputs at 0 or 5 V per the Logic Function or Truth Table |  |
|  |  | 4.5 |  |  | V | All | $\mathrm{I}_{\mathrm{OH}}<1 \mu \mathrm{~A}$, Inputs at 1.5 or 3.5 V |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage |  |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & \hline \end{aligned}$ | V | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\mathrm{I}_{\mathrm{OL}}<1 \mu \mathrm{~A}$, Inputs at 0 or 5 V per the Logic Function or Truth Table |  |
|  |  |  |  | 0.5 | V | All | $\mathrm{I}^{\mathrm{OL}}<1 \mu \mathrm{~A}$, Inputs at 1.5 or 3.5 V |  |
|  | Output | $\begin{array}{r} -1.5 \\ -1.0 \end{array}$ |  |  | mA | $\begin{gathered} \text { MIN }, 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}= \\ & 2.5 \mathrm{~V} \end{aligned}$ | Inputs at 0 or 5 V per the Logic Function or Truth Table |
| ${ }^{1} \mathrm{OH}$ | Output HIGH Current | $\begin{aligned} & \hline-0.7 \\ & -0.4 \end{aligned}$ |  |  | mA | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}= \\ & 4.5 \mathrm{~V} \end{aligned}$ |  |
| IOL | Output LOW Current | $\begin{aligned} & 1.0 \\ & 0.8 \\ & 0.4 \end{aligned}$ | . |  | mA | $\begin{aligned} & \text { MIN } \\ & 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}= \\ & 0.4 \mathrm{~V} \end{aligned}$ |  |
| CIN | Input Capacıtance <br> Per Unit Load |  |  | 7.5 | pF | $25^{\circ} \mathrm{C}$ | Any Input |  |

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEMP | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |  |  |
| $V_{1 H}$ | Input HIGH Voltage | 7.0 |  |  | V | All | Guaranteed Input HIGH Voltage |  |
| $v_{\text {IL }}$ | Input LOW Voltage |  |  | 3.0 | V | All | Guaranteed Input LOW Voltage |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\begin{aligned} & 9.95 \\ & 9.95 \end{aligned}$ |  |  | V | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\mathrm{I}_{\mathrm{OH}}<1 \mu \mathrm{~A}$, Inputs at 0 or 10 V per the Logic Function or Truth Table |  |
|  |  | 9.0 |  |  | V | All | ${ }^{1} \mathrm{OH}<1 \mu \mathrm{~A}$, Inputs at 3 or 7 V |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage |  |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & \hline \end{aligned}$ | V | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | $\mathrm{I}_{\mathrm{OL}}<1 \mu \mathrm{~A}$, Inputs at 0 or 10 V per the Logic Function or Truth Table |  |
|  |  |  |  | 1.0 | V | All | $\mathrm{I}^{\mathrm{OL}}<1 \mu \mathrm{~A}$, Inputs at 3 or 7 V |  |
| ${ }^{1} \mathrm{OH}$ | Output HIGH Current | $\begin{aligned} & -1.4 \\ & -0.8 \end{aligned}$ |  |  | mA | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ | $\mathrm{V}_{\text {OUT }}=$ 9.5 V | Inputs at 0 or 10 V per the Logic Function or Truth Table |
| IOL | Output LOW Current | $\begin{aligned} & 2.6 \\ & 2.0 \\ & 1.2 \end{aligned}$ |  | $\cdot$ | mA | $\begin{aligned} & \text { MIN } \\ & 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ | $\begin{aligned} & \text { VOUT }= \\ & 0.5 \mathrm{~V} \end{aligned}$ |  |
| $\mathrm{CIN}^{\text {N }}$ | Input Capacitance <br> Per Unit Load |  |  | 7.5 | pF | $25^{\circ} \mathrm{C}$ | Any Input |  |

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEMP | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |  |  |
| $V_{\text {IH }}$ | Input HIGH Voltage |  | 11.0 |  |  | V | All | Guaranteed Input HIGH Voltage |  |
| $V_{\text {IL }}$ | Input LOW Voltage |  |  |  | 4.0 | V | All | Guaranteed Input LOW Voltage |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage |  | $\begin{aligned} & 14.95 \\ & 14.95 \end{aligned}$ |  |  | V | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\mathrm{I}_{\mathrm{OH}}<1 \mu \mathrm{~A}$, Inputs at 0 or 15 V per the Logic Function or Truth Table |  |
|  |  |  | 13.5 |  |  | V | All | $\mathrm{I}_{\mathrm{OH}}<1 \mu \mathrm{~A}$, Inputs at 4 or 11 V |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage |  |  |  | $\begin{aligned} & 0.05 \\ & 0.05 \\ & \hline \end{aligned}$ | V | $\begin{gathered} \mathrm{MIN}, 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | ${ }^{\mathrm{I}} \mathrm{OL}<1 \mu \mathrm{~A}$, Inputs at 0 or 15 V per the Logic Function or Truth Table |  |
|  |  |  |  |  | 1.5 | V | All | $\mathrm{I}_{\mathrm{OL}}<1 \mu \mathrm{~A}$, Inputs at 4 or 11 V |  |
| IIN | Input Current | XC |  |  | $\begin{aligned} & 0.3 \\ & 1.0 \end{aligned}$ | $\mu \mathrm{A}$ | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MIX } \end{aligned}$ | Pin under Test at 0 or 15 V <br> All other inputs simultaneously at 0 or 15 V |  |
|  |  | XM |  |  | $\begin{aligned} & 0.1 \\ & 1.0 \\ & \hline \end{aligned}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |  |
| ${ }^{\mathrm{I}} \mathrm{OH}$ | Output HIGH Current |  | $\begin{array}{r} -2.2 \\ -1.4 \\ \hline \end{array}$ |  |  | mA | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}= \\ & 14.5 \mathrm{~V} \\ & \hline \end{aligned}$ | Inputs at 0 or 15 V per the Logic Function or Truth Table |
| ${ }^{1} \mathrm{OL}$ | Output LOW Current |  | $\begin{aligned} & 3.6 \\ & 2.0 \\ & \hline \end{aligned}$ |  |  | mA | $\begin{gathered} \mathrm{MIN}, 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OUT}}= \\ & 0.5 \mathrm{~V} \end{aligned}$ |  |
| CIN | Input Capacitance <br> Per Unit Load |  |  |  | 7.5 | pF | $25^{\circ} \mathrm{C}$ | Any Input |  |

## TYPICAL 4700 SERIES CHARACTERISTICS




## INPUT PROTECTION CIRCUIT



## INPUT CIRCUITRY

All inputs are protected by the network of Figure 3-13; a series input resistor plus diodes D1 and D2 clamp input voltages between $V_{S S}$ and $V_{D D}$. Forward conduction of these diodes is typically 0.9 V at 1 mA . When $\mathrm{V}_{S S}$ or $\mathrm{V}_{\mathrm{DD}}$ is not connected, avalanche breakdown of the diodes limit input voltage; D1 typically breaks down at $20 \mathrm{~V}, \mathrm{D} 2$ at 20 V . In normal logic operation the diodes never conduct, but for certain special applications such as oscillators, circuit operation may actually depend on diode conduction. Operation in this mode is permissible so long as input currents do not exceed 10 mA .
Input capacitance is typically 5 pF across temperature for any input.

# 4702／4702B <br> PROGRAMMABLE BIT－RATE GENERATOR <br> FAIRCHILD CMOS MACROLOGIC 

DESCRIPTION－The 4702 Bit－Rate Generator provides the necessary clock signals for digital data transmission systems，such as Universal Asynchronous Receiver and Trans－ mitter circuits（UARTs）．It generates any of the 14 commonly used bit rates using an on－chip crystal oscillator，but its design also provides for easy and economical multi－ channel operation，where any of the possible frequencies must be made available on any output channel．
One 4702 can control up to eight output channels．When more than one bit－rate genera－ tor is required，they can still be operated from one crystal．
－PROVIDES 14 COMMONLY USED BIT－RATES
－ONE 4702 CONTROLS UP TO EIGHT TRANSMISSION CHANNELS
－USES 2.4576 MHz INPUT FOR STANDARD FREQUENCY OUTPUTS （16 TIMES BIT RATE）
－CONFORMS TO EIA RS－404
－ON－CHIP INPUT PULL UP CIRCUITS
－TTL COMPATIBLE－OUTPUTS WILL SINK 1.6 mA
－INITIALIZATION CIRCUIT FACILITIES DIAGNOSTIC FAULT ISOLATION
－LOW POWER DISSIPATION－ 1.35 mA POWER DISSIPATION AT 5 V AND 2.4576 MHz
－16－PIN DUAL IN－LINE PACKAGE
TABLE 1
CLOCK MODES AND INITIALIZATION

| IX | $\bar{E}_{\mathbf{C P}}$ | CP | OPERATION |
| :---: | :---: | :---: | :---: |
| ルぃ | H | L | Clocked from IX |
| $x$ | L | 凹ூ | Clocked from CP |
| $x$ | H | H | Continuous Reset |
| x | L | $\boxed{L}$ | Reset During First CP $=$ HIGH Time |

TABLE 2
TRUTH TABLE FOR RATE SELECT INPUTS

| $S_{3}$ | $S_{2}$ | $\mathrm{S}_{1}$ | $\mathrm{S}_{0}$ | Output Rate（Z） Note 1 |
| :---: | :---: | :---: | :---: | :---: |
| L | L | L | L | Multiplexed Input（ ${ }^{M}$ ） |
| L | L | L | H | Multiplexed Input（ ${ }^{M}$ ） |
| L | L | H | L | 50 Baud |
| L | L | H | H | 75 Baud |
| L | H | L | L | 134．5 Baud |
| L | H | L | H | 200 Baud |
| L | H | H | L | 600 Baud |
| L | H | H | H | 2400 Baud |
| H | L | L | L | 9600 Baud |
| H | L | L | H | 4800 Baud |
| H | L | H | L | 1800 Baud |
| H | L | H | H | 1200 Baud |
| H | H | L | L | 2400 Baud |
| H | H | L | H | 300 Baud |
| H | H | H | L | 150 Baud |
| H | H | H | H | 110 Baud |



NOTE：
The Flatpak version has the same pin－ outs（Connection Diagram）as the Dual In－line Package．

PIN NAMES

| CP | External Clock Input |
| :--- | :--- |
| $\bar{E}_{\mathrm{CP}}$ | External Clock Enable |
|  | Input（Active LOW） |
| $\mathrm{IX}_{\mathrm{X}}$ | Crystal Input |
| $\mathrm{I}_{\mathrm{M}}$ | Multiplexed Input |
| $\mathrm{S}_{\mathrm{O}}-\mathrm{S}_{3}$ | Rate Select Inputs |
| CO | Clock Output |
| $\mathrm{O}_{\mathrm{X}}$ | Crystal Drive Output |
| $\mathrm{O}_{\mathrm{O}}-\mathrm{O}_{2}$ | Scan Counter Outputs |
| Z | Bit Rate Output |

## BLOCK DIAGRAM



[^3]FUNCTIONAL DESCRIPTION - Digital data transmission systems employ a wide range of standardized bit rates, ranging from 50 baud interfacing with electromechanical devices, to 9600 baud for high speed modems. Modern electronic systems commonly use Universal Asynchronous Receiver and Transmitter circuits (UARTs) to convert parallel data inputs into a serial bit stream (transmitter) and to reconvert the serial bit stream into parallel outputs (receiver). In order to resynchronize the incoming serial data, the receiver requires a clock rate that is a multiple of the incoming bit rate. Popular MOS-LSI UART circuits use a clock that is 16 times the transmitted bit rate. The 4702 can generate 14 standardized clock rates from one common high frequency input.

The 4702 contains the following five functional subsystems which are discussed in detail below:

1. An Oscillator Circuit with associated gating.
2. A prescaler used as Scan Counter for multichannel operation (described in the applications section).
3. A Counter Network to generate the required standardized frequencies.
4. An output Multiplexer (frequency selector) with resynchronizing output flip-flop.
5. An Initialization (reset) Circuit.

Oscillator - For conventional operation generating 16 output clock pulses per bit period, the input clock frequency must be 2.4576 MHz (i.e. 9600 baud $\times 16 \times 16$, since the scan counter and the first flip-flop of the counter chain act as an internal $\div$ 16 prescaler). A lower input frequency will obviously result in a proportionally lower output frequency.
The 4702 can be driven from two alternate clock sources: (1) When the $\bar{E}_{C P}$ (active LOW External Clock Enable) input is LOW, the CP input is the clock source. (2) When the $\bar{E}_{C P}$ input is HIGH , a crystal connected between $\mathrm{I}_{X}$ and $\mathrm{O}_{X}$, or a signal applied to the IX input, is the clock source.

Prescaler (Scan Counter) - The clock frequency is made available on the CO (Clock Output) pin and is applied to the $\div 8$ prescaler with buffered outputs $\mathrm{Q}_{0}, \mathrm{Q}_{1}$, and $\mathrm{Q}_{2}$. This prescaler is of no particular advantage in single frequency applications, but it is essential for the simple economical multichannel scheme described in the Applications section of this data book.

Counter Network - The prescaler output $\mathrm{Q}_{2}$ is a square wave of $1 / 8$ the input frequency and is used to drive the frequency counter network generating 13 standardized frequencies. Note that the frequencies are labeled in the block diagram and described in terms of the transmission bit rate. In a conventional system using a 2.4576 MHz clock input, the actual output frequencies are 16 times higher.
The output from the first frequency divider flip-flop is thus labeled 9600, since it is used to transmit or receive 9600 baud (bits per second). The actual frequency at this node is $16 \times 9.6 \mathrm{kHz}=153.6 \mathrm{kHz}$. Seven more cascaded binaries generate the appropriate frequencies for bit rates 4800, 2400, 1200, 600, 300, 150, and 75.
The other five bit rates are generated by individual counters:
bit rate 1200 is divided by 6 to generate bit rate 200,
bit rate 200 is divided by 4 to generate bit rate 50,
bit rate 2400 is divided by 18 to generate bit rate 134.5 with a frequency error of $-0.87 \%$,
bit rate 2400 is also divided by 22 to generate bit rate 110 with a frequency error of $-0.83 \%$, and
bit rate 9600 is divided by $16 / 3$ to generate bit rate 1800.
The $16 / 3$ division is accomplished by alternating the divide ratio between 5 (twice) and 6 (once). The result is an exact average output frequency with some frequency modulation. Taking advantage of the $\div 16$ feature of the UART, the resulting distortion is less than $0.78 \%$, irrespective of the number of elements in a character, and therefore well within the timing accuracy specified for high speed communications equipment. All signals except 1800 , have a $50 \%$ duty cycle.

Output Multiplexer - The outputs of the counter network are fed to a 16 -input multiplexer, which is controlled by the Rate Select inputs $\left(\mathrm{S}_{0}-\mathrm{S}_{3}\right)$. The multiplexer output is then resynchronized with the incoming clock in order to cancel all cumulative delays and to present an output signal at the buffered output $(Z)$ that is synchronous with the prescaler outputs $\left(Q_{0}-Q_{2}\right)$. Table 2 lists the correspondence between select code and output bit rate. Two of the 16 codes do not select an internally generated frequency, but select an input into which the user can feed either a different, nonstandardized frequency, or a static level (HIGH or LOW) to generate "zero baud".

The bit rates most commonly used in modern data terminals (110, 150, 300, 1200, 2400 baud) require that no more than one input be grounded, easily achieved with a single pole, 5 -position switch. 2400 baud is selected by two different codes, so that the whole spectrum of modern digital communication rates has a common HIGH on the $\mathrm{S}_{3}$ input.

Initialization (Reset) - The initialization circuit generates a common master reset signal for all flip-flops in the 4702. This signal is derived from a digital differentiator that senses the first HIGH level on the CP input after the $\bar{E}_{C P}$ input goes LOW. When $\bar{E}_{C P}$ is HIGH, selecting the Crystal input, CP must be LOW. A HIGH level on CP would apply a continuous reset.

All inputs to the 4702, except $I_{X}$ have on-chip pull-up circuits which improve TTL compatibility and eliminate the need to tie a permanently HIGH input to $V_{D D}$.

FAIRCHILD • 4702/4702B

DC CHARACTERISTICS: $V_{D D}=5 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$

| SYMBOL | PARAMETER |  | LIMITS |  |  | UNITS | TEMP | TEST CONDITIONS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | Input HIGH Voltage |  | 3.5 |  |  | V | All | Guaranteed Input High Voltage |  |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage |  |  |  | 1.5 | V | All | Guaranteed Input LOW Voltage |  |
| VOH | Output HIGH Voltage |  | 4.95 |  |  | V | MIN, $25^{\circ} \mathrm{C}$ | $\mathrm{IOH}^{<1}<1 \mathrm{~A}$, Inputs at 0 or 5 V per the Logic Function or Truth Table |  |
|  |  |  | 4.95 |  |  |  | MAX |  |  |
|  |  |  | 4.5 |  |  |  | All | $\mathrm{IOH}_{\mathrm{OH}}<1 \mu \mathrm{~A}$, Inputs at 1.5 or 3.5 V |  |
| VOL | Output LOW Voltage |  |  |  | 0.05 | V | MIN, $25^{\circ} \mathrm{C}$ | IOL $<1 \mu \mathrm{~A}$, Inputs at 0 or 5 V per the Logic Function or Truth Table |  |
|  |  |  |  |  | 0.05 |  | MAX |  |  |
|  |  |  |  |  | 0.5 |  | All | $\mathrm{I}_{\text {OL }}<1 \mu \mathrm{~A}$, Inp | uts at 1.5 or 3.5 V |
| $I_{L}$ <br> (See <br> Note 5) | Input LOW Current for Input IX | XC |  |  | 0.3 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ | Pin under Test at 0 V All other Inputs Simultaneously at $5 . \mathrm{V}$ |  |
|  |  |  |  |  | 1.0 |  | MAX |  |  |
|  |  | XM |  |  | 0.1 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  |  | 1.0 |  | MAX |  |  |
|  | Input LOW Current for all Other Inputs | XC |  | -30 |  | $\mu \mathrm{A}$ | $25^{\circ} \mathrm{C}$ |  |  |
|  |  | XM |  | -30 |  |  |  |  |  |
| IIH | Input HIGH Current for all Inputs | XC |  |  | 0.3 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ | Pin Under Test at 5 V <br> All other Inputs Simultaneously at 0 V |  |
|  |  |  |  |  | 1.0 |  | MAX |  |  |
|  |  | XM |  |  | 0.1 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  |  | 1.0 |  | MAX |  |  |
| ${ }^{1} \mathrm{OH}$ | Output HIGH Current for Output OX |  | -0.3 |  |  | mA | MIN, $25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {OUT }}=4.5 \mathrm{~V}$ | Inputs at 0 or 5 V <br> per Logic <br> Function or <br> Truth Table |
|  |  |  | -0.1 |  |  |  | MAX |  |  |
|  | Output HIGH Current for Output OX |  | -1.5 |  |  | mA | MIN, $25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {OUT }}=2.5 \mathrm{~V}$ |  |
|  |  |  | -1.0 |  |  |  | MAX |  |  |
|  |  |  | -0.5 |  |  | mA | MIN, $25^{\circ} \mathrm{C}$ |  |  |
|  |  |  | -0.3 |  |  |  | MAX | $\mathrm{V}_{\text {OUT }}=4.5 \mathrm{~V}$ |  |
| ${ }^{\text {IOL }}$ | Output LOW Current for Output OX |  | 0.2 |  |  | mA | MIN, $25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\text {OUT }}=0.4 \mathrm{~V}$ |  |
|  |  |  | 0.1 |  |  |  | MAX |  |  |
|  | Output LOW Current for all Other Outputs |  | 3.2 |  |  | mA | MIN, $25^{\circ} \mathrm{C}$ |  |  |
|  |  |  | 1.6 |  |  |  | MAX |  |  |
| IDD | Quiescent Power Supply Current | XC |  |  | 100 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ | $\bar{E}_{C P}=V_{D D}, C P=0 V$, All other Inputs at 0 V or $V_{D D}$ |  |
|  |  |  |  |  | 1000 |  | MAX |  |  |  |
|  |  | XM |  |  | 10 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ |  |  |  |
|  |  |  |  |  | 150 |  | MAX |  |  |  |

See Notes on following page.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{~V}$ SS $=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 1 )

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| tplH ${ }^{\text {tpHL }}$ | Propagation Delay IX to CO |  | $\begin{array}{r} 150 \\ 125 \end{array}$ | $\begin{aligned} & 300 \\ & 250 \end{aligned}$ | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqq 20 \mathrm{~ns}$ $\mathrm{C}_{\mathrm{L}} \leqq 7 \mathrm{pF}$ <br> ON OX |
| $\begin{aligned} & { }^{\text {t} P L H} \\ & { }^{\text {tPHL }} \end{aligned}$ | Propagation Delay CP to CO | , | $\begin{aligned} & 112 \\ & 100 \end{aligned}$ | $\begin{aligned} & 215 \\ & 195 \end{aligned}$ | ns |  |
| ${ }^{\text {t PLH }}$ tpHL | Propagation Delay CO to $\mathrm{Q}_{\mathrm{n}}$ |  | $\begin{aligned} & 45 \\ & 40 \end{aligned}$ | $\begin{aligned} & \text { Note } \\ & 6 \end{aligned}$ | ns |  |
| tpLH tphL | Propagation Delay CO to Z |  | $\begin{aligned} & 35 \\ & 30 \end{aligned}$ | $\begin{aligned} & \hline 75 \\ & 65 \end{aligned}$ | ns |  |
| $\begin{aligned} & \mathrm{t} \mathrm{TLH} \\ & \mathrm{t} \mathrm{THL} \\ & \hline \end{aligned}$ | Output Transition <br> Time (Except OX) |  | $\begin{aligned} & 40 \\ & 20 \end{aligned}$ | $\begin{aligned} & 80 \\ & 40 \end{aligned}$ | ns |  |

AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 . \mathrm{V}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |  |
| ${ }^{t}$ PLH <br> tPHL | Propagation Delay IX to CO |  | $\begin{aligned} & 175 \\ & 135 \end{aligned}$ | $\begin{aligned} & 350 \\ & 275 \end{aligned}$ | ns | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \\ & \text { Input Transition } \\ & \text { Times } \leqq 20 \mathrm{~ns} \\ & \mathrm{C}_{\mathrm{L}} \leqq 7 \mathrm{pF} \\ & \text { on } \mathrm{OX} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay CP to CO |  | $\begin{aligned} & 130 \\ & 110 \end{aligned}$ | $\begin{aligned} & 260 \\ & 220 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay $\mathrm{CO} \text { to } \mathrm{a}_{\mathrm{n}}$ | . | $\begin{aligned} & 53 \\ & 45 \end{aligned}$ | Note 6 | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay CO to Z |  | $\begin{aligned} & 37 \\ & 32 \end{aligned}$ | $\begin{aligned} & 85 \\ & 75 \end{aligned}$ | ns |  |
| tTLH <br> ${ }^{\mathrm{t}} \mathrm{THL}$ | Output Transition Time (Except $\mathrm{O}_{\mathrm{X}}$ ) |  | $\begin{aligned} & 80 \\ & 35 \end{aligned}$ | $\begin{array}{r} 160 \\ 75 \end{array}$ | ns |  |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}} \\ & \mathrm{t}_{\mathrm{h}} \end{aligned}$ | Set-Up Time, Select to CO Hold Time, Select to CO | $\begin{array}{r} 350 \\ 0 \end{array}$ | $\begin{array}{r} 185 \\ -182 \end{array}$ |  | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqq 20 \mathrm{~ns}$ $C_{L} \leqq 7 \mathrm{pF}$ <br> on $\mathrm{O}_{\mathrm{X}}$ |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}} \\ & \mathrm{t}_{\mathrm{h}} \end{aligned}$ | Set-Up Time, IM to CO Hold Time, $\mathrm{I}_{\mathrm{M}}$ to CO | $\begin{array}{r} 350 \\ 0 \end{array}$ | $\begin{aligned} & -190 \\ & -182 \end{aligned}$ |  | ns |  |
| $\begin{aligned} & t_{w} C P(L) \\ & t_{w} C P(H) \end{aligned}$ | Minimum Clock Pulse Width LOW and HIGH | $\begin{aligned} & 120 \\ & 120 \end{aligned}$ | $\begin{aligned} & 60 \\ & 60 \end{aligned}$ |  | ns |  |
| $\begin{aligned} & t_{w}{ }^{\prime} X(L) \\ & t_{w}{ }^{\prime} X(H) \end{aligned}$ | Minimum IX Pulse Width LOW and HIGH | $\begin{aligned} & 160 \\ & 160 \end{aligned}$ | $\begin{aligned} & 75 \\ & 75 \end{aligned}$ |  | ns |  |

NOTES:

1. Propagation Delays and Output Transition Times are graphically described under 4700 Series CMOS Family Characteristics.
2. Propagation Delays ( $\mathrm{t}_{\mathrm{PLH}}$ and $\mathrm{t}_{\mathrm{PHL}}$ ) and Output Transition Times ( $\mathrm{t}_{\mathrm{TLH}}$ and $\mathrm{t}_{\mathrm{THL}}$ ) will change with Output Load Capacitance ( $\mathrm{C}_{\mathrm{L}}$ ) Set-Up Times ( $t_{s}$ ), Hold Times ( $t_{h}$ ), and Minimum Pulse Widths ( $t_{w}$ ) do not vary with load capacitance.
3. The first HIGH level Clock Pulse after $\bar{E}_{C P}$ goes LOW must be at least 350 ns long to guarantee reset of all Counters.
4. It is recommeded that input rise and fall times to the Clock Inputs (CP, IX) be less than $15 \mu$ s and $V_{P O}$ pin should be decoupled.
5. Input current and quiescent power supply current are relatively higher for this device because of active pull-up circuits on all inputs except lX. This is done for TTL compatibility.
6. For multichannel operation, propagation delay, CO to $\mathrm{Q}_{\mathrm{n}}$, plus set-up time, select to CO , is guaranteed to $\leqslant 367 \mathrm{~ns}$.

## SWITCHING WAVEFORMS



NOTE: Set-up and Hold Times are shown as positive values but may be specified as negative values.

## APPLICATIONS

Single Channel Bit Rate Generator - Figure 1 shows the simplest application of the 4702. This circuit generates one of five possible bit rates as determined by the setting of a single pole, 5 -position switch. The bit rate output (Z) drives one standard TTL load or four low power Schottky loads over the full temperature range. The possible output frequencies correspond to 110, 150, 300, 1200, and 2400 Baud. For many low cost terminals these five bit rates are adequate.

## Simultaneous Generation of Several Bit Rates:

Fixed Programmed Multichannel Operation - Figure 2 shows a simple scheme that generates eight bit rates on eight output lines, using one 4702 and one 93 L34 8-Bit Addressable Latch. This and the following applications take advantage of the built-in scan counter (prescaler) outputs. As shown in the block diagram, these outputs ( $\mathrm{O}_{0}$ to $\mathrm{O}_{2}$ ) go through a complete sequence of eight states for every half-period of the highest output frequency ( 9600 Baud). Feeding these Scan Counter outputs back to the Select inputs of the multiplexer causes the 4702 to interrogate sequentially the state of eight different frequency signals. The 93L34 8-Bit Addressable Latch, addressed by the same Scan Counter outputs, reconverts the multiplexed single output (Z) of the F4702 into eight parallel output frequency signals. In the simple scheme of Figure 2, input $\mathrm{S}_{3}$ is left open (HIGH) and the following bit rates are generated:

| $\mathrm{o}_{0}:$ | 110 Baud, | $\mathrm{o}_{1}:$ | 9600 Baud, | $\mathrm{o}_{2}:$ | 4800 Baud, | $\mathrm{o}_{3}:$ | 1800 Baud, |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{o}_{4}:$ | 1200 Baud, | $\mathrm{o}_{5}:$ | 2400 Baud, | $\mathrm{o}_{6}:$ | 300 Baud, | $\mathrm{o}_{7}:$ | 150 Baud. |

Other bit rate combinations can be generated by changing the Scan Counter to selector interconnection or by inserting logic gates into this path.
Fully Programmable Multichannel Operation - Figure 3 shows a fully programmable 8-channel bit rate generator system that, under computer control, generates arbitrarily assigned bit rates on all eight outputs simultaneously. The basic operation is similar to the previously described fixed programmed system, but two 9LS170 $4 \times 4$ Register File MSI packages are connected as programmable look-up tables between the Scan Counter outputs ( $\mathrm{O}_{0}$ to $\mathrm{O}_{2}$ ) and the multiplexer Select inputs $\left(S_{0}\right.$ to $\left.S_{3}\right)$. The content of this 8 -word by 4 -bit memory determines which frequency appears at what output.
19200 Baud Operation - Though a 19200 Baud signal is not internally routed to the multiplexer, the 4702 can be used to generate this bit rate by connecting the $\mathrm{O}_{2}$ output to the $\mathrm{I}_{\mathrm{M}}$ input and applying select code 0 or 1 . An additional 2 -input NAND gate can be used to retain the "Zero Baud" feature on select code O. Any multichannel operation that involves 19200 Baud must be limited to four outputs as shown in Figure 4. Only the two least significant Scan Counter outputs are used, so that the scan is completed within one half period of the 19200 output frequency.

Clock Expansion -One 4702 can control up to eight output channels. For more than eight channels, additional bit rate generators are required. These bit rate generators can all be run from the same crystal or clock input. Figure 5 shows one possible expansion scheme. One 4702 is provided with a crystal. All other devices derive their clock from this master. Figure 6 shows a different scheme where the master clock output feeds into the $I_{X}$ input of all slaves and all $\bar{E}_{C P}$ inputs are normally held HIGH. This scheme retains the reset feature and the selection between two different clock sources of the basic 4702 circuit.
During normal operation, the common $\bar{E}_{C P}$ line is HIGH and the common clock line (CP) is LOW. For diagnostic purposes the common $\bar{E}_{C P}$ is forced LOW. This deselects the crystal frequency and initiates the diagnostic mode. When CP goes HIGH for the first time, all 4702s are reset through their individual on-chip initialization circuitry. Subsequent LOW-to-HIGH clock transitions on the common CP line advance the scan counter, causing all 4702s to operate synchronously.

## TYPICAL APPLICATIONS



Fig. 1
SWITCH SELECTABLE BIT RATE GENERATOR CONFIGURATION PROVIDING FIVE BIT RATES


Fig. 2
BIT RATE GENERATOR CONFIGURATION WITH EIGHT SIMULTANEOUS FREQUENCIES

TYPICAL APPLICATIONS (Cont'd)


Fig. 3
FULLY PROGRAMMABLE 8-CHANNEL BIT RATE GENERATOR SYSTEM


Fig. 4
FULLY PROGRAMMABLE 4-CHANNEL BIT RATE GENERATOR SYSTEM WITH THE 19.2k BAUD FEATURE

## TYPICAL APPLICATIONS (Cont'd)



Fig. 5
CASCADE CLOCK EXPANSION SCHEME


Fig. 6
TANDEM CLOCK EXPANSION SCHEME

CRYSTAL SPECIFICATION RECOMMENDATIONS - Table 3 is a convenient listing of recommended crystal specifications.
Crystal manufacturers are also listed below.

TABLE 3 CRYSTAL SPECIFICATIONS

| PARAMETERS | TYPICAL CRYSTAL SPEC |
| :--- | :---: |
| Frequency | $2.4576 \mathrm{MHz}^{\prime \prime} \mathrm{AT}^{\prime \prime} \mathrm{Cut}$ |
| Series Resistance (Max) | $250 \Omega$ |
| Unwanted Modes | $-6.0 \mathrm{~dB}(\mathrm{Min})$ |
| Type of Operation | Parallel |
| Load Capacitance | $32 \mathrm{pF} \pm 0.5$ |

## CRYSTAL MANUFACTURERS

| CTS Knights, Inc. |  |
| :--- | :--- |
| Sandwich, III. 60548 | International Crystal Mfg. Company |
| (815) 786-8411 | 10 No. Lee |
| Crystal \#F1004 | Oklahoma City, Okla. 73102 |
|  | (405) 236-3741 |
| X - Tron Electronics |  |
| 1869 National Ave. | Sentry Manufacturing Co. |
| Hayward, Calif. | Crystal Park |
| (415) 783-2145 | Chickasha, Oklahoma 73018 |
|  | (405) 224-6780 |
| Erie Frequency Control | Crystal \# SGP 6-2.4576 or |
| 499 Lincoln St. | Crystal \#SGP-7-2.4576 |
| Carlisle, Pa. 17013 |  |
| (717) 249-2232 |  |

## 4703/4703B

## FIRST-IN FIRST-OUT (FIFO) BUFFER MEMORY

FAIRCHILD CMOS MACROLOGIC

DESCRIPTION - The 4703 is an expandable fall-through type high-speed First-In First-Out (FIFO) Buffer Memory optimized for high speed disc or tape controllers and communication buffer applications. It is organized as 16 words by four bits and may be expanded to any number of words or any number of bits (in multiples of four). Data may be entered or extracted asynchronously in serial or parallel, allowing economical implementation of buffer memories.
The 4703 has 3 -state outputs which provide added versatility and is fully compatible with all CMOS families.

- 2.3 MHz SERIAL OR PARALLEL DATA RATE, TYPICALLY
- SERIAL OR PARALLEL INPUT
- SERIAL OR PARALLEL OUTPUT
- EXPANDABLE WITHOUT EXTERNAL LOGIC
- 3-STATE OUTPUTS
- FULLY COMPATIBLE WITH ALL CMOS FAMILIES
- SLIM 24-PIN PACKAGE


## PIN NAMES

| $\mathrm{D}_{0}-\mathrm{D}_{3}$ | Parallel Data Inputs |
| :--- | :--- |
| DS | Serial Data Input |
| PL | Parallel Load Input |
| $\overline{\mathrm{CPSI}}$ | Serial Input Clock Input (HIGH-to-LOW Triggered) |
| $\overline{\mathrm{CPSO}}$ | Serial Output Clock Input (HIGH-to-LOW Triggered) |
| $\overline{\mathrm{IES}}$ | Serial Input Enable (Active LOW) |
| $\overline{\overline{T T S}}$ | Transfer to Stack Input (Active LOW) |
| $\overline{\mathrm{TOS}}$ | Transfer Out Serial Input (Active LOW) |
| $\overline{\mathrm{TOP}}$ | Transfer Out Parallel Input |
| $\overline{\mathrm{OES}}$ | Serial Output Enable Input (Active LOW) |
| $\overline{\mathrm{EO}}$ | Output Enable Input (Active LOW) |
| $\overline{\mathrm{MR}}$ | Master Reset Input (Active LOW) |
| $\overline{\mathrm{IRF}}$ | Input Register Full Output (Active LOW) |
| $\overline{\mathrm{ORE}}$ | Output Register Empty Output (Active LOW) |
| $\mathrm{O}_{0}-\mathrm{O}_{3}$ | Parallel Data Outputs |
| QS | Serial Data Output |



## BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION - As shown in the block diagram the 4703 consists of three sections:

1. An Input Register with parallel and serial data inputs as well as control inputs and outputs for input handshaking and expansion.
2. A 4 -bit wide, 14 -word deep fall-through stack with self-contained control logic.
3. An Output Register with parallel and serial data outputs as well as control inputs and outputs for output handshaking and expansion.

Since these three sections operate asynchronously and almost independently, they will be described separately below:

## Input Register (Data Entry):

The Input Register can receive data in either bit-serial or in 4-bit parallel form. It stores this data until it is sent to the fallthrough stack and generates the necessary status and control signals.
Figure 1 is a conceptual logic diagram of the input section. As described later, this 5 -bit register is initialized by setting the F3 flip-flop and resetting the other flip-flops. The Q-output of the last flip-flop (FC) is brought out as the "Input Register Full" output (IRF). After initialization this output is HIGH.

Parallel Entry - A HIGH on the PL input loads the $D_{0}-D_{3}$ inputs into the $F_{0}-F_{3}$ flip-flops and sets the FC flip-flop. This forces the $\overline{I R F}$ output LOW indicating that the input register is full. During parallel entry, the $\overline{\text { CPSI }}$ input must be LOW. If parallel expansion is not being implemented, IES must be LOW to establish row mastership (see Expansion section).


Fig. 1
CONCEPTUAL INPUT SECTION

Serial Entry - Data on the DS input is serially entered into the $F_{3}, F_{2}, F_{1}, F_{0}$, FC shift register on each HIGH-to-LOW transition of the CPSI clock input, provided IES and PL are LOW.
After the fourth clock transition, the four data bits located in the four flip-flops $F_{0}-F_{3}$. The FC flip-flop is set, forcing the $\overline{\mathrm{IRF}}$ output LOW and internally inhibiting $\overline{\mathrm{CPS}}$ clock pulses from effecting the register. Figure 2 illustrates the final positions in a 4703 resulting from a 64-bit serial bit train. $\mathrm{B}_{0}$ is the first bit, $\mathrm{B}_{63}$ the last bit.

Transfer to the Stack - The outputs of Flip-Flops $F_{0}-F_{3}$ feed the stack. A LOW level on the TTS input initiates a "fallthrough" action. If the top location of the stack is empty, data is loaded into the stack and the input register is re-initialized. Note that this initialization is postponed until PL is LOW again. Thus, automatic FIFO action is achieved by connecting the $\overline{\mathrm{IRF}}$ output to the $\overline{\mathrm{TTS}}$ input.
An RS Flip-Flop (the Request Initialization Flip-Flop shown in Figure 10) in the control section records the fact that data has been transferred to the stack. This prevents multiple entry of the same word into the stack despite the fact the $\overline{\mathrm{RFF}}$ and $\overline{\text { TTS }}$ may still be LOW. The Request Initialization Flip-Flop is not cleared until PL goes LOW. Once in the stack, data falls through the stack automatically, pausing only when it is necessary to wait for an empty next location. In the 4703, as in most modern FIFO designs, the $\overline{M R}$ input only initializes the stack control section and does not clear the data.


Fig. 2
FINAL POSITIONS IN A 4703 RESULTING
FROM A 64-BIT SERIAL TRAIN

## EXPANSION

Vertical Expansion - The 4703 may be vertically expanded to store more words without external parts. The interconnections necessary to form a 46 -word by 4 -bit FIFO are shown in Figure 4. Using the same technique, any FIFO of ( $15 \mathrm{n}+1$ ) words by four bits can be constructed, where $n$ is the number of devices. Note that expansion does not sacrifice any of the 4703's flexibility for serial/parallel input and output. For other expansion schemes, refer to the Applications section of this book.


Fig. 4
A VERTICAL EXPANSION SCHEME

Output Register (Data Extraction) - The Output Register receives 4-bit data words from the bottom stack location, stores it and outputs data on a 3 -state 4-bit parallel data bus or on a 3 -state serial data bus. The output section generates and receives the necessary status and control signals. Figure 3 is a conceptual logic diagram of the output section.


Fig. 3
CONCEPTUAL OUTPUT SECTION

Parallel Data Extraction - When the FIFO is empty after a LOW pulse is applied to $\overline{M R}$, the Output Register Empty ( $\overline{\mathrm{ORE}}$ ) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided the "Transfer Out Parallel" (TOP) input is HIGH. As a result of the data transfer $\overline{\text { ORE }}$ goes HIGH, indicating valid data on the data outputs (provided the 3 -state buffer is enabled). TOP can now be used to clock out the next word. When TOP goes LOW, $\overline{O R E}$ will go LOW indicating that the output data has been extracted, but the data itself remains on the output bus until the next HIGH level at TOP permits the transfer of the next word (if available) into the Output Register. During parallel data extraction $\overline{\mathrm{CPSO}}$ should be LOW. $\overline{\mathrm{TOS}}$ should be grounded for single slice operation or connected to the appropriate $\overline{\mathrm{ORE}}$ for expanded operation (see Expansion section).
TOP is not edge triggered. Therefore, if TOP goes HIGH before data is available from the stack, but data does become available before TOP goes LOW again, that data will be transferred into the Output Register. However, internal control circuitry prevents the same data from being transferred twice. If TOP goes HIGH and returns to LOW before data is available from the stack, ORE remains LOW indicating that there is no valid data at the outputs.

Serial Data Extraction - When the FIFO is empty after a LOW pulse is applied to $\overline{M R}$, the Output Register Empty ( $\overline{O R E}$ ) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided $\overline{\text { TOS }}$ is LOW and TOP is HIGH. As a result of the data transfer $\overline{\text { ORE }}$ goes HIGH indicating valid data in the register. The 3-state Serial Data Output, $\mathrm{Q}_{\mathrm{S}}$, is automatically enabled and puts the first data bit on the output bus. Data is serially shifted out on the HIGH-to-LOW transition of CPSO. To prevent false shifting, $\overline{\text { CPSO }}$ should be LOW when the new word is being loaded into the Output Register. The fourth transition empties the shift register, forces $\overline{\mathrm{ORE}}$ output LOW and disables the serial output, $Q_{S}$ (refer to Figure 3). For serial operation the $\overline{O R E}$ output may be tied to the TOS input, requesting a new word from the stack as soon as the previous one has been shifted out.

Horizontal Expansion - The 4703 can also be horizontally expanded to store long words (in multiples of four bits) without external logic. The interconnections necessary to form a 16 -word by 12 -bit FIFO are shown in Figure 5 . Using the same technique, any FIFO of 16 words by 4 n bits can be constructed, where n is the number of devices. The $\overline{\mathrm{IRF}}$ output of the right most device (most significant device) is connected to the TTS inputs of all devices. Similarly, the $\overline{\text { ORE }}$ output of the most significant device is connected to the TOS inputs of all devices. As in the vertical expansion scheme, horizontal expansion does not sacrifice any of the 4703's flexibility for serial/parallel input and output.
It should be noted that this form of horizontal expansion extracts a penalty in speed. A single FIFO is guaranteed to operate at 10 MHz ; an array of four FIFOs connected in the above manner is guaranteed at 4.3 MHz . An expansion scheme that provides higher speed but requires additional components is shown in the Applications section of this book.

Horizontal and Vertical Expansion - The 4703 can be expanded in both the horizontal and vertical directions without any external parts and without sacrificing any of its FIFO's flexibility for serial/parallel input and output. The interconnections necessary to form a 31 -word by 16 -bit FIFO are shown in Figure 6 . Using the same technique, any FIFO of $(15 \mathrm{~m}+1)$ words by $(4 n)$ bits can be constructed, where $m$ is the number of devices in a column and $n$ is the number of devices in a row.
Figures 7 and 8 show the timing diagrams for serial data entry and extraction for the 31 -word by 16 -bit FIFO shown in Figure 6. The final position of data after serial insertion of 496 bits into the FIFO array of Figure 6 is shown in Figure 9.


Fig. 5
A HORIZONTAL EXPANSION SCHEME

FAIRCHILD • 4703/4703B


Fig. 6
A $31 \times 16$ FIFO ARRAY


Fig. 7
SERIAL DATA ENTRY FOR ARRAY OF FIG. 6


Fig. 8
SERIAL DATA EXTRACTION FOR ARRAY OF FIG. 6


Fig. 9

Interlocking Circuitry - Most conventional FIFO designs provide status signals analogous to $\overline{\operatorname{RFF}}$ and $\overline{O R E}$. However, when these devices are operated in arrays, variations in unit to unit operating speed require external gating to assure all devices have completed an operation. The 4703 incorporates simple but effective "master/slave" interlocking circuitry to eliminate the need for external gating.
In the 4703 array of Figure 6 devices 1 and 5 are defined as "row masters" and the other devices are slaves to the master in their row. No slave in a given row will initialize its Input Register until it has received LOW on its $\overline{I E S}$ input from a row. master or a slave of higher priority.
In a similar fashion, the $\overline{\mathrm{ORE}}$ outputs of slaves will not go HIGH until their $\overline{\mathrm{OES}}$ inputs have gone HIGH. This interlocking scheme ensures that new input data may be accepted by the array when the $\overline{\mathrm{RF}}$ output of the final slave in that row goes LOW and that output data for the array may be extracted when the $\overline{\text { ORE }}$ of the final slave in the output row goes HIGH.
The row master is established by connecting its $\overline{I E S}$ input to ground while a slave receives its $\overline{I E S}$ input from the $\overline{\operatorname{IRF}}$ output of the next higher priority device. When an array of 4703 FIFOs is initialized with a LOW on the $\overline{M R}$ inputs of all devices, the $\overline{\text { IRF }}$ outputs of all devices will be HIGH. Thus, only the row master receives a LOW on the $\overline{\text { IES }}$ input during initialization. Figure 10 is a conceptual logic diagram of the internal circuitry which determines master/slave operation. Whenever $\overline{M R}$ and IES are LOW, the Master Latch is set. Whenever TTS goes LOW the Request Initialization Flip-Flop will be set. If the Master Latch is HIGH, the Input Register will be immediately initialized and the Request Initialization Flip-Flop reset. If the Master Latch is reset, the Input Register is not initialized until $\overline{\text { IES }}$ goes LOW. In array operation, activating the $\overline{\text { TTS }}$ initiates a ripple input register initialization from the row master to the last slave.
A similar operation takes place for the output register. Either a $\overline{T O S}$ or TOP input initiates a load-from-stack operation and sets the ORE Request Flip-Flop. If the Master Latch is set, the last Output Register Flip-Flop is set and $\overline{\mathrm{ORE}}$ goes HIGH. If the Master Latch is reset, the $\overline{\mathrm{ORE}}$ output will be LOW until an $\overline{\mathrm{OES}}$ input is received.


Fig. 10

DC CHARACTERISTICS: VDD as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (See Note 1)

| SYMBOL | PARAMETER |  | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
| Iozh | Output OFF HIGH Current | XC |  |  | 0.5 30 |  |  | 1.0 60 |  | $\begin{array}{r} 0.2 \\ 12 \\ \hline \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $V_{D D}, \overline{\mathrm{EO}}=\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{r} \hline 0.05 \\ 3.0 \\ \hline \end{array}$ |  |  | 0.1 6.0 |  | $\begin{array}{r} \hline 0.02 \\ 1.2 \end{array}$ |  |  | $\begin{gathered} \text { MIN, } \mathbf{2 5}^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |
| Iozl | Output OFF <br> LOW Current | Xc |  |  | $\begin{array}{r} \hline-0.5 \\ -30 \\ \hline \end{array}$ |  |  | $\begin{array}{r} -1.0 \\ -60 \\ \hline \end{array}$ |  | $\begin{array}{r} -0.2 \\ -12 \\ \hline \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $\mathrm{V}_{\mathrm{SS}}, \overline{\mathrm{EO}}=\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{\|c\|} \hline-0.05 \\ -3.0 \end{array}$ |  |  | $\begin{aligned} & \hline-0.1 \\ & -6.0 \end{aligned}$ |  | $\begin{array}{r} -0.02 \\ -1.2 \end{array}$ |  |  | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ |  |
| IDD | Quiescent <br> Power <br> Supply <br> Current | XC |  |  | $\begin{array}{r} 32.5 \\ 250 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 65 \\ 500 \\ \hline \end{array}$ |  |  | $\begin{array}{\|r\|} \hline 130 \\ 1000 \\ \hline \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | All Inputs at 0 V or $\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{r} \hline 8.75 \\ 250 \\ \hline \end{array}$ |  |  | $\begin{array}{r} \hline 17.5 \\ 500 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 35 \\ 1000 \\ \hline \end{array}$ | $\mu \mathrm{A}$ | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ |  |

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{D D}$ as shown, $V_{S S}=0 \mathrm{~V}, \mathrm{~T}_{A}=25^{\circ} \mathrm{C}$ (See Note 2)


Notes on following page.

FAIRCHILD • 4703/4703B
AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): $V_{D D}$ as shown, $V_{S S}=0 \ddot{V}, T_{A}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| ${ }^{\text {tPHL }}$ | Propagation Delay, $\overline{\mathrm{CPSO}}$ to $\overline{\mathrm{ORE}}$ |  | 159 | 318 |  | 74 | 148 |  | 52 | 104 | ns | $C_{L}=50 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| tPLH | Propagation Delay, $\overline{\text { TOS }}$ to $\overline{\text { ORE }}$ |  | 320 | 640 |  | 114 | 228 |  | 80 | 160 | ns |  |
| tple tPHL | Propagation Delay, TOP to $\overline{\text { ORE }}$ |  | $\begin{aligned} & 401 \\ & 256 \end{aligned}$ | $802$ |  | $\begin{array}{\|l\|} \hline 134 \\ 109 \end{array}$ | $\begin{aligned} & \hline 268 \\ & 218 \end{aligned}$ |  | $\begin{aligned} & 94 \\ & 77 \end{aligned}$ | $188$ | ns |  |
| ${ }^{\text {tPHL }}$ |  |  |  |  |  |  |  |  |  |  |  |  |
| ${ }^{\text {tPHL }}$ | Propagation Delay, PL to $\overline{\text { IRF }}$ |  | 119 | 238 |  | 44 | 88 |  | 31 | 62 | ns |  |
| ${ }^{\text {t }}$ FT | Fall Through Time |  | 2020 | 4040 |  | 820 | 1640 |  | 574 | 1148 | ns |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & 51 \\ & 85 \end{aligned}$ | $\begin{aligned} & 102 \\ & 170 \end{aligned}$ |  | $\begin{aligned} & 24 \\ & 33 \end{aligned}$ | $\begin{aligned} & 48 \\ & 66 \end{aligned}$ |  | $\begin{aligned} & 17 \\ & 24 \end{aligned}$ | $\begin{aligned} & 34 \\ & 48 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| $\begin{aligned} & \mathrm{tPHZ} \\ & \text { tpLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & \hline 64 \\ & 80 \end{aligned}$ | $\begin{aligned} & 128 \\ & 160 \end{aligned}$ |  | $\begin{aligned} & 34 \\ & 39 \end{aligned}$ | $\begin{aligned} & 68 \\ & 78 \end{aligned}$ |  | $\begin{aligned} & 24 \\ & 28 \end{aligned}$ | $\begin{aligned} & 48 \\ & 56 \end{aligned}$ | ns |  |
| ${ }^{\text {t TLH }}$ ${ }^{\mathrm{t}} \mathrm{THL}$ | Output Transition Time |  | 46 34 | 92 68 |  | 25 18 | $\begin{aligned} & 50 \\ & 36 \end{aligned}$ |  | $\begin{aligned} & 18 \\ & 13 \end{aligned}$ | $\begin{aligned} & 36 \\ & 26 \end{aligned}$ | ns |  |
| $\mathrm{t}_{\mathrm{w}} \overline{\overline{\mathrm{P}}(\mathrm{H})}$ | Min CPSI Puise Width (HIGH) | 118 | 59 |  | 44 | 22 |  | 31 | 16 |  | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| ${ }^{\mathrm{t}_{w} \overline{\mathrm{CP}}(\mathrm{L})}$ | Min CPSI Pulse Width (LOW) | 220 | 110 |  | 108 | 54 |  | 76 | 38 |  | ns |  |
| $\mathrm{t}_{\underline{w} \overline{\mathrm{CP}}(\mathrm{L}}$ | Min CPSO Pulse Width (LOW) | 120 | 60 |  | 60 | 30 |  | 42 | 21 |  | ns |  |
| $\mathrm{t}_{\mathrm{w}} \overline{\mathrm{CP}}(\mathrm{H})$ | Min CPSO Pulse Width (HIGH) | 110 | 55 |  | 72 | 36 |  | 51 | 26 |  | ns |  |
| ${ }^{\text {w }}$ PL(H) | Min PL Pulse Width (HIGH) | 122 | 61 |  | 44 | 22 |  | 31 | 16 |  | ns |  |
| $\mathrm{t}_{\mathrm{w}} \overline{\mathrm{TTS}}(\mathrm{L})$ | Min TTS Pulse Width (LOW) | 160 | 80 |  | 124 | 62 |  | 87 | 44 |  | ns |  |
| $\mathrm{tw}_{\text {w }} \overline{\mathrm{TOS}}(\mathrm{L})$ | Min TOS Pulse Width (LOW) | 182 | 91 |  | 60 | 30 |  | 42 | 21 |  | ns |  |
| ${ }^{t_{w} \text { TOP(L) }}$ | Min TOP Pulse Width (LOW) | 142 | 71 |  | 52 | 26 |  | 37 | 19 |  | ns |  |
| $\mathrm{t}_{\mathrm{w}} \overline{\mathrm{MR}}(\mathrm{L})$ | Min $\overline{M R}$ Pulse Width (LOW) | 192 | 96 |  | 108 | 54 |  | 76 | 38 |  | ns |  |
| $\mathrm{t}_{\text {rec }}$ | $\overline{\mathrm{MR}}$ Recovery Time | 44 | 22 |  | 36 | 18 |  | 26 | 13 |  | ns |  |
| ts $\mathrm{th}^{\text {a }}$ | Set-Up and Hold Times, $\mathrm{D}_{\mathrm{s}}$ to $\overline{\mathrm{CPSI}}$ | $\begin{array}{r} 104 \\ -8 \end{array}$ | $\begin{array}{r} 52 \\ -15 \end{array}$ |  | 40 | $\begin{aligned} & 20 \\ & 12 \end{aligned}$ |  | 28 18 | 14 9 |  | ns |  |
| ${ }_{\text {t }}$ | Set-Up and Hold Times, $\overline{\text { TTS }}$ to IRF, Serial or Parallel Mode | 186 76 | 93 38 |  | 98 | 49 |  | 70 | 35 |  |  |  |
| $\underline{t h}$ | $\overline{\text { IRF, Serial or Parallel Mode }}$ | 76 | 38 |  | 52 | 26 |  | 38 | 19 |  | ns |  |
| ${ }_{\text {t }}$ | Set-Up Time, $\overline{\text { ORE }}$ to $\overline{\text { TOS }}$ | -151 | -302 |  | -21 | -42 |  | -15 | -30 |  | ns |  |
| $\mathrm{f}_{\text {MAX }}$ | Input CLOCK Frequency (Note 4) | 1.1 | 2.3 |  | 2.6 | 5.3 |  | 3.4 | 6.9 |  | ns |  |

## NOTES:

1. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4700 Series CMOS Fmily Characteristics.
3. Propagation Delays ( $\mathrm{t} L \mathrm{LH}$ and $\mathrm{t}_{\mathrm{PHL}}$ ) and Output Transition Times ( $\mathrm{t} \mathrm{TLH}^{\prime}$ and $\mathrm{t} \mathrm{THL}^{\text {}}$ ) will change with Output Load Capacitance ( $C_{L}$ ).
4. For $f_{M A X}$, input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns.
5. It is recommended that input rise and fall times to the Clock Input be less than $15 \mu \mathrm{~s}$.

## SWITCHING WAVEFORMS



OUTPUT ENABLE TIME
(tpZH) AND OUTPUT DISABLE TIME (tphZ)


OUTPUT ENABLE TIME (tpZL) AND OUTPUT DISABLE TIME (tpLz)

## SWITCHING WAVEFORMS (Cont'd)

SERIAL INPUT UNEXPANDED OR MASTER OPERATION

 RECOVERY TIME, $\overline{I R F}$ TO CPSI, AND SET-UP AND HOLD TIMES, DS TO $\overline{\mathrm{CPSI}}$, AND $\overline{\text { TTS }}$ TO $\overline{\mathrm{TRF}}$.

CONDITIONS: STACK NOT FULL, $\overline{I E S},=$ PL $=$ LOW


## SWITCHING WAVEFORMS (Cont'd)

SERIAL OUTPUT, UNEXPANDED OR MASTER OPERATION


ORE RECOVERY TIME, PROPAGATION DELAY CPSO TO OS, $\overline{\text { CPSO }}$ TO $\overline{O R E}$, TOS TO ORE, MINIMUM CPSO PULSE WIDTH, MINIMUM TOS PULSE WIDTH AND SET-UP TIME $\overline{O R E}$ TO TOS.
CONDITIONS: DATA IN STACK, TOP = HIGH, $\overline{I E S}=$ LOW WHEN INITIALIZED, $\overline{O E S}=$ LOW

SERIAL OUTPUT, SLAVE OPERATION

$\overline{O R E}$ RECOVERY TIME, PROPAGATION DELAY $\overline{\text { CPSO }}$ TO $\mathbf{O S}_{\mathbf{S}}, \overline{\mathrm{CPSO}}$ TO $\overline{\text { ORE, }}$ TOS TO $\overline{O R E}$, AND SET-UP
AND HOLD TIMES, $\overline{O E S}$ TO CPSO, $\overline{O R E}$ TO TOS $\overline{\text { TOS TO OES }}$
CONDITIONS: DATA IN STACK, TOP = HIGH, $\overline{I E S}=$ HIGH WHEN INITIALIZED

NOTE:
Set-up ( $\mathrm{t}_{\mathrm{s}}$ ) and hold times ( $\mathrm{t}_{\mathrm{h}}$ ) are shown as positive values but may be specified as negative values.

SWITCHING WAVEFORMS (Cont'd)
FALL THROUGH TIME


MINIMUM MR AND PL PULSE WIDTHS, RECOVERY TIME FOR $\overline{M R}$ AND FALL THROUGH TIME

CONDITIONS: $\overline{\text { TTS }}$ CONNECTED TO $\overline{\operatorname{IRF}}, \overline{T O S}$ CONNECTED TO $\overline{O R E}, \overline{I E S}, \overline{O E S}, \overline{E O}, \overline{C P S O}=L O W . T O P=H I G H$


PROPAGATION DELAY, TOP TO $\overline{O R E}$, TOP TO $Q_{n}$, AND MINIMUM TOP PULSE WIDTH

CONDITIONS: $\overline{\mathrm{IES}}=$ LOW WHEN INITIALIZED, $\overline{\mathrm{EO}}=\overline{\mathrm{CPSO}}=$ LOW. DATA AVAILABLE IN STACK

## SWITCHING WAVEFORMS (Cont'd)



PROPAGATION DELAY PL TO $\overline{\operatorname{IRF}}, \overline{\mathrm{T} T S}$ TO $\overline{\mathrm{IRF}}$, MINIMUM PL AND TTS PULSE WIDTHS, AND SET-UP AND HOLD TIMES $\mathrm{D}_{\mathrm{n}}$ TO PL, $\overline{\mathrm{IRF}}$ TO PL, $\overline{\mathrm{T} T S}$ TO $\overline{\mathrm{IRF}}$.
CONDITIONS: STACK NOT FULL, $\overline{\mathrm{IES}}=$ LOW WHEN INITIALIZED
NOTES:

1. Initialization requires a master reset to occur after power has been applied.
2. $\overline{\mathrm{TTS}}$ normally connected to $\overline{\mathrm{RF}}$.
3. If stack is full. $\overline{\mathrm{RF}}$ will stay LOW.


PROPAGATION DELAY, $\overline{T T S}$ TO $\overline{\operatorname{ES}}, \overline{\operatorname{IES}}$ TO $\overline{\mathrm{IRF}}, \mathrm{PL}$ TO $\overline{\mathrm{IRF}}$, MINIMUM PL AND TTS PULSE WIDTHS, AND SET-UP AND HOLD TIMES, $\mathrm{D}_{\mathbf{n}}$ TO PL, $\overline{\mathrm{IRF}}$ TO $\overline{\mathrm{T} T S}, \overline{\mathrm{IRF}}$ TO PL
CONDITIONS: STACK NOT FULL, DEVICE INITIALIZED WITH IES HIGH
NOTE:
Set-up ( $\mathrm{t}_{\mathrm{s}}$ ) and hold times ( $\mathrm{t}_{\mathrm{h}}$ ) are shown as positive values but may be specified as negative values.

# 4704/4704B <br> DATA PATH SWITCH <br> FAIRCHILD CMOS MACROLOGIC 

DESCRIPTION - The 4704 Data Path Switch (DPS) is a combinatorial array for closing data path loops around arithmetic/logic networks such as the 4705 (Arithmetic Logic Register Stack). A total of 30 instructions (see Table 1) facilitate logic shifting, masking, sign extension, introduction of common constants and other operations.

The 5-bit Instruction ( $\mathrm{I}_{0}-\mathrm{I}_{4}$ ) selects one of the 32 instructions operating on two sets of 4-bit data inputs ( $\left.D_{0}-D_{3}, K_{0}-K_{3}\right)$. Left Input (LI) and Left Output (LO) and Right Input (RI) and Right Output (RO) are available for expansion in 4-bit increments. An active LOW Output Enable input ( $\overline{\mathrm{EO}}$ ) provides 3 -state control of the data outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ for bus oriented applications.

The 4704 is fully compatible with all CMOS families.


NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

## BLOCK DIAGRAM



$$
\begin{aligned}
\mathrm{V}_{\mathrm{DD}} & =\operatorname{Pin} 24 \\
\mathrm{~V}_{\mathrm{SS}} & =\operatorname{Pin} 12 \\
\mathrm{O} & =\operatorname{Pin} \text { Number }
\end{aligned}
$$

TABLE 1
INSTRUCTION SET FOR THE 4704

| INPUTS | OUTPUTS | FUNCTION | INPUTS | OUTPUTS | UNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $l_{4} l_{3} l_{2} l_{1} l_{0}$ |  | UNCTION |
| L L L L L | L L L | Byte Mask | H L L L L | RI RI RI RI RI | K-Bus Sign Extend |
| L L L L H | H H H H | Byte Mask | H L L L H |  | K-Bus Sign Extend |
| L L L H L | H | Minus " 2 " in 2s Comp ${ }^{\text {(1) }}$ | H L L H | RI RI RI RI RI | D-Bus Sign Extend |
| L L L $\quad$ H | L L L L | Minus " 1 " in 2s Comp ${ }^{(1)}$ | H L L H H | $\begin{array}{llllll}\mathrm{D}_{3} & \mathrm{D}_{3} & \mathrm{D}_{2} & \mathrm{D}_{1} & \mathrm{D}_{0}\end{array}$ | D-Bus Sign Extend |
| L L H L L | $\mathrm{D}_{3} \quad \mathrm{D}_{2} \quad \mathrm{D}_{1} \mathrm{D}_{0}$ | Byte Mask, D-Bus | H L H L L |  | D-Bus Shift Left |
| L L H L H | H H H H | Byte Mask, D-Bus | H L H L H |  | K-Bus Shift Left |
| L L H H | $\mathrm{D}_{3} \mathrm{D}_{2} \quad \mathrm{D}_{1} \mathrm{D}_{0}$ | Byte Mask, D-Bus | H L H H | $\begin{array}{lllllll}\mathrm{LI} & \mathrm{D}_{3} & \mathrm{D}_{2} & \mathrm{D}_{1} & \mathrm{D}_{0}\end{array}$ | D-Bus Shift Right |
| L L H H H | L L | Byte Mask, D-Bus | H L H H H | $\mathrm{D}_{3} \mathrm{D}_{3} \mathrm{D}_{2} \quad \mathrm{D}_{1} \mathrm{D}_{0}$ | D-Bus Shift Right Arith ${ }^{(2)}$ |
| L H L L L | H H H | Negative Byte Sign Mask | H H L L L |  | K-Bus Shift Right |
| L H L L H | H H H H | Positive Byte Sign Mask | H H L L H | $K_{3} K_{3} K_{2} K_{1} K_{0}$ | K-Bus Shift Right Arith(2) |
| L H L H L | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Byte Mask, K-Bus | H H L H L | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Byte Mask, K-Bus |
| L H L | L L L L | Byte Mask, K-Bus | H H L H H | H H H H | Byte Mask, K-Bus |
| L H H L L | $\mathrm{D}_{3} \mathrm{D}_{2} \quad \mathrm{D}_{1} \mathrm{D}_{0}$ | Load Byte | H H H L L | $\mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}$ | Complement D-Bus |
| L H H L H | $K_{3} K_{2} K_{1} K_{0}$ | Load Byte | H H H L H | $\mathrm{K}_{3} \mathrm{~K}_{2} \mathrm{~K}_{1} \mathrm{~K}_{0}$ | Complement K-Bus |
| L H H H L | H H | Plus "1" | H H H H L |  | Undefined (Reserved) |
| L H H H H | H H H | Zero | H H H H H |  | Undefined (Reserved) |

H = HIGH Level
(1) Comp $=$ Complement
L = LOW Level
(2) Arith $=$ Arithmetic

FUNCTIONAL DESCRIPTION - The 4704 combines the functions of a dual 4 -input multiplexer, a true/complement one/zero generator, and a shift left/shift right array.
As shown in Table 1, there are two shift right modes. The arithmetic right shift preserves the sign bit in the most significant position while the logic shift moves all positions. Right shift is defined as a 1-bit shift toward the least significant position.
For half-word arithmetic the 4704 provides instructions which extend the sign bit left through the more significant slices. Shift linkages are available as individual inputs and outputs for complete flexibility.
The 4704 may be used to generate constants $+1,0,-1$ and -2 in 2 's complement notation.

EXPANSION - Arrays of larger than 4-bit word lengths are easily obtained. Figure 1 illustrates a 16-bit array constructed using four devices; device 1 is the least significant and device 4 is the most significant slice. Within each slice, inputs and outputs with ' 0 ' subscript are the least significant bits.
The $I_{1}$ through $I_{4}$ inputs of all devices are bussed. These four bus lines together with the $I_{0}$ inputs of the devices form an 8 -bit instruction bus to control the array. In some applications, it may be possible to connect the $I_{0}$ inputs of devices 1 and 2 together and the $\mathrm{I}_{0}$ inputs of devices 3 and 4 together, so that only six bits are needed to control the arrays. Connecting the LO of device 1 to RI of device 2, LO of device 2 to RI of device 3, etc., provides left shift (i.e., shift towards most significant bit) and sign extension. In a similar fashion right shift operation is accomplished by connecting the Ll input of a device to the RO of the next more significant device.

The sign-extend group consists of two adjacent instructions differing only in $\mathrm{I}_{\mathrm{O}}$ (refer to Table 1). When the code HLLHH is placed on the instruction inputs ( $D$-Bus Sign Extend), the most significant bit of the $D$ bus ( $D_{3}$ ) is available on the LO output. The companion code HLLHL will copy the RI input (connected to LO of the previous stage) onto the output bus ( $\mathrm{D}_{0^{-}}$ $\mathrm{D}_{3}$ ) and to its own LO output. Thus when a sign extend function is desired (e.g., arithmetic operations on the eight least significant bits in a 16 -bit machine) the code HLLH will be applied to instruction inputs $\left(I_{4}, I_{3}, I_{2}, I_{1}\right)$ of all the 4704 s . $I_{0}$ of the most significant byte will be LOW and $\mathrm{I}_{0}$ of the least significant byte will be HIGH . In a similar fashion sign-extend function on a number present on the K-Bus is executed by the code HLLL on $I_{4}, I_{3}, I_{2}$, and $I_{1}$.


Fig. 1
16-BIT 4704 ARRAY
The 4704 provides several options for masking operations. For example, Byte Mask operation (LLLL on $I_{4}, I_{3}, I_{2}, I_{1}$ ) will force the output bus either HIGH or LOW depending on $I_{0}$. Connecting $I_{0}$ of the most significant byte HIGH and $I_{0}$ of the least significant byte LOW will force the outputs of the DPS array to a state of 00FF (in hexadecimal notation) 16. A LOW on any output is assumed as logic 1. When the output bus of the 4704 is used as an input to a 16 -bit Arithmetic Logic Register Stack (ALRS) network (see Figure 2), the ALRS can execute a logic AND function between its input bus and one of its registers, thus masking the least significant byte of that register. More complex masking operation can be executed using the Byte AND Mask and Byte OR Mask operations (see Table 1):


Fig. 2

FAIRCHILD • 4704/4704B

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (See Note 1)

| SYMBOL | PARAMETER |  | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
| IOZH | Output OFF <br> HIGH Current | XC |  |  | $\begin{array}{r} 0.5 \\ 30 \end{array}$ |  |  | 1.0 60 |  | $\begin{array}{r} 0.2 \\ 12 \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | Output Returned to $V_{D D}, \overline{E O}=V_{D D}$ |
|  |  | XM |  |  | $\begin{array}{r} \hline 0.05 \\ 3.0 \\ \hline \end{array}$ |  |  | 0.1 6.0 |  | $\begin{array}{r} \hline 0.02 \\ 1.2 \\ \hline \end{array}$ |  |  | $\begin{array}{\|c} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{array}$ |  |
| Iozl | Output OFF <br> LOW Current | XC |  |  | $\begin{array}{r} \hline-0.5 \\ -30 \\ \hline \end{array}$ |  |  | $\begin{array}{r} \hline-1.0 \\ -60 \\ \hline \end{array}$ |  | $\begin{aligned} & \hline-0.2 \\ & -12 \\ & \hline \end{aligned}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $\mathrm{V}_{\mathrm{SS}}, \overline{\mathrm{EO}}=\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{r} -0.05 \\ -3.0 \\ \hline \end{array}$ |  |  | -0.1 <br> -6.0 |  | $\begin{array}{r} -0.02 \\ -1.2 \end{array}$ |  |  | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |
| IDD | Quiescent <br> Power <br> Supply <br> Current | XC |  |  | $\begin{array}{r} 32.5 \\ 250 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 65 \\ 500 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 130 \\ 1000 \\ \hline \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | All inputs at 0 V or $V_{D D}$ |
|  |  | XM |  |  | $\begin{array}{r}8.75 \\ 250 \\ \hline\end{array}$ |  |  | $\begin{array}{r}17.5 \\ 500 \\ \hline\end{array}$ |  |  | $\begin{array}{r} 35 \\ 1000 \\ \hline \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ |  |

Notes on following page.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{D D}$ as shown, $\mathrm{V}_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (See Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $D_{n}, K_{n} \text { to } O_{n}$ |  | $\begin{aligned} & 166 \\ & 197 \end{aligned}$ | $\begin{aligned} & 332 \\ & 384 \end{aligned}$ |  | $\begin{aligned} & 65 \\ & 73 \end{aligned}$ | $\begin{aligned} & 130 \\ & 146 \end{aligned}$ |  | $\begin{aligned} & 45 \\ & 48 \end{aligned}$ | $\begin{aligned} & 90 \\ & 96 \end{aligned}$ | ns |  |
| $\begin{aligned} & \overline{\text { tPLH }} \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $D_{n}, K_{n}$ to $L_{O}, R_{O}$ |  | $\begin{array}{r} 91 \\ 100 \end{array}$ | $\begin{aligned} & 182 \\ & 200 \end{aligned}$ |  | $\begin{aligned} & 44 \\ & 46 \end{aligned}$ | $\begin{aligned} & 88 \\ & 92 \end{aligned}$ |  | $\begin{aligned} & 32 \\ & 33 \end{aligned}$ | $\begin{aligned} & 64 \\ & 66 \end{aligned}$ | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $R_{1}$ to $L_{0}$ |  | $\begin{aligned} & 101 \\ & 114 \end{aligned}$ | $\begin{aligned} & 202 \\ & 228 \end{aligned}$ |  | $\begin{aligned} & 57 \\ & 49 \end{aligned}$ | $\begin{array}{r} 114 \\ 98 \end{array}$ |  | $\begin{aligned} & 42 \\ & 41 \end{aligned}$ | $\begin{aligned} & 84 \\ & 82 \end{aligned}$ | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $L_{l}$ to $R_{0}$ |  | $\begin{aligned} & 114 \\ & 122 \end{aligned}$ | $\begin{aligned} & 228 \\ & 244 \end{aligned}$ |  | $\begin{aligned} & 46 \\ & 51 \end{aligned}$ | $\begin{array}{r} 92 \\ 102 \end{array}$ |  | $\begin{aligned} & 31 \\ & 33 \end{aligned}$ | $\begin{aligned} & 62 \\ & 66 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n} \text { to } O_{n}$ |  | $\begin{aligned} & 188 \\ & 201 \end{aligned}$ | $\begin{aligned} & 376 \\ & 402 \end{aligned}$ |  | $\begin{aligned} & 75 \\ & 74 \end{aligned}$ | $\begin{aligned} & 150 \\ & 148 \end{aligned}$ |  | $\begin{aligned} & 49 \\ & 50 \end{aligned}$ | $\begin{array}{r} 98 \\ 100 \end{array}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n}$ to $R_{0}, L_{0}$ |  | $\begin{aligned} & 106 \\ & 152 \end{aligned}$ | $\begin{aligned} & 212 \\ & 304 \end{aligned}$ |  | $\begin{aligned} & 57 \\ & 57 \end{aligned}$ | $\begin{aligned} & 114 \\ & 114 \end{aligned}$ |  | $\begin{aligned} & 41 \\ & 41 \end{aligned}$ | $\begin{aligned} & 82 \\ & 82 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & \hline 44 \\ & 56 \end{aligned}$ | $\begin{array}{r} 88 \\ 112 \end{array}$ |  | $\begin{aligned} & 15 \\ & 24 \end{aligned}$ | $\begin{aligned} & 30 \\ & 48 \end{aligned}$ |  | $\begin{aligned} & 11 \\ & 17 \end{aligned}$ | $\begin{aligned} & 22 \\ & 34 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tPLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & 38 \\ & 39 \end{aligned}$ | $\begin{aligned} & 76 \\ & 78 \end{aligned}$ |  | $\begin{aligned} & 35 \\ & 27 \end{aligned}$ | $\begin{aligned} & 70 \\ & 54 \end{aligned}$ |  | $\begin{aligned} & 26 \\ & 19 \end{aligned}$ | $\begin{aligned} & 52 \\ & 38 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \mathrm{t} \text { TLH } \\ & \mathrm{t}_{\mathrm{T}} \end{aligned}$ | Output Transition Time, $\mathrm{O}_{\mathrm{n}}$ |  | $\begin{aligned} & 43 \\ & 53 \end{aligned}$ | $\begin{array}{r} 86 \\ 106 \end{array}$ |  | $\begin{aligned} & 22 \\ & 20 \end{aligned}$ | $\begin{aligned} & 44 \\ & 40 \end{aligned}$ |  | $\begin{aligned} & 17 \\ & 15 \end{aligned}$ | $\begin{aligned} & 34 \\ & 30 \end{aligned}$ | ns |  |
| $\begin{aligned} & \mathrm{t}_{\mathrm{TLH}} \\ & { }^{\mathrm{t}} \mathrm{THL} \end{aligned}$ | Output Transition Time, $\mathrm{R}_{\mathrm{O}}$ and $\mathrm{L}_{\mathrm{O}}$ |  | $\begin{aligned} & 41 \\ & 55 \end{aligned}$ | $\begin{array}{r} 82 \\ 110 \end{array}$ |  | 19 22 | $\begin{aligned} & 38 \\ & 44 \end{aligned}$ |  | 16 15 | 32 30 | ns |  |

[^4]AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): $V_{D D}$ as shown, $\mathrm{V}_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (See Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| ${ }^{t} \mathrm{PLH}$ <br> tPHL | Propagation Delay, $D_{n}, K_{n} \text { to } O_{n}$ |  | $\begin{aligned} & 192 \\ & 232 \end{aligned}$ | $\begin{aligned} & 384 \\ & 464 \end{aligned}$ |  | $\begin{aligned} & 76 \\ & 85 \end{aligned}$ | $\begin{aligned} & 152 \\ & 170 \end{aligned}$ |  | $\begin{aligned} & 53 \\ & 56 \end{aligned}$ | $\begin{aligned} & 106 \\ & 112 \end{aligned}$ | ns | $\begin{aligned} & C_{\mathrm{L}}=50 \mathrm{pF} \\ & \text { Input Transition } \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \mathrm{t}_{\mathrm{PH}} \end{aligned}$ | Propagation Delay, $D_{n}, K_{n} \text { to } L_{0}, R_{0}$ |  | $\begin{aligned} & 100 \\ & 162 \end{aligned}$ | $\begin{aligned} & 200 \\ & 324 \end{aligned}$ |  | $\begin{aligned} & 56 \\ & 55 \end{aligned}$ | $\begin{aligned} & 112 \\ & 110 \end{aligned}$ |  | $\begin{aligned} & 41 \\ & 42 \end{aligned}$ | $\begin{aligned} & 82 \\ & 84 \end{aligned}$ | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| $\overline{\text { tpLH }}$ ${ }^{\mathrm{t} \mathrm{PHL}}$ | Propagation Delay, $\mathrm{R}_{\mathrm{f}}$ to $\mathrm{L}_{0}$ |  | $\begin{aligned} & \hline 106 \\ & 178 \\ & \hline \end{aligned}$ | $\begin{array}{\|l\|} \hline 212 \\ 356 \\ \hline \end{array}$ |  | $\begin{aligned} & 63 \\ & 61 \end{aligned}$ | $\begin{aligned} & 126 \\ & 122 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 49 \\ & 49 \\ & \hline \end{aligned}$ | $\begin{aligned} & 98 \\ & 98 \\ & \hline \end{aligned}$ | ns |  |
| ${ }^{t} \mathrm{PLH}$ <br> tPHL | Propagation Delay, $L_{1}$ to $R_{0}$ |  | $\begin{aligned} & 133 \\ & 166 \end{aligned}$ | $\begin{aligned} & 266 \\ & 332 \end{aligned}$ |  | $\begin{aligned} & 56 \\ & 61 \end{aligned}$ | $\begin{aligned} & 112 \\ & 122 \end{aligned}$ |  | $\begin{aligned} & 37 \\ & 41 \end{aligned}$ | $\begin{aligned} & 74 \\ & 82 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n} \text { to } O_{n}$ |  | $\begin{aligned} & 204 \\ & 245 \end{aligned}$ | $\begin{array}{\|l\|} \hline 408 \\ 490 \\ \hline \end{array}$ |  | $\begin{aligned} & 83 \\ & 87 \end{aligned}$ | $\begin{aligned} & 166 \\ & 174 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 57 \\ & 59 \end{aligned}$ | $\begin{array}{\|l\|} \hline 114 \\ 118 \\ \hline \end{array}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\mathrm{I}_{\mathrm{n}}$ to $\mathrm{R}_{\mathrm{O}}$, Lo |  | $\begin{aligned} & 122 \\ & 199 \end{aligned}$ | $\begin{aligned} & 244 \\ & 398 \end{aligned}$ |  | $\begin{aligned} & 66 \\ & 69 \end{aligned}$ | $\begin{aligned} & 132 \\ & 138 \end{aligned}$ |  | $\begin{aligned} & 48 \\ & 50 \end{aligned}$ | $\begin{array}{r\|r\|} \hline 96 \\ 100 \end{array}$ | ns |  |
| $\begin{aligned} & \hline \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & 47 \\ & 68 \end{aligned}$ | $\begin{array}{\|r} \hline 94 \\ 136 \\ \hline \end{array}$ |  | $\begin{aligned} & 19 \\ & 29 \end{aligned}$ | $\begin{aligned} & 38 \\ & 58 \end{aligned}$ |  | $\begin{aligned} & 15 \\ & 21 \end{aligned}$ | $\begin{aligned} & 30 \\ & 42 \end{aligned}$ | ns. | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tpLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & \hline 46 \\ & 47 \end{aligned}$ | $\begin{aligned} & 92 \\ & 94 \end{aligned}$ |  | $\begin{aligned} & \hline 41 \\ & 31 \end{aligned}$ | $\begin{aligned} & 82 \\ & 62 \end{aligned}$ |  | $\begin{aligned} & 34 \\ & 20 \end{aligned}$ | $\begin{aligned} & \hline 68 \\ & 40 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { t TLH } \\ & \text { t } \mathrm{THL} \end{aligned}$ | Output Transition Time, $\mathrm{O}_{\mathrm{n}}$ |  | $\begin{array}{r} 80 \\ 129 \end{array}$ | $\begin{aligned} & \hline 160 \\ & 258 \end{aligned}$ |  | $\begin{aligned} & 43 \\ & 38 \end{aligned}$ | $\begin{aligned} & 86 \\ & 76 \end{aligned}$ |  | $\begin{aligned} & 32 \\ & 26 \end{aligned}$ | $\begin{aligned} & 64 \\ & 52 \end{aligned}$ | ns |  |
| ${ }^{t}$ TLH ${ }^{t}$ THL | Output Transition Time, $\mathrm{R}_{\mathrm{O}}$ and $\mathrm{L}_{\mathrm{O}}$ |  | 74 | $\begin{aligned} & \hline 148 \\ & 152 \\ & \hline \end{aligned}$ |  | 42 40 | 84 80 |  | 32 27 | $\begin{aligned} & 64 \\ & 54 \end{aligned}$ | ns |  |

NOTES:

1. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4000 Series CMOS Family Characteristics.

## SWITCHING WAVEFORMS



OUTPUT ENABLE TIME
( $\mathrm{tPZH}^{\prime}$ ) AND OUTPUT DISABLE TIME ( $\mathrm{t}_{\mathrm{PH}}$ )
$\overline{\text { EO }}$


OUTPUT ENABLE TIME (tpZL) AND OUTPUT DISABLE TIME (tPLZ)

# 4705/4705B ARITHMETIC LOGIC REGISTER STACK <br> FAIRCHILD CMOS MACROLOGIC 

DESCRIPTION - The Arithmetic Logic Register Stack (ALRS) is designed to implement accumulators in high performance microprogrammed digital systems. The device contains a 4-bit arithmetic logic unit (ALU), an 8 -word by 4 -bit RAM, and associated control logic. The ALU implements eight arithmetic and logic functions where one 4-bit operand is supplied from an external source (input data bus) and the second 4-bit operand is supplied internally from one of the eight RAM words selected by the Address Inputs $\left(A_{0}-A_{2}\right)$. The result of the operation is loaded into the same RAM location and simultaneously, is loaded into the Output Register making it available at the 3 -state output data bus.

The 4705 operates on four bits of data but features are provided for expansion to longer word lengths. Carry propagate and carry generate facilities are provided for an external carry lookahead where maximum operating speed is required. In applications where highspeed arithmetic is not needed, ripple expansion may also be implemented. The 4705 provides three status signals: Zero, Negative and Overflow. These qualify the result of an operation. The 4705 is fully compatible with all CMOS families.

## - VERY LOW POWER DISSIPATION

- EIGHT ACCUMULATORS IN A SINGLE PACKAGE
- HIGH SPEED - 2 MHz MICROINSTRUCTION RATE
- EXPANDABLE IN MULTIPLES OF FOUR BITS
- PROVIDES FOR RIPPLE OR CARRY LOOKAHEAD
- IMPLEMENTS 64 MICROINSTRUCTIONS
- PROVIDES STATUS - ZERO, NEGATIVE, AND OVERFLOW
- 3-STATE OUTPUTS
- SLIM 24-PIN PACKAGE


## PIN NAMES

| $\bar{D}_{0}-\bar{D}_{3}$ | Data Inputs (Active LOW) |
| :--- | :--- |
| $A_{0}-A_{2}$ | Address Instruction Inputs |
| $I_{0}-I_{2}$ | ALU Instruction Inputs |
| MSS | Most Significant Slice Input (Active HIGH) |
| CP | Clock Input |
| $\overline{\mathrm{EO}}$ | Output Enable Input (Active LOW) |
| $\overline{\mathrm{EX}}$ | Execute Input (Active LOW) |
| $\overline{\bar{O}_{0}}-\overline{\mathrm{O}}_{3}$ | Data Outputs (Active LOW) |
| $\bar{W}$ | Ripple Carry Outputs (Active LOW) |
| $\bar{X}$ | Carry Propagate Output |
| $\bar{Y}$ | Carry Generate Output |
| Z | Zero Status Output (Active HIGH, |
|  | Open Collector) |



BLOCK DIAGRAM


TABLE 1
INSTRUCTION FIELD ASSIGNMENT

| $\mathrm{I}_{2} \mathrm{I}_{1} \mathrm{l}_{0}$ | INTERNAL OPERATION |  |
| :---: | :---: | :---: |
| L L L | $\mathrm{R}_{\mathrm{X}}$ plus D-Bus plus $1 \rightarrow \mathrm{R}_{\mathrm{X}}$ | Accumulate |
| L L H | $R_{X}$ plus D-Bus $\rightarrow R_{X}$ | Accumulate |
| L H L | $R_{X} \cdot$ D-Bus $\rightarrow R_{X}$ | Logical AND |
| L H H | D-Bus $\rightarrow \mathrm{R}_{\mathrm{X}}$ | Load |
| H L L | $\mathrm{R}_{\mathrm{X}} \rightarrow$ Output Register | Output |
| H L H | $\mathrm{R}_{\mathrm{X}}+\mathrm{D}$-Bus $\rightarrow$ | Logical OR |
| H H L | $\mathrm{R}_{\mathrm{X}} \oplus$ D-Bus $\rightarrow \mathrm{R}_{\mathrm{X}}$ | Exclusive OR |
| H H H | D-Bus $\rightarrow \mathrm{R}_{\mathrm{X}}$ | Load Complement |
| $H=$ HIGH Level $L=$ LOW Level |  |  |
| NOTES: |  |  |
| 1. $R_{x}$ is the RAM location addressed by $A_{0}-A_{2}$. |  |  |
| 2. The result of any operation is always loaded into the Output Register. |  |  |

FUNCTIONAL DESCRIPTION - As shown in the block diagram, the 4705 Arithmetic Logic Register Stack (ALRS) consists of a 4-bit ALU, an 8-word by 4-bit RAM with output latches, an Instruction Decoder, Control Logic and a 4-bit Output Register.
The ALU receives the active LOW input data $\left(\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}\right)$ as one operand while the RAM provides the second operand through latches. The ALU output is stored in both the RAM and Output Register. The active LOW output data ( $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ ) is obtained from the Output Register through 3 -state buffers. An active LOW Output Enable ( $\overline{\mathrm{EO}}$ ) input controls these buffers; a HIGH level $\overline{\mathrm{EO}}$ disables the buffers (high impedance state).
The instruction bus for the 4705 consists of two fields, $A$ and $I ; A_{0}-A_{2}$ specify the desired location of the RAM and $I_{0}-I_{2}$ specify the desired function to be performed. Table 1 lists instruction code assignments. Thus, the 4705 provides eight accumulators $\left(R_{0}-R_{7}\right)$ and eight different operations may be performed on any of these accumulators. The $I_{0}-I_{2}$ inputs are decoded by the Instruction Decoder to generate necessary control signals for the ALU. The ALU also generates and transmits to the control logic the following signals: Carry Out (C), Carry Propagate (P), Carry Generate (G), Negative (N) and Overflow (V) status. The control logic manipulates the status signals as a function of $\mathrm{I}_{0}-\mathrm{I}_{2}$ and a control input MSS. A HIGH on the MSS input declares the most significant slice in a 4705 array (the MSS can be tied directly toVDD). All devices, except the most significant 4705 should have a LOW level (ground) on the MSS input. The control logic generates three device outputs $(\bar{W}, \bar{X}$ and $\bar{Y})$ for arrayed operation. An all zero result from the ALU is decoded and presented at the open collector Zero $(Z)$ output.
The $I_{0}$ input serves a dual purpose. For arithmetic instructions, it is used as the carry input and for non-arithmetic instructions it serves as an instruction input. This is possible because only two arithmetic instructions require carry. The dual purpose use of $\mathrm{I}_{0}$ plays an important role in 4705 expansion schemes.

Operation - The 4705 operates on a single clock. A microcycle starts as the clock goes HIGH. For normal operation the Execute ( $\overline{\mathrm{EX}}$ ) is LOW. Data is read from the RAM through enabled latches and applied as one operand to the ALU. Data inputs ( $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ ) are applied to the ALU as the other operand and the operation as determined by instruction lines $\mathrm{I}_{0}-\mathrm{I}_{2}$ is executed. When CP is LOW, the latches are disabled and the result of the operation is written back into the RAM provided that $\overline{E X}$ is LOW. The A lines must obviously be held stable during this time. On the LOW-to-HIGH transition of the CP, the result of the operation is loaded into the output register and a new microcycle can start. If $\overline{E X}$ is held HIGH, the operation selected by the I and A inputs is performed, but the result is not written back into the RAM and is not clocked into the output register.

EXPANSION - The 4705 is organized to operate on a 4-bit wide data bus but can easily be expanded for longer words. Expansion requires that carries from lesser significant slices be propagated towards the most significant slice. The 4705 provides full lookahead capability for high speed arithmetic. Appropriate Carry Generate $(\bar{Y})$ and Carry Progagate ( $\overline{\mathrm{X}}$ ) outputs are provided so that only one external carry lookahead generator is needed for every four 4705s. When speed is not a prime consideration, it is possible to implement ripple carry expansion.
In arrayed operation, it is common to bus the $\overline{E X}, C P$ and $\overline{E O}$ inputs of all devices. The $Z$ output is open collector and is normally OR-tied with the other devices and to an external load resistor so that a HIGH level indicates a zero result from an operation in the array.
Figure 1 shows a ripple carry 16 -bit wide array using four 4705 s. The MSS input is tied toVDD on the most significant slice (ALRS 4); the MSS inputs of the other devices are tied to ground. The instruction bus of this array consists of A-field and 1 -field. A-field is obtained by connecting corresponding $A$ inputs of all four devices. The $I_{0}$ input of device 1 (i.e., least significant slice) in conjunction with the bussed $I_{1}, I_{2}$ inputs forms the $I$-field for the array. The $I_{0}$ inputs of devices 2,3 and 4 are connected to the $\bar{W}$ outputs of devices 1,2 and 3 respectively. The ALU network generates the carry propagate output. The control logic operates on this signal as a function of $I_{1}$ and $I_{2}$ to generate the $\bar{W}$ output. If both $I_{1}$ and $I_{2}$ are LOW (i.e., an arithmetic instruction), the $\bar{W}$ output is the carry output of that slice. In case of non-arithmetic instructions, it assumes the state of the $I_{0}$ input. Thus, in Figure 1, if an arithmetic instruction is specified, carry propagates through the $\bar{W}$ output to $I_{0}$ input of the next higher significant slice. On the other hand, non-arithmetic instructions effectively connect all $I_{0}$ inputs together to form the $I$-field for the array. The $\bar{W}$ output of device 4 is the carry output from the array. The control logic also generates $\bar{X}$ and $\bar{Y}$ outputs which participate in expansion when full carry lookahead is required. These outputs are normally ignored in ripple expansion except for the most significant slice. In the most significant slice, $\overline{\mathrm{X}}$ and $\overline{\mathrm{Y}}$ correspond to Negative and Overflow status signals.
The $\bar{X}$ output of device 4 is LOW, if the result of an operation has its most significant bit as " 1 " (i.e., negative result). Similarly a LOW on $\bar{Y}$ output of device 4 indicates that arithmetic overflow has occurred. If the two operands have the same sign and the result has opposite sign, then it is assumed that an overflow has occurred. It should be noted that $\bar{W}, \bar{X}$ and $\bar{Y}$ are not controlled by $\overline{E X}$ or CP. Figure 2 shows a 16 -bit array with full carry lookahead expansion. Implementation of the lookahead scheme requires the use of an external 4582 in addition to the four 4705 s in the array. Since device 1 is the least significant and device 4 is the most significant slice, the MSS inputs of the first three devices are connected to ground while device 4 has a HIGH at this input. The A-field for the array instruction bus is obtained by connecting corresponding A inputs of all four devices. Bussed $I_{1}$ and $I_{2}$ inputs together with the $I_{0}$ input of device 1 form the $I$-field for the array. The $I_{0}$ inputs for devices 2,3 and 4 are obtained from the 4582 Carry Outputs ( $C_{n+x}, C_{n+y}$ and $C_{n+z}$ respectively). Also the $P$ and $G$ in-

## FAIRCHILD • 4705/4705B

puts of 4582 are connected to $\bar{X}$ and $\bar{Y}$ outputs of the 4705 as shown. The control logic in the 4705 (see block diagram) generates $\bar{X}$ and $\bar{Y}$ outputs as a function of $I_{1}, l_{2}$ and MSS inputs as well as the Carry Generate and Carry Propagate outputs of the ALU. If the MSS input of a slice is LOW and an arithmetic instruction is specified, its $\bar{X}$ output is treated as carry-in into a slice irrespective of MSS. Thus, whenever $I_{1}$ and $I_{2}$ are LOW, the array behaves as an adder with full carry lookahead. The $\bar{W}$ outputs still reflect carry output, which is ignored for devices 1,2 and 3 . The $\bar{W}$ output of device 4 is the carry output from the array. Also note that the lo input of device 1 is not only an instruction input but also provides the carry input to the array so the $I_{0}$ input of device 1 must be connected to the appropriate 4582 input as shown.

When a non-arithmetic instruction is specified to the array, the control logic of the 4705 forces a LOW on $\overline{\mathrm{X}}$ and a HIGH on $\bar{Y}$ outputs on all except the most significant slice. An examination of the 4582 logic reveals that whenever $P$ is LOW and G is HIGH the associated carry output is the same as the carry input. Thus, in Figure 2 devices 2,3, and 4 will assume the logic level as that presented to the $I_{0}$ input of device 1 during non-arithmetic instructions effectively bussing $I_{0}$ through all four devices. As in the case of ripple expansion $\bar{X}$ and $\bar{Y}$ outputs of device 4 represent. Negative and Overflow from the array.


Fig. 1
RIPPLE CARRY EXPANSION


Fig. 2
CARRY LOOKAHEAD EXPANSION

FAIRCHILD • 4705/4705B

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (Note 3)

| SYMBOL | PARAMETER |  | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
| IOZH | Output OFF <br> Current HIGH | XC |  |  | $\begin{array}{r}0.5 \\ 30 \\ \hline\end{array}$ |  |  | $\begin{aligned} & 1.0 \\ & 60 \end{aligned}$ |  | 0.2 12 |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $V_{D D}, \overline{E O}=V_{D D}$ |
|  |  | XM |  |  | 0.05 3.0 |  |  | 0.1 6.0 |  | 0.02 1.2 |  |  | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |
| IOZL | Output OFF <br> Current LOW | XC |  |  | -0.5 -30 |  |  | $\begin{array}{r} -1.0 \\ -60 \\ \hline \end{array}$ |  | -0.2 -12 |  | $\mu \mathrm{A}$ | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $\mathrm{V}_{\mathrm{SS}}, \overline{\mathrm{EO}}=\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{\|r} -0.05 \\ -3.0 \\ \hline \end{array}$ |  |  | $\begin{aligned} & -0.1 \\ & -6.0 \\ & \hline \end{aligned}$ |  | $\begin{array}{r} -0.02 \\ -1.2 \\ \hline \end{array}$ |  |  | $\begin{array}{c\|} \hline \text { MIN, } \mathbf{2 5}{ }^{\circ} \mathrm{C} \\ \text { MAX } \end{array}$ |  |
| IDD | Quiescent <br> Power <br> Supply <br> Current | XC |  |  | $\begin{array}{r} 32.5 \\ 250 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 65 \\ 500 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 130 \\ 1000 \\ \hline \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | All inputs at 0 V or $V_{D D}$ |
|  |  | XM |  |  | $\begin{array}{r} 8.75 \\ 250 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 17.5 \\ 500 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 35 \\ 1000 \end{array}$ |  | $\begin{array}{\|c\|} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{array}$ |  |

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{D D}$ as shown, $V_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ (See Note 4)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (Note 6) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 140 \\ & 145 \end{aligned}$ | $\begin{aligned} & 280 \\ & 290 \end{aligned}$ |  | $\begin{aligned} & \hline 61 \\ & 61 \end{aligned}$ | $\begin{aligned} & 122 \\ & 122 \end{aligned}$ |  | $\begin{aligned} & 43 \\ & 43 \end{aligned}$ | $\begin{aligned} & \hline 86 \\ & 86 \end{aligned}$ | ns | $\overline{\mathrm{EO}}=\overline{\mathrm{EX}}=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, 10 to $\bar{W}$ |  | $\begin{array}{r} 99 \\ 115 \end{array}$ | $\begin{aligned} & 198 \\ & 230 \end{aligned}$ |  | $\begin{aligned} & 45 \\ & .48 \end{aligned}$ | $\begin{aligned} & 90 \\ & 96 \end{aligned}$ |  | $\begin{aligned} & 32 \\ & 34 \end{aligned}$ | $\begin{aligned} & \hline 64 \\ & 68 \end{aligned}$ | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2}=\mathrm{V}_{\text {DD }}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $\bar{D}_{\mathrm{n}}$ to $\overline{\mathrm{W}}$ |  | $\begin{aligned} & 241 \\ & 168 \end{aligned}$ | $\begin{aligned} & 482 \\ & 336 \end{aligned}$ |  | $\begin{aligned} & 92 \\ & 51 \end{aligned}$ | $\begin{aligned} & 184 \\ & 102 \end{aligned}$ |  | $\begin{aligned} & 65 \\ & 36 \end{aligned}$ | $\begin{array}{r} 130 \\ 72 \end{array}$ | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2}=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\bar{D}_{n}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & 360 \\ & 339 \end{aligned}$ | $\begin{aligned} & 720 \\ & 678 \end{aligned}$ |  | $\begin{array}{\|l\|} \hline 143 \\ 133 \\ \hline \end{array}$ | $\begin{aligned} & 286 \\ & 266 \end{aligned}$ |  | $\begin{array}{r} 101 \\ 94 \end{array}$ | $\begin{aligned} & 202 \\ & 188 \end{aligned}$ | ns | $\begin{aligned} & \text { MSS }=V_{D D} \\ & I_{1}=I_{2}=V_{S S} \end{aligned}$ |
| $\begin{aligned} & \hline \text { tpLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\bar{D}_{\mathrm{n}}$ to $\overline{\mathrm{X}}, \overline{\mathrm{Y}}$ |  | $\begin{aligned} & 143 \\ & 220 \end{aligned}$ | $\begin{aligned} & 286 \\ & 440 \end{aligned}$ |  | $\begin{aligned} & 48 \\ & 80 \end{aligned}$ | $\begin{array}{r} 96 \\ 160 \end{array}$ |  | $\begin{aligned} & 34 \\ & 56 \end{aligned}$ | $\begin{array}{r} 68 \\ 112 \end{array}$ | ns | $\begin{aligned} & \text { MSS }=I_{1}=I_{2}= \\ & v_{S S} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{1}, I_{2}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & 198 \\ & 236 \end{aligned}$ | $\begin{aligned} & 396 \\ & 472 \end{aligned}$ |  | $\begin{aligned} & 89 \\ & 99 \end{aligned}$ | $\begin{aligned} & 178 \\ & 198 \end{aligned}$ |  | $\begin{aligned} & 63 \\ & 70 \end{aligned}$ | $\begin{aligned} & 126 \\ & 140 \end{aligned}$ | ns | MSS $=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\bar{D}_{n}$ to $Z$ |  | $\begin{aligned} & 322 \\ & 239 \end{aligned}$ | $\begin{aligned} & 644 \\ & 478 \end{aligned}$ |  | $\begin{array}{r} 140 \\ 89 \end{array}$ | $\begin{aligned} & 280 \\ & 178 \end{aligned}$ |  | $\begin{aligned} & \hline 98 \\ & 63 \\ & \hline \end{aligned}$ | $\begin{aligned} & 196 \\ & 126 \end{aligned}$ | ns | $\begin{aligned} & R_{L}=1 \mathrm{k} \Omega \text { to } \\ & V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $I_{0}$ to $\bar{W}$ |  | $\begin{aligned} & 174 \\ & 201 \end{aligned}$ | $\begin{aligned} & 348 \\ & 402 \end{aligned}$ |  | $73$ | $\begin{aligned} & 146 \\ & 154 \end{aligned}$ |  | $\begin{aligned} & 52 \\ & 54 \end{aligned}$ | $\begin{aligned} & 104 \\ & 108 \end{aligned}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{S S}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $I_{1}, I_{2}$ to $\bar{W}$ |  | $\begin{aligned} & 130 \\ & 227 \end{aligned}$ | $\begin{aligned} & 260 \\ & 454 \end{aligned}$ |  | $\begin{aligned} & 64 \\ & 93 \end{aligned}$ | $\begin{aligned} & 128 \\ & 186 \end{aligned}$ |  | $\begin{aligned} & 45 \\ & 66 \end{aligned}$ | $\begin{array}{r} 90 \\ 132 \end{array}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\bar{D}_{3}$ to $\bar{X}$ |  | $\begin{aligned} & 295 \\ & 373 \end{aligned}$ | $\begin{aligned} & 590 \\ & 746 \end{aligned}$ |  | $\begin{aligned} & \hline 114 \\ & 143 \end{aligned}$ | $\begin{aligned} & 228 \\ & 286 \end{aligned}$ |  | $\begin{array}{\|r\|} \hline \cdot 80 \\ 101 \end{array}$ | $\begin{aligned} & \hline 160 \\ & 202 \end{aligned}$ | ns | $\begin{aligned} & l_{1}=I_{2}=M S S= \\ & V_{D D} \end{aligned}$ |
| tpLH <br> tPHL | Propagation Delay, $A_{n}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & 378 \\ & 507 \end{aligned}$ | $\begin{array}{r} 756 \\ 1014 \end{array}$ |  | $\begin{aligned} & 151 \\ & 205 \end{aligned}$ | $\begin{aligned} & 302 \\ & 410 \end{aligned}$ |  | $\begin{aligned} & 106 \\ & 144 \end{aligned}$ | $\begin{aligned} & 212 \\ & 288 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=M S S= \\ & V_{S S} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & 509 \\ & 647 \end{aligned}$ | $\begin{aligned} & 1018 \\ & 1294 \end{aligned}$ |  | $\begin{aligned} & 196 \\ & 258 \end{aligned}$ | $\begin{aligned} & 392 \\ & 516 \end{aligned}$ |  | $\begin{aligned} & 138 \\ & 181 \end{aligned}$ | $\begin{aligned} & 276 \\ & 362 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=V_{S S} \\ & M S S=V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{X}$ |  | $\begin{aligned} & 500 \\ & 670 \end{aligned}$ | $\begin{aligned} & 1000 \\ & 1340 \end{aligned}$ |  | $\begin{aligned} & 191 \\ & 269 \end{aligned}$ | $\begin{array}{r} 382 \\ 538 \end{array}$ |  | $\begin{aligned} & 134 \\ & 189 \end{aligned}$ | $\begin{aligned} & 268 \\ & 378 \end{aligned}$ | ns | $\begin{aligned} & l_{1}=I_{2}=M S S= \\ & V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{W}$ |  | $\begin{aligned} & 537 \\ & 394 \end{aligned}$ | $\begin{array}{r} 1074 \\ 788 \end{array}$ |  | $\begin{aligned} & 219 \\ & 151 \end{aligned}$ | $\begin{aligned} & 438 \\ & 302 \end{aligned}$ |  | $\begin{array}{\|l\|} 154 \\ 106 \end{array}$ | $\begin{aligned} & 308 \\ & 212 \end{aligned}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{S S}$ |
| $\begin{array}{r} \text { tPLH } \\ \text { tPHL } \\ \hline \end{array}$ | Propagation Delay, $A_{n}$ to $Z$ |  | $\begin{aligned} & 490 \\ & 600 \end{aligned}$ | $\begin{array}{r} 980 \\ 1200 \end{array}$ |  | $\begin{aligned} & 209 \\ & 238 \end{aligned}$ | $\begin{aligned} & \hline 418 \\ & 476 \end{aligned}$ |  | $\begin{aligned} & 147 \\ & 167 \end{aligned}$ | $\begin{aligned} & 294 \\ & 334 \end{aligned}$ | ns | $l_{1}=l_{2}=V_{S S}$ |

Notes on following page.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd):
$\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ (See Note 4)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS <br> (Note 6) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| tplH <br> tpHL | Propagation Delay, $I_{1}, I_{2} \text { to } \bar{X}, \bar{Y}$ |  | $\begin{aligned} & 123 \\ & 316 \end{aligned}$ | $\begin{aligned} & 246 \\ & 632 \end{aligned}$ |  | $\begin{array}{r\|} 61 \\ 126 \end{array}$ | $\begin{aligned} & 122 \\ & 252 \end{aligned}$ |  | $\begin{aligned} & 43 \\ & 89 \end{aligned}$ | $\begin{array}{r} 86 \\ 178 \end{array}$ | ns | $\begin{aligned} & I_{1}=I_{2}=V_{S S} \\ & M S S=V_{D D} \end{aligned}$ |
| ${ }^{t} \mathrm{PLH}$ tpHL | Propagation Delay, $I_{0}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & 151 \\ & 277 \end{aligned}$ | $\begin{aligned} & 302 \\ & 554 \end{aligned}$ |  | $\begin{array}{\|r\|r\|} 74 \\ 108 \end{array}$ | $\begin{aligned} & 148 \\ & 216 \end{aligned}$ |  | $\begin{aligned} & 52 \\ & 76 \end{aligned}$ | $\begin{aligned} & 104 \\ & 152 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=v_{S S} \\ & M S S=V_{D D} \end{aligned}$ |
| tPLH tPHL | Propagation Delay, $I_{1}, I_{2} \text { to } Z$ |  | $\begin{aligned} & 335 \\ & 261 \end{aligned}$ | $\begin{aligned} & 670 \\ & 522 \end{aligned}$ |  | $\begin{aligned} & 148 \\ & 104 \end{aligned}$ | $\begin{aligned} & 296 \\ & 208 \end{aligned}$ |  | $\begin{array}{r} 104 \\ 73 \end{array}$ | $\begin{aligned} & 208 \\ & 146 \end{aligned}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=V_{S S}$ |
| tpLH <br> tpHL | Propagation Delay, $I_{0}$ to $Z$ |  | $\begin{aligned} & \hline 258 \\ & 162 \end{aligned}$ | $\begin{aligned} & 516 \\ & 324 \end{aligned}$ |  | $\begin{array}{r} 117 \\ 64 \end{array}$ | $\begin{aligned} & 234 \\ & 128 \end{aligned}$ |  | $\begin{aligned} & 82 \\ & 45 \end{aligned}$ | $\begin{array}{r} 164 \\ 90 \end{array}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \\ & \hline \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & \hline 67 \\ & 51 \end{aligned}$ | $\begin{aligned} & 134 \\ & 102 \end{aligned}$ |  | $\begin{aligned} & 33 \\ & 25 \end{aligned}$ | $\begin{aligned} & 66 \\ & 50 \end{aligned}$ |  | $\begin{aligned} & 24 \\ & 18 \end{aligned}$ | $\begin{aligned} & 48 \\ & 36 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tpHZ } \\ & \text { tpLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & 64 \\ & 74 \end{aligned}$ | $\begin{aligned} & 128 \\ & 148 \end{aligned}$ |  | $\begin{aligned} & 33 \\ & 37 \end{aligned}$ | $\begin{aligned} & \hline 66 \\ & 74 \end{aligned}$ |  | $\begin{aligned} & 24 \\ & 26 \end{aligned}$ | $\begin{aligned} & 48 \\ & 52 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| $\begin{aligned} & \hline \mathrm{t} \mathrm{TLH} \\ & \mathrm{t}_{\mathrm{THL}} \\ & \hline \end{aligned}$ | Output Transition Time |  | $\begin{aligned} & 46 \\ & 32 \end{aligned}$ | $\begin{aligned} & 92 \\ & 64 \end{aligned}$ |  | $\begin{aligned} & 26 \\ & 14 \end{aligned}$ | $\begin{aligned} & 52 \\ & 28 \end{aligned}$ |  | $\begin{aligned} & 19 \\ & 10 \end{aligned}$ | $\begin{aligned} & 38 \\ & 20 \end{aligned}$ | ns | $C_{L}=15 \mathrm{pF}$ |
| ${ }^{\text {t }}$ W ${ }^{\text {c }}$ | Minimum Clock Period | 1018 | 509 |  | 526 | 263 |  | 370 | 185 |  | ns |  |
| ${ }^{t}{ }_{w} C P(L)$ | CP Minimum Pulse Width, LOW | 214 | 107 |  | 102 | 51 |  | 72 | 36 |  | ns |  |
| ${ }_{t_{w} \mathrm{CP}(\mathrm{H})}$ | CP Minimum Pulse Width, HIGH | 484 | 242 |  | 222 | 111 |  | 156 | 78 |  | ns |  |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{s}} \\ & \mathrm{t}_{\mathrm{h}} \end{aligned}$ | Set-Up Time, EX to CP Hold Time, $\overline{E X}$ to $C P$ | $\begin{array}{r} 326 \\ 20 \end{array}$ | $\begin{array}{\|r} 163 \\ 0 \end{array}$ |  | $\begin{array}{r} 198 \\ 15 \end{array}$ | $\begin{array}{r} 99 \\ 0 \end{array}$ |  | $\begin{array}{r} 134 \\ 10 \end{array}$ | $\begin{array}{r} \hline 67 \\ 0 \end{array}$ |  | ns | $C_{L}=15 \mathrm{pF}$ |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}} \\ & \mathrm{t}_{\mathrm{h}} \end{aligned}$ | Set-Up Time, $A_{n}$ to $C P$ Hold Time, $A_{n}$ to CP | $\begin{array}{r} 452 \\ 20 \end{array}$ | $\begin{array}{r} 226 \\ 0 \end{array}$ |  | $\begin{array}{r} 168 \\ 15 \end{array}$ | $\begin{gathered} 84 \\ -1 \end{gathered}$ |  | $\begin{array}{r} 118 \\ 10 \end{array}$ | $\begin{array}{r} 59 \\ 0 \end{array}$ |  | ns | Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
|  | Set-Up Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to CP Hold Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to CP | $\begin{array}{r} 500 \\ -35 \end{array}$ | $\begin{array}{\|c\|} \hline 250 \\ -69 \end{array}$ |  | 198 -11 | $\begin{array}{\|r\|} \hline 99 \\ -21 \end{array}$ |  | $\begin{array}{r} 140 \\ -8 \end{array}$ | $\begin{array}{r} 70 \\ -15 \end{array}$ |  | ns | $\mathrm{EX}=\mathrm{V}_{\text {SS }}$ |
|  | Set-Up Time, $I_{n}$ to $C P$ Hold Time, $I_{n}$ to CP | $\begin{array}{r} \hline 502 \\ -29 \end{array}$ | $\begin{array}{\|r\|} \hline 251 \\ -57 \end{array}$ |  | 224 -12 | $\begin{array}{\|c\|} \hline 112 \\ -23 \end{array}$ |  | $\begin{array}{r} 158 \\ -9 \end{array}$ | $\begin{array}{r} 79 \\ -17 \end{array}$ |  | ns |  |
| $f_{\text {max }}$ | Input Count Frequency (Note 1) | 0.98 | 1.97 |  | 1.9 | 3.8 |  | 2.47 | 4.94 |  | MHz |  |

Notes on following page.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: VDD as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (Note 6) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{array}{\|l\|} \hline 163 \\ 174 \\ \hline \end{array}$ | $\begin{aligned} & \hline 326 \\ & 348 \end{aligned}$ |  | $\begin{aligned} & 71 \\ & 70 \end{aligned}$ | $\begin{aligned} & 142 \\ & 140 \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 49 \end{aligned}$ | $\begin{array}{r} 100 \\ 98 \end{array}$ | ns | $\overline{\mathrm{EO}}=\overline{\mathrm{EX}}=\mathrm{V}_{S S}$ |
| tpLH tPHL. | Propagation Delay, $I_{0}$ to $\bar{W}$ |  | $\begin{array}{\|l\|} \hline 120 \\ 139 \\ \hline \end{array}$ | $\begin{aligned} & \hline 240 \\ & 278 \end{aligned}$ |  | $\begin{aligned} & 55 \\ & 56 \end{aligned}$ | $\begin{aligned} & 110 \\ & 112 \end{aligned}$ |  | $\begin{aligned} & 39 \\ & 40 \end{aligned}$ | $\begin{aligned} & 78 \\ & 80 \end{aligned}$ | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2}=\mathrm{V}_{\text {DD }}$ |
| tpLH <br> ${ }^{\text {tPHL }}$ | Propagation Delay, $\bar{D}_{\mathrm{n}}$ to $\bar{W}$ |  | $\begin{aligned} & 251 \\ & 186 \end{aligned}$ | $\begin{aligned} & 502 \\ & 372 \end{aligned}$ |  | $\begin{array}{r} 101 \\ 61 \end{array}$ | $\begin{aligned} & 202 \\ & 122 \end{aligned}$ |  | $\begin{aligned} & 71 \end{aligned}$ | $\begin{array}{r} 142 \\ 86 \end{array}$ | ns | $\mathrm{I}_{1}$ or $\mathrm{I}_{2}=\mathrm{V}_{\text {SS }}$ |
| tpLH $\underline{\mathrm{t}_{\mathrm{PH}}}$ | Propagation Delay, $\bar{D}_{\mathrm{n}}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & \hline 382 \\ & 363 \end{aligned}$ | $\begin{aligned} & 764 \\ & 726 \end{aligned}$ |  | $\begin{aligned} & 150 \\ & 140 \end{aligned}$ | $\begin{aligned} & 300 \\ & 280 \end{aligned}$ |  | $\begin{array}{r} 105 \\ 98 \end{array}$ | $\begin{aligned} & 210 \\ & 196 \\ & \hline \end{aligned}$ | ns | $\begin{aligned} & \text { MSS }=V_{D D} \\ & 1_{1}=I_{2}=V_{S S} \end{aligned}$ |
| $\overline{\text { tPLH }}$ <br> tpHL | Propagation Delay, $\bar{D}_{\mathrm{n}}$ to $\overline{\mathrm{X}}, \overline{\mathrm{Y}}$ |  | $\begin{aligned} & 161 \\ & 239 \end{aligned}$ | $\begin{aligned} & 322 \\ & 478 \end{aligned}$ |  | $\begin{aligned} & 58 \\ & 90 \end{aligned}$ | $\begin{aligned} & 116 \\ & 180 \end{aligned}$ |  | $\begin{aligned} & 41 \\ & 63 \end{aligned}$ | $\begin{array}{r} 82 \\ 126 \end{array}$ | ns | $\begin{aligned} & \mathrm{MSS}=I_{1}=I_{2}= \\ & \mathrm{V}_{S S} \end{aligned}$ |
| tpLH tpHL | Propagation Delay, $I_{1}, I_{2}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & \hline 211 \\ & 266 \end{aligned}$ | $\begin{aligned} & 422 \\ & 532 \end{aligned}$ |  | $\begin{array}{r} 96 \\ 109 \end{array}$ | $\begin{aligned} & 192 \\ & 218 \end{aligned}$ |  | $\begin{aligned} & \hline 68 \\ & 77 \end{aligned}$ | $\begin{aligned} & 136 \\ & 154 \end{aligned}$ | ns | MSS $=\mathrm{V}_{\text {SS }}$ |
| $\overline{t P L H}$ tPHL | Propagation Delay, $\bar{D}_{n}$ to $Z$ |  | $\begin{aligned} & \hline 360 \\ & 251 \end{aligned}$ | $\begin{aligned} & 720 \\ & 502 . \end{aligned}$ |  | $\begin{array}{r} 179 \\ 95 \end{array}$ | $\begin{aligned} & 358 \\ & 190 \end{aligned}$ |  | $\begin{array}{r} 126 \\ 67 \end{array}$ | $\begin{aligned} & \hline 262 \\ & 134 \end{aligned}$ | ns | $\begin{aligned} & R_{L}=1 \mathrm{k} \Omega \text { to } \\ & V_{D D} \end{aligned}$ |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PH}} \end{aligned}$ | Propagation Delay, Io to $\bar{W}$ |  | $\begin{aligned} & 198 \\ & 226 \end{aligned}$ | $\begin{aligned} & 396 \\ & 452 \end{aligned}$ |  | $\begin{aligned} & 83 \\ & 87 \end{aligned}$ | $\begin{aligned} & 166 \\ & 174 \end{aligned}$ |  | $\begin{aligned} & 59 \\ & 61 \end{aligned}$ | $\begin{aligned} & 118 \\ & 122 \end{aligned}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\mathrm{I}_{1}, \mathrm{I}_{2} \text { to } \bar{W}$ |  | $\begin{aligned} & 152 \\ & 252 \end{aligned}$ | $\begin{aligned} & 304 \\ & 504 \end{aligned}$ |  | $\begin{array}{r} 73 \\ 104 \end{array}$ | $\begin{aligned} & 146 \\ & 208 \end{aligned}$ |  | $\begin{aligned} & 52 \\ & 73 \end{aligned}$ | $\begin{aligned} & 104 \\ & 146 \end{aligned}$ | ns | $l_{1}=I_{2}=V_{S S}$ |
| tpLH <br> tpHL | Propagation Delay, $\bar{D}_{3}$ to $\bar{X}$ |  | $\begin{aligned} & 317 \\ & 401 \end{aligned}$ | $\begin{aligned} & 634 \\ & 802 \end{aligned}$ |  | $\begin{array}{r} 123 \\ 152 \\ \hline \end{array}$ | $\begin{aligned} & 246 \\ & 304 \end{aligned}$ |  | $\begin{array}{r} \hline 87 \\ 107 \\ \hline \end{array}$ | $\begin{aligned} & \hline 174 \\ & 214 \\ & \hline \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=M S S= \\ & V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{X}, \bar{Y}$ |  | $\begin{aligned} & 397 \\ & 538 \end{aligned}$ | $\begin{array}{r} 794 \\ 1076 \end{array}$ |  | $\begin{aligned} & 161 \\ & 213 \end{aligned}$ | $\begin{aligned} & 322 \\ & 426 \end{aligned}$ |  | $\begin{aligned} & 113 \\ & 150 \end{aligned}$ | $\begin{aligned} & 226 \\ & 300 \end{aligned}$ | ns | $\begin{aligned} & l_{1}=I_{2}=\mathrm{MSS}= \\ & \mathrm{V}_{\mathrm{SS}} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{X}, \bar{Y}$ |  | $\begin{array}{\|l\|} \hline 527 \\ 668 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline 1054 \\ 1336 \end{array}$ |  | $\begin{aligned} & 205 \\ & 269 \end{aligned}$ | $\begin{aligned} & 410 \\ & 538 \end{aligned}$ |  | $\begin{aligned} & \hline 144 \\ & 189 \end{aligned}$ | $\begin{aligned} & 288 \\ & 378 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=V_{S S} \\ & M S S=V_{D D} \\ & \hline \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{X}$ |  | $\begin{aligned} & 519 \\ & 695 \end{aligned}$ | $\begin{aligned} & 1038 \\ & 1380 \end{aligned}$ |  | $\begin{aligned} & 202 \\ & 279 \end{aligned}$ | $\begin{aligned} & 404 \\ & 558 \end{aligned}$ |  | $\begin{aligned} & 142 \\ & 196 \end{aligned}$ | $\begin{aligned} & 284 \\ & 392 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=M S S= \\ & V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tpHL } \\ & \hline \end{aligned}$ | Propagation Delay, $A_{n}$ to $\bar{W}$ |  | $\begin{array}{\|l\|} \hline 556 \\ 415 \\ \hline \end{array}$ | $\begin{array}{r} 1112 \\ 830 \end{array}$ |  | $\begin{aligned} & 229 \\ & 161 \end{aligned}$ | $\begin{aligned} & 458 \\ & 322 \end{aligned}$ |  | $\begin{aligned} & 161 \\ & 113 \end{aligned}$ | $\begin{aligned} & 322 \\ & 226 \end{aligned}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{S S}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $A_{n}$ to $Z$ |  | $\begin{aligned} & \hline 512 \\ & 618 \end{aligned}$ | $\begin{aligned} & 1024 \\ & 1236 \end{aligned}$ |  | $\begin{aligned} & 236 \\ & 245 \end{aligned}$ | $\begin{aligned} & 472 \\ & 490 \end{aligned}$ |  | $\begin{aligned} & 166 \\ & 172 \end{aligned}$ | $\begin{aligned} & 332 \\ & 344 \end{aligned}$ | ns | $I_{1}=I_{2}=V_{S S}$ |
| $\begin{aligned} & \overline{{ }^{\text {tPLH }}} \\ & { }^{\mathrm{t} P \mathrm{HL}} \end{aligned}$ | Propagation Delay, $\mathrm{t}_{1}, \mathrm{I}_{2} \text { to } \bar{X}, \bar{Y}$ |  | $\begin{aligned} & \hline 143 \\ & 338 \end{aligned}$ | $\begin{aligned} & 286 \\ & 676 \end{aligned}$ |  | $\begin{array}{r} 71 \\ 134 \end{array}$ | $\begin{aligned} & 142 \\ & 268 \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 94 \end{aligned}$ | $\begin{aligned} & 100 \\ & 188 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=V_{S S} \\ & M S S=V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{0}$ to $\bar{X}, \bar{Y}$ |  | $\begin{array}{\|l\|} \hline 171 \\ 304 \end{array}$ | $\begin{aligned} & 342 \\ & 608 \end{aligned}$ |  | $\begin{array}{r} 85 \\ 118 \end{array}$ | $\begin{aligned} & 170 \\ & 236 \end{aligned}$ |  | $\begin{aligned} & \hline 60 \\ & 83 \end{aligned}$ | $\begin{aligned} & 120 \\ & 166 \end{aligned}$ | ns | $\begin{aligned} & I_{1}=I_{2}=V_{S S} \\ & M S S=V_{D D} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & { }^{\text {tPHL }} \end{aligned}$ | Propagation Delay, $I_{1}, I_{2}$ to $Z$ |  | $\begin{aligned} & 370 \\ & 276 \end{aligned}$ | $\begin{aligned} & 740 \\ & 552 \end{aligned}$ |  | $\begin{aligned} & \hline 186 \\ & 109 \end{aligned}$ | $\begin{aligned} & \hline 392 \\ & 218 \end{aligned}$ |  | $\begin{array}{r} 131 \\ 77 \end{array}$ | $\begin{aligned} & 262 \\ & 154 \end{aligned}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{S S}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{0}$ to $Z$ |  | $\begin{aligned} & 298 \\ & 177 \end{aligned}$ | $\begin{aligned} & 596 \\ & 354 \end{aligned}$ |  | $\begin{array}{r} 155 \\ 70 \end{array}$ | $\begin{aligned} & 310 \\ & 140 \end{aligned}$ |  | $\begin{array}{r} 109 \\ 49 \end{array}$ | $\begin{array}{r} 218 \\ 98 \end{array}$ | ns | $\mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{\text {SS }}$ |
| $\begin{aligned} & \text { tpZH } \\ & \text { tpZL } \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & 71 \\ & 58 \end{aligned}$ | $\begin{aligned} & 142 \\ & 116 \end{aligned}$ |  | $\begin{aligned} & 36 \\ & 27 \end{aligned}$ | $\begin{aligned} & 72 \\ & 54 \end{aligned}$ |  | $\begin{aligned} & 26 \\ & 19 \end{aligned}$ | $\begin{aligned} & 52 \\ & 38 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tpLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & 71 \\ & 79 \end{aligned}$ | $\begin{aligned} & 142 \\ & 158 \end{aligned}$ |  | $\begin{aligned} & 40 \\ & 42 \end{aligned}$ | $\begin{aligned} & 80 \\ & 84 \end{aligned}$ |  | $\begin{aligned} & 28 \\ & 30 \end{aligned}$ | $\begin{aligned} & 56 \\ & 60 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tTLH } \\ & { }^{\mathrm{t} T \mathrm{HL}} \end{aligned}$ | Output Transition Time |  | $\begin{aligned} & 95 \\ & 67 \end{aligned}$ | $\begin{aligned} & 190 \\ & 134 \end{aligned}$ |  | 54 27 | $\begin{array}{r} 108 \\ 54 \end{array}$ |  | $\begin{aligned} & 38 \\ & 19 \end{aligned}$ | $\begin{aligned} & 76 \\ & 38 \end{aligned}$ | ns | $C_{L}=50 \mathrm{pF}$ |

## NOTES:

1. For f MAX input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns .
2. It is recommended that input rise and fall times to the Clock Input be less than $15 \mu \mathrm{~s}$.
3. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
4. Propagation Delays and Output transition times are graphically described in this section under 4700 Series CMOS Family Characteristics.
5. The Internal Clock is generated from CP and $\overline{E X}$. The Internal Clock is HIGH if $\overline{E X}$ or $C P$ is HIGH, LOW if $\overline{E X}$ and CP are LOW. For timing considerations the $\overline{E X}, C P$ two input active LOW AND gate is considered to exhibit no propagation delay. Actual timing requirements are referenced to the external CP and $\overline{\mathrm{EX}}$ inputs.
6. Input Transition Times $\leqslant 20 \mathrm{~ns}$.

## SWITCHING WAVEFORMS



PROPAGATION DELAYS, $A_{n}$ to $Z, I_{n}$ to $Z, \bar{D}_{n}$ to $Z$, $A_{n}$ to $\bar{X}, \bar{Y}, I_{n}$ to $\bar{X}, \bar{Y}, \bar{D}_{n}$ to $\bar{X}, \bar{Y}, A_{n}$ to $\bar{W}, I_{n}$ to $\bar{W}, \bar{D}_{n}$ to $\bar{W}, I_{n}$ to $\bar{O}_{n}$ SET-UP AND HOLD TIMES EX TO CP, $A_{n}$ TO CP, $\bar{D}_{\mathrm{n}}$ to $C P, I_{\mathrm{n}}$ to $C P$, MINIMUM INTERNAL CLOCK PULSE

NOTES:
a. Delay for logical operation ( $l_{1}$ or $\left.I_{2}=\mathrm{HIGH}\right)$
b. Delay for arithmetic operation ( $1_{1}=I_{2}=$ LOW )
c. Set-up Times ( $\mathrm{t}_{\mathrm{s}}$ ) and Hold Times ( $\mathrm{t}_{\mathrm{h}}$ ) are shown as positive values but may be specified as negative values.

# 4706/4706B <br> PROGRAM STACK <br> FAIRCHILD CMOS MACROLOGIC 

DESCRIPTION - The 4706 is a 16 -word by 4 -bit "push-down pop-up" Program Stack. It is designed to implement Program Counter (PC) and return address storage for nested subroutines in programmable digital systems. The 4706 executes 4 instructions: Return, Branch, Call and Fetch as specified by a 2-bit instruction. When the device is initialized, PC is in the top location of the stack. As a new PC value is "pushed" into the stack (Call operation), all previous PC values effectively move down one level. The top location of the stack is the current PC. Up to 15 new program counter values can be stored, which gives the 4706 a 15 level nesting capability. "Popping" the stack (Return operation) brings the most recent PC to the top of the stack. The remaining two instructions affect only the top location of the stack. In the Branch operation a new PC value is loaded into the top location of the stack from the $\bar{D}_{0}-\bar{D}_{3}$ inputs. In the Fetch operation, the contents of the top stack location (current PC value) are put on the $X_{0}-X_{3}$ bus and the current PC value is incremented.

The 4706 may be expanded to any word length without additional logic. 3-state output. drivers are provided on the 4-bit address outputs ( $X_{0}-X_{3}$ ) and data outputs, $\left(\bar{O}_{0}-\bar{O}_{3}\right)$; the X -Bus outputs are enabled internally during the Fetch instruction while the O -bus outputs are controlled by an Output Enable ( $\overline{\mathrm{EO}}_{0}$ ). Two status outputs, Stack Full ( $\overline{\mathrm{SF}}$ ) and Stack Empty ( $\overline{\mathrm{SE}}$ ) are provided. The 4706 is fully compatible with all CMOS families.

```
- 16-WORD BY 4-BIT LIFO
- 15-LEVEL NESTING CAPABILITY
- 2 MHz MICROINSTRUCTION RATE
- PROGRAM COUNTER LOADS FROM DATA BUS
- OPTIONAL AUTOMATIC INCREMENT OF PROGRAM COUNTER
- STACK LIMIT STATUS INDICATORS
- SLIM 24-PIN PACKAGE
- 3-STATE OUTPUTS
- VERY LOW POWER DISSIPATION
```

PIN NAMES

| $\overline{\mathrm{D}_{0}}-\overline{\mathrm{D}}_{3}$ | Data Inputs (Active LOW) |
| :--- | :--- |
| $\overline{\mathrm{I}_{1}}, \mathrm{I}_{1}$ | Instruction Inputs |
| $\overline{\mathrm{EX}}$ | Execute Input (Active LOW) |
| $\overline{\mathrm{CP}}$ | Clock Input |
| $\overline{\mathrm{MR}}$ | Master Reset Input (Active LOW) |
| $\overline{\mathrm{Cl}}$ | Carry Input (Active LOW) |
| $\overline{\mathrm{O}}_{0}$ | Output Enable Input (Active LOW) |
| $\overline{\mathrm{X}_{0}}-\overline{\mathrm{O}}_{3}$ | Output Data Outputs (Active LOW) |
| $\overline{\mathrm{CO}}$ | Address Outputs |
| $\overline{\mathrm{SF}}$ | Carry Output (Active LOW) |
| $\overline{\mathrm{SE}}$ | Stack Full Output (Active LOW) |
|  | Stack Empty Output (Active LOW) |



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.

## BLOCK DIAGRAM



TABLE 1
INSTRUCTION SET FOR THE 4706

| $1_{1} I_{0}$ | INSTRUCTION | INTERNAL OPERATION | X-BUS | O-BUS (WITH $\overline{\mathrm{EO}}_{0}$ LOW) |
| :---: | :---: | :---: | :---: | :---: |
| L L | Return (Pop) | Decrement Stack Pointer | Disabled | Depending on the relative timing of $\overline{E X}$ and $C P$, the outputs will reflect the current program counter or the new value while $C P$ is LOW. When CP goes HIGH again, the output will reflect the new value. |
| L H | Branch (Load PC) | Load D-Bus into Current Program Counter Location | Disabled | Current Program Counter until CP goes HIGH again, then updated with newly entered PC value. |
| H L | Call (Push) | Increment Stack Pointer and Load D-Bus into New Program Counter Location | Disabled | Depending on the relative timing of $\overline{E X}$ and $C P$, the outputs will reflect the current program counter or the previous contents of the incremented SP location. When CP goes HIGH again, the outputs will reflect the newly entered PC value. <br> See Switching Waveforms for details. |
| H H | Fetch <br> (Increment PC) | Increment Current Program Counter if $\overline{\mathrm{CI}}$ is LOW | Current Program Counter while both CP and $\overline{E X}$ are LOW, disabled while CP or $\overline{\mathrm{EX}}$ is HIGH | Current Program Counter until CP goes HIGH again, then updated with incremented PC value. |

[^5]FUNCTIONAL DESCRIPTION - As shown in the block diagram, the 4706 consists of an Input Multiplexer, a $16 \times 4$ RAM with output latches addressed by the Stack Pointer (SP), an incrementor, control logic, and output buffers. The 4706 is organized around three 4-bit busses; the input data bus ( $\bar{D}_{0}-\bar{D}_{3}$ ), output data bus ( $\bar{O}_{0}-\bar{O}_{3}$ ) and the address bus ( $X_{0}-X_{3}$ ). The 4706 implements four instructions as determined by Inputs $I_{0}$ and $I_{1}$ (see Table 1). The O-Bus is derived from the RAM output latches and enabled by a LOW on the Output Enable ( $\overline{\mathrm{EO}}_{0}$ ) input. The X -Bus is also derived from the output latches; it is enabled internally during the Fetch instruction. Execution of instructions is controlled by the Execute ( $\overline{\mathrm{EX}}$ ) and Clock (CP) inputs.

Fetch Operation - The Fetch operation places the content of the current Program Counter (PC) on the X-Bus. If the Carry In $(\overline{\mathrm{CI}})$ is LOW, the current PC is incremented in preparation for the next Fetch. If $\overline{\mathrm{Cl}}$ is HIGH , the value of the current PC is unchanged, (Iterative Fetch).
The instruction code is set up on the I lines when CP is HIGH. The Execute $(\overline{E X})$ is normally LOW at this time. The control logic interprets $I_{0}$ and $I_{1}$ and selects the incrementor output as the data source to the RAM via the Input Multiplexer. The current PC value is loaded into the latches and is available on the O-Bus if $\overline{\mathrm{EO}}_{0}$ is LOW. When CP is LOW the latches are disabled from following the RAM output, when both CP and $\overline{E X}$ are LOW, buffers are enabled, applying the current PC to the $X$-Bus. The output of the incrementor is written into the RAM during the period when $C P$ and $\overline{E X}$ are LOW. If $\overline{\mathrm{Cl}}$ is LOW, the value stored in the current PC, plus one, is written into the RAM. If $\overline{\mathrm{Cl}}$ is HIGH , the current PC is not incremented. Carry Out $(\overline{\mathrm{CO}})$ is LOW when the content of the current PC is at its maximum, i.e., all ones and the Carry In $(\overline{\mathrm{CI}})$ is LOW. When CP or $\overline{E X}$ goes HIGH, writing into the RAM is inhibited and the address buffers ( $\mathrm{X}_{0}-\mathrm{X}_{3}$ ) are disabled.
Branch Operation - During a Branch operation, the data inputs ( $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ ) are loaded into the current program counter.
The instruction code and the $\overline{E X}$ Input are set up when CP is HIGH. The Stack Pointer remains unchanged. When CP goes LOW (assuming $\overline{\mathrm{EX}}$ is LOW) the D-Bus Inputs are written into the current PC. The X-Bus drivers are not enabled during a Branch operation.

Call Operation - During a Call operation the content of the data bus is loaded into the top location of the stack and all previous PC values are effectively moved down one level.
The instruction code and the $\overline{E X}$ input are set up when CP is HIGH. When $\overline{E X}$ is LOW, a "one" is added to the Stack Pointer value thus incrementing the RAM address. Since the output latches go to the nontransparent or store mode when CP is LOW, the O-Bus outputs will reflect the RAM output at the CP negative-going transition. If $\overline{E X}$ goes LOW considerably before CP goes LOW, the O-Bus will correspond to the previous contents of the incremented RAM address after CP goes LOW. If CP goes LOW a very short time after $\overline{E X}$, the O-Bus will remain unchanged until the LOW to HIGH transition of CP. When CP is LOW (assuming $\overline{E X}$ is LOW) the D-Bus inputs are written into this new RAM location. On the LOW-to-HIGH transition of CP, the incremented Stack Pointer value is loaded into the Stack Pointer and the O-Bus outputs reflect the newly entered data. When the RAM address is "1111" the Stack Full output ( $\overline{\mathrm{SF}}$ ) is LOW, indicating that no further Call operations should be initiated. If an additional Call operation is performed SP is incremented to (0000), the contents of that location will be written over, $\overline{\mathrm{SF}}$ will go HIGH and the Stack Empty ( $\overline{\mathrm{SE}}$ ) will go LOW.
The X-Bus drivers are not enabled during a Call operation.
Return Operation - During the Return operation the previous PC is "popped" to become the current PC.
The instruction is set up when CP is HIGH. When $\overline{E X}$ is LOW, a "one" is subtracted from the Stack Pointer value, thus decrementing the RAM address. If $\overline{E X}$ goes LOW considerably before CP goes LOW, the O-Bus will correspond to the new value after $\overline{E X}$ goes LOW. If CP goes LOW a short time after $\overline{E X}$, the O-Bus will remain unchanged until the LOW-to-HIGH transition of CP.
On the LOW-to-HIGH transition of CP the decremented Stack Pointer value is loaded into the Stack Pointer and the O-Bus outputs correspond to the new "popped" value.
The X-Bus drivers are not enabled during a Return operation. When the RAM address is " 0000 ", the Stack Empty output $(\overline{S E})$ is LOW, indicating that no further return operations should be initiated. If an additional Return operation is performed, SP is decremented to "1111", the $\overline{\text { SE }}$ will go HIGH and the Stack Full output ( $\overline{\mathrm{SF}}$ ) will go LOW. A LOW on the Master Reset $(\overline{\mathrm{MR}})$ causes the SP to be reset and the contents of that RAM location (0000) to be cleared. The Stack Empty ( $\overline{\mathrm{SE}}$ ) output goes LOW. This operation overrides all other inputs.

EXPANSION - The 4706 may be expanded to any word length in multiples of four without external logic. The connection for expanded operation is shown in Figure 1. Carry $\operatorname{In}(\overline{\mathrm{Cl}})$ and Carry Out $(\overline{\mathrm{CO}})$ are connected to provide automatic increment of the current program counter during Fetch. The $\overline{\mathrm{CI}}$ input of the least significant 4706 is tied LOW to ground.
If automatic increment during Fetch is not desired, the $\overline{\mathrm{Cl}}$ input of the least significant 4706 is held HIGH.

*Tie to $V_{D D}$ to disable automatic increment.

Fig. 1
4706 EXPANSION A 16 BY 12-PROGRAM STACK

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (Note 1)

| SYMBOL | PARAMETER |  |  |  |  |  | IMIT |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
| IOZH | Output OFF <br> Current HIGH | Xc |  |  | $\begin{array}{r} 0.5 \\ 30 \\ \hline \end{array}$ |  |  | 1.0 60 |  | $\begin{array}{r} 0.2 \\ 12 \\ \hline \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | Output Returned to $V_{D D}, \overline{\mathrm{EO}}_{0}=V_{D D}$ |
|  |  | XM |  |  | $\begin{gathered} \hline 0.05 \\ 3.0 \end{gathered}$ |  |  | 0.1 6.0 |  | $\begin{array}{r} \hline 0.02 \\ 1.2 \end{array}$ |  |  | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ |  |
| Iozl | Output OFF Current LOW | Xc |  |  | $\begin{gathered} -0.5 \\ -30 \end{gathered}$ |  |  | $\begin{array}{r} -1.0 \\ -60 \end{array}$ |  | $\begin{aligned} & \hline-0.2 \\ & -12 \\ & \hline \end{aligned}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | Output Returned to $\mathrm{V}_{\mathrm{SS}}, \overline{\mathrm{EO}}_{0}=\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | -0.05 -3.0 |  |  | -0.1 -6.0 |  | $\begin{array}{r} -0.02 \\ -1.2 \end{array}$ |  |  | $\begin{gathered} \hline \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ |  |
| IDD | Quiescent <br> Power <br> Supply <br> Current | Xc |  |  | $\begin{aligned} & 32.5 \\ & 250 \end{aligned}$ |  |  | $\begin{gathered} 65 \\ 500 \\ \hline \end{gathered}$ |  |  | $\begin{aligned} & 130 \\ & 1000 \\ & \hline \end{aligned}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | All inputs at 0 V or VDD |
|  |  | XM |  |  | $\begin{aligned} & 8.75 \\ & 250 \end{aligned}$ |  |  | $\begin{array}{r} 17.5 \\ 500 \end{array}$ |  |  | $\begin{gathered} 35 \\ 1000 \end{gathered}$ |  | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ |  |

[^6]FAIRCHILD • 4706/4706B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
(ALL MODES OF OPERATION)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (See Note 2) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \\ & \hline \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & 121 \\ & 103 \end{aligned}$ | $\begin{aligned} & 242 \\ & 206 \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 38 \end{aligned}$ | $\begin{array}{r} 100 \\ 76 \end{array}$ |  | $\begin{aligned} & 38 \\ & 29 \end{aligned}$ | $\begin{array}{r} 76 \\ 58 \\ \hline \end{array}$ | ns | $\begin{aligned} & \left(R_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| $\begin{aligned} & \hline{ }_{\text {tPHZ }} \\ & { }^{\text {tPLZ }} \end{aligned}$ | Output Disable Time |  | $\begin{array}{r} 136 \\ 99 \end{array}$ | $\begin{aligned} & 272 \\ & 198 \end{aligned}$ |  | $\begin{aligned} & \hline 54 \\ & 47 \end{aligned}$ | $\begin{array}{r} 108 \\ 94 \end{array}$ |  | $\begin{aligned} & 36 \\ & 32 \end{aligned}$ | $\begin{aligned} & 72 \\ & 64 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tTLH } \\ & { }^{\mathrm{t} T \mathrm{HL}} \\ & \hline \end{aligned}$ | Output Transition Time |  | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ | $\begin{aligned} & 60 \\ & 60 \end{aligned}$ |  | $\begin{aligned} & 15 \\ & 15 \end{aligned}$ | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ |  | $\begin{aligned} & 12 \\ & 12 \end{aligned}$ | $\begin{array}{r} 24 \\ 24 \\ \hline \end{array}$ | ns | $\begin{aligned} & C_{L}=15 \mathrm{pF} \\ & \text { Input Transition } \\ & \text { Times } \leqslant 20 \mathrm{~ns} \\ & \hline \end{aligned}$ |
| $\begin{aligned} & \hline \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & \hline 144 \\ & 126 \end{aligned}$ | $\begin{aligned} & 288 \\ & 252 \end{aligned}$ |  | $\begin{aligned} & \hline 62 \\ & 48 \end{aligned}$ | $\begin{array}{r} 124 \\ 96 \end{array}$ |  | $\begin{aligned} & \hline 47 \\ & 34 \end{aligned}$ | $\begin{aligned} & 94 \\ & 68 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tPLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & 162 \\ & 121 \end{aligned}$ | $\begin{aligned} & 324 \\ & 242 \end{aligned}$ |  | $\begin{aligned} & \hline 67 \\ & 59 \end{aligned}$ | $\begin{aligned} & 134 \\ & 118 \end{aligned}$ |  | $\begin{aligned} & 45 \\ & 38 \end{aligned}$ | $\begin{aligned} & 90 \\ & 76 \end{aligned}$ | ns | $\begin{aligned} & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| tTLH <br> ${ }^{\text {t }}$ THL | Output Transition Time |  | $\begin{aligned} & \hline 60 \\ & 60 \end{aligned}$ | $\begin{aligned} & 120 \\ & 120 \end{aligned}$ |  | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ | $\begin{aligned} & 60 \\ & 60 \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | $\begin{aligned} & 40 \\ & 40 \end{aligned}$ | ns | $C_{L}=50 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| $\mathrm{t}_{\text {rec }}$ | $\overline{\text { MR Recovery Time }}$ | 538 | 269 |  | 440 | 220 |  | 296 | 148 |  | ns |  |
| ${ }_{t}{ }_{w} \overline{M R}(L)$ | $\overline{\mathrm{MR}}$ Minimum Pulse Width | 314 | 157 |  | 116 | 58. |  | 74 | 37 |  | ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |
| ${ }^{\text {t }}$ WP(L) | CP Minimum Pulse Width, LOW | 520 | 260 |  | 142 | 71 |  | 80 | 40 |  |  | Input Transition |
| ${ }^{t w}{ }^{\text {c }}$ CP(H) | CP Minimum Pulse Width, HIGH | 622 | 311 |  | 196 | 98 |  | 90 | 45 |  | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| ${ }^{\text {t }} \mathrm{CW}$ | Clock Period | 1142 | 571 |  | 558 | 279 |  | 440 | 220 |  | ns |  |

Notes on following pages.

## RESET OPERATION



## MINIMUM $\overline{M R}$ PULSE WIDTH AND $\overline{M R}$ RECOVERY TIME



## $\overline{E O}_{0}$ TO OUTPUT ENABLE AND DISABLE TIMES

NOTE: Set-up ( $\mathrm{t}_{\mathrm{s}}$ ) and Hold ( $\mathrm{t}_{\mathrm{h}}$ ) Times are shown as positive values but may be specified as negative values.

FAIRCHILD • 4706/4706B

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{D D}$ as shown, $V_{S S}=0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$ (BRANCH OPERATION)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (See Note 2) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| ${ }^{\text {tPLH }}$ | Propagation Delay, |  | 236 | 472 |  | 97 | 194 |  | 68 | 136 |  | $C_{L}=15 \mathrm{pF}$ <br> Input Transition |
| ${ }^{\text {tPHL }}$ | CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | 181 | 362 |  | 68 | 136 |  | 47 | 194 | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| tplh | Propagation Delay, |  | 287 | 574 |  | 109 | 218 |  | 78 | 156 |  | $C_{L}=50 \mathrm{pF}$ |
| ${ }^{\text {tPHL }}$ | CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | 238 | 476 |  | 84 | 168 |  | 61 | 122 | ns | $\begin{aligned} & \text { Input Transition } \\ & \text { Times } \leqslant 20 \mathrm{~ns} \end{aligned}$ |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\mathrm{In}_{\mathrm{n}}$ to $\overline{\mathrm{EX}}$ | 172 | 86 |  | 58 | 29 |  | 42 | 21 |  |  |  |
| $t_{\text {h }}$ | Hold Time, $\mathrm{I}_{\mathrm{n}}$ to EX | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to CP | 182 | 91 |  | 106 | 53 |  | 64 | 32 |  |  | $C_{L}=15 \mathrm{pF}$ |
| $t_{\text {h }}$ | Hold Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to CP | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns | $\begin{aligned} & \text { Input Transition } \\ & \text { Times } \leqslant 20 \mathrm{~ns} \end{aligned}$ |
| $t_{\text {h }}$ | Hold Time, $\mathrm{I}_{\mathrm{n}}$ to CP | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |
| $\mathrm{t}_{w} \overline{E X}$ | Min. $\overline{\mathrm{EX}}$ Pulse Width | 188 | 94 |  | 74 | 37 |  | 50 | 25 |  | ns |  |

Notes on following pages.

BRANCH OPERATION, CP GOES HIGH BEFORE EX


PROPAGATION DELAY CP TO $\bar{O}_{n}$ AND SET-UP AND HOLD
TIMES, $I_{n}$ TO $\overline{E X}, \bar{D}_{n}$ TO CP AND $I_{n}$ TO CP
CONDITIONS: $\overline{E O}_{0}=$ LOW

NOTE: Set-up ( $t_{s}$ ) and Hold ( $t_{h}$ ) Times are shown as positive values but may be specified as negative values.

FAIRCHILD • 4706/4706B
SWITCHING WAVEFORMS FOR A BRANCH OPERATION EX GOES HIGH BEFORE CP


PROPAGATION DELAY, CP TO $\overline{\mathrm{O}}_{\mathrm{n}}$, MINIMUM $\overline{E X}$ PULSE WIDTH AND SET-UP AND HOLD TIMES, $I_{n}$ TO $\overline{E X}, \overline{E X}$ TO CP AND $I_{n}$ TO CP CONDITIONS: $\overline{E O}_{0}=$ LOW
NOTE: Set-up ( $t_{s}$ ) and Hold ( $t_{h}$ ) Times are shown as positive values but may be specified as negative values.
AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (CALL OPERATION ONLY)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (See Note 2) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, CP to $\bar{O}_{n}$ |  | $\begin{aligned} & 481 \\ & 435 \end{aligned}$ | $\begin{aligned} & 962 \\ & 870 \end{aligned}$ |  | $\begin{aligned} & 172 \\ & 152 \end{aligned}$ | $\begin{aligned} & 344 \\ & 304 \end{aligned}$ |  | $\begin{array}{r} 114 \\ 98 \end{array}$ | $\begin{aligned} & 228 \\ & 196 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}}$ to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{array}{r} \hline 421 \\ .570 \end{array}$ | $\begin{array}{\|r} 842 \\ 1140 \\ \hline \end{array}$ |  | $\begin{aligned} & 127 \\ & 171 \end{aligned}$ | $\begin{aligned} & 254 \\ & 342 \end{aligned}$ |  | $\begin{array}{r} 93 \\ 120 \end{array}$ | $\begin{aligned} & 186 \\ & 240 \end{aligned}$ | ns | $C_{L}=15 \mathrm{pF}$ Input Transition Times $\leqslant 20$ ns |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\overline{E X}$ to $\overline{S E}$ or $\overline{S F}$ |  | $\begin{aligned} & 191 \\ & 225 \end{aligned}$ | $\begin{aligned} & 382 \\ & 450 \end{aligned}$ |  | $\begin{aligned} & 103 \\ & 120 \end{aligned}$ | $\begin{aligned} & 206 \\ & 240 \end{aligned}$ |  | $\begin{aligned} & 73 \\ & 84 \end{aligned}$ | $\begin{aligned} & 146 \\ & 168 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 513 \\ & 461 \end{aligned}$ | $\begin{array}{r} \hline 1026 \\ 922 \end{array}$ |  | $\begin{aligned} & 182 \\ & 161 \end{aligned}$ | $\begin{aligned} & 364 \\ & 322 \end{aligned}$ |  | $\begin{aligned} & 121 \\ & 104 \end{aligned}$ | $\begin{aligned} & 242 \\ & 208 \end{aligned}$ | ns |  |
| $\begin{aligned} & \overline{\mathrm{tPLH}} \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}}$ to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 480 \\ & 505 \end{aligned}$ | $\begin{array}{\|r\|} \hline 960 \\ 1010 \\ \hline \end{array}$ |  | $\begin{aligned} & 134 \\ & 180 \end{aligned}$ | $\begin{aligned} & 268 \\ & 360 \end{aligned}$ |  | $\begin{array}{r} 99 \\ 127 \end{array}$ | $\begin{aligned} & 198 \\ & 254 \end{aligned}$ | ns | $C_{L}=50 \mathrm{pF}$ Input Transition |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}}$ to $\overline{\mathrm{SE}}$ or $\overline{\mathrm{SF}}$ |  | $\begin{aligned} & 202 \\ & 240 \end{aligned}$ | $\begin{aligned} & 404 \\ & 480 \end{aligned}$ |  | $\begin{aligned} & 110 \\ & 127 \end{aligned}$ | $\begin{aligned} & 220 \\ & 254 \end{aligned}$ |  | $\begin{aligned} & 77 \\ & 89 \end{aligned}$ | $\begin{aligned} & 154 \\ & 178 \end{aligned}$ | ns |  |
| $\mathrm{t}_{\mathrm{s}}$ | Set-Up Time, $\overline{E X}$ to $I_{n}$ | 96 | 48 |  | 48 | 24 |  | 34 | 17 |  | ns |  |
| th | Hold Time, CP to $\mathrm{In}_{n}$ | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |
| $\mathrm{t}_{\text {s } 1} \mathrm{EX}$ | Set-Up Time, $\overline{E X}$ to CP With Data On $\overline{\mathrm{O}}_{\mathrm{n}}$ While CP = LOW | 848 | 424 |  | 324 | 162 |  | 186 | 93 |  | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition |
| ${ }^{\mathrm{t}_{5} \mathrm{EX}}$ | Set-Up Time, $\overline{\overline{E X}}$ to CP With No Change $\operatorname{In} \overline{\mathrm{O}}_{\mathrm{n}}$ While $\mathrm{CP}=$ LOW | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| $t_{4} \mathrm{EX}$ | Hold Time, CP to EX | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |
| $\mathrm{t}_{5}$ | Set-Up Time, $\overline{\mathrm{D}}_{n}$ to CP | 426 | 213 |  | 194 | 97 |  | 128 | 64 |  | ns |  |
| ${ }^{\text {th }}$ | Hold Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to CP | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |

Notes on following pages.


PROPAGATION DELAY, CP TO $\overline{\mathrm{O}}_{\mathrm{n}}, \overline{\mathrm{EX}}$ TO $\overline{\mathrm{O}}_{\mathrm{n}}$, $\overline{E X}$ TO $\overline{\text { SE OR }} \overline{\text { SF }}$, AND SET-UP AND HOLD TIMES, $\overline{E X}$ TO $I_{n}, C P$ TO $\mathrm{I}_{n}, \bar{D}_{n}$ TO CP, CP TO $\overline{E X}$.

CONDITIONS: $\overline{\mathrm{EO}}_{0}=$ LOW

NOTES: a. Condition which occurs when $\overline{E X}$ goes LOW considerably before CP goes LOW ( $t_{s 1} E X$ is met)
b. Condition which occurs when EX goes LOW slightly before CP goes LOW ( $t_{s 2} E X$ is met).
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

FAIRCHILD • 4706/4706B
AC CHARACTERISTICS AND SWITCHING REQUIREMENTS: $V_{D D}$ as shown, $V_{S S}=0 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$ (RETURN OPERATION ONLY)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (See Note 2) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 480 \\ & 445 \end{aligned}$ | $\begin{aligned} & 960 \\ & 890 \end{aligned}$ |  | $\begin{aligned} & 181 \\ & 161 \end{aligned}$ | $\begin{aligned} & 363 \\ & 322 \end{aligned}$ |  | $\begin{aligned} & 120 \\ & 113 \end{aligned}$ | $\begin{aligned} & 240 \\ & 226 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH }^{\text {tPHL }} \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}} \text { to } \overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 479 \\ & 546 \\ & \hline \end{aligned}$ | $\begin{array}{r} 958 \\ 1092 \\ \hline \end{array}$ |  | $\begin{aligned} & 141 \\ & 192 \end{aligned}$ | $\begin{aligned} & 282 \\ & 384 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 133 \\ & 141 \end{aligned}$ | $\begin{aligned} & 266 \\ & 282 \end{aligned}$ | ns | $C_{L}=15 \mathrm{pF}$ Input Transition Times $\leqslant 20 \mathrm{~ns}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}}$ to $\overline{\mathrm{SE}}$ or $\overline{\mathrm{SF}}$ |  | $\begin{aligned} & 204 \\ & 220 \end{aligned}$ | $\begin{aligned} & 408 \\ & 440 \end{aligned}$ |  | $\begin{aligned} & 98 \\ & 92 \end{aligned}$ | $\begin{aligned} & 196 \\ & 184 \end{aligned}$ |  | $\begin{aligned} & \hline 74 \\ & 72 \end{aligned}$ | $\begin{aligned} & 148 \\ & 144 \end{aligned}$ | ns |  |
| $\begin{aligned} & \hline{ }^{\mathrm{t} P L H} \\ & { }^{\mathrm{t} P \mathrm{HL}} \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 510 \\ & 475 \end{aligned}$ | $\begin{array}{\|r\|} \hline 1020 \\ 950 \end{array}$ |  | $\begin{aligned} & \hline 193 \\ & 172 \end{aligned}$ | $\begin{aligned} & 386 \\ & 344 \end{aligned}$ |  | $\begin{aligned} & 130 \\ & 120 \end{aligned}$ | $\begin{aligned} & 260 \\ & 240 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}}$ to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{array}{\|l\|} \hline 505 \\ 580 \\ \hline \end{array}$ | $\begin{array}{\|l\|l\|} \hline 1010 \\ 1160 \\ \hline \end{array}$ |  | $\begin{aligned} & 150 \\ & 205 \\ & \hline \end{aligned}$ | $\begin{aligned} & 300 \\ & 410 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 142 \\ & 150 \\ & \hline \end{aligned}$ | $\begin{aligned} & 282 \\ & 300 \end{aligned}$ | ns | $C_{L}=50 \mathrm{pF}$ Input Transition Times $\leqslant 20 \mathrm{~ns}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tpHL } \\ & \hline \end{aligned}$ | Propagation Delay, $\overline{\mathrm{EX}}$ to $\overline{\mathrm{SE}}$ or $\overline{\mathrm{SF}}$ |  | $\begin{aligned} & 216 \\ & 233 \end{aligned}$ | $\begin{aligned} & 432 \\ & 466 \end{aligned}$ |  | $\begin{array}{r} 105 \\ 78 \end{array}$ | $\begin{aligned} & 210 \\ & 156 \end{aligned}$ |  | $\begin{aligned} & 79 \\ & 77 \end{aligned}$ | $\begin{aligned} & 158 \\ & 154 \end{aligned}$ | ns |  |
| $\mathrm{t}_{\mathrm{s}}$ | Set-Up Time, $\overline{E X}$ to $I_{n}$ | 62 | 31 |  | 18 | 9 |  | 10 | 5 |  | ns |  |
| $t^{\text {th}}$ | Hold Time, $\mathrm{I}_{\mathrm{n}}$ to CP | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |
| $\mathrm{t}_{51} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{\mathrm{EX}}$ to CP Which Guarantees a New Value On $\overline{\mathrm{O}}_{\mathrm{n}}$ While CP is LOW | 540 | 270 |  | 266 | 133 |  | 148 | 74 |  | ns | $C_{L}=15 \mathrm{pF}$ |
| $\mathrm{t}_{\mathrm{s} 2} \overline{\mathrm{EX}}$ | Set-Up Time, $\overline{\mathrm{EX}}$ to CP Either $\mathrm{t}_{\mathrm{s} 2} \overline{\mathrm{EX}}$ or $\mathrm{t}_{\mathrm{s} 3} \overline{\mathrm{EX}}$ Must Be Met For Proper Operation | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns | Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| $\mathrm{t}_{\mathrm{s} 3} \overline{\mathrm{EX}}$. | Set-Up Time, $\overline{E X}$ to CP Either $\mathrm{t}_{\mathrm{s} 2} \overline{\overline{E X}}$ or $\mathrm{t}_{\mathrm{s} 3} \overline{\mathrm{EX}}$ Must Be Met For Proper Operation | 280 | 140 |  | 186 | 93 |  | 70 | 35 |  | ns |  |

Notes on following pages.
SWITCHING WAVEFORMS FOR A RETURN (POP) OPERATION


PROPAGATION DELAY, CP TO $\overline{O_{n}}, \overline{E X}$ TO $\overline{O_{n}}, \overline{E X}$ TO $\overline{S E}$ OR $\overline{S F}$, AND SET-UP AND HOLD TIMES, EX TO $I_{n}, I_{n}$ TO CP, EX TO CP'

CONDITIONS: $\overline{\mathrm{EO}}_{0}=$ LOW
NOTES: a. Condition which occurs when $\overline{E X}$ goes LOW considerably before CP goes LOW ( $T_{s 1} \overline{E X}$ is met).
b. Condition which occurs when $\overline{E X}$ goes LOW slightly before or after CP goes LOW (Either $t_{s 2} \overline{\overline{E X}}$ or $t_{s 3} \overline{E X}$ are met).
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

## AC CHARACTERISTICS AND SET-UP REOUIREMENTS: $\mathrm{V}_{\text {DD }}$ as shown, $\mathrm{V}_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (FETCH OPERATION ONLY)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS (See Note 2) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{array}{l\|l} 234 \\ 174 \end{array}$ | $\begin{aligned} & 468 \\ & 348 \end{aligned}$ |  | $\begin{aligned} & 92 \\ & 67 \end{aligned}$ | $\begin{aligned} & 184 \\ & 134 \end{aligned}$ |  | 65 | $\begin{array}{r} 130 \\ 94 \end{array}$ | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Output Enable <br> Time ( $X_{n}$ ) |  | $\begin{aligned} & 121 \\ & 103 \end{aligned}$ | $\begin{aligned} & 242 \\ & 206 \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 38 \end{aligned}$ | $\begin{array}{r} 100 \\ 76 \end{array}$ |  | $\begin{aligned} & 38 \\ & 29 \end{aligned}$ | 76 58 | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tphz } \\ & \text { tpLZ } \end{aligned}$ | Output Disable <br> Time ( $X_{n}$ ) |  | $\begin{array}{r} 136 \\ 99 \end{array}$ | $\begin{aligned} & 272 \\ & 198 \end{aligned}$ |  | $\begin{aligned} & 54 \\ & 47 \end{aligned}$ | $\begin{array}{r} 108 \\ 94 \end{array}$ |  | $\begin{aligned} & 36 \\ & 32 \end{aligned}$ | 72 64 | ns | $\begin{aligned} & \left(R_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, CP to $\overline{\mathrm{O}}_{\mathrm{n}}$ |  | $\begin{aligned} & 274 \\ & 215 \end{aligned}$ | $\begin{aligned} & 548 \\ & 430 \end{aligned}$ |  | $\begin{array}{r} 108 \\ 82 \end{array}$ | $\begin{aligned} & 216 \\ & 164 \end{aligned}$ |  | $\begin{aligned} & 77 \\ & 57 \end{aligned}$ | $\begin{aligned} & 154 \\ & 114 \end{aligned}$ | ns | $C_{L}=50 \mathrm{pF}$ <br> Input Transition |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZ } \\ & \hline \end{aligned}$ | Output Enable <br> Time ( $X_{n}$ ) |  | $\begin{aligned} & 144 \\ & 126 \end{aligned}$ | $\begin{aligned} & 288 \\ & 252 \end{aligned}$ |  | $\begin{aligned} & 62 \\ & 48 \end{aligned}$ | $\begin{array}{r} 124 \\ 96 \end{array}$ |  | $\begin{aligned} & 47 \\ & 34 \end{aligned}$ | $\begin{aligned} & 94 \\ & 68 \end{aligned}$ | ns | $\begin{aligned} & \text { Times } \leqslant 20 \mathrm{~ns} \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{SS}}\right) \\ & \left(\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{DD}}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tphz } \\ & \text { tpLZ } \\ & \hline \end{aligned}$ | Output Disable Time ( $X_{n}$ ) |  | $\begin{array}{\|l\|} \hline 162 \\ 121 \end{array}$ | $\begin{aligned} & 324 \\ & 242 \end{aligned}$ |  | $\begin{aligned} & \hline 67 \\ & 59 \end{aligned}$ | $\begin{aligned} & 134 \\ & 118 \end{aligned}$ |  | $\begin{aligned} & 45 \\ & 38 \end{aligned}$ | $\begin{aligned} & 90 \\ & 76 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $I_{n}$ to $\overline{E X}$ | 488 | 244 |  | 134 | 67 |  | 90 | 45 |  | ns |  |
| $\mathrm{th}^{\text {r }}$ | Hold Time, $\mathrm{I}_{\mathrm{n}}$ to CP or $\overline{\mathrm{EX}}$ | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, EX to CP | 644 | 322 |  | 170 | 85 |  | 148 | 74 |  | ns | Input Transi |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\overline{\mathrm{Cl}}$ to CP | 570 | 285 |  | 132 | 66 |  | 90 | 45 |  | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| th | Hold Time, $\overline{\mathrm{Cl}}$ to $\overline{\mathrm{EX}}$ | 20 | 0 |  | 15 | 0 |  | 10 | 0 |  | ns |  |

NOTES:

1. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4700 Series CMOS Family Characteristics.
3. Propagation Delays ( $\mathrm{t}_{\mathrm{PLH}}$ and $\mathrm{tPHL}_{\mathrm{L}}$ ) and Output Transition Times ( $\mathrm{t}_{\mathrm{TLH}}$ and $\mathrm{t}_{\mathrm{TH}}$ ) will change with Output Load Capacitance ( $\mathrm{C}_{\mathrm{L}}$ ).

Set-up Times ( $t_{s}$ ), Hold Times ( $t_{h}$ ), Recovery Times ( $t_{r e c}$ ), and Minimum Pulse Widths ( $t_{w}$ ) do not vary with load capacitance.
4. It is recommended that input rise and fall times to the Clock Input be less than $15 \mu \mathrm{~s}$.

SWITCHING WAVEFORMS FOR AN ITERATIVE FETCH


OUTPUT $X_{n}$ DISABLE DELAY, OUTPUT $X_{n}$ ENABLE DELAY, AND SET-UP AND HOLD TIMES, $I_{n}$ TO $\overline{E X}, I_{n}$ TO CP, $\overline{E X}$ TO CP, AND $\overline{C I}$ TO $\overline{E X}$.
CONDITIONS: $\overline{E O}_{0}=$ LOW, CP GOES HIGH BEFORE $\overline{E X}$
NOTES: a. $X_{0}-X_{3}$ turn on delay measured from time both EX and CP go LOW.
b. $X_{0}-X_{3}$ turn off delay measured from time either EX or CP goes HIGH.
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

SWITCHING WAVEFORMS FOR AN ITERATIVE FETCH (Cont'd)


OUTPUT $X_{n}$ ENABLE AND DISABLE TIMES AND SET-UP AND HOLD TIMES, $I_{n}$ TO $\overline{E X}, \overline{C l}$ TO $\overline{E X}$ AND $\overline{E X}$ TO CP. CONDITIONS: $\overline{E O}_{0}=$ LOW, $\overline{E X}$ GOES HIGH BEFORE CP

## SWITCHING WAVEFORMS FOR A FETCH OPERATION WITH INCREMENT PC



PROPAGATION DELAY, CP TO $\overline{\mathrm{O}}_{\mathrm{n}}$, OUTPUT $\mathrm{X}_{\mathrm{n}}$ ENABLE AND DISABLE TIMES
AND SET-UP AND HOLD TIMES, $I_{n}$ TO $\overline{E X}, \overline{E X}$ TO CP, AND $\overline{\mathrm{Cl}}$ TO CP
CONDITIONS: $\overline{\mathrm{EO}}_{0}=$ LOW, CP GOES HIGH BEFORE $\overline{\mathrm{EX}}$
NOTES: a. $X_{0}-x_{3}$ turn on delay measured from time both $\overline{E X}$ and CP go LOW.
b. $X_{0}-X_{3}$ turn off delay measured from time either $\overline{E X}$ or $C P$ goes HIGH.
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.


PROPAGATION DELAY CP TO $\bar{\sigma}_{n}$, OUTPUT $X_{n}$ ENABLE AND DISABLE TIMES, AND SET-UP AND HOLD TIMES, $I_{n}$ TO EX, EX TO CP AND $\overline{C l}$ TO CP

CONDITIONS: $\overline{E O}_{0}=$ LOW, $\overline{E X}$ GOES HIGH BEFORE CP
NOTES: a. $X_{0}-X_{3}$ turn on delay measured from the time both $E X$ and CP go LOW.
b. $X_{0}-X_{3}$ turn on delay measured from the time either $\overline{E X}$ or $C P$ go HIGH.
c. Set-up and Hold Times are shown as positive values but may be specified as negative values.

# 4707/4707B <br> DATA ACCESS REGISTER 

FAIRCHILD CMOS MACROLOGIC

DESCRIPTION - The 4707 Data Access Register (DAR) is designed to perform the memory address functions for RAM resident stack applications. The DAR can implement general registers with an adder network in programmable digital systems. The 4707 contains three 4-bit registers intended for Program Counter ( $\mathrm{R}_{0}$ ), Stack Pointer ( $\mathrm{R}_{1}$ ), and Operand Address $\left(R_{2}\right)$. The 4707 implements 16 instructions (see Table 1) which allow either pre or post decrement/increment and register-to-register transfer in a single clock cycle. It is expandable in 4-bit increments and can operate at a 5.3 MHz microinstruction rate on a 16 -bit word. The 3 -state outputs are provided for bus oriented applications. The 4707 is fully compatible with all CMOS families.

- HIGH SPEED - 5.2 MHz MICROINSTRUCTION RATE, TYPICALLY
- THREE 4-BIT REGISTERS
- 16 INSTRUCTIONS FOR REGISTER MANIPULATION
- TWO SEPARATE OUTPUT PORTS, ONE TRANSPARENT
- RELATIVE ADDRESSING CAPABILITY
- 3-STATE OUTPUTS
- OPTIONAL PRE OR POST ARITHMETIC
- EXPANDABLE IN MULTIPLES OF FOUR BITS
- SLIM 24-PIN PACKAGE


## PIN NAMES

| $\overline{\mathrm{D}}_{0}-\overline{\mathrm{D}}_{3}$ | Data Inputs (Active LOW) |
| :--- | :--- |
| $\overline{\mathrm{I}}_{0}-\mathrm{I}_{3}$ | Instruction Word Inputs |
| $\overline{\mathrm{CI}}$ | Carry Input (Active LOW) |
| $\overline{\mathrm{CO}}$ | Carry Output (Active LOW) |
| CP | Clock Input (L $\rightarrow$ H Edge-Triggered) |
| $\overline{\mathrm{EX}}$ | Execute Input (Active LOW) |
| $\overline{\mathrm{EO}}$ | Address Output Enable Input |
| $\overline{\mathrm{EO}}_{0}$ | (Active LOW) |
|  | Data Output Enable Input |
| $\mathrm{X}_{0}-\mathrm{X}_{3}$ | (Active LOW) |
| $\overline{\mathrm{O}}_{0}-\overline{\mathrm{O}}_{3}$ | Address Outputs |
|  | Data Outputs (Active Low) |



The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-line Package.


FUNCTIONAL DESCRIPTION - The 4707 contains a 4 -bit slice of three registers ( $\mathrm{R}_{0}-\mathrm{R}_{2}$ ), a 4-Bit Adder, 3-state address output buffers ( $X_{0}-X_{3}$ ) and a separate Output Register with 3 -state buffers ( $\left.\bar{O}_{0}-\bar{O}_{3}\right)$, allowing output of the register contents on the data bus (refer to the block diagram). The DAR performs 16 instructions, selected by $I_{0}-I_{3}$ inputs, as listed in Table 1.

Operation - A microcycle starts as the clock goes HIGH. Data inputs $\bar{D}_{0}-\bar{D}_{3}$ are applied to the Adder as one of the operands. Three of the four instruction lines $\left(I_{1}, I_{2}, I_{3}\right)$ select which of the three registers, if any, is to be used as the other operand. The LOW-to-HIGH transition of the CP linput writes the result from the Adder into a register ( $\mathrm{R}_{0}-\mathrm{R}_{2}$ ) and into the Output Register provided EX is LOW. If the $\mathrm{I}_{0}$ input is HIGH, the multiplexer routes the result from the Adder to the 3 -state buffer controlling the address bus ( $X_{0}-X_{3}$ ) independent of $E X$ and CP. If $I_{0}$ is LOW, the multiplexer routes the output of the selected register directly into the 3 -state buffer controlling the address bus ( $X_{0}-X_{3}$ ), independent of $E X$ and $C P$.

TABLE 1
INSTRUCTION SET FOR THE 4707

| INSTRUCTION |  |  |  | COMBINATORIAL FUNCTION <br> AVAILABLE ON THE X-BUS | SEQUENTIAL FUNCTION OCCURRING ON THE NEXT RISING CP EDGE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $I_{3}$ | $\mathrm{I}_{2}$ | $\mathrm{I}_{1}$ | $\mathrm{I}_{0}$ |  |  |
| L | L | L | L | $\mathrm{R}_{0}$ |  |
| L | L | L | H | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{0}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{0}$ and Output Register |
| L | L | H | L |  |  |
| L | L | H | H | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{0}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{1}$ and Output Register |
| L | H | L | L | $\mathrm{R}_{0}$ |  |
| L | H | L | H | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{0}$ plus $\overline{\mathrm{D}}$ plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Register |
| L | H | H | L | $\mathrm{R}_{1} \quad-$ | $\mathrm{R}_{1}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{1}$ and Output Register |
| L | H | H | H | $\mathrm{R}_{1}$ plus $\overline{\mathrm{D}}$ p/us $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{1}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{1}$ and Output Re |
| H | L | L | L | $\mathrm{R}_{2}$ | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}} \rightarrow \mathrm{R}_{2}$ and Output Register |
| H | L | L | H | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Register |
| H | L | H | L | $\mathrm{R}_{0}$ |  |
| H | L | H | H | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{0}$ and Output Register |
| H | H | L | L | $\mathrm{R}_{2}$ |  |
| H | H | L | H | $\mathrm{R}_{2}$ plus $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | $\mathrm{R}_{2}$ plus D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{2}$ and Output Register |
| H | H | H | L |  |  |
| H | H | H | H | $\overline{\mathrm{D}}$ plus $\overline{\mathrm{Cl}}$ | D plus $\mathrm{Cl} \rightarrow \mathrm{R}_{1}$ and Output Register |

L $=$ LOW Level
H $=$ HIGH Level

4707 EXPANSION - The 4707 is organized as a 4-bit register slice. The active LOW $\overline{\mathrm{Cl}}$ and $\overline{\mathrm{CO}}$ lines allow ripple-carry expansion over longer word lengths.

APPLICATIONS - The 4707 is organized as a 4-bit register slice. The $\overline{\mathrm{Cl}}$ and $\overline{\mathrm{CO}}$ lines allow ripple-carry expansion over longer word lengths. Figure 1 is a block diagram of a typical application. Each block of the Macrologic parts represents four identical slices, thus creating a 16 -bit array. For this application the register utilizations in the DAR may be as follows: $R_{0}$ is the Program Counter (PC), $R_{1}$ is the Stack Pointer (SP) for memory resident stack and $R_{2}$ contains the operand address. For an instruction fetch, PC can be gated on the X-Bus while it is being incremented (i.e., D-Bus $=1$ ). If the fetched instruction calls for an effective address for calculation, which is displaced from the PC, the displacement can be added to the PC and loaded into $\mathrm{R}_{2}$ during the next microcycle.
A different type of application using the DAR is shown in Figure 2. Four 4707s are used here as the major elements in a data path loop closed by four 4704s (DPS). This data path can be used for dedicated multiply/divide function. The DAR register utilization in this application can be as follows :
$R_{0}$ is the multiplicand in case of multiply or the divisor in case of divide;
$\mathrm{R}_{1}$ is the temporary result in case of multiply or the dividand/quotient in case of divide;
$\mathrm{R}_{2}$ is the product in case of multiply or a temporary register in case of divide.


Fig. 1
TYPICAL MEMORY ADDRESS APPLICATION


Fig. 2

DC CHARACTERISTICS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (Note 1)

| SYMBOL | PARAMETER |  | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
| IOZH | Output OFF HIGH Current | Xc |  |  | 0.5 30 |  |  | 1.0 60 |  | $\begin{array}{r} 0.2 \\ 12 \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $V_{D D}, \overline{\mathrm{EO}}_{0}=V_{D D}$ $\overline{E O} X=V_{D D}$ |
|  |  | XM |  |  | $\begin{array}{r} \hline 0.05 \\ 3.0 \end{array}$ |  |  | 0.1 6.0 |  | 0.02 1.2 |  |  | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ |  |
| IOZL | Output OFF <br> Low Current | XC |  |  | $\begin{aligned} & -0.5 \\ & -30 \end{aligned}$ |  |  | $\begin{array}{r} -1.0 \\ -60 \end{array}$ |  | $\begin{array}{r} \hline-0.2 \\ -12 \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ | $\begin{aligned} & \text { Output Returned } \\ & \text { to } V_{S S}, \overline{E O}_{0}=V_{D D}, \\ & \overline{\mathrm{EO}}_{\mathrm{X}}=\mathrm{V}_{\mathrm{DD}} \end{aligned}$ |
|  |  | XM |  |  | $\begin{array}{\|c} -0.05 \\ -3.0 \end{array}$ |  |  | $\begin{aligned} & \hline-0.1 \\ & -6.0 \end{aligned}$ |  | $\begin{array}{r} -0.02 \\ -1.2 \end{array}$ |  |  | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ |  |
| ${ }^{1} \mathrm{DD}$ | Quiescent <br> Power <br> Supply <br> Current | Xc |  |  | $\begin{array}{r} 32.5 \\ 250 \end{array}$ |  |  | $\begin{array}{r} 65 \\ 500 \end{array}$ |  |  | $\begin{array}{\|r\|} \hline 130 \\ 1000 \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | All inputs at 0 V or $\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{r} 8.75 \\ 250 \end{array}$ |  |  | 17.5 500 |  |  | $\begin{array}{\|r\|} \hline 35 \\ 1000 \end{array}$ | $\mu \mathrm{A}$ | $\begin{aligned} & \text { MIN, } 25^{\circ} \mathrm{C} \\ & \text { MAX } \end{aligned}$ |  |

AC CHARACTERISTICS AND SET-UP REOUIREMENTS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\overline{\text { tpLH }}$ tPHL | Propagation Delay, Internal Clock to $\overline{\mathrm{Q}}_{\mathrm{n}}$ |  | $\begin{aligned} & 189 \\ & 203 \end{aligned}$ | $\begin{aligned} & \hline 378 \\ & 406 \end{aligned}$ |  | 84 86 | $\begin{aligned} & \hline 168 \\ & 172 \end{aligned}$ |  | $\begin{aligned} & \hline 64 \\ & 63 \end{aligned}$ | $\begin{aligned} & 128 \\ & 126 \end{aligned}$ | ns |  |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { Propagation Delay, } I_{1}-I_{3} \text { to } X_{n} \\ & \text { With } I_{0}=\text { LOW } \end{aligned}$ |  | $\begin{aligned} & 265 \\ & 215 \end{aligned}$ | $\begin{aligned} & 530 \\ & 430 \end{aligned}$ |  | $\begin{array}{\|r\|} \hline 113 \\ 82 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline 226 \\ 164 \\ \hline \end{array}$ |  | $\begin{aligned} & 95 \\ & 62 \end{aligned}$ | $\begin{aligned} & 190 \\ & 124 \end{aligned}$ | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition |
| tpLH <br> tpHL | Propagation Delay, $I_{1}-I_{3}$ to $X_{n}$ With $\mathrm{I}_{0}=$ HIGH |  | $\begin{aligned} & 286 \\ & 272 \end{aligned}$ | $\begin{aligned} & 572 \\ & 544 \end{aligned}$ |  | $\begin{aligned} & \hline 130 \\ & 113 \end{aligned}$ | $\begin{array}{\|l\|} \hline 260 \\ 226 \end{array}$ |  | $\begin{array}{r} 107 \\ 75 \end{array}$ | $\begin{aligned} & 214 \\ & 150 \end{aligned}$ | ns | Times $\leqslant 20 \mathrm{~ns}$ |
| tpLH tpHL | Propagation Delay, Internal Clock to $X_{n}$ with $I_{0}=$ LOW |  | $\begin{aligned} & 259 \\ & 217 \end{aligned}$ | $\begin{aligned} & 518 \\ & 434 \end{aligned}$ |  | $\begin{array}{\|r\|} \hline 101 \\ 83 \end{array}$ | $\begin{array}{\|l\|} \hline 202 \\ 166 \end{array}$ |  | $\begin{aligned} & 82 \\ & 72 \end{aligned}$ | $\begin{aligned} & 164 \\ & 144 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & { }^{\text {tPHL }} \end{aligned}$ | Propagation Delay, Internal Clock to $X_{n}$ With $I_{0}=$ HIGH |  | $\begin{aligned} & 331 \\ & 343 \end{aligned}$ | $\begin{aligned} & 662 \\ & 686 \end{aligned}$ |  | $\begin{array}{\|l\|} \hline 131 \\ 131 \end{array}$ | $\begin{array}{\|l\|} \hline 262 \\ 262 \\ \hline \end{array}$ |  | $\begin{array}{r} 99 \\ 101 \end{array}$ | $\begin{aligned} & 198 \\ & 202 \end{aligned}$ | ns |  |
| tPLH tPHL | Propagation Delay, $\overline{\mathrm{D}}_{\mathrm{n}}$ to $\mathrm{X}_{\mathrm{n}}$ |  | $\begin{aligned} & 190 \\ & 177 \end{aligned}$ | $\begin{array}{\|l\|} \hline 380 \\ 354 \\ \hline \end{array}$ |  | $\begin{aligned} & 82 \\ & 66 \end{aligned}$ | $\begin{array}{\|l\|} \hline 164 \\ 172 \\ \hline \end{array}$ |  | $\begin{aligned} & \hline 62 \\ & 48 \end{aligned}$ | $\begin{array}{r} 124 \\ 96 \end{array}$ | ns |  |
| $\begin{aligned} & \hline \begin{array}{l} \text { tPLH } \\ { }^{\text {tPHL }} \end{array} \end{aligned}$ | Propagation Delay, $\overline{\mathrm{Cl}}$ to $\mathrm{X}_{\mathrm{n}}$ |  | $\begin{aligned} & 235 \\ & 235 \end{aligned}$ | $\begin{aligned} & 470 \\ & 470 \end{aligned}$ |  | $\begin{aligned} & 116 \\ & 125 \end{aligned}$ | $\begin{aligned} & 232 \\ & 250 \end{aligned}$ |  | $\begin{aligned} & 76 \\ & 81 \end{aligned}$ | $\begin{aligned} & 152 \\ & 162 \end{aligned}$ | ns |  |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\mathrm{I}_{0}$ to $\mathrm{X}_{\mathrm{n}}$ |  | $\begin{aligned} & 137 \\ & 126 \end{aligned}$ | $\begin{aligned} & 274 \\ & 252 \end{aligned}$ |  | 63 <br> 52 | $\begin{array}{\|l\|} \hline 126 \\ 104 \\ \hline \end{array}$ |  | $\begin{aligned} & 47 \\ & 37 \end{aligned}$ | $\begin{aligned} & 94 \\ & 74 \end{aligned}$ | ns |  |
| tPLH tPHL | Propagation Delay, Positive-going Internal Clock to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 232 \\ & 286 \end{aligned}$ | $\begin{array}{\|l\|} \hline 464 \\ 572 \\ \hline \end{array}$ |  | $\begin{aligned} & 104 \\ & 119 \end{aligned}$ | $\begin{aligned} & 208 \\ & 238 \end{aligned}$ |  | $\begin{aligned} & 70 \\ & 81 \end{aligned}$ | $\begin{aligned} & 140 \\ & 162 \end{aligned}$ | ns | * |
| $\begin{aligned} & \hline \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\overline{\mathrm{Cl}}$ to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 102 \\ & 113 \end{aligned}$ | $\begin{array}{\|l\|} \hline 204 \\ 226 \\ \hline \end{array}$ |  | $\begin{aligned} & 38 \\ & 41 \end{aligned}$ | $\begin{aligned} & 76 \\ & 82 \end{aligned}$ |  | $\begin{aligned} & 26 \\ & 28 \end{aligned}$ | $\begin{aligned} & 52 \\ & 56 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\overline{\mathrm{D}}_{\mathrm{n}}$ to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 126 \\ & 130 \end{aligned}$ | $\begin{aligned} & 252 \\ & 260 \end{aligned}$ |  | $\begin{aligned} & 46 \\ & 51 \end{aligned}$ | $\begin{array}{r} 92 \\ 102 \end{array}$ |  | $\begin{aligned} & 35 \\ & 37 \end{aligned}$ | $\begin{aligned} & 70 \\ & 74 \end{aligned}$ | ns |  |
| tpLH tPHL | Propagation Delay, $I_{1}-I_{3}$ to $\overline{C O}$ |  | $\begin{aligned} & 219 \\ & 244 \end{aligned}$ | $\begin{aligned} & 438 \\ & 488 \end{aligned}$ |  | $\begin{array}{\|l\|l\|} \hline 113 \\ 126 \end{array}$ | $\begin{aligned} & 226 \\ & 252 \end{aligned}$ |  | $\begin{aligned} & 68 \\ & 68 \end{aligned}$ | $\begin{aligned} & 136 \\ & 136 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Output Enable Time |  | 77 <br> $\because 87$ | $\begin{array}{\|l\|} \hline 154 \\ 174 \\ \hline \end{array}$ |  | $\begin{aligned} & 28 \\ & 31 \\ & \hline \end{aligned}$ | $\begin{aligned} & 56 \\ & 62 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 19 \\ & 21 \\ & \hline \end{aligned}$ | $\begin{array}{r} 38 \\ 42 \\ \hline \end{array}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \text { tpHZ } \\ & \text { tpLZ } \\ & \hline \end{aligned}$ | Output Disable Time |  | 49 58 | $\begin{array}{\|r} \hline 98 \\ 116 \\ \hline \end{array}$ |  | $\begin{aligned} & 24 \\ & 24 \end{aligned}$ | $\begin{aligned} & 48 \\ & 48 \end{aligned}$ |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | $\begin{aligned} & 40 \\ & 40 \end{aligned}$ | ns | $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| ${ }^{\text {tTLH }}$ <br> ${ }^{\text {tTHL }}$ | Output Transition Time |  | 54 33 | $\begin{array}{\|r} 108 \\ 66 \end{array}$ |  | 31 20 | $\begin{aligned} & 62 \\ & 40 \end{aligned}$ |  | 27 18 | $\begin{aligned} & 54 \\ & 36 \end{aligned}$ | ns |  |

AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, Internal Clock to $\overline{\mathrm{a}}_{\mathrm{n}}$ |  | $\begin{array}{r} 243 \\ 232 \\ \hline \end{array}$ | $\begin{array}{r} 486 \\ 464 \\ \hline \end{array}$ |  | $\begin{array}{r} 113 \\ 99 \\ \hline \end{array}$ | $\begin{array}{\|l} 226 \\ 198 \\ \hline \end{array}$ |  | $\begin{aligned} & 68 \\ & 70 \\ & \hline \end{aligned}$ | $\begin{array}{\|l} 136 \\ 140 \\ \hline \end{array}$ | ns | $C_{L}=50 \mathrm{pF}$ Input Transition Times $\leqslant 20$ ns$\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \hline \text { tPLH } \\ & { }^{\text {tPHL }} \end{aligned}$ | Propagation Delay, $I_{1}-I_{3}$ to $X_{n}$ With $I_{0}=$ LOW |  | $\begin{aligned} & 288 \\ & 243 \end{aligned}$ | $\begin{aligned} & 576 \\ & 486 \end{aligned}$ |  | $\begin{array}{r} 134 \\ 93 \end{array}$ | $\begin{array}{\|l\|} \hline 268 \\ 186 \end{array}$ |  | $\begin{array}{r} 125 \\ 70 \end{array}$ | $\begin{aligned} & 250 \\ & 140 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & { }^{\text {tPHL }} \end{aligned}$ | Propagation Delay, $I_{1}-I_{3}$ to $X_{n}$ With $\mathrm{I}_{0}=\mathrm{HIGH}$ |  | $\begin{aligned} & 383 \\ & 302 \end{aligned}$ | $\begin{aligned} & 766 \\ & 604 \end{aligned}$ |  | $\begin{aligned} & 139 \\ & 119 \end{aligned}$ | $\begin{array}{\|l\|} \hline 278 \\ 238 \end{array}$ |  | $\begin{array}{\|r\|} \hline 126 \\ 91 \end{array}$ | $\begin{aligned} & 252 \\ & 182 \end{aligned}$ | ns |  |
| tPLH tPHL | Propagation Delay, Internal Clock to $X_{n}$ With $\mathrm{I}_{0}=$ LOW |  | $\begin{aligned} & 288 \\ & 244 \end{aligned}$ | $\begin{aligned} & .576 \\ & 488 \end{aligned}$ |  | $\begin{array}{r} 134 \\ 93 \end{array}$ | $\begin{array}{\|l\|} \hline 268 \\ 186 \end{array}$ |  | $\begin{array}{r} 125 \\ 63 \end{array}$ | $\begin{array}{\|l\|} \hline 250 \\ 126 \\ \hline \end{array}$ | ns |  |
| tPLH ${ }^{\text {tPHL }}$ | Propagation Delay, Internal Clock to $X_{n}$ With $I_{0}=H I G H$ |  | $\begin{aligned} & 221 \\ & 358 \end{aligned}$ | $\begin{aligned} & 442 \\ & 716 \end{aligned}$ |  | $\begin{array}{r} 97 \\ 146 \end{array}$ | $\begin{array}{\|l\|} \hline 194 \\ 292 \end{array}$ |  | $\begin{array}{r} 69 \\ 110 \end{array}$ | $\begin{array}{\|l\|} \hline 138 \\ 220 \\ \hline \end{array}$ | ns |  |
| tPLH tPHL | Propagation Delay, $\overline{\mathrm{D}}_{\mathrm{n}}$ to $\mathrm{X}_{\mathrm{n}}$ |  | $\begin{aligned} & 221 \\ & 211 \end{aligned}$ | $\begin{aligned} & 442 \\ & 422 \end{aligned}$ |  | $\begin{aligned} & 97 \\ & 79 \end{aligned}$ | $\begin{array}{\|l\|} \hline 194 \\ 158 \end{array}$ |  | $\begin{aligned} & 69 \\ & 55 \end{aligned}$ | $\begin{array}{\|l\|} \hline 138 \\ 110 \\ \hline \end{array}$ | ns |  |
| tPLH tPHL | Propagation Delay, $\overline{\mathrm{Cl}}$ to $\mathrm{X}_{\mathrm{n}}$ |  | $\begin{aligned} & \hline 276 \\ & 277 \\ & \hline \end{aligned}$ | $\begin{aligned} & 552 \\ & 554 \end{aligned}$ |  | $\begin{array}{\|l\|} \hline 136 \\ 146 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline 272 \\ 292 \\ \hline \end{array}$ |  | $\begin{aligned} & 89 \\ & 95 \end{aligned}$ | $\begin{array}{\|l} \hline 178 \\ 190 \\ \hline \end{array}$ | ns |  |
| tpLH ${ }^{\text {tPHL }}$ | Propagation Delay, $I_{0}$ to $X_{n}$ |  | $\begin{aligned} & 168 \\ & 137 \\ & \hline \end{aligned}$ | $\begin{array}{r} 336 \\ 274 \\ \hline \end{array}$ |  | 82 63 | $\begin{array}{\|l\|} \hline 164 \\ 126 \\ \hline \end{array}$ |  | $\begin{aligned} & 59 \\ & 47 \\ & \hline \end{aligned}$ | $\begin{array}{\|r} 118 \\ 94 \\ \hline \end{array}$ | ns |  |
| tplH tPHL | Propagation Delay, Positive-going Internal Clock to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 258 \\ & 325 \\ & \hline \end{aligned}$ | $\begin{array}{r} 516 \\ 650 \\ \hline \end{array}$ |  | $\begin{array}{\|l} 127 \\ 141 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline 254 \\ \hline 282 \\ \hline \end{array}$ |  | $\begin{aligned} & 80 \\ & 91 \\ & \hline \end{aligned}$ | $\begin{array}{\|l\|} \hline 160 \\ 182 \\ \hline \end{array}$ | ns |  |
| tpLH tPHL | Propagation Delay, $\overline{\mathrm{Cl}}$ to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 132 \\ & 143 \\ & \hline \end{aligned}$ | $\begin{aligned} & 264 \\ & 286 \end{aligned}$ |  | 51 53 | $\begin{array}{\|l\|} \hline 102 \\ 106 \\ \hline \end{array}$ |  | 32 35 | 64 70 | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\overline{\mathrm{D}}_{\mathrm{n}}$ to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 152 \\ & 149 \end{aligned}$ | $\begin{aligned} & 304 \\ & 298 \end{aligned}$ |  | 63 | $\begin{aligned} & 126 \\ & 130 \end{aligned}$ |  | $\begin{aligned} & 46 \\ & 46 \end{aligned}$ | $\begin{aligned} & 92 \\ & 92 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $\mathrm{I}_{1}-\mathrm{I}_{3}$ to $\overline{\mathrm{CO}}$ |  | $\begin{aligned} & 274 \\ & 305 \end{aligned}$ | $\begin{aligned} & 548 \\ & 610 \end{aligned}$ |  | $\begin{array}{\|l\|} \hline 142 \\ 158 \\ \hline \end{array}$ | $\begin{array}{\|l\|} \hline 284 \\ 316 \\ \hline \end{array}$ |  | $\begin{aligned} & 85 \\ & 85 \end{aligned}$ | $\begin{array}{\|l\|} \hline 170 \\ 170 \\ \hline \end{array}$ | ns |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZ } \\ & \hline \end{aligned}$ | Output Enable Time |  | $\begin{aligned} & 79 \\ & 90 \end{aligned}$ | $\begin{aligned} & 158 \\ & 180 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 30 \\ & 34 \end{aligned}$ | $\begin{aligned} & \hline 60 \\ & 68 \end{aligned}$ |  | $\begin{aligned} & 14 \\ & 23 \end{aligned}$ | $\begin{aligned} & 28 \\ & 46 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tPLZ } \end{aligned}$ | Output Disable Time |  | $\begin{aligned} & 53 \\ & 61 \end{aligned}$ | $\begin{aligned} & 106 \\ & 122 \end{aligned}$ |  | $\begin{aligned} & 26 \\ & 28 \end{aligned}$ | $\begin{aligned} & 52 \\ & 56 \end{aligned}$ |  | $\begin{aligned} & 22 \\ & 23 \end{aligned}$ | $\begin{aligned} & 44 \\ & 46 \end{aligned}$ | ns |  |
| $\begin{aligned} & \hline \text { TLH } \\ & \mathrm{t}_{\mathrm{THL}} \\ & \hline \end{aligned}$ | Output Transition Time |  | $\begin{array}{r} 105 \\ 62 \\ \hline \end{array}$ | $\begin{aligned} & 210 \\ & 124 \end{aligned}$ |  | $\begin{aligned} & 54 \\ & 31 \end{aligned}$ | $\begin{array}{\|r} \hline 108 \\ 62 \end{array}$ |  | $\begin{aligned} & \hline 45 \\ & 22 \end{aligned}$ | $\begin{aligned} & 90 \\ & 44 \end{aligned}$ | ns |  |
| $\mathrm{t}_{\mathrm{w}} \mathrm{CP}(\mathrm{H})$ | Internal CP minimum Pulse Width (HIGH) | 282 | 141 |  | 240 | 120 |  | 176 | 88 |  | ns | $C_{L}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| $\mathrm{t}_{\mathrm{w}} \mathrm{CP}(\mathrm{L})$ | Internal CP Minimum Pulse Width (LOW) | 102 | 51 |  | 48 | 24 |  | 44 | 22 |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-up Time, $I_{1}-I_{3}$ to Internal Clock | 218 | 109 |  | 82 | 41 |  | 60 | 30 |  | ns |  |
| th | Hold Time, $I_{1}-I_{3}$ to Internal Clock | -48 | -96 |  | -17 | -34 |  | -12 | -24 |  | ns |  |
| $\mathrm{t}_{\mathrm{s}}$ | Set-up Time, $\overline{\mathrm{D}}_{\mathrm{n}}, \overline{\mathrm{Cl}}$ to Internal Clock | 170 | 85 |  | 88 | 44 |  | 58 | 29 |  | ns |  |
| $t^{\text {h }}$ | Hold Time, $\overline{\mathrm{D}}_{\mathrm{n}}, \overline{\mathrm{Cl}}$ to Internal Clock | 28 | 14 |  | 30 | 15 |  | 28 | 14 |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-up Time, $\overline{\mathrm{Cl}}$ to Internal Clock | 82 | 41 |  | 44 | 22 |  | 38 | 19 |  | ns |  |
| ${ }^{\text {th }}$ | Hold Time, $\overline{\mathrm{Cl}}$ to Internal Clock | 112 | 56 |  | 58 | 29 |  | 42 | 21 |  | ns |  |
| ${ }^{\text {t }}$ W | Internal Clock Period (Note 3) | 388 | 194 |  | 170 | 85 |  | 146 | 73 |  | ns |  |
| $\mathrm{f}_{\text {MAX }}$ | Input Count Frequency (Note 5) | 2.6 | 5.2 |  | 5.9 | 11.8 |  | 6.8 | 13.7 |  | MHz |  |

## NOTES:

1. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under F 4000 Series CMOS Family Characteristics.
3. The Internal Clock is generated from CP and $\overline{E X}$. The Internal Clock is HIGH if $\overline{E X}$ or $C P$ is HIGH, LOW if $\overline{E X}$ and CP are LOW. For timing considerations the $\overline{E X}, C P$ two input active LOW NAND gate is considered to exhibit no propagation delay. Actual timing requirements are referenced to the external CP and $\overline{\mathrm{EX}}$ inputs.
4. Propagation Delays ( $\mathrm{P}_{\mathrm{PLH}}$ and $\mathrm{t}_{P H L}$ ) and Output Transition Times ( $\mathrm{t}_{\mathrm{TLH}}$ and $\mathrm{t}_{T H L}$ ) will change with Output Load Capacitance ( $\mathrm{C}_{\mathrm{L}}$ ). Set-up Times ( $\mathrm{t}_{\mathrm{s}}$ ), Hold Times ( $\mathrm{t}_{\mathrm{h}}$ ), and Minimum Pulse Widths ( $\mathrm{t}_{\mathrm{w}}$ ), do not vary with load capacitance.
5. For $f_{M A X}$ input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns .
6. It is recommended that input rise and fall times to the Clock Input be less than $15 \mu \mathrm{~s}$.

SWITCHING WAVEFORMS (Cont'd)


PROPAGATION DELAYS, INTERNAL CLOCK TO $\bar{O}_{n}$, INTERNAL CLOCK TO $X_{n}$, INTERNAL CLOCK TO $\overline{C O}$, SET-UP AND HOLD TIMES, $1_{1}-l_{3}$ TO INTERNAL CLOCK,
$\bar{D}_{\mathrm{n}}$ TO INTERNAL CLOCK, $\overline{\mathbf{C l}}$ TO INTERNAL CLOCK, AND MINIMUM INTERNAL CLOCK PULSE WIDTH

CONDITIONS: $\overline{\mathrm{EO}}_{\mathrm{X}}=\overline{\mathrm{EO}}_{\mathrm{O}}=$ LOW

NOTE: Set-up ( $t_{s}$ ) and Hold ( $t_{h}$ ) Times are shown as positive values but may be specified as negative values.

# 4708/4708B <br> MICROPROGRAM SEQUENCER <br> FAIRCHILD CMOS MACROLOGIC 

DESCRIPTION - The 4708 Microprogram Sequencer controls the order in which microinstructions are fetched from the control memory. It contains a 10-bit program counter, a 4-level last-in first-out stack with associated stack control logic, an Input Multiplexer, an Instruction Decoder, a 10-bit Incrementer and a 4-bit Test Register. It can control up to a maximum of 1024 words of memory. For larger word capacities, external paging can be used. The 4708 is controlled by a 4-bit instruction input. The instruction set includes Fetch, Conditional and Unconditional Branches, Branch to Subroutine and Return from Subroutine.

There are seven test inputs - four participate in conditional branches ( $\mathrm{T}_{0}-\mathrm{T}_{3}$ ), and three in multiway branches ( $\mathrm{MW}_{\mathrm{O}}-\mathrm{MW}_{2}$ ). The conditional test inputs ( $\mathrm{T}_{0}-\mathrm{T}_{3}$ ) are flip-flop buffered. These flip-flops can be tested individually by appropriate branch instructions. The three multiway-test inputs ( $\mathrm{MWO}^{-}-\mathrm{MW}_{2}$ ) are used to form the least significant three bits of the branch address for a multiway branch. Thus, branching occurs at one of eight unique locations depending on the bit pattern present on these three inputs.

The 4708 is designed to operate in pipeline or non-pipeline mode as specified by the user. The device operates synchronously with the Clock input (CP) and can be initialized using the Master Reset input ( $\overline{\mathrm{MR}}$ ).

The 4708 is fabricated using Isoplanar C CMOS technology and is fully compatible with all CMOS families.

```
- CONTROLS 1024 WORDS OF MICROPROGRAM MEMORY
    (10-BIT ADDRESS)
- UNRESTRICTED BRANCHING WITHIN 10-BIT ADDRESS SPACE
- 16 INSTRUCTIONS
- FOUR FLIP-FLOP BUFFERED TEST INPUTS FOR CONDITIONAL
        BRANCHES
- 8-WAY BRANCH CAPABILITY
- PIPELINE/NON-PIPELINE MODE OF OPERATION
```


## PIN NAMES

| $\mathrm{BA}_{0}-\mathrm{BA} 9$ | Branch Address Inputs |
| :--- | :--- |
| $\mathrm{TO}_{0}-\mathrm{T}_{3}$ | Test Inputs |
| $\mathrm{MW}_{0}-\mathrm{MW}_{2}$ | Multiway Branch Inputs |
| $\mathrm{IO}_{0}-\mathrm{I}_{3}$ | Instruction Inputs |
| PLS | Pipeline Select Input |
| $\overline{M R}$ | Master Reset Input |
|  | (Active LOW) |
| CP | Clock Pulse Input |
| STRB | Strobe Input |
| $\mathrm{AO}_{0}-\mathrm{A9}$ | Address Outputs |
| VIAO, VIA1 | VIA Outputs |
| INH | Inhibit Output |



$$
\begin{aligned}
& \mathrm{V}_{\mathrm{DD}}=\operatorname{Pin} 10 \\
& \mathrm{~V}_{\mathrm{SS}}=\operatorname{Pin} 30
\end{aligned}
$$

## CONNECTION DIAGRAM

 DIP (TOP VIEW)

FAIRCHILD • 4708/4708B

## BLOCK DIAGRAM



FAIRCHILD • 4708/4708B

TABLE 1
4708 INSTRUCTION SET

| Unconditional | MNEMONIC | DEFINITION | $13 l_{2} 11_{0}$ | $\mathrm{T}_{3} \mathrm{~T}_{2} \mathrm{~T}_{1} \mathrm{~T}_{0}$ | $\mathrm{O}_{9} \mathrm{O}_{8} \mathrm{O}_{7} \cdots \mathrm{O}_{2} \mathrm{O}_{1} \mathrm{O}_{0}$ | $\mathrm{VIA}_{1} \mathrm{VIA}_{0}$ | INH | DESCRIPTION OF OPERATION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{BRV}_{0}$ | Branch VIA ${ }_{\text {O }}$ | LHLL | $\times \times \times \times$ | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | L L | H | $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ |
|  | $\mathrm{BRV}_{1}$ | Branch VIA 1 | LHLH | $\mathrm{X} \times \times \mathrm{x}$ | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | L H | H | $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ |
| Branch | $\mathrm{BRV}_{2}$ | Branch VIA 2 | LHHL | $x \times \times \times$ | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | H L | H | $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ |
|  | $\mathrm{BRV}_{3}$ | Branch VIA3 | LHHH | $\times \times \times \times$ | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | H H | H | $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ |
| Instructions | BMW | Branch Multiway | LLHH | $\mathrm{X} \times \times \mathrm{X}$ | $\mathrm{BA}_{9} \mathrm{BA}_{3}--\mathrm{MW}_{2} \mathrm{MW}_{0}$ | L L | H | $\begin{aligned} & \mathrm{MW}_{0}-\mathrm{MW} W_{2} \\ & \mathrm{BA}_{3}-\mathrm{BA} \mathrm{~A}_{9} \mathrm{PC} \end{aligned}$ |
|  | BSR | Branch to Subroutine | L L L H | X X X X | $\mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0}$ | L L | H | $\mathrm{BA}_{0}-\mathrm{BA} 9 \rightarrow \mathrm{PC} \&$ <br> Push the Stack |
| . | $\mathrm{BTH}_{0}$ | Branch on $\mathrm{T}_{0}$ HIGH | H HLL | $\begin{aligned} & X X X H \\ & X X X L \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 0 is HIGH: $\mathrm{BA}_{0}-\mathrm{BA} \mathrm{~g} \rightarrow \mathrm{PC}$ <br> If Test Register 0 is LOW: $P C+1 \rightarrow P C$ |
|  | BTH 1 | Branch on $\mathrm{T}_{1}$ HIGH | HHLH | $\begin{aligned} & X X H X \\ & X X L X \end{aligned}$ | $\begin{gathered} \mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0} \\ \mathrm{PC}+1 \end{gathered}$ | L L | H | If Test Register 1 is HIGH: $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 1 is LOW: $P C+1 \rightarrow P C$ |
|  | $\mathrm{BTH}_{2}$ | Branch on $\mathrm{T}_{2}$ HIGH | HHHL | $\begin{aligned} & \text { XHXX } \\ & \text { XLXX } \end{aligned}$ | $\begin{gathered} \mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 2 is HIGH: $\mathrm{BA}_{\mathrm{O}}-\mathrm{BA} \mathrm{~g}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 2 is LOW: $P C+1 \rightarrow P C$ |
| Conditional | $\mathrm{BTH}_{3}$ | Branch on $T_{3}$ <br> HIGH | HHH | $\begin{aligned} & H X X X \\ & L X X X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 3 is HIGH: $\mathrm{BA}_{0}-\mathrm{BA} \mathrm{~g}_{\mathrm{g}} \rightarrow \mathrm{PC}$ <br> If Test Register 3 is LOW: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
| Instructions | $B T L_{0}$ | Branch on $\mathrm{T}_{0}$ <br> LOW | HLLL | $\begin{aligned} & X X X L \\ & X X X H \end{aligned}$ | $\begin{gathered} \mathrm{BA}_{9} \mathrm{BA}_{8}-\mathrm{BA}_{1} \mathrm{BA}_{0} \\ \mathrm{PC}+1 \end{gathered}$ | L L | H | If Test Register 0 is LOW: $\mathrm{BA}_{\mathrm{O}}-\mathrm{BA} \mathrm{~g}_{\mathrm{g}} \rightarrow \mathrm{PC}$ <br> If Test Register 0 is HIGH: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
|  | BTL1 | Branch on $T_{1}$ <br> LOW | HLLH | $\begin{aligned} & X X L X \\ & X X H X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 1 is LOW: $\mathrm{BA}_{0}-\mathrm{BA} \mathrm{~g}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 1 is HIGH: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
|  | BTL2 | Branch on $T_{2}$ <br> LOW | HLHL | $\begin{aligned} & \text { XLXX } \\ & X H X X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 2 is LOW: $\mathrm{BA}_{0}-\mathrm{BA}_{9} \rightarrow \mathrm{PC}$ <br> If Test Register 2 is HIGH: $P C+1 \rightarrow P C$ |
|  | BTL3 | Branch on $\mathrm{T}_{3}$ <br> LOW | HLHH | $\begin{aligned} & \text { LXXX } \\ & H X X X \end{aligned}$ | $\begin{gathered} B A_{9} B A_{8}--B A_{1} B A_{0} \\ P C+1 \end{gathered}$ | L L | H | If Test Register 3 is LOW: $\mathrm{BA}_{0}-\mathrm{BA} 9 \rightarrow \mathrm{PC}$ <br> If Test Register 3 is HIGH: $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |
| Miscellaneous <br> Instructions | RTS | Return from Subroutine | LLLL | $\mathrm{X} \times \times \times$ | Contents of the Stack Addressed by Read Pointer | L L | L | Pop the Stack |
| Instructions | FTCH | FETCH | LLHL | $x \times \times \times$ | PC+1 | L L | L | $\mathrm{PC}+1 \rightarrow \mathrm{PC}$ |

FUNCTIONAL DESCRIPTION - The 4708 Microprogram Sequencer, shown in the block diagram consists of a 10 -bit Program Counter (PC), a 4 -word by 10 -bit Last-In First-Out (LIFO) Stack with associated Stack Control, an Input Multiplexer, a Pipeline Multiplexer, an Instruction Decoder, a 10-bit Incrementer, and a 4-bit Test Register comprised of four edge-triggered D flip-flops.

The Pipeline Multiplexer has two ports - the PC output provides the input port for the non-pipeline mode and the Input Multiplexer output provides the input port for the pipeline mode. Port selection is controlled by the Pipeline Select (PLS) and Master Reset (MR) inputs. A LOW level on the MR input forces the non-pipeline mode of operation and clears the PC. Thus when the 4708 is initialized by the MR input, the AO through A9 outputs are LOW regardless of the state of the PLS input. A LOW level on the PLS input specifies non-pipeline mode and a HIGH specifies pipeline mode.

The Program Counter is a 10-bit edge-triggered register. The LOW-to-HIGH transition on the Clock (CP) input loads the Input Multiplexer output into the PC. The PC input is always the address of the next microinstruction. Because of the edgetriggered nature of the PC register, the PC output remains static for a full clock cycle. Thus, in the non-pipeline mode, the PC output can be used to address a control memory built with static devices without storing the memory output in an external microinstruction register. However, in the pipeline mode, the 4708 provides the next address information as soon as available; therefore, execution of a microinstruction can be overlapped with the fetching of the next microinstruction. To ensure microinstruction stability for a full clock cycle, the control-memory output should be buffered with an external microinstruction register.

The Input Multiplexer receives data from four different sources. One port is the output of the LIFO Stack; a second is the output of the 10 -bit Incrementer. The Incrementer always adds one to the PC contents. The third and fourth ports are the branch and multiway-branch ports, the former comprised of the Branch Address inputs ( $B A_{0}-B A 9$ ) and the latter comprised of the seven most significant Branch Address inputs ( $\mathrm{BA}_{3}$ through $\mathrm{BA} \mathrm{g}_{\text {) }}$ ) and the three Multiway inputs (MW0 through $\mathrm{MW}_{2}$ ).

The 4-word by 10-bit LIFO Stack is a RAM and receives data from the Incrementer output. The Stack Control logic generates the appropriate control signals, while stack pointers in the Stack Control generate the read and write addresses.

The 4-bit Test Register consists of four type-D flip-flops. The data inputs, which are the four Test inputs ( $T_{0}$ through $T_{3}$ ), are loaded on the LOW-to-HIGH transition of the Strobe input (STRB).

The Instruction Decoder receives the 4-bit Instruction input ( $I_{0}$ through $I_{3}$ ) and the Test Register output and generates the VIA0, VIA 1 and Inhibit (INH) outputs of the 4708. In addition, it generates appropriate logic signals for the Stack Control and Input Multiplexer.

Stack Control - The 4708 has a 4-level subroutine nesting capability as detailed in Figure 1. The $\mathrm{R}_{0}$ and $\mathrm{R}_{1}$ (Read Address) inputs to the 4 -word by 10 -bit LIFO Stack specify the address from which information will be read. The $W_{0}$ and $W_{1}$ (Write Address) inputs specify the address into which information will be written; and the 4708 Incrementer output provides the information to be written into the stack (see block diagram). In addition, writing into the memory is controlled by the Write Enable ( $\overline{\mathrm{WE}}$ ) and $\overline{\mathrm{CP}}$ inputs.

The $R_{0}, R_{1}$ and $W_{0}, W_{1}$ inputs of the LIFO Stack are derived from the outputs of a 3-bit edge-triggered register called the Stack Pointer (SP). The least significant two bits ( $\mathrm{SPO}_{0}$ and $\mathrm{SP}_{1}$ ) of this register are the read address inputs to the memory. The SP outputs are also connected to a Stack-Pointer Incrementer and a Decrementer that generate SP + 1 and SP-1 respectively. The least significant two bits of the Incrementer are the write address bits for the memory.

The outputs of the Incrementer, Decrementer and the Stack Pointer are fed as inputs to a 3-port Stack-Pointer Multiplexer which, in turn, feeds the Stack Pointer inputs. Stack pointer loading always occurs on the LOW-to-HIGH transition of the CP input. The MR input clears the Stack Pointer. The Stack Pointer Control receives two inputs from the 4708 Instruction Decoder - the BSR input, which is active whenever a Branch-to-Subroutine (BSR) instruction is present on the lo through $I_{3}$ inputs, and the RTS input, which is active whenever a Return-from-Subroutine (RTS) instruction is specified. The port selection of the Stack Pointer Multiplexer is controlled by the outputs of the Stack Pointer Control. For all 4708 instructions except BSR and RTS, the Stack Pointer Multiplexer selects the Stack Pointer outputs as the instruction source.

Writing into the memory takes place whenever the $\overline{W E}$ and $\overline{C P}$ inputs are LOW. Note that the most significant register bit, $\mathrm{SP}_{2}$, controls the $\overline{\mathrm{WE}}$ input to prevent writing into the memory when all four locations are filled with return addresses. Thus the 4708 does not store and return addresses beyond four nesting levels.


Fig. 1
STACK CONTROL

## 4708 INSTRUCTIONS

The 4708 instruction set has 16 instructions (Table 1). These instructions can be divided into three groups - unconditional branches, conditional branches and miscellaneous - and are specified by appropriate logic levels on the $\mathrm{I}_{0}-\mathrm{I}_{3}$ inputs.
The unconditional branch group consists of four Branch VIA instructions ( $B R V_{0}-B R V_{3}$ ), Branch Multiway ( $B M W$ ) and Branch to Subroutine (BSR). This group requires that the next address be explicitly specified on the BA inputs.

The conditional branch group consists of eight instructions, Branch Test HIGH ( $\mathrm{BTH}_{0}-\mathrm{BTH}_{3}$ ) and Branch Test LOW ( $\mathrm{BTL}_{0}-\mathrm{BTL}_{3}$ ), for interrogating the four test flip-flops of the 4708 individually. The $\mathrm{BTH}_{0}-\mathrm{BTH}_{3}$ instructions test flip-flops $T_{0}-T_{3}$ respectively for a HIGH on the $Q$ output (see block diagram). Similarly BTLO - BTL 3 test for a LOW on the corresponding $Q$ output. If the test condition is satisfied, the next address is taken from the Branch Address ( $B A_{0}-B A g$ ) inputs. If the test condition is not satisified the 4708 performs a Fetch operation.

The miscellaneous group consists of two instructions - Fetch (FTCH) and Return from Subroutine (RTS). These instructions do not require explicit specification of the next address. For the FTCH instruction, the next address is assumed to be the address of the current microinstruction +1 . For RTS, the next address is taken from the Stack. The Inhibit (INH) output of the 4708 is LOW only for FTCH and RTS instructions. For all other instruction, the INH output is HIGH.

The VIA outputs of the $4708\left(\mathrm{VIA}_{0}, \mathrm{VIA}_{1}\right)$ are LOW for all instructions except $\mathrm{BRV}_{1}-\mathrm{BRV}_{3}$. For $\mathrm{BRV}_{1}$, the $\mathrm{VIA}_{0}$ is HIGH and VIA 1 LOW. For $\mathrm{BRV}_{2}$, the $\mathrm{VIA}_{0}$ is LOW and VIA $1_{1}$ HIGH. For BRV ${ }_{3}$, both VIA ${ }_{0}$ and VIA ${ }_{1}$ are HIGH.

## Unconditional Branches

$B R V_{O}-B R V_{3}-$ Whenever a Branch VIA instruction code is present on the $\mathrm{I}_{0}-I_{3}$ inputs, the Instruction Decoder (see block diagram) establishes the appropriate HIGH/LOW pattern on the VIAO and VIA 1 outputs per Table 1. The Instruction Decoder also forces the INH output HIGH. Moreover, the $\mathrm{BA}_{0}-\mathrm{BA} 9$ inputs are selected as the source of the next address by the Input Multiplexer.

If the 4708 is in the pipeline mode (PLS input HIGH), the Pipeline Multiplexer transfers the $\mathrm{BA}_{0}-\mathrm{BA} \mathrm{g}^{2}$ inputs to the $\mathrm{A}_{0}{ }^{-}$ Ag outputs. The $\mathrm{BA}_{0}-\mathrm{BA} 9$ inputs are loaded into the PC on the LOW-to-HIGH transition of the CP input. Conversely, if the non-pipeline mode of operation is selected, the BAO-BAg inputs appear on the output only after the LOW-to-HIGH transition of the $C P$ input.

BMW - For a Branch Multiway instruction, the Instruction Decoder forces the VIAO and VIA 1 outputs LOW and INH output HIGH. The Input Multiplexer selects the $B_{3}-B A 9$ inputs as the most significant seven bits and $M W_{0}-M_{2}$ inputs as the least significant three bits of the next address. If the pipeline mode of operation is selected, the next address formed by the Input Multiplexer ( $B_{3}-B_{9}$ and $M W_{0}-M_{2}$ inputs) is transferred to the $A_{0}-A_{9}$ outputs. On the LOW-to-HIGH transition of the CP input, this next address is also leaded into the PC. For non-pipeline mode, the next address is available on the $A_{0}-A_{9}$ output only after the $C P$ transition.

BSR - During a Branch-to-Subroutine instruction, the Instruction Decoder forces a LOW on the VIA Oand VIA 1 outputs and a HIGH on the INH output. The Input Multiplexer selects the BAO - BAg inputs as the source for the next address. If the pipeline mode is selected, this next address is transferred to the $A_{0}-A_{g}$ outputs by the Pipeline Multiplexer. As usual, the PC is updated with this next address on the LOW-to-HIGH transition of the CP input. During non-pipeline operation, the next address appears on the output only after the CP transition.

The PC holds the address of the current microinstruction. For the BSR instruction, the return address must be stored in the Stack, which is fed by the PC through an Incrementer (see block diagram). When the CP input is LOW, the incremented value is written into the Stack as a return address. The LOW-to-HIGH transition of the CP input not only loads the PC with the next address, i.e., $\mathrm{BA}_{0}-\mathrm{BA} g$ inputs, but also increments the Stack Pointer as explained above.

## Conditional Branches

$\mathrm{BTH}_{\mathrm{O}}-\mathrm{BTH}_{3}$ - For a Branch Test HIGH instruction, the Instruction Decoder establishes a LOW on VIAO and VIA 1 outputs and HIGH on the INH output. It then tests for a HIGH on the Q output of the corresponding flip-flop in the test register. If a HIGH level is found, the Input Multiplexer selects the BAO-BAg inputs as the source for the next address.
On the other hand, if the tested $Q$ output of the flip-flop is LOW, the Incrementer output is selected as the source of the next address by the Input Multiplexer. In either case, the PC is loaded with the next address on the LOW-to-HIGH transition of the CP input. As usual, if the pipeline mode is selected, the next address is transferred to the $A_{0}-A_{9}$ outputs. For non-pipeline mode, the next address appears on the output after the clock transition.
$B T L O-B T L_{3}$ - Operation of the Branch Test LOW instructions is identical to $\mathrm{BTH}_{0}-\mathrm{BTH} 3$ except that Q outputs of the test register flip-flops are tested for a LOW. If the tested output is LOW, a branch occurs. If tested output is HIGH the Incrementer output is the next address.

## Miscellaneous

FTCH - For a Fetch instruction, the Instruction Decoder establishes a LOW on the VIAO and VIA 1 outputs. In addition, the INH output is also LOW. The Input Multiplexer selects the Incrementer output as the next address. If pipeline mode is selected, the Incrementer output is transferred to the $A_{0}-A_{9}$ outputs. For non-pipeline mode, the incremented address appears at the output only after the clock transition.

RTS - For a Return-from-Subroutine instruction, the Instruction Decoder establishes a LOW on the VIA $0_{0}$, VIA 1 and the INH outputs. The Input Multiplexer selects the Stack output as the source of the next address. As usual, for the pipeline mode, the next address is transferred to the output by the Pipeline Multiplexer. For non-pipeline operation, the next address appears on the output only after the clock transition. In addition, this instruction also decrements the Stack Pointer as described above.

DC CHARACTERISTICS: VDD as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (See Note 1)

| SYMBOL | PARAMETER |  | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
|  | Quiescent | XC |  |  | 32.5 |  |  | 65 |  |  | 130 | $\mu \mathrm{A}$ | MIN, $25^{\circ} \mathrm{C}$ | All Inputs |
|  | Power |  |  |  | 250 |  |  | 500 |  |  | 1000 |  | MAX | at 0 V or |
| 1 DD | Supply | XM |  |  | 8.75 |  |  | 17.5 |  |  | 35 | A | MIN, $25^{\circ} \mathrm{C}$ | $V_{\text {DD }}$ |
|  | Current |  |  |  | 250 |  |  | 500 |  |  | 1000 |  | MAX |  |

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, Input Transition $\leqslant 20 \mathrm{~ns}$. (Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tpLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n}$ to VIA $_{n}$ |  | $\begin{aligned} & 240 \\ & 320 \end{aligned}$ |  |  | $\begin{aligned} & 120 \\ & 160 \end{aligned}$ |  |  | $\begin{array}{r} 96 \\ 128 \end{array}$ |  | ns | $\begin{aligned} & I_{1}=I_{2}=V_{D D}, I_{3}=V_{S S} \\ & I_{\text {Input }}=I_{0}, \text { Output }=V I A_{0} \end{aligned}$ |
| $\begin{aligned} & \overline{t_{P L H}} \\ & t_{\mathrm{tPHL}} \end{aligned}$ | Propagation Delay, $I_{n}$ to INH |  | $\begin{aligned} & 240 \\ & 320 \end{aligned}$ |  |  | $\begin{aligned} & 120 \\ & 160 \end{aligned}$ |  |  | $\begin{array}{r} 96 \\ 128 \end{array}$ |  | ns | $\begin{aligned} & I_{1}=V_{D D}, I_{2}=I_{3}=V_{S S} \\ & I_{n p u t}=I_{0}, \text { Output }=I_{N H} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, CP to $A_{n}$ (Non-Pipeline) |  | $\begin{aligned} & 360 \\ & 400 \end{aligned}$ |  |  | $\begin{aligned} & 180 \\ & 200 \end{aligned}$ |  |  | $\begin{aligned} & 144 \\ & 160 \end{aligned}$ |  | ns | $\begin{aligned} & I_{1}=V_{D D}, P L S=I_{0}= \\ & I_{2}=I_{3}=V_{S S} \end{aligned}$ |
| $\begin{aligned} & \hline \mathrm{tPLH} \\ & \text { tPHL } \\ & \hline \end{aligned}$ | Propagation Delay, $C P$ to $A_{n}$ (Pipeline) |  | $\begin{aligned} & 720 \\ & 784 \end{aligned}$ |  |  | $\begin{aligned} & 360 \\ & 392 \end{aligned}$ |  |  | $\begin{aligned} & 288 \\ & 314 \end{aligned}$ |  | ns | $\begin{aligned} & \text { PLS }=1_{1}=V_{D D} \\ & I_{0}=I_{2}=I_{3}=V_{S S} \end{aligned}$ |
| tpLH <br> tphe | Propagation Delay, $B A_{n}$ to $A_{n}$ (Pipeline) |  | $\begin{aligned} & 240 \\ & 320 \end{aligned}$ |  |  | $\begin{aligned} & 120 \\ & 160 \end{aligned}$ |  |  | $\begin{array}{r} 96 \\ 128 \end{array}$ |  | ns | $\begin{aligned} & \mathrm{PLS}=1_{0}=I_{1}=I_{2}=V_{D D} \\ & I_{3}=V_{S S} \end{aligned}$ |

Notes on following page.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS (Cont'd): $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, Input Transition $\leqslant 20 \mathrm{~ns}$. (Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tpLH } \\ & \text { tpHL } \end{aligned}$ | Propagation Delay, <br> $I_{n}$ to $A_{n}$ (Pipeline) |  | $\begin{aligned} & 640 \\ & 720 \end{aligned}$ |  |  | $\begin{aligned} & 320 \\ & 360 \end{aligned}$ |  |  | $\begin{aligned} & 256 \\ & 288 \end{aligned}$ |  | ns | $\begin{aligned} & I_{0}=I_{1}=B A_{0}=P L S=V_{D D} \\ & I_{3}=M W_{0}=V_{S S} \\ & \text { Output }=A_{0}, \text { Input }=I_{2} \end{aligned}$ |
| $\begin{aligned} & \mathrm{t} \mathrm{TLH} \\ & \mathrm{t} \mathrm{THL} \\ & \hline \end{aligned}$ | Output Transition Time |  | $\begin{aligned} & 50 \\ & 50 \end{aligned}$ |  |  | $\begin{aligned} & 30 \\ & 30 \end{aligned}$ |  |  | $\begin{aligned} & 24 \\ & 24 \end{aligned}$ |  | ns |  |
| trec | $\overline{\text { MR Recovery Time }}$ |  | 120 |  |  | 120 |  |  | 96 |  | ns |  |
| ${ }^{t_{w} \overline{M R}(L)}$ | $\overline{M R}$ Minimum Pulse Width |  | 280 |  |  | 140 |  |  | 112 |  | ns |  |
| $\mathrm{tww}^{\mathrm{CP}(\mathrm{H})}$ | CP Minimum Pulse Width (HIGH) |  | 280 |  |  | 140 |  |  | 112 |  | ns | $1{ }^{\text {d }}$ |
| $t_{w} \mathrm{CP}(\mathrm{L})$ | CP Minimum Pulse Width (LOW) |  | 240 |  |  | 120 |  |  | 96 |  | ns | $\mathrm{I}_{3}=\mathrm{PLS}=\mathrm{V}_{\text {SS }}$ |
|  | Set-Up Time, $B A_{n}$ to $C P$ Hold Time, $B A_{n}$ to $C P$ |  | $\begin{array}{r} 240 \\ -10 \end{array}$ |  |  | $\begin{array}{r} 120 \\ -5 \end{array}$ |  |  | $\begin{gathered} 96 \\ -3 \end{gathered}$ |  | ns | $\begin{aligned} & I_{2}=V_{D D}, I_{0}=I_{1}=I_{3}= \\ & \text { PLS }=V_{S S}, I_{n p u t}=B A_{0}, \\ & \text { Output }=A_{0} \end{aligned}$ |
| $t_{s}$ $t_{\text {h }}$ | Set-Up Time, $I_{n}$ to CP <br> Hold Time, $I_{n}$ to $C P$ |  | $\begin{gathered} 720 \\ -10 \end{gathered}$ | . |  | $\begin{array}{r} 360 \\ -5 \end{array}$ |  |  | $\begin{array}{r} 288 \\ -3 \end{array}$ |  | ns | $I_{0}=I_{1}=B A_{0}=V_{D D}, I_{0}=$ <br> $\mathrm{MW} \mathrm{O}_{\mathrm{O}}, \mathrm{PLS}=\mathrm{V}_{\mathrm{SS}}$. <br> Input $=I_{2}$, Output $=A_{0}$ |
| $\begin{aligned} & \mathrm{t}_{\mathrm{s}} \\ & \mathrm{t}_{\mathrm{h}} \end{aligned}$ | Set-Up Time, $T_{n}$ to STRB Hold Time, $T_{n}$ to STRB |  | $\begin{array}{r} 120 \\ -10 \end{array}$ |  |  | $\begin{array}{r} 60 \\ -5 \end{array}$ |  |  | $\begin{aligned} & 48 \\ & -3 \end{aligned}$ |  | ns | $\begin{aligned} & I_{2}=I_{3}=P L S=V_{D D}, \\ & I_{0}=I_{1}=B A_{0}=V_{S S}, \\ & \text { Input }=T_{0}, \text { Output }=A_{0} \\ & \hline \end{aligned}$ |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, STRB to CP (Required to achieve a conditional branch in the same microcycle) |  | 480 |  |  | 240 |  |  | 192 |  | ns | $\begin{aligned} & I_{3}=T_{0}=V_{D D}, I_{0}=I_{1}= \\ & I_{2}=P L S=B A_{0}=V_{S S}, \\ & \text { Input=STRB, } \\ & \text { Output }=A_{0} \end{aligned}$ |
| ${ }^{\text {f MAX }}$ | Input Count Frequency (Note 4) |  |  |  |  |  |  |  |  |  | MHz |  |

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $V_{D D}$ as shown, $V_{S S}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, Input Transition Times $\leqslant 20$ ns (Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $V_{D D}=5 \mathrm{~V}$ |  |  | $V_{D D}=10 \mathrm{~V}$ |  |  | $V_{D D}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n}$ to VIA $_{n}$ |  | $\begin{aligned} & 290 \\ & 385 \end{aligned}$ |  |  | $\begin{aligned} & 145 \\ & 195 \end{aligned}$ |  |  | $\begin{aligned} & 116 \\ & 156 \end{aligned}$ |  | ns | $\begin{aligned} & \mathrm{I}_{1}=\mathrm{I}_{2}=\mathrm{V}_{D D}, \mathrm{I}_{3}=\mathrm{V}_{S S} \\ & \text { Input }=\mathrm{I}_{0}, \text { Output }=\mathrm{VIA}_{0} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n}$ to INH |  | $\begin{aligned} & 290 \\ & 385 \end{aligned}$ |  |  | $\begin{aligned} & 145 \\ & 195 \end{aligned}$ |  |  | $\begin{aligned} & 116 \\ & 156 \end{aligned}$ |  | ns | $\begin{aligned} & I_{1}=V_{D D}, I_{2}=I_{3}=V_{S S} \\ & I_{\text {nput }}=I_{0}, \text { Output }=I N H \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, CP to $A_{n}$ (Non-Pipeline) |  | $\begin{aligned} & 430 \\ & 480 \end{aligned}$ |  |  | $\begin{aligned} & 215 \\ & 240 \end{aligned}$ |  |  | $\begin{aligned} & 172 \\ & 192 \end{aligned}$ |  | ns | $\begin{aligned} & I_{1}=V_{D D}, P L S=I_{0}= \\ & I_{2}=I_{3}=V_{S S} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, CP to $A_{n}$ (Pipeline) |  | $\begin{aligned} & 860 \\ & 945 \end{aligned}$ |  |  | $\begin{aligned} & 430 \\ & 475 \end{aligned}$ |  |  | $\begin{aligned} & 344 \\ & 380 \end{aligned}$ |  | ns | $\begin{aligned} & \text { PLS }=I_{1}=V_{D D}, \\ & I_{0}=I_{2}=I_{3}=V_{S S} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $B A_{n}$ to $A_{n}$ (Pipeline) |  | $\begin{aligned} & 290 \\ & 385 \end{aligned}$ |  |  | $\begin{aligned} & 145 \\ & 195 \end{aligned}$ | $\cdots$ |  | $\begin{aligned} & 116 \\ & 156 \end{aligned}$ |  | ns | $\begin{aligned} & \text { PLS }=I_{0}=I_{1}=I_{2}= \\ & V_{D D}, I_{3}=V_{S S} \end{aligned}$ |
| $\begin{aligned} & \text { tPLH } \\ & \text { tPHL } \end{aligned}$ | Propagation Delay, $I_{n}$ to $A_{n}$ (Pipeline) |  | $\begin{aligned} & 770 \\ & 870 \end{aligned}$ |  |  | $\begin{aligned} & 385 \\ & 435 \end{aligned}$ |  |  | $\begin{aligned} & 308 \\ & 348 \end{aligned}$ |  | ns | $\begin{aligned} & I_{0}=I_{1}=B A_{0}=P L S=V_{D D}, \\ & I_{3}=M W_{0}=V_{S S} \\ & \text { Output }=A_{0}, \text { Input }=I_{2} \end{aligned}$ |
| $\begin{aligned} & \text { tTLH } \\ & \text { t THL } \end{aligned}$ | Output Transition Time |  | 60 60 |  |  | $\begin{aligned} & 40 \\ & 40 \end{aligned}$ |  |  | 32 |  | ns |  |

NOTES:

1. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition Times are graphically described in this section under 4700 Series CMOS Family Characteristics.
 Set-up Times ( $\mathrm{t}_{\mathrm{s}}$ ), Hold Times ( $\mathrm{t}_{\mathrm{h}}$ ), Recovery Times ( $\mathrm{t}_{\mathrm{rec}}$ ), and Minimum Pulse Widths ( $\mathrm{t}_{\mathrm{w}}$ ), do not vary with load capacitance.
3. For $f_{M A X}$, input rise and fall times are greater than or equal to 5 ns and less than or equal to 20 ns .
4. It is recommended that input rise and fall times to the Clock Input be less than $15 \mu \mathrm{~s}$.

# 4710/4710B <br> REGISTER STACK • $16 \times 4$ RAM WITH 3-STATE OUTPUT REGISTER <br> FAIRCHILD CMOS MACROLOGIC 

DESCRIPTION - The 4710 is a register oriented high speed 64-bit Read/Write Memory organized as 16 -words by 4 -bits. An edge triggered 4 -bit output register allows new input data to be written while previous data is held. 3-state outputs are provided for maximum versatility. The 4710 is fully compatible with all CMOS families.

- EDGE-TRIGGERED OUTPUT REGISTER
- TYPICAL ACCESS TIME OF 48 ns at $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$
- 3-STATE OUTPUTS
- OPTIMIZED FOR REGISTER STACK OPERATION
- 18-PIN PACKAGE

PIN NAMES

| $\mathrm{A}_{0}-\mathrm{A}_{3}$ | Address Inputs |
| :--- | :--- |
| $\mathrm{D}_{0}-\mathrm{D}_{3}$ | Data Inputs |
| $\overline{\mathrm{CS}}$ | Chip Select Input (Active LOW) <br> $\overline{\mathrm{EO}}$ |
| $\overline{\mathrm{WE}}$ | Output Enable Input (Active LOW) <br> CP |
| Write Enable Input (Active LOW) <br> Clock Input (Outputs Change on LOW <br> to HIGH Transition) <br> $\mathrm{Q}_{0}-\mathrm{O}_{3}$ | Outputs |

## NOTES:

a) 1 Unit Load (U.L.) $=40 \mu \mathrm{~A}$ HIGH, 1.6 mA LOW.
b) 10 LOW Unit Loads measured at 0.5 V .


## FAIRCHILD•4710/4710B

FUNCTIONAL DESCRIPTION - The 4710 consists of a $16 \times 4$-bit RAM selected by four address inputs ( $A_{0}-A_{3}$ ) and an edge-triggered 4-bit Output Register with 3-state Output Buffers.
Write Operation - When the three control inputs: Write Enable ( $\overline{\mathrm{WE}}$ ), Chip Select ( $\overline{\mathrm{CS}}$ ), and Clock (CP), are LOW the information on the data inputs $\left(D_{0}-D_{3}\right)$ is written into the memory location selected by the address inputs $\left(A_{0}-A_{3}\right)$. If the input data changes while $\overline{W E}, \overline{\mathrm{CS}}$, and CP are LOW, the contents of the selected memory location follows these changes provided set-up time criteria are met.
Read Operation - Whenever $\overline{\mathrm{CS}}$ is LOW and CP goes from LOW-to-HIGH, the contents of the memory location selected by the address inputs $\left(A_{0}-A_{3}\right)$ is edge triggered into the Output Register.
A 3-State Output Enable ( $\overline{\mathrm{EO}}$ ) controls the output buffers. When $\overline{\mathrm{EO}}$ is HIGH the four outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{3}\right)$ are in a high impedance or OFF state; when $\overline{\mathrm{EO}}$ is LOW, the outputs are determined by the state of the Output Register.

DC CHARACTERISTICS: VDD as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (See Note 1)

| SYMBOL | PARAMETER |  | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEMP | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  |  |  |  |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |  |
| Iozh | Output OFF <br> Current HIGH | XC |  |  | $\begin{array}{r} 0.5 \\ 30 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 1.0 \\ 60 \\ \hline \end{array}$ |  | $\begin{array}{r} 0.2 \\ 12 \end{array}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN }, 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $V_{D D}, \overline{E O}=V_{D D}$ |
|  |  | XM |  |  | $\begin{array}{r} \hline 0.05 \\ 3.0 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 0.1 \\ 60 \end{array}$ |  | $\begin{array}{r\|} \hline 0.02 \\ 1.2 \end{array}$ |  |  | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |
| Iozl | Output OFF <br> Current LOW | XC |  |  | $\begin{array}{r} -0.5 \\ -30 \\ \hline \end{array}$ |  |  | $\begin{array}{\|l} \hline-1.0 \\ -6.0 \\ \hline \end{array}$ |  | $\begin{aligned} & -0.2 \\ & -12 \\ & \hline \end{aligned}$ |  | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \\ \hline \end{gathered}$ | Output Returned to $\mathrm{V}_{\mathrm{SS}}, \overline{\mathrm{EO}}=\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{\|r\|} \hline-0.05 \\ -3.0 \end{array}$ |  |  | $\begin{array}{\|l} \hline-0.1 \\ -6.0 \end{array}$ |  | $\begin{array}{r} -0.02 \\ -1.2 \end{array}$ |  |  | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |
| IDD | Quiescent <br> Power <br> Supply <br> Current | XC |  |  | $\begin{array}{r} 20 \\ 150 \end{array}$ |  |  | $\begin{array}{r} 40 \\ 300 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 80 \\ 600 \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ | All Inputs at at 0 V or $\mathrm{V}_{\mathrm{DD}}$ |
|  |  | XM |  |  | $\begin{array}{r} 5.0 \\ 150 \end{array}$ |  |  | $\begin{array}{r} 10 \\ 300 \end{array}$ |  |  | $\begin{array}{r} 20 \\ 600 \end{array}$ | $\mu \mathrm{A}$ | $\begin{gathered} \text { MIN, } 25^{\circ} \mathrm{C} \\ \text { MAX } \end{gathered}$ |  |

Notes on following page.

AC CHARACTERISTICS AND SET-UP REQUIREMENTS: $\mathrm{V}_{\mathrm{DD}}$ as shown, $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (See Note 2)

| SYMBOL | PARAMETER | LIMITS |  |  |  |  |  |  |  |  | UNITS | TEST CONDITIONS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=10 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  |  |  |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX |  |  |
|  | READ MODE |  |  |  |  |  |  |  |  |  |  | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ $\begin{aligned} & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{S S}\right) \\ & \left(R_{L}=1 \mathrm{k} \Omega \text { to } V_{D D}\right) \end{aligned}$ |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PLH}} \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Propagation Delay, CP to Output |  | $\begin{aligned} & 120 \\ & 109 \end{aligned}$ | $\begin{aligned} & 240 \\ & 218 \end{aligned}$ |  | $\begin{aligned} & 48 \\ & 43 \end{aligned}$ | 96 86 |  | $\begin{aligned} & 36 \\ & 31 \end{aligned}$ | $\begin{aligned} & 72 \\ & 62 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPZH } \\ & \text { tPZL } \end{aligned}$ | Enable Time, $\overline{\mathrm{EO}}$ to Output |  | 52 81 | $\begin{aligned} & 104 \\ & 162 \end{aligned}$ |  | $\begin{aligned} & 19 \\ & 28 \end{aligned}$ | 38 56 |  | $\begin{aligned} & 15 \\ & 20 \end{aligned}$ | $\begin{aligned} & 30 \\ & 40 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tPLZ } \end{aligned}$ | Disable Time, $\overline{\mathrm{EO}}$ to Output |  | 52 66 | $\begin{aligned} & 104 \\ & 132 \end{aligned}$ |  | 26 | 52 |  | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ | $\begin{aligned} & 40 \\ & 40 \end{aligned}$ | ns |  |
| $\begin{aligned} & \mathrm{t} \text { TLH } \\ & \mathrm{t} \mathrm{THL} \end{aligned}$ | Output Transition Time |  | 45 50 | $\begin{array}{r} 90 \\ 100 \end{array}$ |  | 25 25 | 50 |  | $\begin{aligned} & 17 \\ & 17 \end{aligned}$ | $\begin{aligned} & 34 \\ & 34 \end{aligned}$ | ns |  |
|  | READ MODE |  |  |  |  |  |  |  |  |  |  | $C_{L}=50 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ <br> ( $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{SS}}$ ) <br> ( $R_{L}=1 \mathrm{k} \Omega$ to $V_{D D}$ ) <br> $\left(R_{L}=1 \mathrm{k} \Omega\right.$ to $\left.\mathrm{V}_{\mathrm{SS}}\right)$ <br> $\left(R_{L}=1 \mathrm{k} \Omega\right.$ to $\left.V_{D D}\right)$ |
| $\begin{aligned} & \mathrm{t} P L H \\ & \mathrm{t} P \mathrm{H} \end{aligned}$ | Propagation Delay, CP to Output |  | $\begin{aligned} & 146 \\ & 125 \end{aligned}$ | $\begin{aligned} & 292 \\ & 250 \end{aligned}$ |  | 56 49 | 112 98 |  | $\begin{aligned} & 40 \\ & 34 \end{aligned}$ | $\begin{aligned} & 80 \\ & 68 \end{aligned}$ | ns |  |
| $\begin{aligned} & \mathrm{tPZH} \\ & \text { tPZL } \end{aligned}$ | Enable Time, $\overline{\text { EO }}$ to Output |  | 57 81 | $\begin{aligned} & 114 \\ & 162 \end{aligned}$ |  | 20 31 | 40 62 |  | $\begin{aligned} & 16 \\ & 23 \end{aligned}$ | $\begin{aligned} & 32 \\ & 46 \end{aligned}$ | ns |  |
| $\begin{aligned} & \text { tPHZ } \\ & \text { tPLZ } \end{aligned}$ | Disable Time, $\overline{\mathrm{EO}}$ to Output |  | 57 72 | $\begin{aligned} & 114 \\ & 144 \end{aligned}$ |  | 29 31 | 58 62 |  | $\begin{aligned} & 23 \\ & 25 \end{aligned}$ | $\begin{aligned} & 46 \\ & 50 \end{aligned}$ | ns |  |
| $\begin{aligned} & \mathrm{t} \text { TLH } \\ & \text { t } \mathrm{THL} \end{aligned}$ | Output Transition Time |  | 75 80 | 150 160 |  | 45 45 | 90 90 |  | 35 35 | $\begin{aligned} & 70 \\ & 70 \end{aligned}$ | ns |  |
|  | WRITE MODE |  |  |  |  |  |  |  |  |  |  | $C_{L}=15 \mathrm{pF}$ <br> Input Transition <br> Times $\leqslant 20 \mathrm{~ns}$ |
| ${ }_{\text {tw }}$ WE | Minimum $\overline{\text { WE }}$ Pulse Width (Note 4) | 218 | 109 |  | 104 | 52 |  | 62 | 31 |  | ns |  |
| ${ }_{t_{w} \overline{C S}}$ | Minimum $\overline{\mathrm{CS}}$ Pulse Width (Note 4) | 226 | 113 |  | 124 | 62 |  | 74 | 37 |  | ns |  |
| ${ }_{t w}{ }^{\text {CP }}$ | Minimum CP Pulse Width (Note 4) | 240 | 120 |  | 124 | 62 |  | 74 | 37 |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WE}}$ (Note 5) | 326 | 163 |  | 198 | 99 |  | 134 | 67 |  | ns |  |
| th | Hold Time, $\overline{\mathrm{CS}}$ to $\overline{\mathrm{WE}}$ (Note 5) | 0 | -15 |  | 0 | -10 |  | 0 | -5 |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\overline{\mathrm{CS}}$ to CP | 186 | 93 |  | 104 | 52 |  | 68 | 34 |  | ns |  |
| ${ }^{\text {th }}$ | Hold Time, $\overline{\mathbf{C S}}$ to CP | 0 | -15 |  | 0 | -10 |  | 0 | -5 |  | ns |  |
| $\mathrm{t}_{\text {s }}$ | Set-Up Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to $\overline{\mathrm{WE}}$ (Note 5) | 176 | 68 |  | 70 | 35 |  | 48 | 24 |  | ns |  |
| $\underline{t h}$ | Hold Time, $\overline{\mathrm{D}}_{\mathrm{n}}$ to $\overline{\mathrm{WE}}$ (Note 5) | 0 | -15 |  | 0 | -10 |  | 0 | -5 |  | ns |  |
| $\mathrm{t}_{5}$ | Set-Up Time, Address to $\overline{W E}$ (Note5) | 206 | 103 |  | 100 | 50 |  | 58 | 29 |  | ns |  |
| th | Hold Time, Address to $\overline{\mathrm{WE}}$ (Note 5) | 0 | -15 |  | 0 | -10 |  | 0 | -5 |  | ns |  |
|  | READ MODE |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{5}$ | Set-Up Time Address to CP | 706 | 353 |  | 372 | 186 |  | 208 | 104 |  | ns |  |
| $t_{h}$ | Hold Time Address to CP | 0 | -15 |  | 0 | -10 |  | 0 | -5 |  | ns |  |

## NOTES:

1. Additional DC Characteristics are listed in this section under 4700 Series CMOS Family Characteristics.
2. Propagation Delays and Output Transition times are graphically described in this section under 4700 Series CMOS Family Characteristics.
3. Propagation Delays ( $t_{\text {PLH }}$ and Output Transition Times ( $\mathrm{T}_{\mathrm{T}} \mathrm{H}$ and $\mathrm{t}_{\mathrm{TH}}$ ) will change with output load capacities ( $\mathrm{C}_{\mathrm{L}}$ ). Set-up Times ( $\mathrm{t}_{\mathrm{s}}$ ). Hold Times ( $t_{h}$ ), Minimum Pulse Widths ( $t_{w}$ ) do not vary with load capacitance.
4. Writing occurs when $\overline{W E}, \overline{C E}$, and $C P$ are LOW.
5. Assuming $\overline{W E}$ is utilized as a Writing STROBE.

## FAIRCHILD • 4710/4710B

## SWITCHING WAVEFORMS


$\overline{E O}$ TO OUTPUT ENABLE AND DISABLE TIMES


MINIMUM CP PULSE WIDTH, PROPAGATION DELAY CLOCK TO OUTPUT, AND SET-UP AND HOLD TIMES ADDRESS TO CLOCK

CONDITIONS: $\overline{\mathrm{CS}}=\overline{\mathrm{EO}}=$ LOW, $\overline{\mathrm{WE}}=\mathrm{HIGH}$


MINIMUM $\overline{C S}$ PULSE WIDTH, MINIMUM WRITE ENABLE PULSE WIDTH, SET-UP AND HOLD TIMES ADDRESS TO $\overline{W E}$, DATA TO $\overline{W E}$, AND $\overline{\mathrm{CS}}$ TO WE

CONDITIONS: CP = LOW
NOTE: Set-Up $\left(\mathrm{t}_{\mathrm{s}}\right)$ and Hold Times $\left(\mathrm{t}_{\mathrm{h}}\right)$ are shown as positive values but may be specified as negative values.


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BIPOLAR MACROLOGIC
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## CMOS MACROLOGIC

## APPLICATIONS

## MACROLOGIC APPLICATIONS

## MICROPROGRAMMING WITH MACROLOGIC

## Microprogram Execution Modes

Any microprogrammed system, in effect, consists of two major elements-a controller and controllee (data path). The data path usually consists of ALUs, general registers, stacks etc., and can readily be implemented with Macrologic devices (ALRS, DPS etc.). The controller for operating the data path can be designed to perform in either pipeline or non-pipeline mode. The non-pipeline controller is simply a 9408 and a control store that usually consists of a PROM (ROM) or RAM (Figure 5-1). In a pipeline system, an edge-triggered microinstruction register is needed in addition to the memory and the 9408 (Figure 5-2).

In a non-pipeline system, a microinstruction is read from the control store and executed in the same clock cycle. No attempt is made to read the control store for the next microinstruction until the execution of the current instruction is complete.

Most microprogrammed systems are designed as synchronous machines. The actual data-path logic dictates the maximum frequency at which the data path will operate properly. However, a non-pipeline system cannot be run at this speed because of the overhead imposed by the controller. Reading a microinstruction involves setting up the address and accessing the memory. Because of the synchronous nature of the system, setting up the address is in sympathy with the clock. The sum of the 9408 propagation delay (CP to Address outputs) and the read access time of the memory should be added to the allowable clock cycle time of the data path to arrive at the actual system speed. The overhead imposed by the microprogram controller could be a significant percentage of the data-path speed. This is an inefficient use of the data-path resources. Also, the total system may not have the desired operating speed. However, the pipeline mode can overcome this disadvantage.

In a pipeline system, reading the next microinstruction overlaps the execution of the current instruction. This requires holding the current microinstruction in a microinstruction register as shown in Figure 5-2. If the sum of 9408 propagation delay (Instruction input to Address output in pipeline mode), the read access time of the memory, set-up and propagation-delay times of the microinstruction register is less than the intrinsic data-path clock period, then a full overlap can be achieved and the actual system speed is not affected by the controller overhead. Otherwise, the system speed is determined by propagation, set-up and access times of the controller alone. In practice, pipeline systems achieve much higher operating speeds than non-pipeline systems.


Fig. 5-1 Non-Pipeline System


Fig. 5-2 Pipeline System

In many instances, a microprogram written for non-pipeline system cannot be executed in pipeline mode. However, 9408 architecture is designed so that the same microprogram can be executed in pipeline or non-pipeline mode without any modification. This feature gives the user a distinct advantage since he can design his high end product with pipeline execution and lower end product with non-pipeline. No microprogram changes are required thus significant cost advantages can be realized.

## Initializing The Microprogram

In microprogrammed systems, the current control-memory address identifies the current control state, while the contents of the addressed location, i.e. microinstruction, provides the information required to establish proper control-signal combinations for the data path and to choose the next address. A microprogrammed system is inherently a sequential machine and initialization of the controller is necessary for proper system operation.
Initialization of the non-pipeline systems is rather straightforward. Whenever the $9408 \overline{M R}$ input is LOW, the program counter (PC) is cleared and hence all the Address outputs of the 9408 will be LOW. This address then defines the starting location for the microprogram execution. The PC is held clear as long as the $\overline{M R}$ input is LOW. A simple initialization scheme is shown in Figure 5-3. The flip-flop is held clear by a low-level Reset input. The $\overline{\mathrm{Q}}$ output of this flip-flop is connected to the $\overline{M R}$ input of the 9408 . As long as the reset signal is LOW, the Raw Clock signal is blocked by the OR gate, due to the HIGH level from the $\overline{\mathrm{Q}}$ output, thus the System Clock output will be HIGH. When the Reset input goes HIGH, the following LOW-toHIGH transition of the Raw Clock sets the flip-flop. The OR gate passes the Raw Clock input as the System Clock which then can be used to drive the data path and the CP input of the 9408.

In a pipeline system, merely addressing the starting location is not enough. The first microinstruction must be loaded into the microinstruction register to prime the pipe. The Raw Clock can be used for this purpose-a LOW-to-HIGH transition loads the microinstruction register. As before, the System Clock operates on the data path and the 9408.


Fig. 5-3 Initialization Circuit

## Sharing The Control Fields For Next Address

A straightforward microinstruction consists of fields for specifying data-path control and an explicit specification of the next address. An explicit next-address specification is mandatory in many microprogram sequencer architectures. However, in the 9408, a Fetch instruction is provided to facilitate writing a microprogram where a large number of instructions fit naturally into sequential memory locations. The next address for a Fetch instruction need not be explicit; it is always implied to be PC + 1. In general, the total number of bits required for the data-path control (total control-field width) is more than the number of bits needed to explicitly specify the next address. Thus, if there is an easy way to use the control fields, or part of them, to specify the address, significant reduction of the microinstruction width can be achieved. The Inhibit output of the 9408 is provided to facilitate sharing of microinstruction fields.

There are two 9408 instructions that do not require next-address specification, FTCH and RTS. The remaining 14 instructions fall into a branch class requiring an external next address. The Inhibit output is LOW for FTCH and RTS only and HIGH for all other instructions. Thus, if the system clock can be inhibited from operating the data path whenever the Inhibit output is HIGH, then the microinstruction field that normally operates on the data path can be fed into the 9408 as the next address. Inhibiting the data path operation is extremely simple with the Macrologic processor elements. In some Macrologic systems, the devices are connected as a bussed system; an example is shown in Figure 5-4. Although the 9405A and 9406 devices derive their instructions from the same microinstruction field, either the 9405A or the 9406 can be individually selected to respond to an instruction by controlling the $\overline{\mathrm{EX}}$ inputs. Macrologic systems can employ an encoded field in the microinstruction, called destination field, for this purpose. A decoder is commonly used to drive the individual $\overline{E X}$ inputs. Now, if the Inhibit output of the 9408 is connected to the Enable input of the decoder, all $\overline{\mathrm{EX}}$ inputs are HIGH for branch-class instructions. Thus clocking would not affect the devices. This technique of sharing fields is beneficial only if a large percentage of the operations is from sequential memory locations with an occasional random branch. If a microprogram has many branch instructions, the extra clock cycle needed for branch operation may affect the system speed.

## Handling The Test Inputs

In microprogrammed systems, it is often necessary to test the status of external conditions. Often, these inputs are derived from the ALU of the data path as condition codes. For example, the ALRS (9405A) provides four status signals-Carry ( $\bar{W}$ ), Negative ( $\bar{X}$ ), Overflow ( $\bar{Y}$ ), and Zero (Z). These signals can be connected to the $T_{0}-T_{3}$ inputs of 9408 so that a LOW-to-HIGH transistion of the STRB will load them


Fig. 5-4 Sharing the Control Fields
into the 4-bit test register. Although the STRB and CP inputs of the 9408 can be connected together, in most systems, the STRB input is derived from the system clock by appropriate gating. This is done so that the test register is only affected during those microinstructions that involve an ALU operation. Figure 5-5 illustrates test-input handling. In both modes of operation, the ALRS status can be stored in the 9408 during a microcycle and tested during subsequent microcycles using appropriate conditional branch instructions.

It should be noted that the 9405A provides the status signals towards the end of the microcycle and the system clock should be chosen so that the 9408 set up (test-to-strobe) time is satisfied. In Figure 5-5a, gating the system clock with $\overline{E X}$ inputs of the 9405A assures that the test register operates only for those microcycles that affect the 9405A. Also note that the 9405A is operating in accumulator mode. If the 9405A is operating in the general register mode (Figure 5-5b) the $\overline{E X}$ is a negative pulse; hence, it can be connected to the STRB input of the 9408. (Refer to the 9405A data sheet for operation details.)


Fig. 5-5 Handling the 9408 Test Inputs

## Expanding The Multiway Inputs

Three 9408 inputs participate in multiway branch operation. This gives eight individual branch addresses depending on the bit pattern present on the $\mathrm{MW}_{0}-\mathrm{MW}_{2}$ inputs during a BMW instruction. Although the 9408 provides only three inputs for this purpose, they can be readily expanded. For example, in Figure 5-6, the $M W_{0}-M W_{2}$ are obtained from three 8 -input multiplexers. During a BMW instruction, the 9408 ignores the $B A_{0}-B A_{2}$ inputs; thus these three bits can be used to control the multiplexers and increase the Branch Multiway inputs.

## Using the VIA Outputs

Since a microinstruction contains information relating to the address of the next microinstruction, it would seem that the $B A_{0}-B A_{9}$ inputs of the 9408 are derived from the next address field. However, in most practical systems, the $B A_{0}-B A_{9}$ inputs must be obtained from other sources in addition to the next microinstruction address field.

For example, a system designed to emulate the instruction set of a target computer contains a "macroinstruction register" to hold the bit patterns corresponding to the target instruction that currently requires execution. There is a routine in the control store starting at a certain address which corresponds to the current macroinstruction. It is simple to connect an address mapper, consisting of PROMS or PLAs, to the macroinstruction register. The address inputs (input variables) are the outputs of the macroinstruction register and the mapper output is the starting address of the microsequence for the current target instruction. Thus, if the mapper output is used as another source of next address, a very fast macroinstruction decoding can be accomplished. This source selection could easily be accomplished by feeding the addresses from different sources into a 4 -input multiplexer and using the VIA outputs of the 9408 to select the appropriate sets of inputs.


Fig. 5-6 Expanding Multiway Inputs

## A Microprogram Example

The simple microprogram example, shown in Figure 5-7 and Table 5-1, is an assembly of a 7-bit word from a serial data stream (SER DATA) using the associated clock (SER CLK). Figure 5-8 illustrates the assumed timing relationship between SER DATA and SER CLK signals. Consider an 8 -bit wide data path using two 9405A and two 9404 devices as shown in Figure 5-7a. A 6-bit instruction bus is obtained (9405A field) by appropriate connections of the 9405A instruction inputs. These six bits are controlled by an appropriate field in the microinstruction, bit 4 through bit 9 of the control store (see Figure 5-7b). The 6 -bit 9404 field is obtained by connecting $I_{1}$ through $I_{4}$ of 9404 devices and using $I_{0}$ of each device separately. These six bits are also controlled by an appropriate field in the microinstruction, bit 10 through bit 15 of the control store. In this illustration, the 9404 and 9405A control fields of the microinstruction are also used to provide the 10 -bit branch address for the 9408 . The instruction inputs for the 9408 are provided by the appropriate microinstruction field, bit 0 through bit 3 of the control store.

| ADDRESS (Octal) | 9408 FIELD |  |  |  | 9405A FIELD |  |  |  |  |  | 9404 FIELD |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
| 10 | FTCH |  |  |  | RO |  |  | LOAD |  |  | PLUS 1 |  |  |  |  |  |
|  | L | H | L | L | L | L | L | L | H | H | L | H | H | H | L | H |
| 11 | BMW |  |  |  | X | X | 2X |  |  |  |  |  |  |  |  |  |
|  | H | H | L | L |  |  | L | L | L | L | L | H | L | X | X | x |
| 12 | FTCH |  |  |  | RO |  |  | LOAD |  |  | SHIFT LEFT D-BUS |  |  |  |  |  |
|  | L | H | L | L | L | L | L | L | H | H | H | L | H | L | L | L |
| 13 | BMW |  |  |  | X | X | 3X |  |  |  |  |  |  |  |  |  |
|  | H | H | L | L |  |  | L | L | L | L | L | H | H | X | X | X |
| 14 | BTL1 |  |  |  | X | X | 16 |  |  |  |  |  |  |  |  |  |
|  | H | L | H | H |  |  | L | L | L | L | L | L | H | H | H | L |
| 15 | $\mathrm{BRV}_{0}$ |  |  |  | X | X | 11 |  |  |  |  |  |  |  |  |  |
|  | L | L | H | L |  |  | L | L | L | L | L | L | H | L | L | H |
| 16 | RTS |  |  |  | RO |  |  | EXCLUSIVE-OR |  |  | BYTE SIGN MASK |  |  |  |  |  |
|  | L | L | L | L | L | L | L | H | H | L | L | H | L | L | H | L |
| 20 | $\mathrm{BRV}_{0}$ |  |  |  | X | X | 11 |  |  |  |  |  |  |  |  |  |
|  | L | L | H | L |  |  | L | L | L | L | L | L | H | L | L | H |
| 21 | $\mathrm{BRV}_{0}$ |  |  |  | X | X | 12 |  |  |  |  |  |  |  |  |  |
|  | L | L | H | L |  |  | L | L | L | L | L | L | H | L | H | L |
| 30 | $\mathrm{BRV}_{0}$ |  |  |  | X | X | 14 |  |  |  |  |  |  |  |  |  |
|  | L | L | H | L |  |  | L | L | L | L | L | L | H | H | L | L |
| 31 | $\mathrm{BRV}_{0}$ |  |  |  | X | X | 13 |  |  |  |  |  |  |  |  |  |
|  | L | L | H | L |  |  | L | L | L | L | L | L | H | L | H | H |

X = Don't Care



Fig. 5-7b Microprogrammed Controller


Fig. 5-8 Timing Relationship between SER DATA and SER CLK

The status outputs from the most significant $9405 A, \bar{W}, \bar{X}, \bar{Y}$ and $Z$, are connected to the $T_{0}-T_{3}$ inputs of the 9408 although only the $\bar{X}$ output is used in this example. The $\overline{E X}$ inputs of both 9405As are connected to the INH output of the 9408. The Clock signal operates the 9405As and the 9408. In addition, the Clock is gated with the INH output to operate the STRB input of the 9408.

The SER CLK input is synchronized to the Clock input by using a synchronizing flip-flop with the Q output connected to the $\mathrm{MW}_{0}$ input of the 9408 while $\mathrm{MW}_{1}$ and $\mathrm{MW}_{2}$ inputs are grounded. The $\mathrm{A}_{0}-\mathrm{Ag}$ outputs of the 9408 are used to address the control store. The SER DATA is fed into the right shift input of the least significant 9404.

The flow chart in Figure 5-9 shows the sequence of operations assuming the sequence is a subroutine starting at location (10) 8 in the control store. The program for implementing this flow chart is shown in Table 5-1. Note that register $\mathrm{R}_{0}$, the first of the eight general purpose registers of the 9405A, is used for the serial-to-parallel conversion. Thus bit 4 through bit 6 (address bits of the 9405A field) are LL L. To indicate that a load operation into $\mathrm{R}_{0}$ is desired, bit 7 through bit 9 ( 9405 A instruction field) are LH H.

Bit 10 through bit 15 of the microinstruction ( 9404 instruction field) is L H H H L H so that bit pattern 00000001 is present at the inputs of the 9405A. This becomes apparent when the 9404 truth table in the data sheet is consulted. (The 9405A treats a LOW level data input as logic " 1 ".) Bit 0 through bit 3 ( 9408 instruction field) require the 9408 to perform a Fetch for the next instruction.

Location (11)8 contains a Branch Multiway, BMW, instruction to determine whether or not the synchronization flip-flop is set. Bit 6 through bit 15 of the microinstruction is specified as LLLLLHLXXX where $X$ indicates "don't care". Thus, if the synchronization flip-flop is not set, the 9408 generates L L L L L H L L L L as the next address (20) 8 . At location (20) 8 , there is a Branch VIA, BRV 0 , to location (11) 8 instruction. Thus, the microprogram loops between locations (11) 8 and (20) 8 testing for a HIGH on the SER CLK input. When the synchronization flip-flop is set, the BMW instruction at location (11)8 results in (21)8 as the next address instead of (20)8. Location (21) 8 contains the instruction " $\mathrm{BRV}_{0}$ to location (12) $8^{\prime \prime}$.

The instruction in (12) 8 shifts the contents of the 9405A to the left and loads the shifted value back into RO. Because the SER DATA input is connected to the shift input of the 9404, the information present as the SER DATA input is loaded into $\mathrm{R}_{0}$. Thus after taking the first data bit, $\mathrm{R}_{0}$ reads $0000001 \mathrm{~B}_{1}$,


Fig. 5-9 Sequence of Operation
where $B_{1}$ is the first bit assembled. The instruction in location (12) 8 specifies a Fetch for the 9408 , thus the INH output is LOW. This activates the $\overline{E X}$ inputs of the 9405As. Moreover, the LOW level also enables the gate; thus, the Clock activates the STRB input of the 9408 so that the 9405A status outputs can be loaded into the 9408 test register. As long as the result of an ALU operation is positive, i.e., most significant bit HIGH, the negative status ( $\bar{X}$ output of the 9405A) is HIGH.

Location (13) 8 contains BMW with ( 3 X$)_{8}$ as the next address. Thus if MW $\mathrm{MW}_{0}$ input is HIGH, the next address is (31) 8 ; if $M_{0}$ is LOW, the next address is (30) 8 . Location (30) 8 contains " $B R V_{0}$ to location (13) 8 " and (31) 8 contains "BRVO to (14)8." Thus, as long as SER CLK input is HIGH, the program loops between locations $\mathbf{1 1 3}^{(13)} 8$ and (31) 8 . When the synchronizing flip-flop is cleared, the program goes to location (14) 8 due to the instruction in location (30) 8 .

At location (14)8, the "Branch Test LOW, BTL1, to location (16) $)_{8}$ " is used to determine when the $\mathrm{T}_{1}$ input of the 9408 is LOW. It will not be LOW until seven SER DATA bits have been shifted. Instead of branching to $(16)_{8}$, the program goes to location $(15)_{8}$, which contains " $B R V_{0}$ to location $(11)_{8}$ ". The program loops around until seven data bits have been shifted in. At this time, the 9405A has indicated a LOW on its $\bar{X}$ output and the BTL results in a branch to location (16) 8 .

At location (16)8, the 9404 provides 10000000 as a mask and an exclusive $O R$ is performed in $R_{0}$ of the 9405A to eliminate the marker bit that was previously loaded into $R_{0} . R_{0}$ then contains seven data bits assembled from the SER DATA bit stream. It has been assumed that this small program is a subroutine. Therefore, by specifying RTS to the 9408 in location (16)8, a return to the main program is effected.

## IMPLEMENTING DATA PATHS WITH MACROLOGIC

Individual Macrologic data sheets indicate how each 4-bit slice may be expanded into arrays to handle larger word lengths; these different arrays (Figure 5-10) can be configured to develop the data paths. Since Macrologic elements are designed to be used in bus-organized systems, all devices are provided with 3 -state data outputs and an Output Enable (EO) input to control them. Therefore, the data outputs from the arrays can be bussed together to obtain the output bus (Figure 5-11). With a LOW level on the appropriate $\overline{\mathrm{EO}}$ input, an array can be made to source data on to the output bus. For example, in Figure 5-11, a LOW on the $\overline{\mathrm{EO}}_{1}$ input selects the ALRS array as the source. The data inputs can also be bussed together to obtain the input bus.


Fig. 5-10 Typical Macrologic Arrays

The instruction inputs of the arrays must be controlled by the microinstruction fields. However, what are the chances of two different Macrologic arrays performing two different operations on the same input data during the same clock cycle? This situation occurs very rarely; therefore, individual control fields are seldom needed.

The Macrologic elements are provided with individual $\overline{E X}$ inputs. A device does not respond to the clock unless its $\overline{E X}$ input is LOW. Thus, the instruction inputs can be bussed together to obtain an instruction bus (Figure 5-12). The individual $\overline{E X}$ inputs are used to control the array chosen to perform the current microinstruction, i.e., the destination. Thus, in Figure 5-12, a 6 -bit field is sufficient for the instruction inputs.


Fig. 5-11 Bussing Macrologic Arrays


Fig. 5-12 Bussing Macrologic Instruction Inputs


Fig. 5-13 Closed Data-Path Loop

Experience indicates that data paths in microprogrammed systems are closed loop, therefore, a means should be provided for the output bus to communicate with the input bus. The Macrologic DPS element is ideally suited for this purpose (Figure 5-13) since it has two identical input ports. One port can be used to close the data-path loop while the other is used to introduce data from external sources into the data paths. The DPS is a combinatorial device and hence will always operate on the data; in many cases the operation may be just to pass the input to the output. Thus it will always require an instruction input and cannot be bussed with the instruction bus.

It can be concluded that the basic steps involved in data path configuration are, first, choose arrays of desired word lengths and desired functions, then arrange them into a bus organization similar to Figure 5-13.

## A SIMPLE PROCESSOR EXAMPLE

One of the many possible Macrologic applications is to implement emulators for existing instruction sets. These complex functional LSIs offer improved cost and performance while retaining software compatibility with the target machine. A simple 16 -bit processor is a good example to demonstrate the ease of use and versatility of Macrologic.

The 16 -bit fixed word-length processor, with four accumulators $\left(A C_{0}-A C_{3}\right)$ and $2 s$ complement arithmetic, has a 16 -word push/pop stack for subroutine nesting, as well as general use. The memory reference instruction format is shown in Figure 5-14. The 2-bit index field in the instruction specifies four addressing modes-base page, PC relative, $\mathrm{AC}_{2}$ and $\mathrm{AC}_{3}$ relative. For the base-page mode, the 8 -bit displacement field of the instruction is taken as the absolute address i.e., first 256 memory locations. For the relative mode, the 8 -bit displacement is treated as a signed number in 2 s complement notation and added to the Program Counter ( PC relative) or one of the specified accumulators ( $A C_{2}$ or $A C_{3}$ relative). The result then is used as the effective address for the operand.

A data path suitable for this processor is shown in Figure $5-15$. It consists of a 16 -bit ALRS array, 16-bit P-Stack array and 16 -bit DPS array. The ALRS and DPS can perform all the arithmetic logic operations needed. The P-Stack provides the required 16 -level stack function. The ALRS has eight built-in accumulators but only four are needed for this processor. The P-Stack has the necessary features to implement the PC, however, if this feature is used, only 15 levels of nesting remain. This processor requires 16. Because the ALRS has four spare accumulators, one of these can be used as the PC, thus leaving three spares. Thus the PC feature of the P-Stack is not needed and therefore the address outputs are not used. The storage in the ALRS is allocated as follows: $R_{0}=A C_{0}, R_{1}=A C_{1}, R_{2}=A C_{2}, R_{3}=A C_{3}, R_{4}=P C, R_{5}=T E M P 1$, $R_{6}=$ TEMP 2 and $R_{7}=$ TEMP 3. An edge-triggered memory address register (MAR) on the output bus is provided. Data from the memory is introduced into the data path using one of the input ports of the DPS array. Data to the memory is obtained directly from the output bus. An edge-triggered instruction register (IR) is also provided to hold the OP code bits and index bits of the macroinstruction.


Fig. 5-14 Memory Reference Instruction Format


Fig. 5-15 Data Path for the Processor

Figure 5-16 illustrates the microprogram control section for the data path. This control is centered around the 9408 sequencer operating in the pipeline mode (see page 5-3). The INH output of the 9408 is used to share the control fields. Thus, the source, destination, and ALRS/P-stack control fields provide the 10 -bit address for branching when needed. A 6-bit DPS control field provides the instruction inputs for the DPS array while the 4 -bit SEQ field provides the instruction inputs for the 9408 . Other fields lumped as miscellaneous are used to control the memory etc.
The Source and Destination fields are decoded to activate the $\overline{E O}$ and $\overline{E X}$ inputs (see Figure 5-16). Note that the IR Clock and MAR Clock signals are generated by gating the system clock with the appropriate destination decoder outputs. The branch address inputs ( $B A_{0}-B A_{g}$ ) are obtained from a 4 -way input multiplexer which, in turn, is controlled by the VIA 0 and VIA 1 outputs of the 9408 . One of the inputs to this multiplexer consists of the address inputs for branching from the microinstruction register. The second port is fed by a mapper that may be a PROM or FPLA. It receives the IR outputs and translates them into a starting address in the control memory for emulation. Figure 5-17 is a flow chart for the sequence of operations to accomplish macroinstruction fetch while Table 5-2 lists the operations performed by various data path elements and the 9408.


Fig. 5-16 Microprogram Control


Fig. 5-17 Flow Chart for Fetch Operation

| SOURCE | DESTINATION | P-STACK CONTROL | DPS CONTROL | SEQ | MISCELLANEOUS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DON'T CARE | ALRS | READ R4 (PC) | DON'T CARE | FTCH | $\ldots$. |
| ALRS | MAR | DON'T CARE | DON'T CARE | FTCH | READ MEMORY |
| DON'T CARE | ALRS | ADD WITH CARRY <br> TO R4 | ALL ZEROS | FTCH | $\ldots .$. |
| DON'T CARE | IR | DON'T CARE | DON'T CARE | FTCH | $\ldots$ |
| DON'T CARE | ALRS | LOAD R5 (TEMP 1) | K-BUS SIGN | FTCH | $\ldots$ |
| DON'T CARE | DON'T CARE | DON'T CARE | DON'T CARE | BRV 1 |  |

Table 5-2 Operations for FETCH Instruction

The first operation is to read the PC. Thus, the destination field specifies the ALRS and the destination decoder drives the $\overline{E X}$ input of the ALRS LOW. The ALRS/P-stack control field specifies "read R4". At the end of the microcycle, the contents of R4, i.e., the PC, are in the output register of the ALRS. The SEQ field of the first microinstruction is FTCH, therefore, the 9408 generates the address of the second microinstruction.

Here, the ALRS is specified as the source and the MAR as the destination. The source decoder activates the EO input of the ALRS, the destination decoder enables the gating for the MAR Clock, and the microinstruction loads the PC into the MAR. In the miscellaneous field, a memory Read is initiated. The third microinstruction is made to increment $R_{4}$ by selecting ALRS as the destination specifying Add with Carry. The DPS outputs (ALRS inputs) are forced HIGH. This incrementation is in preparation for the next macroinstruction fetch. The result from the memory read operation, initiated during the second microinstruction, is now available on the K-bus of the DPS. The fourth microinstruction activates the IR clock so that the eight most significant bits of the memory data are loaded into the IR. Assuming the data is still on the bus, the sign extended displacement is loaded into $R_{5}$ (TEMP 1) of the ALRS in the fifth microcycle by selecting "Load R5" as the ALRS operation and selecting the "K-bus sign extend" for the DPS. It should be recalled that the data path has a 16 -bit fixed word length and the displacement must be treated as a 2 s complement number. By using the sign extension capabilities of the DPS, the sign bits, i.e., most significant bits, can be aligned. At this point, the instruction is in the IR and the sign extended displacement is in TEMP 1. The sign of the least significant eight bits of the macroinstruction is extended in anticipation of a memory reference instruction. The sixth microcycle is intended to decode the IR. By specifying a $B R V_{1}$ in the SEO field, the VIA outputs of the 9408 select the mapper output as the source for next address. The mapper is designed to provide the starting address of the routine to emulate the instruction currently residing in the IR.

The total microprogram really consists of several simple routines. These easy steps can be converted into binary patterns to be loaded into the control store. Once a data path architecture and microinstruction format has been chosen for a given system design, the microprogram can be written to realize the desired function. It can then be assembled, using the microprogram assembler, to get the binary listing that specifies the control store address and contents. Using this information, the control store can be loaded with the program and the system is ready for operation.

## MACROLOGIC ASSEMBLERS

Macrologic users, designing programmed logic systems, find a need for a microprogram assembler to aid in software development. To fill that need, Fairchild offers a choice of assembler software, the microprogram assembler and DAPL, available through two different worldwide time share networks.

## Microprogram Assembler

The microprogram assembler is an aid in the preparation of a microcode. The user defines his own mnemonics to represent meaningful binary bit patterns and using the symbolic language thus created, writes the program. The microprogram assembler translates the symbolic language into binary code and produces punched card, disk or tape output for each program step. The same information is also printed along with indications of errors that were present in the input statements. Access to the microprogram assembler is easily arranged from anywhere in the world.

The microprogram assembler is available at the Computer Useage Company, Data Center, Sunnyvale, California. (408-738-4300).

## DAPL

DAPL is a highly modular microprogramming language for the Fairchild Macrologic series. Constructed in four concentric and compatible levels, the microprogrammer selects the DAPL feature that provides a con-
venient symbolic representation of a particular microprogram. Macros and symbolic values may be used at all DAPL levels. Level 0 essentially permits the microinstructions to be formed by sequences of symbolic names and binary, octal, decimal, and hexadecimal numbers. In Level 1, microinstructions are defined as a series of fields with each field sequentially assigned a value as in Level 0 . Additionally, label tables can be incorporated for mapping ROMs and PLAs. Level 2 extends the microinstruction field definition to include symbolic names and default values. Finally, Level 3 allows the expression of microprograms in register transfer notation.

Other DAPL features include:

- Microprogram accommodation up to 8192 words by 256 bits.
- Free form input with comments arbitrarily interspersed for documentation.
- An interlist command that lists the generated microcode directly beneath the associated microinstruction.
- A complete variable cross-reference listing.
- Extensive error detection and debugging aids.
- Optional hexadecimal or binary object format.
- A use map showing those locations actually used.

DAPL is available under a one-time license from Zeno Systems Inc., 2210 3rd St., Santa Monica Ca., (213) $396-6020$ or on a timesharing basis from Remote Computing Corporation, One Wilshire, Los Angeles, Ca. 90015, (213) 629-2532.

## CYCLIC CHECKS FOR ERROR DETECTION

Error detection schemes using parity checks are well known. A parity check on a character is called "vertical" parity and a check on corresponding bits of every character in a message (data block) is called "longitudinal" parity. Used together, they provide a satisfactory checking scheme; the measure of protection provided is better than using vertical or longitudinal parity alone. However, the level of redundancy to achieve this protection is relatively high. For example, if there are x bytes in a message each consisting of seven data bits and one parity bit, the ratio of number of check bits to data bits is $(x+8) / 7 x$. As $x$ increases, the ratio reaches a limit of 1/7.

Another checking scheme exists called polynomial or cyclic coding that can be designed to perform with higher efficiencies than traditional parities. The level of protection achieved with a 16 -bit cyclic check is probably satisfactory for most practical purposes; when used with a data block consisting of $7 x$ data bits, ratio of check to data bits is only $16 / 7 x$. The ratio reaches a limit of zero as $x$ increases. This high efficiency is inducing designers to incorporate cyclic check schemes in modern data communication and peripheral equipment such as tapes and discs. Theoretical knowledge necessary for cyclic check implementation existed for several years. However, widespread use is only in recent designs using integrated circuits. Because it is relatively new, many designers do not have the needed exposure to cyclic schemes and tend to shy away.

This discussion is intended to familiarize uninitiated readers with the algebraic concepts required to design circuits for implementing cyclic check schemes. Not only are these concepts of value to the hardware designer, but also to the diagnostic programmer who must generate the code to check the implemented logic for validity and failures.

## Polynomial Notation and Manipulation

A very convenient way of expressing a bit stream (message) consisting of $K$ bits is to think of it as a polynomial in a dummy variable $x$ with K terms. The bits of the message are the coefficients in the
polynomial. Thus, if 100100011011 is the message, it may be written as:

$$
\begin{gathered}
M(x)=1 \cdot x^{11}+0 \cdot x^{10}+0 \cdot x^{9}+1 \cdot x^{8}+0 \cdot x^{7}+0 \cdot x^{6}+0 \cdot x^{5}+1 \cdot x^{4}+1 \cdot x^{3}+0 \cdot x^{2}+1 \cdot x^{1}+1 \cdot x^{0} \\
\text { or } \\
M(x)=x^{11+x^{8}+x^{4}+x^{3}+x+1}
\end{gathered}
$$

To compute the cyclic check on a message, another polynomial $P(x)$ called a generating polynomial is chosen. The degree " $r$ " of the $P(x)$ is such that it is greater than zero but less than the degree of $M(x)$. Moreover, $\mathrm{P}(\mathrm{x})$ has a non-zero coefficient in the $\mathrm{x}^{0}$ term. It is clear then that for a given message length, more than one generating polynomial of desired length can be specified. Fortunately, several accepted standard generating polynomials exist; most common are CRC-16 and CRC-12 which were originally proposed for the IBM binary synchronous communications.
CRC-16 is a 16 -bit check resulting from a generating polynomial $x^{16+x}{ }^{15}+x^{2}+1$ and CRC-12 is a 12 -bit check resulting from $x^{12}+x^{11}+x^{3}+x^{2}+x+1$. Theory suggests that use of CRC -16 and CRC-12 will catch all messages with an odd number of errors, all with a single burst of less than 16 or 12 bits respectively and most of the few messages with larger bursts.

Cyclic check computation involves manipulating $M(x)$ and $P(x)$ using laws of ordinary algebra, except that modulo 2 arithmetic is used. Because modulo arithmetic yields the same result for addition and subtraction, it is necessary only to consider three operations involving polynomials-addition, multiplication and division.
Addition of two polynomials $x^{6}+x^{5}+x^{2}+1$ and $x^{5}+x^{4}+x^{3}+x^{2}$ yields $x^{6}+x^{4}+x^{3}+1$ as shown below:

$$
\begin{aligned}
x^{6}+x^{5}+0+0+x^{2}+0+1 & =1100101 \\
\frac{x^{5}+x^{4}+x^{3}+x^{2}+0+0}{x^{6}+0+x^{4}+x^{3}+0+0+1} & =\frac{11100}{1011001}
\end{aligned}
$$

Multiplication of two polynomials $x^{7}+x^{6}+x^{5}+x^{2}+1$ and $x+1$ results in $x^{8}+x^{5}+x^{3}+x^{2}+x+1$

$$
\begin{array}{ll}
\left(x^{7}+x^{6}+x^{5}+x^{2}+1\right)(x+1) & =(11100101) \times 11 \\
x^{8}+x^{7}+x^{6}+0+0+x^{3}+0+x+0 & =111001010 \\
\frac{x^{7}+x^{6}+x^{5}+0+0+x^{2}+0+1}{x^{8}+0+0+x^{5}+0+x^{3}+x^{2}+x+1} & =\frac{011100101}{100101111}
\end{array}
$$

It is interesting to note that multiplication of a polynomial by $x^{m}$ results in a shifted bit pattern which is identical to the original except for zeros in the lower $m$ positions. For example:

$$
\begin{aligned}
x^{5}\left(x^{11}+x^{10}+x^{8}+x^{4}+x^{3}+x+1\right)= & x^{16}+x^{15}+x^{13}+x^{9}+x^{8}+x^{6}+x^{5} \text { where } x^{11}+x^{10}+x^{8}+x^{4}+x^{3}+x+1=110100011011 \text { and } \\
& x^{16+}+x^{15}+x^{13}+x^{9}+x^{8}+x^{6}+x^{5}=11010001101100000
\end{aligned}
$$

Dividing $x^{13+}+x^{11+x^{10}+x^{7}+x^{4}+x^{3}+x+1}$ by $x^{6}+x^{5}+x^{4}+x^{3}+1$ results in a quotient of $\left(x^{7}+x^{6}+x^{5}+x^{2}+x+1\right)$ and a remainder of $\left(x^{4}+x^{2}\right)$ as shown below. Practically, it might be easier to divide by longhand if the bit pattern is used rather than the polynomial.

$$
\begin{gathered}
x^{13}+x^{11}+x^{10}+x^{7}+x^{4}+x^{3}+x+1=10110010011011 x^{6}+x^{5}+x^{4}+x^{3}+1=1111001 \\
1 1 1 1 0 0 1 \longdiv { 1 1 1 0 0 1 1 1 } \\
\frac{11110010011011}{1000000} \\
\frac{1111001}{1110010} \\
\frac{1111001}{1011110} \\
\frac{1111001}{1001111} \\
\frac{1111001}{1101101} \\
\frac{1111001}{10100}
\end{gathered}
$$

Thus, $Q(x)=11100111=x^{7}+x^{6}+x^{5}+x^{2}+x+1 \quad R(x)=10100=x^{4}+x^{2}$

## Cyclic Check - Computing Procedure

To compute a check on $M(x)$, a generating polynomial $P(x)$ is chosen as mentioned earlier. Steps involved in check computation are as follows:
a) Message polynomial $M(x)$ is multiplied by $x^{r}$ where $r$ is the degree of $P(x)$. As noted earlier, this process yields zeros in the lower $r$ positions of $M(x)$. These vacated positions are in preparation for the $r$ check bits that will be appended to the message. Also note that this process does not alter the message bit pattern.
b) The result obtained from step (a) is divided by $P(x)$. This gives a quotient $Q(x)$ and a remainder $R(x)$. The remainder will be $r$ bits or less.
c) The quotient is discarded and the remainder is added to the result of step (a). The remainder is the check. The message with this remainder at the tail end constitutes the transmitted polynomial $T(x)$.

The following example illustrates the computation procedure. Let $M(x)=x^{11+x} 10+x^{8}+x^{4}+x^{3}+x+1=$ 110100011011 and $P(x)=x^{5}+x^{4}+x^{2}+1=110101$. Thus, $r=5$ and $x^{r} M(x)=x^{16}+x^{15}+x^{13}+x^{9}+x^{8}+x^{6}+x^{5}$ $=11010001101100000$

$$
\frac{x^{r} M(x)}{P(x)}=\frac{11010001101100000}{110101}
$$

Carrying this division, $Q(x)=100001100111$ and $R(x)=1011$.
Transmitted message $T(x)$ is obtained by adding $R(x)$ to $x^{r} M(x)$


Note that transmission occurs from left to right; data thus is unmodified and check bits follow at the end.

## Data Validation at the Receiver

The transmitted polynomial arrives at the receiver modified or unmodified depending on whether transmission has encountered errors or not. Clearly, one of the ways by which the receiver can ensure data validity is to recompute the check bits on the message using the same generator polynomial and compare them with the received check bits. If they agree, it is assumed that received data is good.

Instead, the receiver can divide the complete received polynomial by the same generator polynomial $P(x)$. If there are no errors, it can be shown that this divison results in zero remainder. This property can be easily verified by long division of $T(x)=1101000110110101$, by $P(x)=110101$. If the division results in a non-zero remainder, it can be assumed that $T(x)$ has been modified by errors. This may be verified by introducing error and performing the division. The process of dropping and picking bits can be viewed as adding another polynomial $E(x)$ (error polynomial) to $T(x)$.

For example, if $T^{\prime}(x)=10010001101101011$ is received, instead of $T(x), T^{\prime}(x)=T(x) \oplus E(x)$ can be written where $E(x)=01010001101101011$. It follows then that if $T^{\prime}(x)$ is exactly divisible by $P(x)$, the receiver is blind and indicates no errors. This only happens if $E(x)$ is exactly divisible by $P(x)$. Knowing the characteristics of the transmission medium, it is advisable to choose such a generating polynomial that the probability of error patterns occurring that are divisible by $\mathrm{P}(\mathrm{x})$ is extremely low. The process of not detecting such errors is somewhat analogous to the erroneous validity indication in normal parity schemes where multiple bit errors may cancel each others contribution to the check.

## Basic Polynomial Divider

Consider long hand division of the polynomial $x^{16}+x^{15}+x^{13}+x^{9}+x^{8}+x^{6}+x^{5}$, i.e., 11010001101100000 , by another polynomial $x^{5}+x^{4}+x^{2}+1$, i.e., 110101.

110101 | 100001100111 |
| ---: |
| $\frac{11010001101100000}{101101}$ |
| $\frac{110101}{110001}$ |
| $\frac{110101}{100000}$ |
| $\frac{110101}{101010}$ |
| $\frac{110101}{11110}$ |
| $\underline{110101}$ |
| $\underline{1011}$ |

From this example, long hand division procedure can be summarized; align the most significant bits of the partial remainder and divisor borrowing from the dividend as required. This implies aligning the divisor and dividend to start the division process. Then, subtract the divisor from the partial product using modulo 2 arithmetic. When all bits in the dividend are processed, the result is the remainder.

Subtraction in modulo 2 of two bits is the same as performing an Exclusive-OR operation and alignment of bits suggests a shift operation. Consider two registers as shown in Figure 5-18.


Fig. 5-18 Conceptual Polynomial Divider


Fig. 5-19 Polynomial Divider for $x^{5}+x^{6}+x^{2}+1$

Assume that register $A$ is initially clear and register B contains 110101, which is the divisor bit pattern. Also imagine that the dividend serially enters the network as input (most significant bit first), in response to a clock signal that operates register $A$. As long as $A_{4}$ is cleared and $B_{5}$ is set, the AND gates are inhibited. This establishes a connection between $A_{4}$ input and $A_{3}$ output, $A_{3}$ input and $A_{2}$ output etc. Thus, register A serves as a "shift left" register. When clocked with the dividend as serial input, the most significant bit eventually appears in A4. At this point, $A_{4}$ and $\mathrm{B}_{4}$ are both set, i.e., the most significant bits of divisor and dividend are aligned. This alignment enables the AND gates. However, this has no effect on the Exclusive-OR gates with inputs derived from Zero bit positions of register B. The "shift left" nature of register $A$ at bit locations fed by these Exclusive-OR gates is preserved. Thus in Figure 5-18, the $A_{1}$ input comes from $A_{0}$ and $A_{3}$ input from $A_{2}$. On the other hand, the remaining bit positions receive the result of modulo 2 subtraction between appropriate bits. In summary, when register $A$ is clocked after bit alignment, the partial remainder is loaded into it. If clocking is continued until all dividend bits are processed, the content of register $A$ is the required remainder. Table 5-3 illustrates the register contents through this process; it is instructive to compare it with the long division.

Closer examination of Figure 5-18 suggests that it can be greatly simplified. Figure 5-19 shows a functionally identical scheme similar to that used for cyclic checking purposes.

| Input | Register |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | $A_{4}$ | $A_{3}$ | $A_{2}$ | $A_{1}$ | $A_{0}$ |
| 1 | 0 | 0 | 0 | 0 | 1 |
| 1 | 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 0 | 1 | 1 | 0 |
| 1 | 0 | 1 | 1 | 0 | 1 |
| 0 | 1 | 1 | 0 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | 1 |
| 0 | 0 | 0 | 0 | 1 | 0 |
| 1 | 0 | 0 | 1 | 0 | 1 |
| 1 | 0 | 1 | 0 | 1 | 1 |
| 0 | 1 | 0 | 1 | 1 | 0 |
| 1 | 1 | 1 | 0 | 0 | 0 |
| 1 | 0 | 0 | 1 | 0 | 0 |
| 0 | 0 | 1 | 0 | 0 | 0 |
| 0 | 1 | 0 | 0 | 0 | 0 |
| 0 | 1 | 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 1 | 1 | 1 |
| 0 | 1 | 0 | 1 | 1 |  |

Table 5-3 Bit Patterns Through Division Process

Discussion on basic polynomial division circuits can now be concluded with these observations-the division algorithm can be implemented by suitable interconnection of shift registers and Exclusive-OR gates. The total number of register positions equals the degree of the divisor polynomial. The total number of Exclusive-OR gates is equal to one less than the number of non-zero terms in the divisor.

## Polynomial Divider for Cyclic Checks

But for one drawback, the polynomial divider could be used as a cyclic check generator. Imagine that the
 by $x^{5}$, and the divisor $x^{5}+x^{4}+x^{2}+1$ is the generating polynomial. From the cyclic check coding scheme, remember that $x^{11+x} 10+x^{8}+x^{4}+x^{3}+x+1$ is the actual data stream. The divider circuit discussed so far does not provide the remainder until the trailing zeros have been processed. Thus, if the remainder is to be appended as a check to the data stream, there is a delay before it is available for transmission. In almost all applications, such a gap between data and check bits is undesirable. This deficiency could easily be rectified if a circuit were possible which could multiply two polynomials while dividing by a third simultaneously.

Polynomial multiplication circuits can be derived using analogous arguments that result in the division circuit. For example, the arrangement shown in Figure 5-20 multiplies an incoming polynomial by $x^{6}+x^{5}+x^{4}+x^{3}+1$. Fortunately, for cyclic check applications, multiplication by a single term of the form $x^{r}$,
where ' $r$ ' is the degree of the generator polynomial, is sufficient. To implement a "multiply by $x^{5}$ " circuit, only a 5-bit shift register and one Exclusive-OR gate are needed as shown in Figure 5-21.

It is possible to combine the multiplier shown in Figure 5-21 and the divider in Figure 5-18 to implement a simultaneous multiply by $x^{5}$ and divide by $x^{5}+x^{4}+x^{2}+1$ circuit as shown in Figure 5-22. As before, Figure $5-22$ may be simplified to arrive at Figure 5-23 which can be used as a cyclic check generator for the generating polynomial $P(x)=x^{5}+x^{4}+x^{2}+1$. Table 5-4 lists the register content as each bit of the dividend (message polynomial) is processed.


Fig. 5-20 Circuit for Multiplying by ( $x^{6}+x^{5}+x^{4}+x^{3}+1$ )


Fig. 5-21 Circuit for Multiplying by $\mathbf{x}^{5}$


Fig. 5-22 Conceptual Cyclic Check Generator


Fig. 5-23 Basic Cyclic Check Circuit for $P(x)=x^{5}+x^{4}+x^{2}+1$

| Input | Register |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | $A_{4}$ | $A_{3}$ | $A_{2}$ | $A_{1}$ | $A_{0}$ |
| 1 | 1 | 0 | 1 | 0 | 1 |
| 1 | 0 | 1 | 0 | 1 | 0 |
| 0 | 1 | 0 | 1 | 0 | 0 |
| 1 | 0 | 1 | 0 | 0 | 0 |
| 0 | 1 | 0 | 0 | 0 | 0 |
| 0 | 1 | 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 1 | 1 | 1 |
| 1 | 1 | 1 | 1 | 1 | 0 |
| 1 | 1 | 1 | 1 | 0 | 0 |
| 0 | 0 | 1 | 1 | 0 | 1 |
| 1 | 0 | 1 | 1 | 1 | 1 |
| 1 | 0 | 1 | 0 | 1 | 1 |

Table 5-4 Bit Pattern Through the Check Circuit

From Table 5-4, it is clear that the remainder is available as soon as the last data bit is processed. Also note that the quotient bit pattern appears in $A_{0}$. If it is desired to transmit the remainder from the register of Figure $5-23$ in a serial fashion, the connections must be established to make the register a straight shift from right to left by disabling the feedback through the Exclusive-OR gates.

## Reverse Polynomials

Cyclic checks are often used in magnetic tape systems. Many of these have capabilities to read data in both forward and reverse directions. One of the reasons for this capability is to combat the overhead required to position the tape in front of the data block for a re-read operation in the event of an error. When "data followed by check bits" format is used to write on the tape, the check character is encountered first while reading in the opposite direction and the bit order for the whole block is reversed. Clearly, if the same check circuitry is used for error detection in both directions, erroneous indications are inevitable when reading in the opposite direction. This situation can be avoided by utilizing a reverse polynomial for checking in the opposite direction. The reverse polynomial is obtained by writing a polynomial bit pattern backwards. For example, the bit pattern for CRC-16 (forward) is 11000000000000101, i.e.,


## PROGRAMMABLE BIT-RATE GENERATOR

The industry standard Universal Asynchronous Receiver/Transmitter (UART), an MOS/LSI subsystem, has had a considerable impact on data-communication system design. Not only has the UART dramatically reduced chip counts and increased reliability, etc., but it has also provided an incentive to integrate the remaining support functions.

One such subsystem is the 4702 programmable bit-rate generator, designed to provide the necessary clocking signals to operate asynchronous transmitter and receiver circuits. Several standardized signaling rates are used for start-stop communication depending on the transmission medium and other system requirements. The equipment must be capable of generating all the necessary frequencies and provide a way to select the desired one. In the past, this required several SSI/MSI circuits. Now, the 4702 can perform the task more easily and economically.

The 4702 provides any one of the 13 common bit rates on a selectable basis using an on-board oscillator and an external crystal; it also is expandable for multichannel applications. In its most general form, multichannel clocking requires that any of the possible frequencies must be available on any channel. Expansion up to eight channels is accomplished without device duplication. In multiple-device systems, there is no need to use a crystal with every device. Figure $5-24$ shows the block diagram of the 4702 which consists of the following major parts:

- Oscillator and associated gating
- Scan counter
- Count chains
- Initialization circuit
- Multiplexer and output storage


## Oscillator and Associated Gating

The oscillator circuit together with an external crystal generates the master timing. A 2.4576 MHz crystal provides 16 times the frequency of the baud values marked; for example, 9600 baud corresponds to 153.6 kHz . If the External Clock Enable ( $\bar{E}_{\mathrm{CP}}$ ) is HIGH, the oscillator output signal drives the count chain. On the other hand, if it is LOW, the External Clock (CP) signal is enabled and is then the timing source. The External Clock input also participates in the device initialization scheme. The master timing signal, either from the external source or the local oscillator, is available on the Clock Output pin (CO). This signal can be used to drive other 4702s in a multiple device system, thus eliminating the need to provide more than one crystal.

## Scan Counter

The master timing drives a 3 -bit binary scan counter which, in turn, drives the remaining counter chains on the chip. The scan counter allows expansion to eight channels as described later. The prescaling feature of


Fig. 5-24 4702 Block Diagram
this counter provides another benefit, i.e., it moves the input frequency to 2.4576 MHz which is ideal for low-cost crystals. If it were not for the scan counter, the 4702 would require a more expensive crystal of about 300 kHz .

## Count Chains

The scan counter output drives an 8-bit binary counter which provides the frequencies corresponding to $9600,4800,2400,1200,600,300,150$ and 75 baud. The 1800 -baud signal is generated by dividing 9600 by $16 / 3$. The 110 and 134.5 baud signals are approximated by dividing 2400 by 22 and 18 respectively. Dividing 1200 by 6 gives the 200 baud signal, while 50 baud is generated by dividing 200 baud by 4 . All division factors except 16/3 are even; thus, all outputs except 1800 baud have a $50 \%$ duty cycle.

The actual division by $16 / 3$ is achieved by using a sequence of integers 5 and 6 such that cumulative error after every three cycles is zero. This scheme, in conjunction with the divide by 16 performed in the UART, achieves good timing accuracy demanded by high speed communication equipment. Calculations indicate that the maximum distortion introduced does not exceed $0.78 \%$ regardless of the number of elements in a character.

## Initialization Circuit

This circuit generates a Master Reset signal to initialize the flip-flops on the 4702 to a known state. If the External Clock Enable ( $\bar{E}_{\mathrm{CP}}$ ) is LOW, the local oscillator output is inhibited and timing is derived from the External Clock (CP). The first positive half cycle of the External Clock is used to generate the Master Reset and all succeeding clock signals are used for timing. This initialization scheme allows software-controlled diagnosis for fault isolation.

## Multiplexer and Output Storage

All the desired outputs from the count chains are fed as data inputs to a multiplexer. The select inputs for this multiplexer are brought out as Rate Select input ( $\mathrm{S}_{0}-\mathrm{S}_{3}$ ). Table $5-5$ shows the correspondence between this code and the resulting frequency. The multiplexer output is fed as data input to a resynchronizing flip-flop that is clocked by the leading edge of the master timing.

If only single-channel applications of the 4702 were considered, the output flip-flop would be unnecessary. In multichannel applications, however, the Rate Select inputs change as a function of the Scan Counter outputs $\left(\mathrm{O}_{0}-\mathrm{O}_{2}\right)$. The resynchronizing flip-flop assures a fixed timing relationship between $\mathrm{O}_{0}-\mathrm{O}_{2}$ and the Bit Rate output ( Z ).

Three important features should be noted from Table 5-5. First, two of the select codes specify Multiplexed Input ( $I_{M}$ ) signal as the data source to the multiplexer. The user can feed a signal into this input, however, the primary intent was to feed a static logic level to achieve a "zero baud" situation. Secondly, the codes corresponding to $110,150,300,1200$ and 2400 baud each have a maximum of only one LOW level. These are the most commonly used rates in contemporary data terminals. Thus the rate select mechanism on these terminals need only be a single-pole 5-position switch with the common terminal grounded. Thirdly, 2400 baud is selected by two different codes so that the whole spectrum of modern communication rates will have a HIGH code in the most significant bit position.

## Typical Applications

In those applications where the Rate Select inputs are static levels, operation of the 4702 is rather straightforward. The multiplexer connects the specified counter output to the data input of the output flip-flop. Because the flip-flop is clocked by the master timing, its output reflects the selected frequency.

## Single-Channel Bit-Rate Generator

Figure $5-25$ shows the simplest of all 4702 applications. This circuit provides one of five possible bit rates as determined by the setting of the 5 -position switch. The generated frequencies correspond to $110,150,300$, 1200 and 2400 baud depending on the switch setting. For many low cost terminal applications, these five selectable bit rates are adequate. The 4702 is not only intended for single-channel but also for multi-channel operation, as illustrated in the following applications.

| $\mathrm{S}_{3}$ | $\mathrm{~S}_{2}$ | $\mathrm{~S}_{1}$ | $\mathrm{~S}_{0}$ | OUTPUT RATE (Z) |
| :--- | :--- | :--- | :--- | :--- |
| L | L | L | L | MULTIPLEXED INPUT ( $\mathrm{I}_{\mathrm{M}}$ ) |
| L | L | L | H | MULTIPLEXED INPUT ( $\mathrm{I}_{\mathrm{M}}$ ) |
| L | L | H | L | 50 BAUD |
| L | L | H | H | 75 BAUD |
| L | H | L | L | 134.5 BAUD |
| L | H | L | H | 200 BAUD |
| L | H | H | L | 600 BAUD |
| L | H | H | H | 2400 BAUD |
| H | L | L | L | 9600 BAUD |
| H | L | L | H | 4800 BAUD |
| H | L | H | L | 1800 BAUD |
| H | L | H | H | 1200 BAUD |
| H | H | L | L | 2400 BAUD |
| H | H | L | H | 300 BAUD |
| H | H | H | L | 150 BAUD |
| H | H | H | H | 110 BAUD |

Table 5-5 Truth Table for Rate Select Inputs


Fig. 5-25 Switch Selectable Bit-Rate
Generator Configuration Providing 5 Bit Rates

Figure 5-26 illustrates a fully programmable 8 -channel bit-rate generator system. Two $4 \times 4$ register file devices (9LS170) can be loaded with information (rate select codes from Table 5-5) relating to the desired frequency on a per-channel basis. For clarity, circuits for writing into the files are not shown.

The least significant Scan Counter outputs $\left(\mathrm{O}_{0}, \mathrm{O}_{1}\right)$ control the Read Address of the 9LS170s while the most significant output $\left(\mathrm{O}_{2}\right)$ controls the Read Enable (RE) inputs. Thus, as the counter advances, file locations are read out sequentially. The Scan Counter outputs are also the Address inputs for the 93L34 addressable latch. The Bit Rate output ( $Z$ ) of the 4702 is the Data input to the 93L34 while the Clock Output is the Enable input.

To understand the operation, consider the instant when the Scan Counter outputs become Zero ( $\mathrm{O}_{0}-\mathrm{O}_{2}$ = LOW). The same clock that incremented this counter to Zero also
clocked the counter output, corresponding to the selected frequency for channel 7 into the output flip-flop, and
disabled the 93L34 latch via the Clock Output (CO), thus preventing any change in the latch outputs while the Scan Counter outputs and the Bit Rate output $(Z)$ are changing.

During the second half of the clock cycle, when the Clock Output (CO) is LOW, the counter output representing the selected frequency for channel 7 is loaded into the 93 L 34 latch and is locked up on the $\mathrm{O}_{0}$ output.


Fig. 5-26 A Fully Programmable 8-Channel Bit-Rate Generator System

The Scan Counter outputs $\left(\mathrm{O}_{0}-\mathrm{Q}_{2}\right)$, which represent the selected channel, are used to interrogate the register file to determine the assigned bit rate for channel 0 . The stored code for channel 0 is routed to the Rate Select inputs ( $\mathrm{S}_{0}-\mathrm{S}_{3}$ ) to select the appropriate internal frequency, so that during the next LOW-to-HIGH clock transition, the state of this internal signal is clocked into the output flip-flop. Thus, each channel is sequentially interrogated and the 93L34 latch is updated at least once during each half cycle of the highest output frequency ( 9600 baud).

By connecting the Scan Counter output $\mathrm{O}_{2}$ to the Multiplexed input ( $I_{M}$ ) a similar technique can be used to implement a system with a maximum output frequency of 19,200 baud, however, the number of channels must be limited to four. This ensures that the output will be interrogated and updated at least once during each half cycle of the highest output frequency (19,200 baud).

## Jumper Programmable 8-Channel Bit-Rate Generator

In systems where channel-speed assignments remain relatively fixed, software-controlled channel assignment is not necessary or practical. It may be simpler to program with "jumpers", at appropriate places in the system. See Figure 5-27.


Fig. 5-27 Jumper Programmable 8-Channel Bit-Rate Generator

In the jumper programmable 8 -channel bit-rate generator, the scan counter outputs ( $\mathrm{O}_{0}-\mathrm{O}_{2}$ ) are fed as Address inputs to a 93L01 decoder and a 93L34 addressable latch. The decoder outputs drive the diode clusters which contain four diodes for each channel. All four diode cathodes in a cluster are connected together to a decoder output; the anodes of corresponding diodes in every cluster are connected together to the appropriate Rate Select inputs of the 4702. Presence of a diode results in a LOW on the particular 4702 input; when a diode is absent, a HIGH results. As the scan counter advances, the decoder outputs activate the desired bit-rate code for that channel. The 93L34 synchronously demultiplexes the 4702 output ( $Z$ ) and reconstructs the specified bit rates at its output.

## Clock Expansion

The basic 4702 can be expanded to a maximum of eight channels. In applications where more than eight channels are needed, the 4702 must be duplicated. The device is designed with a clock-expansion feature; therefore only one crystal is required to operate all the channels.

The most economical expansion scheme provides one 4702 with a crystal and all other devices derive their timing from this master. The device wiring is such that the External Clock Enable input and $\mathrm{I}_{\mathrm{X}}$ input of all but the master device feeds into the External Clock input of all the other devices. The Clock output of each device is connected to its associated 93L34 Enable input as before. An alternative scheme is shown in Figure 5-28.

The advantage of this scheme is that it can be conveniently used to implement the software external clock feature mentioned previously. Imagine that the External Clock Enable ( $\bar{E}_{\mathrm{C}}$ ) inputs of all the 4702s in the system are controlled by the output of a flip-flop (mode) and the External Clock inputs (CP) of all the devices are tied together and software driven, possibly by operating another flip-flop. During normal operation, the mode control is HIGH, thus selecting the crystal oscillator for timing. Also, the external Clock input of each device is held LOW. When the External Clock Enable goes LOW, in preparation for the diagnostic mode, all devices receive their timing from the External Clock input. When this input goes HIGH for the first time, all devices generate an internal Master Reset signal clearing their counter chains. The next HIGH-to-LOW transition sets the internal control flip-flop and thus terminates the Reset; all counters are free to start counting in response to the External Clock signal.


Fig. 5-28 Tandem Clock Expansion Scheme

## USING THE 9403 AND 4703 FIFOs

The First-In First-Out (FIFO) memory is a read/write memory which automatically stacks the words in the same order as they were entered and makes them available at the output in the same sequence, thus its name first-in first-out. In the past, MOS technology has been the dominant manufacturing process for FIFOs. Now, however, there are two new members of the Macrologic family that utilize advanced Schottky TTL and Isoplanar CMOS technologies, the 9403 and the 4703 respectively. These two FIFOs are functionally identical and offer several unique features other than those directly attributable to the manufacturing techniques.

## Description

The $9403 / 4703$ FIFO is a $16 \times 4$ parallel/serial memory consisting of the following (Figure 5-29).

- An input register with parallel and serial data inputs as well as control inputs and outputs for input handshaking and expansion.
- A 4-bit wide, 14-word deep fall-through stack with self-contained control logic.
- An output register with parallel and serial data outputs, control inputs and outputs for output handshaking and expansion.

Parallel data is entered into the input register by using $D_{0}$ through $D_{3}$ as data inputs and Parallel Load (PL) as the strobe. A HIGH at the PL input operates the direct set and clear inputs of the input-register flip-flops. The quiescent state of the PL input is LOW.

To enter data serially, the $D_{S}$ is used as the data input and CPSI as the clock. The input register responds to the HIGH-to-LOW clock transition and the quiescent state of the CPSI input is LOW. For the CPSI to effect shifting, the Input Expand Serial (IES) input must be LOW.

Whenever the input register receives four data bits whether by serial or parallel entry, the status output signal, Input Register Full (IRF), goes LOW. If the Transfer to Stack (TTS) input is activated with a LOW pulse, data from the input register is transferred into the first stack location (provided it is empty). As soon as data is transferred, the control logic attempts to initialize the input register so that it can accept another word; however, the initialization is postponed until the PL input is LOW. The device is designed so that the IRF output can be connected to the TTS input. Thus, when a data word is received by the input register, it automatically enters the stack and falls through toward the output, pausing only as needed for an "empty" location.

Normally, the Output Register Empty (ORE) is LOW, indicating that the output register does not contain valid data. As soon as a data word arrives in the register, the ORE output goes HIGH, indicating the presence of valid data. If the Output Enable (EO) input is LOW, the 3 -state buffers are enabled and data is available on the $\mathrm{O}_{0}$ through $\mathrm{O}_{3}$ outputs.

Data can be extracted either serially or in parallel. The QS is used for serial data output and CPSO for the clock input. The QS output is also available through a 3-state buffer; however its enabling is controlled internally. Output register shifting occurs on the HIGH-to-LOW transition of the CPSO whose quiescent state is LOW. As soon as the last data bit is shifted out, the ORE output goes LOW, indicating that the output register is empty.

The quiescent state of the TOS input is LOW. A HIGH-to-LOW transition on this input causes new data to be loaded from the stack into the output register (provided data is available). The ORE output can be connected to the TOS input so that as soon as the last bit is shifted out, new data is automatically demanded.


$$
\begin{aligned}
& V_{D D}=\operatorname{Pin} 24 \\
& V_{S S}=\operatorname{Pin} 12
\end{aligned}
$$

| $\mathrm{D}_{0}-\mathrm{D}_{3}$ | Parallel Data Inputs |
| :---: | :---: |
| $\mathrm{D}_{S}$ | Serial Data Input |
| PL | Parallel Load Input |
| CPSI | Serial Input Clock Input (HIGH-to-LOW Triggered) |
| CPSO | Serial Output Clock Input (HIGH-to-LOW Triggered) |
| IES | Serial Input Enable (Active LOW) |
| TTS | Transfer to Stack Input (Active LOW) |
| TOS | Transfer Out Serial Input (Active LOW) |
| TOP | Transfer Out Parallel Input |
| $\overline{\text { OES }}$ | Serial Output Enable Input (Active LOW) |
| EO | Output Enable Input (Active LOW) |
| MR | Master Reset Input (Active LOW) |
| $\overline{\text { IRF }}$ | Input Register Full Output (Active LOW) |
| ORE | Output Register Empty Output (Active LOW) |
| $\mathrm{O}_{0}-\mathrm{O}_{3}$ | Parallel Data Outputs |
| ${ }^{\mathrm{O}_{S}}$ | Serial Data Output |

Fig. 5-29 9403/4703 Block Diagram

The quiescent state of the TOP input is HIGH and a LOW-to-HIGH transition causes new data to be loaded into the output register. Moreover, a HIGH level on the TOP input causes the ORE to go LOW. The TOP input can be connected to the EO input so that the output data can be enabled when EO is LOW. When the output is disabled, new data is automatically demanded. It should be noted that the TOS input does not affect the ORE output.

The FIFO is initialized by a LOW signal on the Master Reset (MR). This causes the status outputs, IRF and ORE, to assume an empty state; i.e., IRF is then HIGH and ORE LOW. It is important to remember that the MR does not clear all the data flip-flops; it only initializes the control. Specifically, the $\mathrm{O}_{0} \ldots \mathrm{O}_{3}$ outputs are not affected by the Master Reset.

## Expansion

The 9403/4703 can be vertically expanded to store more words or horizontally expanded to store longer words (in multiples of four bits) without external logic. Also, the expansion scheme fully preserves the parallel/serial data features. To illustrate the expansion connections, a FIFO array consisting of eight devices is shown in Figure 5-30. If there are $m$ devices in a row and $n$ rows, the array provides ( $15 n+1$ ) words of storage with 4 m bits in each word. The reduction in storage to $(15 n+1)$ words instead of 16 n is quite common in such expansion (see explanation at end of this section). Data is entered into devices 1 through 4 and extracted from devices 5 through 8.


Fig. 5-30 $31 \times 16$ FIFO Array

The DS inputs of the first four devices are bussed together and serial data is entered on this line. The CPSI inputs are also connected together for clocking the serial data. The IES input of device 1 is connected to ground, while the IES inputs of devices 2, 3 and 4 are each connected to the IRF output of the preceding device. The IRF output of device 4 feeds into the TTS inputs of all four devices.

After initialization by a LOW level on the MR input, the IRF output of all four devices are HIGH. Under these conditions, only device 1 responds to the CPSI because its IES input is LOW. The first four clock pulses shift four data bits into the device-1 input register; its IRF output then becomes LOW. The first data bit is located in a flip-flop corresponding to the $D_{0}$ input of device 1 . Control logic inhibits the CPSI from further affecting this device.

Because the IES input of device 2 is now LOW, the clock starts shifting data into the input register of device 2 . On the eighth clock pulse, the IRF output of device 2 goes LOW and disables shifting of device 2. This process continues on devices 3 and 4 . Therefore, on the 16 th clock pulse, the IRF output of device 4 becomes LOW and activates the TTS inputs of all devices. The stack control logic in each device responds by transferring data into each stack from the respective input register, and the input registers are initialized. Thus the IRF outputs of all devices become HIGH once again. An automatic priority scheme assures that if the IRF output of device 4 is HIGH, the input registers of all four devices have been initialized. The timing diagram for 16 bits of serial entry into the array is shown in Figure 5-31.


Fig. 5-31 Serial Data Entry for FIFO Array

Parallel entry into the array is made with a HIGH level on the PL inputs. The same conditions prevail in the input section that exist after the 16th clock pulse in the serial entry mode. The stack controls do not initialize the input registers until the PL inputs are LOW to assure proper device operation.

Data loaded into the stacks eventually arrives at the output registers of the first four devices. Normally, the ORE outputs are LOW due to initialization; however, as soon as data is loaded into each output register, the ORE goes HIGH. An automatic priority scheme, similar to the one for data entry, also exists at the output. Thus a HIGH level on the ORE output of device 4 guarantees that valid data is present in all the output registers.

The ORE output of device 4 is connected to the PL inputs of devices 5 through 8, as well as to the TOS inputs of the first four devices. It should be noted that if serial extraction from the output is not desired, the TOS inputs can be connected to ground instead. The EO inputs of the first four devices are connected to ground; thus the contents of an output register are available on the appropriate outputs. .

The HIGH level on the ORE output of device 4 activates the PL inputs of devices $5 \ldots 8$, thus forcing the data outputs from each device in the first row into the input register of the corresponding device in the second row. The IRF output of device 8 is connected to the TOP inputs of devices $1 \ldots 4$ and to the TTS inputs of devices $5 \ldots 8$. Because the PL inputs are HIGH, the IRF outputs of devices 5 . . 8 are LOW, therefore establishing a LOW on the TOP inputs of devices $1 \ldots 4$. This causes the ORE of devices $1 \ldots 4$ to go LOW and hence the PL inputs to devices 5. . 8. Furthermore, the LOW on the IRF output of device 8 also activates the TTS inputs of devices $5 \ldots 8$, thus initiating a fall-through action. The stack controls in devices $5 \ldots 8$ initialize their respective registers and the IRF outputs go HIGH . An automatic priority scheme is also present at the inputs of devices 5...8. The HIGH on the IRF output of device 8 restores the TOP inputs of devices $1 \ldots 4$ to the quiescent state.

If the stacks of devices $5 \ldots 8$ are full, activating the TTS inputs by the LOW IRF output of device 8 would not initiate a data transfer from the input registers. The IRF output of device 8 would remain LOW until the data can be successfully transferred into the stacks. Thus, as long as devices $5 \ldots 8$ are holding 16 words, the IRF output of device 8 remains LOW. This also holds the TOP inputs of devices 1 . . 4 LOW. As long as they remain LOW, data cannot be loaded into the output registers from the stacks because a LOW-to-HIGH transition at the TOP inputs is needed to demand new data. Under these circumstances, devices $1 \ldots 4$ temporarily lose the ability to use their output registers and hence can hold only 15 words. As a result, the two rows have a storage capacity of 31 words instead of 32 ; and, for the general case, the storage capacity of an $n$-row array is $(15 n+1)$ instead of $16 n$.

The data loaded into the stacks eventually arrives at the output registers of devices $5 \ldots 8$, at which time the ORE outputs go HIGH from the LOW state originally initialized by the MR input. The automatic priority scheme is still in effect, and the data from the output can be extracted either in serial or parallel format.

The OS outputs of devices $5 \ldots 8$, each available through a 3 -state buffer, are connected together and the serial data output from the array appears on this line. The CPSO inputs are also connected together and the line driven by the output clock. When there is no valid data in the output register, $\mathrm{O}_{\mathrm{S}}$ is disabled and is therefore in a high impedance state.
The OES input of device 5 is connected to ground and devices 6,7 and 8 each receives its OES input from the preceding device. As soon as data arrives in the output registers of devices $5 \ldots 8$, the ORE outputs go HIGH and the 3 -state buffer of device 5 is enabled so that its $\mathrm{Q}_{\mathrm{S}}$ output becomes identical to tis $\mathrm{O}_{0}$ output. The $\mathrm{O}_{\mathrm{S}}$ outputs of devices $5 \ldots 8$ are in a high impedance state. The clock on the CPSO input shifts the device-5 output register and data is shifted out in the same bit order as entered at the array input. After the fourth clock pulse, the ORE output of device 5 goes LOW and its $Q_{S}$ output is disabled into the high impedance state.

The ORE output of device 5 establishes a LOW on the OES input of device 6. This enables its OS output buffer and a signal, corresponding to that of the $\mathrm{Q}_{0}$ output, appears on the serial output line. Device 6 now.


Fig. 5-32 Serial Data Extraction for FIFO Array
responds to the clock inputs and, after shifting the data out, its $\mathrm{O}_{\mathrm{S}}$ output goes into a high impedance mode. The LOW on the ORE output of device 6 enables device 7 . This process continues until the last data bit has been shifted out of device 8, at which time its ORE output goes LOW. This activates the TOS inputs of devices $5 \ldots 8$ and new data can then be loaded from the stack when available. The timing diagram for 16 bits of serial data extraction is shown in Figure 5-32.

Data can be extracted from the array in parallel by activating the TOP inputs of device 5 . . 8 LOW. New data is loaded into the output registers on the LOW-to-HIGH transition of this input. The TOP and EO inputs can be connected together so that data can be automatically extracted.

## Automatic Priority Scheme

Most conventional FIFO designs provide status signals analogous to the IRF and ORE outputs. However, when these devices are operated in arrays, unit-to-unit delay variations require external gating to avoid transient false-status indications. This is commonly referred to as composite-status signal generation. The design of the $9403 / 4703$ FIFO eliminates this problem. An automatic priority feature is built in to assure that a slow device will automatically predominate, irrespective of location in the array.
In Figure 5-30, devices 1 and 5 are defined as "row masters". Devices 2, 3 and 4 are "slaves" to device 1 while devices 6,7 and 8 are slaves to device 5 . The row master is established by sensing the IES input during the period when the MR input is LOW. Because of the initialization, the IRF outputs of all devices are HIGH for a short time after the HIGH-to-LOW transition of the MR input. Thus IES inputs of all devices except 1 and 5 are HIGH. This condition is sensed by the device logic to establish the row mastership.
All devices in any given row transfer data from their input registers into the corresponding stacks simultaneously. However, no slave can initialize its input register until its IES input goes HIGH. Thus initialization starts with the row master and eventually ends at the last slave in the row.

A similar situation occurs at the output registers of all devices in a row. They are loaded simultaneously from corresponding stacks; however, the ORE output of a slave cannot go HIGH until its OES input is HIGH. Thus the row master is the first to indicate a HIGH on its ORE and eventually the slaves will follow. It should be pointed out that this automatic priority scheme reduces the maximum operation speed of the array. If speed is essential, the master-slave hierarchy can be replaced by the traditional composite-status signal-generation scheme, which requires external gating.

## Other Expansion Schemes

The expansion scheme illustrated in Figure $5-30$ is quite simple and straightforward. It does not require any external support logic to achieve the desired expansion and retains all the serial/parallel features. However, these advantages are not without sacrifice-one storage location is eliminated at the interface between rows-and the n-row array has a storage capacity of $15 n+1$ instead of $16 n$ words. Moreover, the automatic priority scheme results in a ripple action from row master to the last slave in that row for the status signaling. This reduces the maximum operation frequency of an array and the inherent speed of the individual devices is not fully utilized.

The 9403/4703 FIFO, because of its versatility, can be used to overcome both above disadvantages with minimum external logic. A vertically expanded array, consisting of three FIFOs, yields 16 n words of storage for an n-row array (Figure 5-33). After initialization by a LOW level on the $\overline{\mathrm{MR}}$ inputs, the $\overline{\mathrm{IRF}}$ outputs of all three devices are HIGH and the ORE outputs LOW. The AND gates at the row interface are thus disabled. The PL inputs of devices 2 and 3 are LOW. Now, if the input register of device 1 receives four bits of data, then $\overline{\mathrm{IRF}}$ output goes LOW. This activates the $\overline{\mathrm{TTS}}$ input and the data falls through into the output register of device 1 and the $\overline{\text { ORE }}$ output becomes HIGH. Since the $\overline{\mathrm{RF}}$ output of device 2 is HIGH from initialization, the AND gate between devices 1 and 2 is enabled and the PL input of device 2 becomes HIGH. Data from device 1 is loaded into the input register of device 2 causing the IRF output of device 2 to go LOW. Moreover, a HIGH level on the PL input of device 2 results in a LOW level on the TOP input of device 1. As a result, the $\overline{\text { ORE }}$ output of device 1 also becomes LOW. Either way, the AND gate is disabled and the PL input of device 2 goes LOW and the TOP input of device 1 becomes HIGH.

The LOW level on the IRF output of device 2 activates its $\overline{T T S}$ input and initiates a fall-through action; the data appears at the output register. Because the TOP input of device 1 is HIGH, new data arrives at the device-2 output register. When data appears at the output of device 2, the AND gate at the interface of devices 2 and 3 is enabled. By a similar action described above, device 3 takes the data word into its input register and passes it on to the output. Thus, if 16 words are loaded at the input to the array, the 1 st word is located in the output and the 16th word is in the input register of device 3 . Device 3 is full now and its $\overline{\text { IRF }}$ output remains LOW until data is extracted. This LOW level disables the AND gate between devices 2 and 3 and hence any arrival of new data into the output register of device 2 does not activate the PL input of device 3. As new data is received, it is arranged in devices 1 and 2 so that the 17th data word falls into the device 2 output register and the 48th word remains in the input register of device 1. Forty-eight data words fill all devices in the array. Under these conditions, the status output is as follows: the $\overline{\mathrm{IRF}}$ outputs of devices 1, 2, and 3 are LOW and the $\overline{\text { ORE }}$ outputs of devices 1,2 and 3 HIGH.

The data extraction takes place when the TOP input of device 3 is activated; normally it is HIGH. To extract data, TOP is made LOW and then HIGH. When the TOP input is LOW, the $\overline{\text { ORE }}$ of device 3 goes LOW. When TOP is returned HIGH, data is demanded from the stack.

The internal control in device 3 loads the second data word into the output register and the $\overline{\text { ORE }}$ goes HIGH. The internal control also initiates a fall through action in device 3 . Thus, the 16 th data word that was located in the input register is transferred into the device - 3 stack and the input register is initialized. Thus, the $\overline{\mathrm{RF}}$ output of device 3 becomes HIGH.

The 17 th data word is located in the output register of device 2 , hence the $\overline{\text { ORE }}$ output is HIGH. When the $\overline{\text { IRF }}$ output of device 3 becomes HIGH, the AND gate at the interface causes the PL input of device 3 to go HIGH and the TOP input of device 2 LOW. The 17 th data word then goes into the input register of device 3. The internal control of device 2 initiates fall-through action so that the 18th word falls into the output and the 32 nd word is transferred into the stack. This results in a HIGH at the $\overline{\mathrm{RFF}}$ output of device 2. Similar action takes place between devices 1 and 2 with the net result that all data has fallen one location creating a vacancy in the input register of device 1. It is now clear that this FIFO array has a 48 -word capacity without affecting the serial/parallel data feature at the input or the output. It can then be concluded that if an array of $n$ rows is constructed using the proposed scheme, the effective storage capacity of the FIFO is $16 n$ words.


Fig. 5-33 Expansion without Sacrificing a Storage Location at the Interface

The array of Figure $5-34$ has all the features and yet operates at a higher speed than the array shown in Figure 5-30. Whenever the $\overline{\mathrm{IRF}}$ output of device 1 is HIGH, the $\overline{\mathrm{IES}}$ inputs of devices 2, 3 and 4 are also HIGH. Therefore, when the array is initialized by a LOW level on the $\overline{M R}$ inputs, device 1 is the row master and devices 2, 3 and 4 are the slaves. In the second row of devices, the IRFs and IESs are interconnected so that device 5 is also a row master and devices 6,7 and 8 are slaves.

When serial data is entered into the array, device 1 receives the first four bits of data. Devices 2, 3 and 4 do not respond to the clock since all three $\overline{\mathrm{ES}}$ inputs are HIGH. After the 4 th bit, the $\overline{\mathrm{RF}}$ output of device 1 is LOW. This disables device 1 from responding to the clock and enables device 2 so that the next four bits are entered into device 2. Devices 3 and 4 remain disabled by a HIGH level on the $\overline{\mathrm{IES}}$ inputs. After the 8 th bit, the $\overline{\mathrm{RF}}$ of device 2 becomes LOW, thus disabling device 2 and enabling device 3 . After the 12 th bit, the $\overline{\text { IRF }}$ output of device 3 is LOW and thus device 4 is enabled. After the 16 th bit, the $\overline{\text { IRF output of }}$ device 4 is LOW. So far, the serial data entry into this array is identical to that for the array in Figure 5-30.
The LOW level on the $\overline{\mathrm{RF}}$ output of device 4 activates the $\overline{\mathrm{TTS}}$ inputs of all 4 devices, causing the transfer of data into the stacks. Although all devices transfer data into the stack simultaneously, device 1 (row master) is the first to initialize its input register. Since devices 2, 3 and 4 are slaves, they need a HIGH on their $\overline{\mathrm{IES}}$ inputs for input-register initialization. As soon as the $\overline{\mathrm{RF}}$ output of device 1 goes HIGH due to initialization, the $\overline{\text { IES }}$ inputs of devices 2, 3 and 4 become HIGH and their input registers are initialized simultaneously. This is in contrast to Figure 5-30 where device 3 has to wait for device 2 to initialize, etc. The ripple action of input initialization has been overcome by simple gating. The IRF outputs of devices 1 , 2,3 and 4 are fed into 4 -input AND gates to generate the composite input status. To obtain an indication that the input register of the array is empty, the input register of each device in the first row should be empty.

The $\overline{\mathrm{ORE}}$ and $\overline{\mathrm{OES}}$ interconnections for the second row are essentially similar to the input section. This gating at the output section eliminates the rippling effect of the output status indication. If the gating arrangement used in Figure $5-33$ is incorporated into the array of Figure 5-34, the result is a 32 word x 16-bit FIFO network.


Fig. 5-34 Expansion with Priority Defeated for Faster Operation

| DEVICE INDEX AND |
| :--- |
| SELECTOR INFORMATION |

## BIPOLAR MACROLOGIC

## CMOS MACROLOGIC



## MACROLOGIC ORDERING INFORMATION

Fairchild Macrologic circuits may be ordered using a simplified purchasing code in which the package style and temperature range are defined below.

## TEMPERATURE RANGE

$M=$ Military $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
$\mathrm{C}=$ Commercial $0^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$ (Bipolar), $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (CMOS)

## PACKAGE STYLE

$\mathrm{D}=$ Dual In-line - Ceramic (Hermetic)
P = Dual In-line - Plastic


In order to accommodate varying die sizes (MSI, LSI, etc.), numbers of pins (16, 18, 24, etc.), and package outlines, a number of different package forms are required in each of the three package style categories.

The following list indicates the specific package dimensions currently used for each device type. The detailed outline corresponding to each package code is shown at the end of this section.

| DEVICE | CERAMIC DIP (D) | PLASTIC DIP (P) | FLATPAK <br> (F) |
| :---: | :---: | :---: | :---: |
| Bipolar |  |  |  |
| 9401 | 7A | 9A |  |
| 9403 | 60 | 9 U |  |
| 9404 | 60 | 9 U |  |
| 9405 | 60 | 9 U |  |
| 9405A | 60 | 90 |  |
| 9406 | 60 | 90 |  |
| 9407 | 60 | 9 U |  |
| 9408 | 61 | 8P |  |
| 9410 | 7D | 9M |  |
| CMOS |  |  |  |
| 4702 | 6B | 9 B | 4L |
| 4703 | 60 | 9 O | 4M |
| 4704 | 60 | 90 | 4M |
| 4705 | 60 | 90 | 4M |
| 4706 | 60 | 90 | 4M |
| 4707 | 60 | 90 | 4M |
| 4708 | 61 | 8P |  |
| 4710 | 7D | 9M |  |

## PACKAGE OUTLINES



24-Pin BeO Cerpak


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are gold-plated kovar
Package weight is 0.8 gram

## PACKAGE OUTLINES

16-Pin Ceramic Dual In-line
6B

## 40-Pin Dual In-line Side-Brazed Package (Large Cavity)



NOTES:
All dimensions in inches (bold) and millimeters (parentheses) Pins are intended for insertion in hole rows on .400' (10.16) centers
They are purposely shipped with "positive" misalignment to facilitate insertion
Board-drilling dimensions should equal your practice for .020" (0.51) diameter pin
Pins are tin-plated kovar




NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pin material nickel gold-plated kovar Cap is kovar
Base is ceramic
Package weight is 6.5 grams

24-Pin Ceramic Dual In-line


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are intended for insertion in hole rows on .300" (7.62) centers
They are purposely shipped with "positive" misalignment to facilitate insertion
Board-drilling dimensions should equal your practice for $.020^{\prime \prime}(0.51)$ diameter pins
Pins are tin-plated kovar
Package weight is 2.0 grams
*The .037/.027 dimension does not apply to the corner pins

## PACKAGE OUTLINES

14-Pin Ceramic Dual In-line


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are intended for insertion in hole rows on .300" (7.62) centers
They are purposely shipped with "positive" misalignment to facilitate insertion
Board-drilling dimensions should equal your practice for .020" (0.51) diameter pin
Pins are tin-plated kovar
Package weight is 2.0 grams


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are intended for insertion in hole rows on .300" (7.62) centers
They are purposely shipped with "positive" misalignment to facilitate insertion
Board-drilling dimensions should equal your practice for .020" (0.51) diameter pin
Pins are tin-plated kovar
*The .037/.027 dimension does not apply to the corner pins


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are tin-plated kovar
Package material is plastic
Pins are intended for insertion in hole rows on .600" (15.24) centers
They are purposely shipped with "positive" misalignment to facilitate insertion

## PACKAGE OUTLINES



## PACKAGE OUTLINES

18-Pin Plastic Dual In-line


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are intended for insertion in hole rows on .300" (7.62) centers
They are purposely shipped with "positive" misalignment to facilitate insertion
Board-drilling dimensions should equal your practice for .020" (0.51) diameter pin Pins are tin-plated kovar


NOTES:
All dimensions in inches (bold) and millimeters (parentheses)
Pins are intended for insertion in hole rows on .300" (7.62) centers
They are purposely shipped with "positive" misalignment to facilitate insertion
Board-drilling dimensions should equal your ,practice for $.020^{\prime \prime}(0.51)$ diameter pin Pins are tin-plated kovar

## DEVICE INDEX AND

SELECTOR INFORMATION

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## CMOS MACROLOGIC

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Tel: 617-861-9200 TWX: 710-326-6617

## FAIRCHILD FRANCHISED DISTRIBUTORS (Cont'd) UNITED STATES AND CANADA

## SCHWEBER ELECTRONICS

213 Third Avenue
Waltham, Massachusetts 02154
Tel: 617-890-8484

## MICHIGAN

HAMILTON/AVNET ELECTRONICS
12870 Farmington Rd.
Livonia, Michigan 48150
Tel: 313-522-4700 TWX: 810-242-8775
PIONEER/DETROIT
13485 Stamford
Livonia, Michigan 48150
Tel: 313-525-1800
SCHWEBER ELECTRONICS
86 Executive Drive
Troy, Michigan 48084
Tel: 313-583-9242
SHERIDAN SALES CO.
24543 Indoplex Drive (P.O. Box 529)
Farmington, Mich. 48024
Tel: 313-477-3800

## minNESOTA

HAMILTON/AVNET ELECTRONICS
7683 Washington Ave. South
Edina, Minnesota 55435
Tel: 612-941-3801
TWX: None - use 910-227-0060
(Regional Hq. in Chicago, III.)
SCHWEBER ELECTRONICS
7402 Washington Ave. South
Eden Prairie, Minnesota 55343
Tel: 612.941-5280
SEMICONDUCTOR SPECIALISTS, INC.
8030 Cedar Avenue South
Minneapolis, Minnesota 55420
Tel: 612-854-8841. TWX: 910-576-2812
MISSISSIPPI
ELLINGTON ELECTRONICS SUPPLY, INC 1425 Terry Road
Jackson, Mississippi 39204
Tel: 601-355-0561
MISSOURI
HAMILTON/AVNET ELECTRONICS
364 Brookes Lane
Hazelwood, Missouri 63042
Tel: 314.731-1144 TWX: 910-762-0606
SEMICONDUCTOR SPECIALISTS, INC.
3805 N. Oak Trafficway
Kansas City, Mo. 64116
Tel: 816-452-3900 TWX: 910-771-2114
NEW JERSEY
HAMILTON/AVNET ELECTRONICS
218 Little Falls Road
Cedar Grove, New Jersey 07009
Tel: 201-239-0800 TWX: 710-994-5787
HAMILTON/AVNET ELECTRONICS
113 Gaither Drive
East Gate Industrial Park
Mt. Laurel, N.J. 08057
Tel: 609-234-2133 TWX: 710-897-1405
SCHWEBER ELECTRONICS
43 Belmont Drive
Somerset, N.J. 08873
Tel: 201-469-6008 TWX: 710-480-4733
STERLING ELECTRONICS
774 Pfeiffer Blvd.
Perth Amboy, N.J. 08861
Tel: 201-442-8000 Telex: 138-679
WILSHIRE ELECTRONICS
1111 Paulison Avenue
Clifton, New Jersey 07011
Tel: 201-365-2600 TWX: 710-989-7052

## NEW MEXICO

CENTURY ELECTRONICS
121 Elizabeth, N.E.
Albuquerque, New Mexico 87123 Tel: 505-292-2700 TWX: 910-989-0625

HAMILTON/AVNET ELECTRONICS 2450 Baylor Dr. S.E
Albuquerque, New Mexico 87119
Tel: 505-765-1500
TWX: None - use 910-379-6486 (Regional Hq. in Mt. View, Ca.)

## NEW YORK

COMPONENTS PLUS, INC
40 Oser Avenue
Hauppauge, L.I., New York 11787 Tel: 516-231-9200 TWX: 510-227-9869

HAMILTON/AVNET ELECTRONICS
167 Clay Road
Rochester, New York 14623
Tel: 716-442-7820
TWX: None - use 710-332-120
(Regional Hq. in Burlington, Mass.)
HAMILTON/AVNET ELECTRONICS
6500 Joy Road
E. Syracuse, New York 13057

Tel: 315-437-2642 TWX: 710-541-0959
HAMILTON/AVNET ELECTRONICS
70 State Street
Westbury, L.I., New York 11590
Tel: 516-333-5800 TWX: 510-222-8237
ROCHESTER RADIO SUPPLY CO., INC.
140 W. Main Street
(P.O. Box 1971)

Rochester, New York 14603
Tel: 716-454-7800
SCHWEBER ELECTRONICS
Jericho Turnpike
Westbury, L.I., New York 11590
Tel: 516-334-7474 TWX: 510-222-3660
SCHWEBER ELECTRONICS, INC.
2 Town Line Circle
Rochester, New York 14623
Tel: 716-461-4000
SEMICONDUCTOR CONCEPTS
145 Oser Ave.
Hauppauge, L.I., New York 1178
Tel: 516-273-1234 TWX: 510-227-6232
SUMMIT DISTRIBUTORS, INC.
916 Main Street
Buffalo, New York 14202
Tel: 716-884-3450 TWX: 710-522-1692
NORTH CAROLINA
HALLMARK ELECTRONICS
3000 Industrial Drive
Raleigh, North Carolina 27609
Tel: 919-832-4465 TWX: 510-928-1831
KIRKMAN ELECTRONICS, INC
901 W. Second Street
Winston-Salem, North Carolina 27108
Tel: 919-722-9131
PIONEER/CAROLINA ELECTRONICS
2906 Baltic Avenue
Greensboro, North Carolina 27406
Tel: 919-273-4441
OHIO
HAMILTON/AVNET ELECTRONICS
761 Beta Drive, Suite ' $E$ '
Cleveland Ohio 44143
Tel: 216-461-1400
TWX: None - use 910-227-0060
(Regional Hq. in Chicago, III.)
HAMILTON/AVNET ELECTRONICS
118 Westpark Road
Dayton, Ohio 45459
Tel: 513-433-0610 TWX: 810-450-2531
PIONEER/CLEVELAND
4800 East 131 st Street
Cleveland, Ohio 44105
Tel: 216-587-3600
PIONEER/DAYTON
1900 Troy Street
Dayton, Ohio 45404
Tel: 513-236-9900 TWX: 810-459-1622
SCHWEBER ELECTRONICS
23880 Commerce Park Road
Beachwood, Ohio 44122
Tel: 216-464-2970 TWX: 810-427-9441
SHERIDAN SALES COMPANY
23224 Commerce Park Road
Beachwood Ohio 44122
Tel: 216-831-0130 TWX: 810-427-2957

SHERIDAN SALES CO
mailing address)
P.O. Box 37826

Cincinnati, Ohio 45222
(shipping address)
10 Knollcrest Drive
Reading, Ohio 45237 WX. 810-461-2670
OKLAHOMA
HALLMARK ELECTRONICS
4846 South 83rd East Avenue
Tulsa, Oklahoma 74145
Tel: 918-835-8458 TWX: 910-845-2290
PENNSYLVANIA
HALLMARK ELECTRONICS, INC.
458 Pike Road
Huntingdon Valley, Pennsylvania 19006
Tel: 215-355-7300 TWX: 510-667-1727
PIONEER/DELWARE VALLEY, INC.
203 Witmer Rd.
Horsham, Pennsylvania 19044
Tel: 215-674-5710 (from Pennsylvania phones)
Tel: 609-541-1120 (from New Jersey phones)
PIONEER ELECTRONICS, INC
560 Alpha Drive
Pittsburgh, Pennsylvania 15238
Tel: 412-782-2300 TWX: 710-795-3122
SCHWEBER ELECTRONICS
101 Rock Road
Horsham, Pennsylvania 19044
Tel: 215-441-0600
SHERIDAN SALES COMPANY
1717 Penn Ave.
Suite 5009
Pittsburgh, Pennsylvania 15221
Tel: 412-244-1640
SOUTH CAROLINA
DIXIE RADIO SUPPLY CO., INC
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1900 Barnwell Street
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Tel: 803-779-5332

## TEXAS

ALLIED ELECTRONICS
401 East 8th Street
Fort Worth, Texas 76102
Tel: 817-336-5401
CRAMER ELECTRONICS
13740 Midway Road, Suite 700
Dallas, Texas 75240
Tel: 214-661-9300
HALLMARK ELECTRONICS
9333 Forest Lane
Dallas, Texas 75231
Tel: 214-231-6111
HAMILTON/AVNET ELECTRONICS
4445 Sigma Road
Dallas, Texas 75240
Tel: 214-661-8661
Telex: HAMAVLECB DAL 73-0511
HAMILTON/AVNET ELECTRONICS
3939 Ann Arbor
Houston. Texas 77042
Tel: 713-780-1771
Telex: HAMAVLECB HOU 76-2589
SCHWEBER ELECTRONICS, INC.
14177 Proton Road
Dallas, Texas 75240
Tel: 214-661-5010 TWX: 910-860-5493
SCHWEBER ELECTRONICS, INC.
7420 Harwin Drive
Houston, Texas 77036
Tel: 713-784-3600 TWX: 910-881-1109
STERLING ELECTRONICS
4201 Southwest Freeway
Houston, Texas 77027
Tel: 713-627-9800 TWX: 910-881-5042
Telex: STELECO HOUA 77-5299

## FAIRCHILD FRANCHISED DISTRIBUTORS (Cont'd) UNITED STATES AND CANADA

UTAH
CENTURY ELECTRONICS
2150 South 300 West
Salt Lake City, Utah 84115
Tel: 801-487-8551 TWX: 910-925-5686
HAMILTON/AVNET ELECTRONICS
647 W. Billinis Rd.
Salt Lake City, Utah 84119
Tel: 801-262-8451
TWX: None - use 910-379-6486 (Regional Hq. in Mt. View, Ca.)

WASHINGTON
HAMILTON/AVNET ELECTRONICS
13407 Northrup Way
Bellevue, Washington 98005
Tel: 206-746-8750 TWX: 910-443-2449
LIBERTY ELECTRONICS
5305 2nd Ave. South
Seattle, Washington 98108
Tel: 206-763-8200 TWX: 910-444-1379
RADAR ELECTRIC CO., INC.
168 Western Avenue West
168 Western Avenue West
Seattle, Washington 981
Tel: 206-282-2511 TWX: 910-444-2052

## WISCONSIN

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6047 Beloit Road
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Tel: 414-545-6500 TWX: 910-262-3321
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10855 W. Potter Road
Wauwatosa, Wisconsin 53226
Tel: 414-257-1330 TWX: 910-262-3022

## CANADA

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640 42nd Avenue S.E.
Calgary, Alberta, T2G 1Y6, Canada
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| CAM GARD SUPPLY LTD. <br> 10505 111th Street <br> Edmonton, Alberta, T5H 3E8, Canada <br> Tel: 403-426-1805 Telex: 03-72960 |  |
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| CAM GARD SUPPLY LTD. |  |
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| Red Deer, Alberta, T4N 2C8, Canada |  |
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FUTURE ELECTRONICS CORPORATION
130 Albert Street
Ottawa, Ontario, K1P 5G4, Canada
Tel: 613-232-7757
FUTURE ELECTRONICS CORPORATION
44 Fasket Drive, Unit #24
Rexdale, Ontario,M9W MK5, Canada
Tel: 416-677-7820
FUTURE ELECTRONICS CORPORATION
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Montreal, Quebec, H4P 2K5, Canada
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CANADA) LTD.
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Tel: 416-677-7432 TWX: 610-492-8867
HAMILTON/AVNET INTERNATIONAL
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Ottawa, Ontario, K1Z 5L9, Canada
Tel: 613-226-1700
HAMILTON/AVNET INTERNATIONAL
(CANADA) LTD
2670 Paulus Street
St. Laurent, Quebec, H4S 1G2, Canada
Tel: 514-331-6443 TWX: 610-421-3731
R.A.E. INDUSTRIAL ELECTRONICS, LTD
1629 Main Street
Vancouver, British Columbia, V6A 2W5, Canada
Tel: 604-687-2621 TWX: 610-929-3065
Telex: RAE-VCR 04-54550
SEMAD ELECTRONICS LTD
625 Marshall Ave., Suite 2
Dorval, Quebec, H9P 1E1, Canada
Tel: 514-636-4614 TWX: 610-422-3048
SEMAD ELECTRONICS LTD
1111 Finch Ave. W., Suite }10
lon
Tel: 416-635-9880 TWX: 610-492-2510
SEMAD ELECTRONICS LTD.
1485 Laperriere Ave.
Ottawa, Ontario, K1Z 7S8, Canada
Tel: 613-722-6571 TWX: 610-562-8966
```

FAIRCHILD SALES REPRESENTATIVES
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| ALABAMA <br> CARTWRIGHT \& BEAN, INC. <br> 2400 Bob Wallace Ave., Suite 201 <br> Huntsville, Alabama 35805 <br> Tel: 205-533-3509 |
| :---: |
| ARIZONA <br> ELECTRONIC DEVELOPMENT \& SALES CORP. <br> 4414 North 19th Avenue, Suite H <br> Phoenix, Arizona 85015 <br> Tel: 602-277-7407 TWX: 910-951-1544 |
| CALIFORNIA <br> CELTEC COMPANY <br> 2041 Business Center Drive, Suite 211 <br> Irvine, California 92664 <br> Tel: 714-752-6111 TWX: 910-595-2512 |
| CELTEC COMPANY <br> 15300 Ventura Blvd., Room 200 Sherman Oaks, California 91403 Tel: 213-990-3440 TWX: 910-495-2010 |
| CELTEC COMPANY <br> 7380 Clairemont Mesa Blvd., Suite 109 <br> San Diego, California 92111 <br> Tel: 714-279-7961 TWX: 910-335-1512 |
| MAGNA SALES, INC. <br> 3080 Olcott Street, Suite 210A <br> Santa Clara, California 95050 <br> Tel: 408-985-1750 TWX: 910-338-0241 |
| COLORADO <br> SIMPSON ASSOCIATES, INC. <br> 2552 Ridge Road <br> Littleton, Colorado 80120 <br> Tel: 303-794-8381 TWX: 910-935-0719 |
| CONNECTICUT <br> PHOENIX SALES COMPANY <br> 389 Main Street <br> Ridgefield, Connecticut 06877 <br> Tel: 203-438-9644 TWX: 710-467-0662 |
| FLORIDA <br> LECTROMECH, INC. <br> 303 Whooping Loop <br> Altamonte Springs. Florida 32701 <br> Tel: 305-831-1577 TWX: 810-853-0262 |
| LECTROMECH, INC. <br> 2741 North 29th Avenue, Suite 218 <br> Hollywood, Florida 33020 <br> Tel: 305-920-2291 TWX: 510-954-9793 |
| LECTROMECH, INC. <br> 5527 Bayou Grande N.E. <br> St. Petersburg, Florida 33703 <br> Tel: 813-527-2406 |
| GEORGIA <br> CARTWRIGHT \& BEAN, INC. <br> P.O. Box 52846 (Zip Code 30355) <br> 90 W. Wieuca Square, Suite 155 <br> Atlanta, Georgia 30342 <br> Tel: 404-255-5262 TWX: 810-751-3220 |
| ILLINOIS <br> MICRO SALES, INC. <br> 2258-B Landmeir Road <br> Elk Grove Village, Illinois 60007 <br> Tel: 312-956-1000 |
| INDIANA <br> LESLIE M. DEVOE COMPANY <br> 7172 North Keystone Ave., Suite C Indianapolis, Indiana 46240 Tel: 317-257-1227 TWX: 810-341-3284 |
| IOWA <br> B.C. ELECTRONIC SALES, INC. 858 First Avenue N.E. Cedar Rapids, lowa 52402 Tel: 319-364-7253 |
| KANSAS <br> B.C. ELECTRONIC SALES, INC. <br> P.O. Box 788 <br> 11495 Lenexa Drive <br> Olathe, Kansas 66061 <br> Tel: 913-888-6680 TWX: 910.749-6414 |

## MARYLAND

DELTA III ASSOCIATES
5801 Annapolis Road, Suite 500
Bladensburg, Maryland 20710
Tel: 301-779-0977 TWX: 710-826-9654
MASSACHUSETTS
SPECTRUM ASSOCIATES, INC.
888 Worcester Street
Wellesley, Massachusetts 02181
Tel: 617-237-2796 TWX: 710-348-0424
MICHIGAN
RATHSBURG ASSOCIATES
16621 E. Warren Ave.
Detroit, Michigan 48224
Tel: 313-882-1717 Telex: $23-5229$

## MINNESOTA

PSI COMPANY
7710 Computer Avenue
Minneapolis, Minnesota 55435
Tel: 612-835-1777 TWX: 910-576-2740
MISSISSIPPI
CARTWRIGHT \& BEAN, INC.
P.O. Box 16728

5250 Galaxy Drive, Suite J
Jackson, Mississippi 39206
Tel: 601-981-1368
MISSOURI
B.C. ELECTRONIC SALES, INC

300 Brookes Drive, Suite 105
Hazelwood, Missouri 63042
Tel: 314-731-1255 TWX: 910-762-0600
NEW JERSEY
LORAC SALES, INC.
580 Valley Road
Wayne, New Jersey 07470
Tel: 201-696-8875 TWX: 710-988-5846
NEW MEXICO
INTERFACE ELECTRONICS, INC.
South \#1
2403 San Mateo N.E
Albuquerque, New Mexico 87110
Tel: 505-265-9521 TWX: 910-379-6435

## NEW YORK

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275 Broadhollow Road
Melville, L.I., New York 11746
Tel: 516-293-2970 TWX: 510-224-6480
TRI-TECH ELECTRONICS, INC.
3215 East Main Street
Endwell, New York 13760
Tel: 607-754-1094 TWX: 510-252-0891
TRI-TECH ELECTRONICS, INC.
290 Perinton Hills Office Park
Fairport, New York 14450
Tel: 716-223-5720
TRI-TECH ELECTRONICS, INC.
6836 East Genesee Street
Fayetteville, New York 13066
Tel: 315-446-2881 TWX: 710-541-0604
NORTH CAROLINA
CARTWRIGHT \& BEAN, INC
625 Harwyn Drive
Charlotte, North Carolina 28215
Tel: 704-333-6457
CARTWRIGHT \& BEAN, INC
P.O. Box 18465
P.O. Box 18465
3948 Browning Place

3948 Browning Place
Raleigh, North Carolina 27609
Raleigh, North Carolina 27609
Tel: 919.781-6560

OHIO
COMPONENTS, INC
16600 Sprague Rd., Suite 235
Interstate Plaza
Cleveland, Ohio 44130
Tel: 216-243-9200 TWX: 810-423-9435
COMPONENTS, INC.
9 Pierce Street
West Carroliton, Ohio 45449
Tel: 513-866-0661

## OKLAHOMA

TECHNICAL MARKETING
9717 East 42nd Street, Suite 210
Tulsa, Oklahoma 74101
Tel: 918-622-5984
OREGON
QUADRA CORPORATION
P.O. Box 23681

4227 N.E. Azalea 97123
Tel: 503-225-0350 TWX: 910-443-2318
PENNSYLVANIA
BGR ASSOCIATES
500 Office Center
Fort Washington Industrial Park
Fort Washington, Pennsylvania 19034
Tel: 215-643-4111 TWX: 510-665-1654
COMPONENTS, INC.
6107 Squires Manor Lane
Library, Pennsylvania 15129
Tel: 412-833-9380
TENNESSEE
CARTWRIGHT \& BEAN, INC.
P.O. Box 4760

560 S. Cooper Street
Memphis, Tennessee 38104
Tel: 901-276-4442
CARTWRIGHT \& BEAN, INC.
8501 Kingston Pike
Knoxville, Tennessee 37919
Tel: 615-693-7450

## TEXAS

TECHNICAL MARKETING
4445 Alpha Road, Suite 102
Dallas, Texas 75240
Tel: 214-387-3601 TWX: 910-860-5158
TECHNICAL MARKETING
6430 Hillcroft, Suite 104
Houston, Texas 77036
Tel: 713-777-9228
UTAH
SIMPSON ASSOCIATES, INC
P.O. Box 151430

Salt Lake City, Utah 84115
Tel: 801-486-3731
WASHINGTON
QUADRA CORPORATION
1621 - 114th Avenue S.E.
Suite 212
Bellevue, Washington 98004
Tel: 206-454-4946 TWX: 910-443-2318

## WISCONSIN

LARSEN ASSOCIATES
10855 West Potter Road
Wauwatosa, Wisconsin 53226
Tel: 414-258-0529

## CANADA

R.N. LONGMAN SALES, INC. (L.S.I.)

1590 Matheson Blvd., Unit \#26
Mississauga, Ontario, L4W 1J1, Canada
Tel: 416-625-6799 or 6770 TWX: 610-492-4311
R.N. LONGMAN SALES, INC. (L.S.I.)

1385 Mazurette Street W., Suite \#3
Montreal, Quebec, H4N 1G8, Canada
Tel: 514-382-2552 TWX: 610-421-317

FAIRCHILD SALES OFFICES
UNITED STATES AND CANADA

ALABAMA
untsville Office*
3322 So. Memorial Parkway 35801
uite 92
Tel: 205-883-7020 TWX: 810-726-2214

## ARIZONA

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CALIFORNIA
os Angeles Office*
6922 Hollywood Blva. 90028
Suite 818
Tel: 213-466-8393 TWX: 910-321-3009
Santa Ana Office
2101 East Fourth St. 92705
Bldg. B, Suite 185
Tel: 714-558-1881 TWX: 910-595-1109
Santa Clara Office*
3080 Olcott Street 95050
Suite 210A
Tel: 408-244-1400 TWX: 910-338-0241

## FLORIDA

Orlando Office*
Crane's Roost Office Park
303 Whooping Loop
Altamonte Springs 3270
Tei: 305-834-7000 TWX: 810-850-0152
GEORGIA
Atlanta Office*
1504 Idlehour Way
Tucker 30084
Tel: 404-939-3402

## ILLINOIS

Chicago Office*
The Tower - Suite 610
Rolling Meadows 60008
Tel: 312-640-1000

INDIANA
Fort Wayne Office
2118 Inwood Drive 46805
2118 Inwood Drive 46805
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Indianapolis Office*
7202 N. Shadeland 46250
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5801 Annapolis Road 20710
Suite 500
Tel: 301-779-0954 TWX: 710-826-9654
MASSACHUSETTS
Boston Office*
888 Worcester Stree
Wellesley Hills 02181
Tel: 617-237-3400 TWX: 710-348-0424

## MICHIGAN

Detroit Office*
Westland Office Plaza
33300 Warren Avenue, Suite 101
Westland 48185
Tel: 313-425-3250 TWX: 810-242-2973

## MINNESOTA

Minneapolis Office*
7600 Parklawn Avenue
Room 251
Edina 55435
Tel: 612-835-3322 TWX: 910-576-2944
NEW JERSEY
Wayne Office
580 Valley Road 07490
Suite 1
Tel: 201-696-7070
NEW MEXICO
Albuquerque Office
2403 San Mateo N.E. 87110
Plaza \#2
Tel: 505-265-5601 TWX: 910-989-1186

## NEW YORK

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Tel: 516-293-2900 TWX: 510-224-6480

Poughkeepsie Office
15 College View Ave. 12603
Tel: 914-452-4200 TWX: 510-248-0030
Rochester Office*
260 Perinton Hills Office Park
260 Perinton Hi
Tel: 716-223-7700
OHIO
Cleveland Office
6151 Wilson Mills Rd., Suite 10
Highland Heights 44143
Tel: 216-461-8288 TWX: 810-427-9271
Dayton Office
4812 Frederick Road 45414
Suite 101
Tel: 513-278-8278 TWX: 810-459-1803
OKLAHOMA
Tulsa Office
9717 E. 42nd Street 74101
Suite 210
Tel: 918-663-7131
PENNSYLVANIA
Philadelphia Office*
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Fort Washington 19034
Tel: 215-886-6623

## TEXAS

Dallas Office*
13771 N. Central Expressway 75231
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Tel: 214-234-3391 TWX: 910-867-4757
Houston Office*
6430 Hillcroft 7708
Suite 102
Tel: 713-771-3547 TWX: 910-881-6278

## CANADA

Toronto Regional Office
Fairchild Semiconductor
1590 Matheson Blvd., Unit 26
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## INTERNATIONAL

FAIRCHILD SALES OFFICES

## AUSTRALIA

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[^0]:    *5.0 V VDD

[^1]:    - EIGHT GENERAL REGISTERS/ACCUMULATORS IN A SINGLE PACKAGE
    - OPTIMIZED FOR MICROPROGRAMMED OPERATION
    - HIGH SPEED - 13 MHz MICROINSTRUCTION RATE (SINGLE SLICE)
    - EXPANDABLE IN MULTIPLES OF FOUR BITS
    - PROVIDES FOR RIPPLE OR CARRY LOOKAHEAD
    - PROVIDES STATUS - CARRY, ZERO, NEGATIVE AND OVERFLOW
    - 3-STATE OUTPUTS
    - SLIM 24-PIN PACKAGE

[^2]:    ${ }^{*}$ LLOW $=-55^{\circ} \mathrm{C}$ for Military Temp. Range device, $-40^{\circ} \mathrm{C}$ for Commercial Temp. Range device
    ${ }^{*}{ }^{\text {THIGH }}=+125^{\circ} \mathrm{C}$ for Military Temp. Range device, $+85^{\circ} \mathrm{C}$ for Commercial Temp. Range device

[^3]:    $V_{D D}=P$ in 16
    $V_{S S}=\operatorname{Pin} 8$
    $O=$ Pin Number

[^4]:    Notes on following page.

[^5]:    $H=H I G H$ Level
    $L=$ LOW Level

[^6]:    Notes on following pages.

